

# LS1020A

## QorIQ LS1020A Data Sheet

### Features

- Arm® Cortex®-A7 MPCore compliant with Armv7-A™ architecture
- LS1020A contains a dual-core Cortex-A7. Each core includes:
  - 32 KB L1 Instruction Cache (ECC protection)
  - 32 KB L1 Data Cache (ECC protection)
  - NEON Co-processor
  - Floating Point (FPU)
  - QorIQ Trust Architecture and Arm TrustZone®
- Snoop Control Unit (SCU)
- 512 KB unified I/D L2 Cache (ECC protection)
- Hierarchical interconnect fabric
  - The platform has a single 128-bit AMBA 4 AXI Coherency Extensions (ACE) master port, which connects to CCI-400 Interconnect.
- One 8/16/32-bit DDR3L/DDR4 SDRAM memory controllers
  - ECC and interleaving support
- VeTSEC Ethernet complex
  - Up to 3x Gigabit Ethernet
  - MII, RMII, RGMII, and SGMII support
  - QoS, lossless flow control, and IEEE® 1588
- Up to 4 SerDes lanes for high-speed peripheral interfaces
  - Two PCI Express Gen2 controllers
  - One Serial ATA 3.0 (SATA 1.5, 3.0, 6.0 Gbps) controller
  - Two SGMII interfaces supporting 1000 Mbps
- Integrated audio block
  - Four synchronous audio interfaces (SAI)
  - I2S, AC97, and Codec/DSP interfaces
  - Sony/Philips Digital Interconnect Format (S/PDIF)
  - Asynchronous Sample Rate Converter (ASRC)
- Additional peripheral interfaces
  - One high-speed USB 3.0 controller with integrated PHY
  - One high-speed USB 2.0 controller with ULPI
  - Enhanced secure digital host controller (eSDHC/MMC/eMMC)
  - Three I2C controllers
  - FlexTimer/PWM
  - SPI interface
  - QuadSPI controller
  - Two DUARTs
  - Six LPUART interfaces
  - Integrated flash controller supporting NAND and NOR flash
  - TDM interface
  - Four GPIO controllers supporting up to 109 general purpose I/O signals
  - One 4-channel qDMA controller and one eDMA controller
  - Global interrupt controller (GIC)
  - Thermal monitor unit (TMU)
- QUICC Engine ULite block
  - 32-bit RISC controller for flexible support of the communications peripherals
  - Serial DMA channel for receive and transmit on all serial channels
  - Two universal communication controllers (TDM and HDLC) supporting 64 multichannels, each running at 64 Kbps
- 525 FC-PBGA package, 19 mm x 19 mm

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# 1 Introduction

A member of the Layerscape (LS1) series, the LS102xA family is a cost-effective, power-efficient, and highly integrated system-on-chip (SoC) design that extends the reach of the NXP value-performance line of QorIQ communications processors. Featuring a pair of extremely power-efficient 32-bit Arm® Cortex®-A7 cores with ECC-protected L1 and L2 cache memories for high reliability, running up to 1 GHz, and providing pre-silicon CoreMark® performance of over 5,000, the LS102xA family delivers greater performance than any previous sub-4W communication processor.

This chip can be used for networking and wireless access points, industrial gateways, industrial automation, printing, imaging, and M2M for enterprise and consumer networking and router applications.

This figure shows the block diagram of the LS1020A chip.

## QorIQ LS1020A Processor Block Diagram

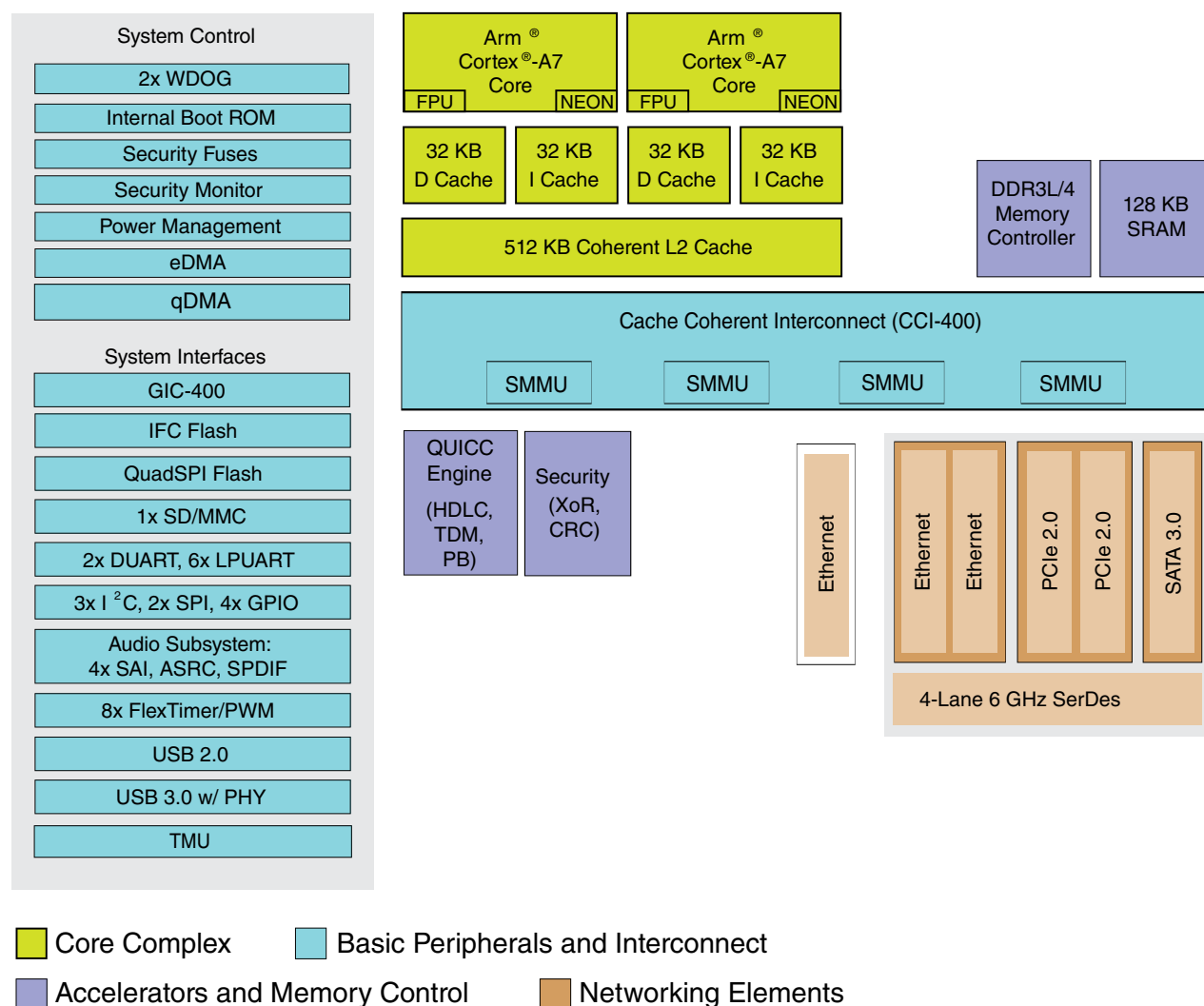


Figure 1. LS1020A block diagram

## 2 Pin assignments

### 2.1 LS1020A Ball Map and Pin List

#### 2.1.1 525 ball layout diagrams

This figure shows the complete view of the LS1020A ball map diagram. [Figure 3](#), [Figure 4](#), [Figure 5](#), and [Figure 6](#) show quadrant views.

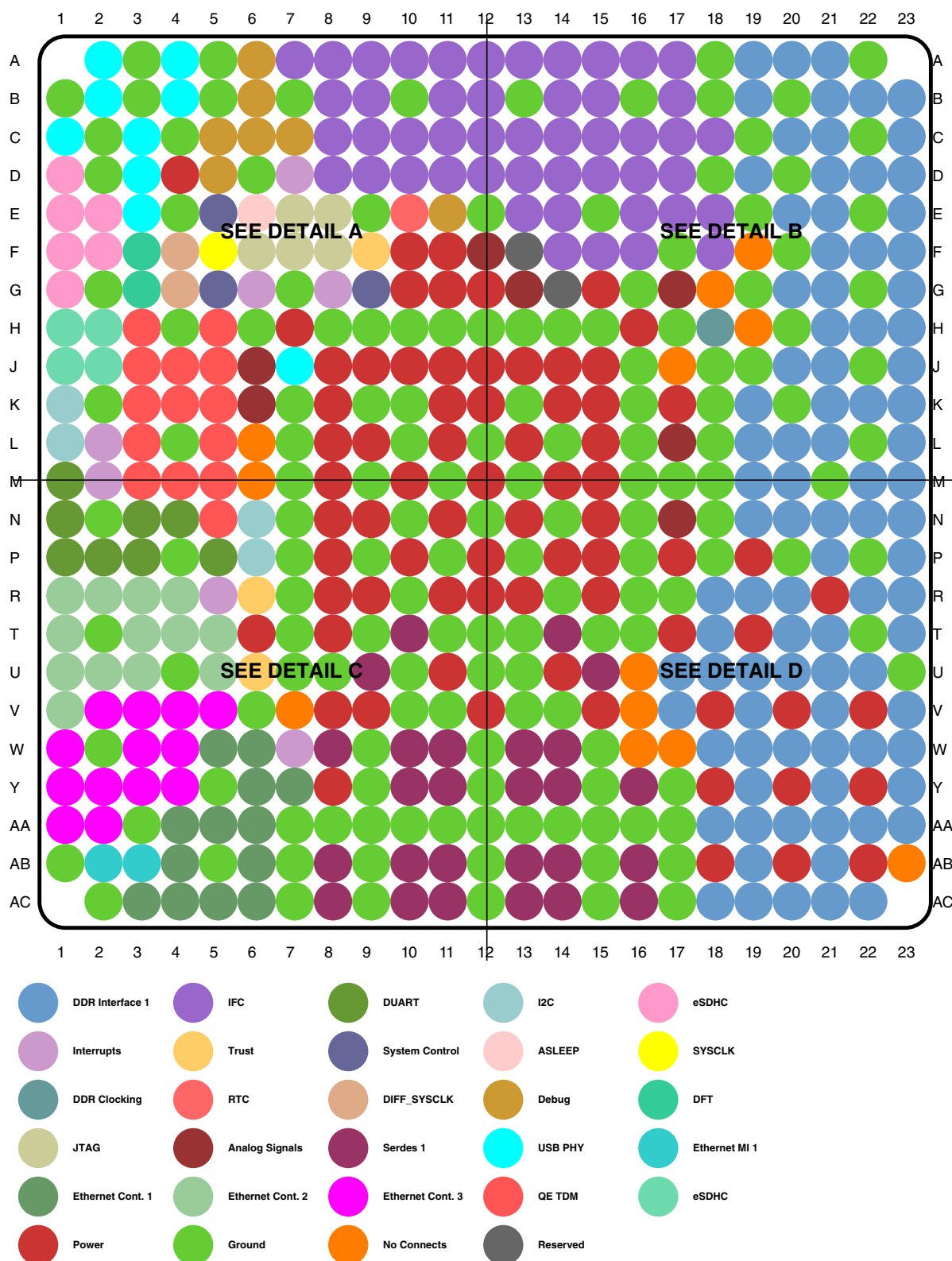


Figure 2. Complete BGA Map for the LS1020A

## LS1020A Ball Map and Pin List



Figure 3. Detail A

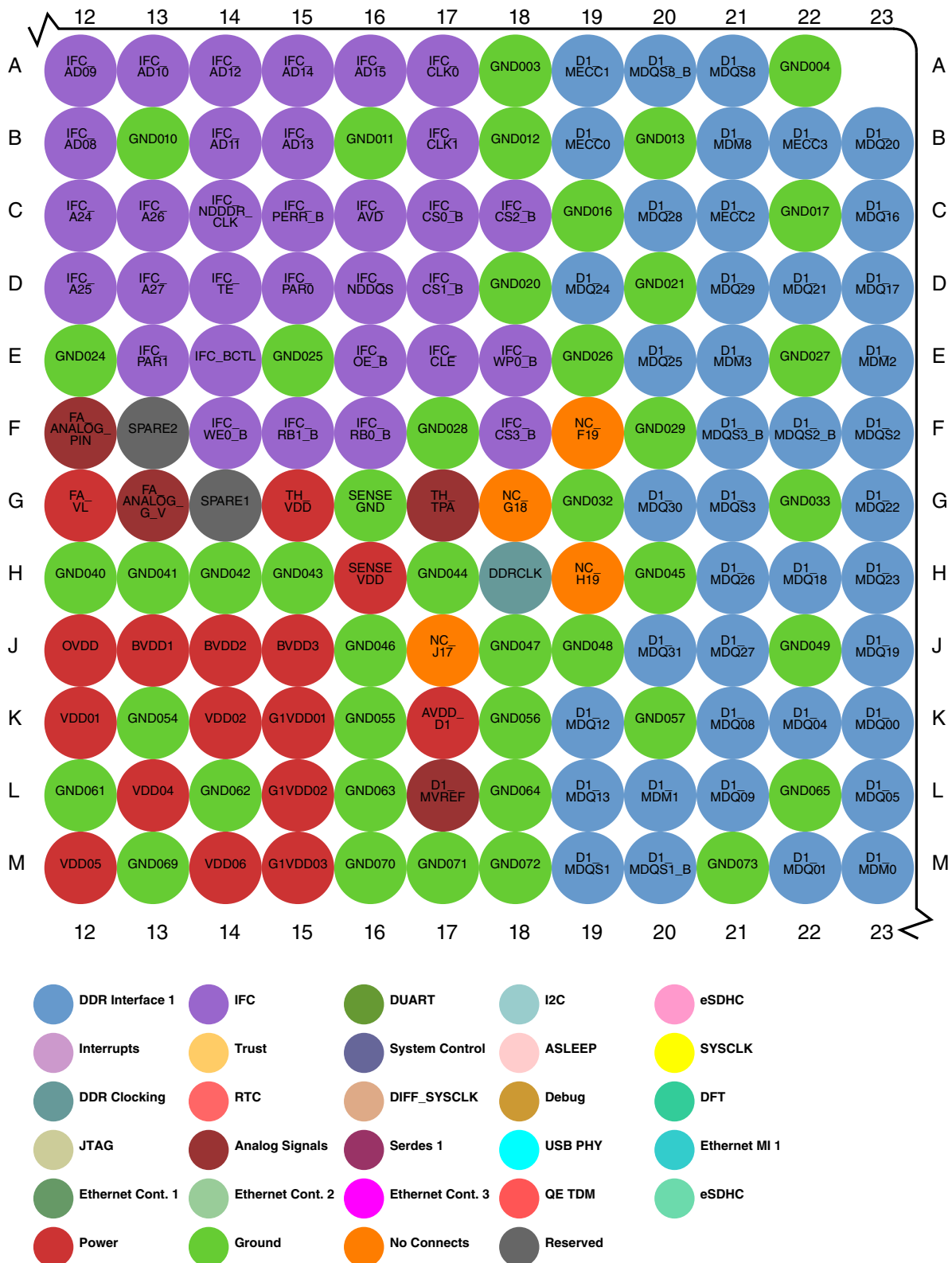


Figure 4. Detail B

## LS1020A Ball Map and Pin List

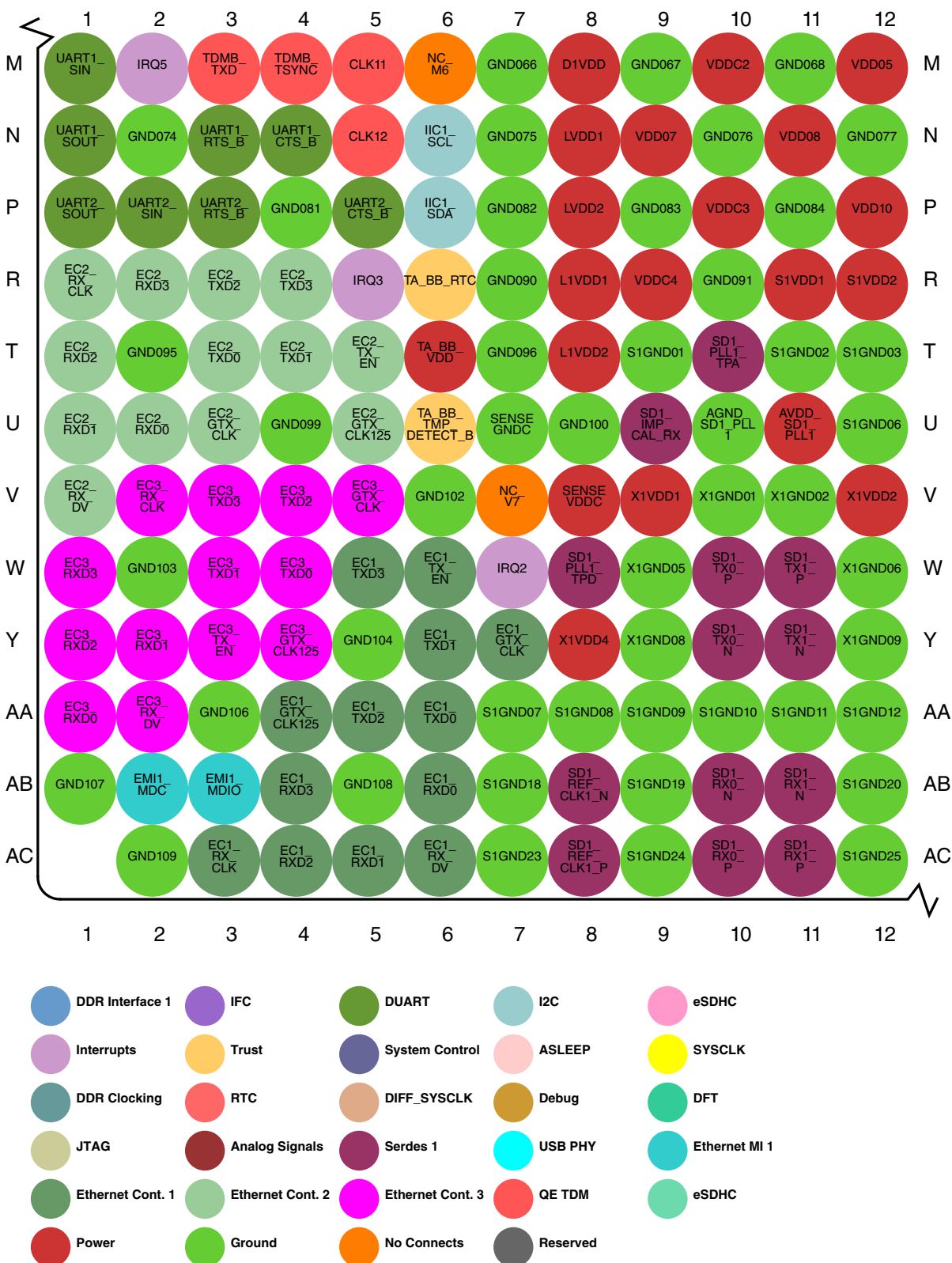


Figure 5. Detail C

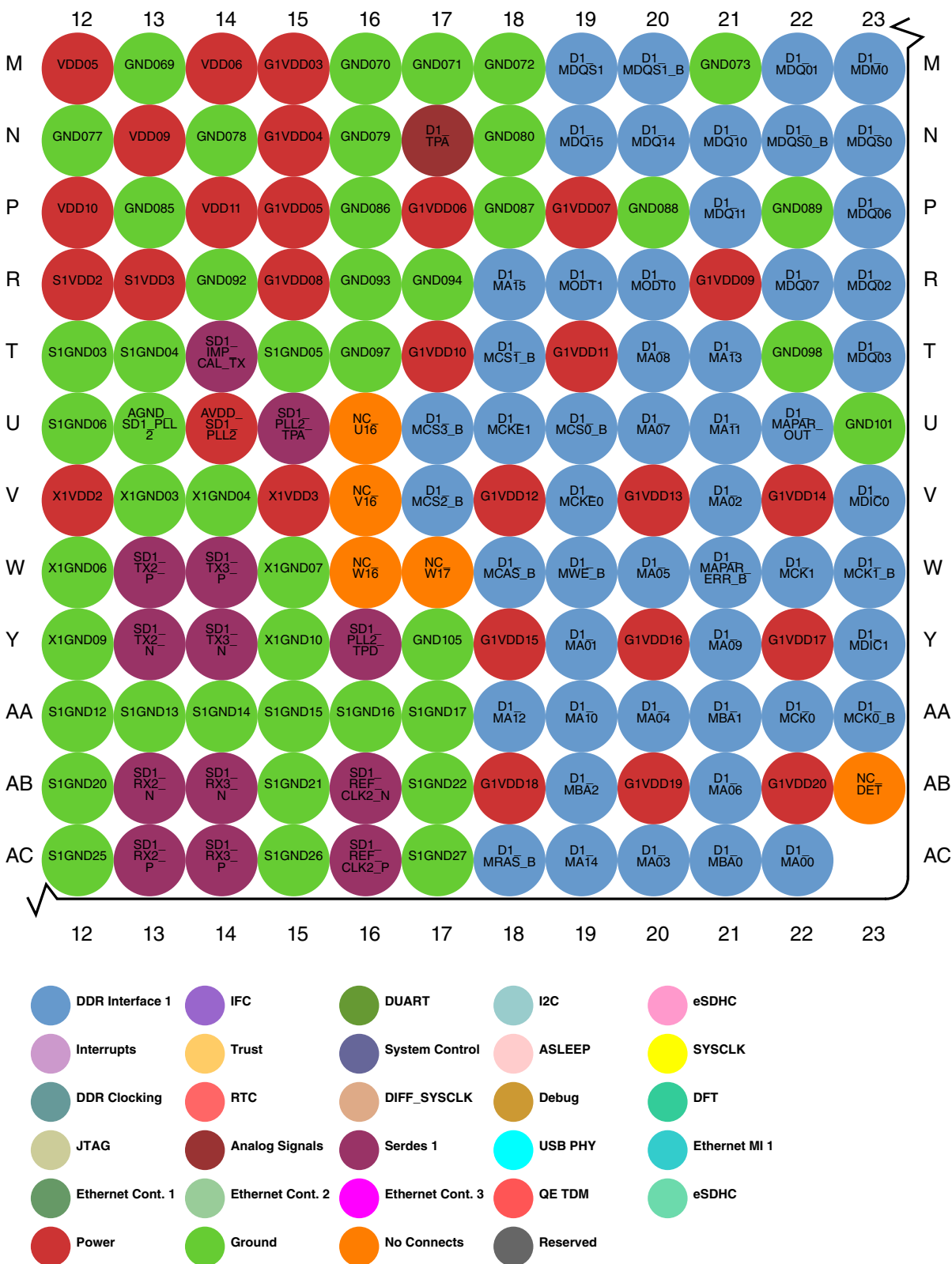


Figure 6. Detail D

## 2.1.2 Pinout list

This table provides the pinout listing for the LS1020A by bus. Primary functions are **bolded** in the table.

**Table 1. Pinout list by bus**

| Signal                              | Signal description    | Package pin number | Pin type | Power supply      | Notes |
|-------------------------------------|-----------------------|--------------------|----------|-------------------|-------|
| <b>DDR SDRAM Memory Interface 1</b> |                       |                    |          |                   |       |
| D1_MA00                             | Address               | AC22               | O        | G1V <sub>DD</sub> | ---   |
| D1_MA01                             | Address               | Y19                | O        | G1V <sub>DD</sub> | ---   |
| D1_MA02                             | Address               | V21                | O        | G1V <sub>DD</sub> | ---   |
| D1_MA03                             | Address               | AC20               | O        | G1V <sub>DD</sub> | ---   |
| D1_MA04                             | Address               | AA20               | O        | G1V <sub>DD</sub> | ---   |
| D1_MA05                             | Address               | W20                | O        | G1V <sub>DD</sub> | ---   |
| D1_MA06                             | Address               | AB21               | O        | G1V <sub>DD</sub> | ---   |
| D1_MA07                             | Address               | U20                | O        | G1V <sub>DD</sub> | ---   |
| D1_MA08                             | Address               | T20                | O        | G1V <sub>DD</sub> | ---   |
| D1_MA09                             | Address               | Y21                | O        | G1V <sub>DD</sub> | ---   |
| D1_MA10                             | Address               | AA19               | O        | G1V <sub>DD</sub> | ---   |
| D1_MA11                             | Address               | U21                | O        | G1V <sub>DD</sub> | ---   |
| D1_MA12                             | Address               | AA18               | O        | G1V <sub>DD</sub> | ---   |
| D1_MA13                             | Address               | T21                | O        | G1V <sub>DD</sub> | ---   |
| D1_MA14                             | Address               | AC19               | O        | G1V <sub>DD</sub> | ---   |
| D1_MA15                             | Address               | R18                | O        | G1V <sub>DD</sub> | ---   |
| D1_MAPAR_ERR_B                      | Address Parity Error  | W21                | I        | G1V <sub>DD</sub> | 1, 25 |
| D1_MAPAR_OUT                        | Address Parity Out    | U22                | O        | G1V <sub>DD</sub> | ---   |
| D1_MBA0                             | Bank Select           | AC21               | O        | G1V <sub>DD</sub> | ---   |
| D1_MBA1                             | Bank Select           | AA21               | O        | G1V <sub>DD</sub> | ---   |
| D1_MBA2                             | Bank Select           | AB19               | O        | G1V <sub>DD</sub> | ---   |
| D1_MCAS_B                           | Column Address Strobe | W18                | O        | G1V <sub>DD</sub> | ---   |
| D1_MCK0                             | Clock                 | AA22               | O        | G1V <sub>DD</sub> | ---   |
| D1_MCK0_B                           | Clock Complement      | AA23               | O        | G1V <sub>DD</sub> | ---   |
| D1_MCK1                             | Clock                 | W22                | O        | G1V <sub>DD</sub> | ---   |
| D1_MCK1_B                           | Clock Complement      | W23                | O        | G1V <sub>DD</sub> | ---   |
| D1_MCKE0                            | Clock Enable          | V19                | O        | G1V <sub>DD</sub> | 2     |
| D1_MCKE1                            | Clock Enable          | U18                | O        | G1V <sub>DD</sub> | 2     |
| D1_MCS0_B                           | Chip Select           | U19                | O        | G1V <sub>DD</sub> | ---   |
| D1_MCS1_B                           | Chip Select           | T18                | O        | G1V <sub>DD</sub> | ---   |
| D1_MCS2_B                           | Chip Select           | V17                | O        | G1V <sub>DD</sub> | ---   |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal    | Signal description           | Package pin number | Pin type | Power supply      | Notes |
|-----------|------------------------------|--------------------|----------|-------------------|-------|
| D1_MCS3_B | Chip Select                  | U17                | O        | G1V <sub>DD</sub> | ---   |
| D1_MDIC0  | Driver Impedence Calibration | V23                | IO       | G1V <sub>DD</sub> | 3     |
| D1_MDIC1  | Driver Impedence Calibration | Y23                | IO       | G1V <sub>DD</sub> | 3     |
| D1_MDM0   | Data Mask                    | M23                | O        | G1V <sub>DD</sub> | 1     |
| D1_MDM1   | Data Mask                    | L20                | O        | G1V <sub>DD</sub> | 1     |
| D1_MDM2   | Data Mask                    | E23                | O        | G1V <sub>DD</sub> | 1     |
| D1_MDM3   | Data Mask                    | E21                | O        | G1V <sub>DD</sub> | 1     |
| D1_MDM8   | Data Mask                    | B21                | O        | G1V <sub>DD</sub> | 1     |
| D1_MDQ00  | Data                         | K23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ01  | Data                         | M22                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ02  | Data                         | R23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ03  | Data                         | T23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ04  | Data                         | K22                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ05  | Data                         | L23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ06  | Data                         | P23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ07  | Data                         | R22                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ08  | Data                         | K21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ09  | Data                         | L21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ10  | Data                         | N21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ11  | Data                         | P21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ12  | Data                         | K19                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ13  | Data                         | L19                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ14  | Data                         | N20                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ15  | Data                         | N19                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ16  | Data                         | C23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ17  | Data                         | D23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ18  | Data                         | H22                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ19  | Data                         | J23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ20  | Data                         | B23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ21  | Data                         | D22                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ22  | Data                         | G23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ23  | Data                         | H23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ24  | Data                         | D19                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ25  | Data                         | E20                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ26  | Data                         | H21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ27  | Data                         | J21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ28  | Data                         | C20                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ29  | Data                         | D21                | IO       | G1V <sub>DD</sub> | ---   |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                            | Signal description    | Package pin number | Pin type | Power supply      | Notes |
|-------------------------------------------------------------------|-----------------------|--------------------|----------|-------------------|-------|
| D1_MDQ30                                                          | Data                  | G20                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQ31                                                          | Data                  | J20                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS0                                                          | Data Strobe           | N23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS0_B                                                        | Data Strobe           | N22                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS1                                                          | Data Strobe           | M19                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS1_B                                                        | Data Strobe           | M20                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS2                                                          | Data Strobe           | F23                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS2_B                                                        | Data Strobe           | F22                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS3                                                          | Data Strobe           | G21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS3_B                                                        | Data Strobe           | F21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS8                                                          | Data Strobe           | A21                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MDQS8_B                                                        | Data Strobe           | A20                | IO       | G1V <sub>DD</sub> | ---   |
| D1_MECC0                                                          | Error Correcting Code | B19                | IO       | G1V <sub>DD</sub> | 22    |
| D1_MECC1                                                          | Error Correcting Code | A19                | IO       | G1V <sub>DD</sub> | 22    |
| D1_MECC2                                                          | Error Correcting Code | C21                | IO       | G1V <sub>DD</sub> | 22    |
| D1_MECC3                                                          | Error Correcting Code | B22                | IO       | G1V <sub>DD</sub> | 22    |
| D1_MODT0                                                          | On Die Termination    | R20                | O        | G1V <sub>DD</sub> | 2     |
| D1_MODT1                                                          | On Die Termination    | R19                | O        | G1V <sub>DD</sub> | 2     |
| D1_MRAS_B                                                         | Row Address Strobe    | AC18               | O        | G1V <sub>DD</sub> | ---   |
| D1_MWE_B                                                          | Write Enable          | W19                | O        | G1V <sub>DD</sub> | ---   |
| <b>Integrated Flash Controller</b>                                |                       |                    |          |                   |       |
| IFC_A16/QSPI_CS_A0                                                | IFC Address           | C8                 | O        | BV <sub>DD</sub>  | 1, 5  |
| IFC_A17/QSPI_CS_A1                                                | IFC Address           | D8                 | O        | BV <sub>DD</sub>  | 1, 5  |
| IFC_A18/QSPI_CK_A                                                 | IFC Address           | C9                 | O        | BV <sub>DD</sub>  | 1, 5  |
| IFC_A19/QSPI_CS_B0                                                | IFC Address           | D9                 | O        | BV <sub>DD</sub>  | 1, 5  |
| IFC_A20/QSPI_CS_B1                                                | IFC Address           | C10                | O        | BV <sub>DD</sub>  | 1, 5  |
| IFC_A21/QSPI_CK_B/<br>cfg_dram_type                               | IFC Address           | D10                | O        | BV <sub>DD</sub>  | 1, 4  |
| IFC_A22/QSPI_DIO_A0/<br>IFC_WP1_B                                 | IFC Address           | C11                | O        | BV <sub>DD</sub>  | 1     |
| IFC_A23/QSPI_DIO_A1/<br>IFC_WP2_B                                 | IFC Address           | D11                | O        | BV <sub>DD</sub>  | 1     |
| IFC_A24/QSPI_DIO_A2/<br>IFC_WP3_B                                 | IFC Address           | C12                | O        | BV <sub>DD</sub>  | 1     |
| IFC_A25/GPIO2_25/<br>QSPI_DIO_A3/FTM5_CH0/<br>IFC_RB2_B/IFC_CS4_B | IFC Address           | D12                | O        | BV <sub>DD</sub>  | 1, 6  |
| IFC_A26/GPIO2_26/<br>FTM5_CH1/IFC_RB3_B/<br>IFC_CS5_B             | IFC Address           | C13                | O        | BV <sub>DD</sub>  | 1, 6  |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                             | Signal description                         | Package pin number | Pin type | Power supply     | Notes |
|------------------------------------------------------------------------------------|--------------------------------------------|--------------------|----------|------------------|-------|
| <b>IFC_A27</b> /GPIO2_27/<br>FTM5_EXTCLK/IFC_CS6_B                                 | IFC Address                                | D13                | O        | BV <sub>DD</sub> | 1, 6  |
| <b>IFC_AD00</b> /cfg_gpinput0                                                      | IFC Address / Data                         | A7                 | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD01</b> /cfg_gpinput1                                                      | IFC Address / Data                         | B8                 | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD02</b> /cfg_gpinput2                                                      | IFC Address / Data                         | A8                 | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD03</b> /cfg_gpinput3                                                      | IFC Address / Data                         | B9                 | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD04</b> /cfg_gpinput4                                                      | IFC Address / Data                         | A9                 | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD05</b> /cfg_gpinput5                                                      | IFC Address / Data                         | A10                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD06</b> /cfg_gpinput6                                                      | IFC Address / Data                         | B11                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD07</b> /cfg_gpinput7                                                      | IFC Address / Data                         | A11                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD08</b> /cfg_rcw_src0/<br>SPI1_PCS1                                        | IFC Address / Data                         | B12                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD09</b> /cfg_rcw_src1/<br>SPI1_PCS2                                        | IFC Address / Data                         | A12                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD10</b> /cfg_rcw_src2/<br>SPI1_PCS3                                        | IFC Address / Data                         | A13                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD11</b> /cfg_rcw_src3/<br>SPI1_PCS4                                        | IFC Address / Data                         | B14                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD12</b> /cfg_rcw_src4/<br>SPI1_PCS5                                        | IFC Address / Data                         | A14                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD13</b> /cfg_rcw_src5/<br>SPI1_SOUT                                        | IFC Address / Data                         | B15                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD14</b> /cfg_rcw_src6                                                      | IFC Address / Data                         | A15                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AD15</b> /cfg_rcw_src7                                                      | IFC Address / Data                         | A16                | IO       | BV <sub>DD</sub> | 4     |
| <b>IFC_AVD</b>                                                                     | IFC Address Valid                          | C16                | O        | BV <sub>DD</sub> | 1, 5  |
| <b>IFC_BCTL</b>                                                                    | IFC Buffer control                         | E14                | O        | BV <sub>DD</sub> | 2     |
| <b>IFC_CLE</b> /cfg_rcw_src8                                                       | IFC Command Latch Enable /<br>Write Enable | E17                | O        | BV <sub>DD</sub> | 1, 4  |
| <b>IFC_CLK0</b>                                                                    | IFC Clock                                  | A17                | O        | BV <sub>DD</sub> | 1     |
| <b>IFC_CLK1</b>                                                                    | IFC Clock                                  | B17                | O        | BV <sub>DD</sub> | 1     |
| <b>IFC_CS0_B</b>                                                                   | IFC Chip Select                            | C17                | O        | BV <sub>DD</sub> | 1, 6  |
| <b>IFC_CS1_B</b> /GPIO2_10/<br>SPI1_PCS0/FTM7_CH0                                  | IFC Chip Select                            | D17                | O        | BV <sub>DD</sub> | 1, 6  |
| <b>IFC_CS2_B</b> /GPIO2_11/<br>SPI1_SCK/FTM7_CH1/<br>IIC3_SCL                      | IFC Chip Select                            | C18                | O        | BV <sub>DD</sub> | 1, 6  |
| <b>IFC_CS3_B</b> /GPIO2_12/<br>QSPI_DIO_B3/IIC3_SDA/<br>FTM7_EXTCLK                | IFC Chip Select                            | F18                | O        | BV <sub>DD</sub> | 1, 6  |
| <b>IFC_CS4_B</b> / <b>IFC_A25</b> /<br>GPIO2_25/QSPI_DIO_A3/<br>FTM5_CH0/IFC_RB2_B | IFC Chip Select                            | D12                | O        | BV <sub>DD</sub> | 1     |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                            | Signal description              | Package pin number | Pin type | Power supply      | Notes   |
|-------------------------------------------------------------------|---------------------------------|--------------------|----------|-------------------|---------|
| IFC_CS5_B/IFC_A26/<br>GPIO2_26/FTM5_CH1/<br>IFC_RB3_B             | IFC Chip Select                 | C13                | O        | BV <sub>DD</sub>  | 1       |
| IFC_CS6_B/IFC_A27/<br>GPIO2_27/FTM5_EXTCLK                        | IFC Chip Select                 | D13                | O        | BV <sub>DD</sub>  | 1       |
| IFC_NDDDDR_CLK                                                    | IFC NAND DDR Clock              | C14                | O        | BV <sub>DD</sub>  | 1       |
| IFC_NDDQS                                                         | IFC DQS Strobe                  | D16                | IO       | BV <sub>DD</sub>  | ---     |
| IFC_OE_B/cfg_eng_use1                                             | IFC Output Enable               | E16                | O        | BV <sub>DD</sub>  | 1, 4, 5 |
| IFC_PAR0/GPIO2_13/<br>QSPI_DIO_B0/FTM6_CH0                        | IFC Address & Data Parity       | D15                | IO       | BV <sub>DD</sub>  | ---     |
| IFC_PAR1/GPIO2_14/<br>QSPI_DIO_B1/FTM6_CH1                        | IFC Address & Data Parity       | E13                | IO       | BV <sub>DD</sub>  | ---     |
| IFC_PERR_B/GPIO2_15/<br>QSPI_DIO_B2/FTM6_EXTCLK                   | IFC Parity Error                | C15                | I        | BV <sub>DD</sub>  | 1, 6    |
| IFC_RB0_B                                                         | IFC Ready / Busy CS0            | F16                | I        | BV <sub>DD</sub>  | 6       |
| IFC_RB1_B/SPI1_SIN                                                | IFC Ready / Busy CS1            | F15                | I        | BV <sub>DD</sub>  | 6       |
| IFC_RB2_B/IFC_A25/<br>GPIO2_25/QSPI_DIO_A3/<br>FTM5_CH0/IFC_CS4_B | IFC Ready / Busy CS 2           | D12                | I        | BV <sub>DD</sub>  | 1       |
| IFC_RB3_B/IFC_A26/<br>GPIO2_26/FTM5_CH1/<br>IFC_CS5_B             | IFC Ready / Busy CS 3           | C13                | I        | BV <sub>DD</sub>  | 1       |
| IFC_TE/cfg_ifc_te                                                 | IFC External Transceiver Enable | D14                | O        | BV <sub>DD</sub>  | 1, 4    |
| IFC_WE0_B/cfg_eng_use0                                            | IFC Write Enable                | F14                | O        | BV <sub>DD</sub>  | 1, 19   |
| IFC_WP0_B/cfg_eng_use2                                            | IFC Write Protect               | E18                | O        | BV <sub>DD</sub>  | 1, 4, 5 |
| IFC_WP1_B/IFC_A22/<br>QSPI_DIO_A0                                 | IFC Write Protect               | C11                | O        | BV <sub>DD</sub>  | 1       |
| IFC_WP2_B/IFC_A23/<br>QSPI_DIO_A1                                 | IFC Write Protect               | D11                | O        | BV <sub>DD</sub>  | 1       |
| IFC_WP3_B/IFC_A24/<br>QSPI_DIO_A2                                 | IFC Write Protect               | C12                | O        | BV <sub>DD</sub>  | 1       |
| <b>DUART</b>                                                      |                                 |                    |          |                   |         |
| UART1_CTS_B/GPIO1_21/<br>UART3_SIN/LPUART2_SIN/<br>SPI2_SIN       | Clear To Send                   | N4                 | I        | DV <sub>DD</sub>  | 1       |
| UART1_RTS_B/GPIO1_19/<br>UART3_SOUT/<br>LPUART2_SOUT/SPI2_SOUT    | Ready to Send                   | N3                 | O        | DV <sub>DD</sub>  | 1       |
| UART1_SIN/GPIO1_17                                                | Receive Data                    | M1                 | I        | DV <sub>DD</sub>  | 1       |
| UART1_SOUT/GPIO1_15                                               | Transmit Data                   | N1                 | O        | DV <sub>DD</sub>  | 1       |
| UART2_CTS_B/GPIO1_22/<br>UART4_SIN/SPI2_SCK/                      | Clear To Send                   | P5                 | I        | D1V <sub>DD</sub> | 1       |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                                   | Signal description | Package pin number | Pin type | Power supply      | Notes |
|------------------------------------------------------------------------------------------|--------------------|--------------------|----------|-------------------|-------|
| LPUART1_CTS_B/<br>LPUART4_SIN                                                            |                    |                    |          |                   |       |
| <b>UART2_RTS_B</b> /GPIO1_20/<br>UART4_SOUT/<br>LPUART1_RTS_B/<br>LPUART4_SOUT/SPI2_PCS2 | Ready to Send      | P3                 | O        | D1V <sub>DD</sub> | 1     |
| <b>UART2_SIN</b> /GPIO1_18/<br>LPUART1_SIN/SPI2_PCS1                                     | Receive Data       | P2                 | I        | D1V <sub>DD</sub> | 1     |
| <b>UART2_SOUT</b> /GPIO1_16/<br>SPI2_PCS0/LPUART1_SOUT                                   | Transmit Data      | P1                 | O        | D1V <sub>DD</sub> | 1     |
| UART3_SIN/ <b>UART1_CTS_B</b> /<br>GPIO1_21/LPUART2_SIN/<br>SPI2_SIN                     | Receive Data       | N4                 | I        | DV <sub>DD</sub>  | 1     |
| UART3_SOUT/<br><b>UART1_RTS_B</b> /GPIO1_19/<br>LPUART2_SOUT/SPI2_SOUT                   | Transmit Data      | N3                 | O        | DV <sub>DD</sub>  | 1     |
| UART4_SIN/ <b>UART2_CTS_B</b> /<br>GPIO1_22/SPI2_SCK/<br>LPUART1_CTS_B/<br>LPUART4_SIN   | Receive Data       | P5                 | I        | D1V <sub>DD</sub> | 1     |
| UART4_SOUT/<br><b>UART2_RTS_B</b> /GPIO1_20/<br>LPUART1_RTS_B/<br>LPUART4_SOUT/SPI2_PCS2 | Transmit Data      | P3                 | O        | D1V <sub>DD</sub> | 1     |
| <b>LPUART</b>                                                                            |                    |                    |          |                   |       |
| LPUART1_CTS_B/<br><b>UART2_CTS_B</b> /GPIO1_22/<br>UART4_SIN/SPI2_SCK/<br>LPUART4_SIN    | Clear To Send      | P5                 | I        | D1V <sub>DD</sub> | 1     |
| LPUART1_RTS_B/<br><b>UART2_RTS_B</b> /GPIO1_20/<br>UART4_SOUT/<br>LPUART4_SOUT/SPI2_PCS2 | Ready to Send      | P3                 | O        | D1V <sub>DD</sub> | 1     |
| LPUART1_SIN/ <b>UART2_SIN</b> /<br>GPIO1_18/SPI2_PCS1                                    | Receive Data       | P2                 | I        | D1V <sub>DD</sub> | 1     |
| LPUART1_SOUT/<br><b>UART2_SOUT</b> /GPIO1_16/<br>SPI2_PCS0                               | Transmit Data      | P1                 | O        | D1V <sub>DD</sub> | 1     |
| LPUART2_CTS_B/<br><b>SDHC_DAT2</b> /GPIO2_07/<br>LPUART5_SIN                             | Clear to Send      | F1                 | I        | EV <sub>DD</sub>  | 1     |
| LPUART2_RTS_B/<br><b>SDHC_DAT1</b> /GPIO2_06/<br>LPUART5_SOUT                            | Ready to Send      | F2                 | O        | EV <sub>DD</sub>  | 1     |
| LPUART2_SIN/<br><b>UART1_CTS_B</b> /GPIO1_21/<br>UART3_SIN/SPI2_SIN                      | Receive Data       | N4                 | I        | DV <sub>DD</sub>  | 1     |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                                   | Signal description | Package pin number | Pin type | Power supply      | Notes |
|------------------------------------------------------------------------------------------|--------------------|--------------------|----------|-------------------|-------|
| LPUART2_SOUT/<br><b>UART1_RTS_B</b> /GPIO1_19/<br>UART3_SOUT/SPI2_SOUT                   | Transmit Data      | N3                 | O        | DV <sub>DD</sub>  | 1     |
| LPUART3_CTS_B/<br><b>SDHC_CLK</b> /GPIO2_09/<br>LPUART6_SIN                              | Clear to Send      | D1                 | I        | EV <sub>DD</sub>  | 1     |
| LPUART3_RTS_B/<br><b>SDHC_DAT3</b> /GPIO2_08/<br>LPUART6_SOUT                            | Ready to Send      | G1                 | O        | EV <sub>DD</sub>  | 1     |
| LPUART3_SIN/ <b>SDHC_DAT0</b> /<br>GPIO2_05                                              | Receive Data       | E1                 | I        | EV <sub>DD</sub>  | 1     |
| LPUART3_SOUT/<br><b>SDHC_CMD</b> /GPIO2_04                                               | Transmit Data      | E2                 | O        | EV <sub>DD</sub>  | 1     |
| LPUART4_SIN/<br><b>UART2_CTS_B</b> /GPIO1_22/<br>UART4_SIN/SPI2_SCK/<br>LPUART1_CTS_B    | Receive Data       | P5                 | I        | D1V <sub>DD</sub> | 1     |
| LPUART4_SOUT/<br><b>UART2_RTS_B</b> /GPIO1_20/<br>UART4_SOUT/<br>LPUART1_RTS_B/SPI2_PCS2 | Transmit Data      | P3                 | O        | D1V <sub>DD</sub> | 1     |
| LPUART5_SIN/ <b>SDHC_DAT2</b> /<br>GPIO2_07/LPUART2_CTS_B                                | Receive Data       | F1                 | I        | EV <sub>DD</sub>  | 1     |
| LPUART5_SOUT/<br><b>SDHC_DAT1</b> /GPIO2_06/<br>LPUART2_RTS_B                            | Transmit Data      | F2                 | O        | EV <sub>DD</sub>  | 1     |
| LPUART6_SIN/ <b>SDHC_CLK</b> /<br>GPIO2_09/LPUART3_CTS_B                                 | Receive Data       | D1                 | I        | EV <sub>DD</sub>  | 1     |
| LPUART6_SOUT/<br><b>SDHC_DAT3</b> /GPIO2_08/<br>LPUART3_RTS_B                            | Transmit Data      | G1                 | O        | EV <sub>DD</sub>  | 1     |
| <b>I2C</b>                                                                               |                    |                    |          |                   |       |
| <b>IIC1_SCL</b>                                                                          | Serial Clock       | N6                 | IO       | D1V <sub>DD</sub> | 7, 8  |
| <b>IIC1_SDA</b>                                                                          | Serial Data        | P6                 | IO       | D1V <sub>DD</sub> | 7, 8  |
| <b>IIC2_SCL</b> /GPIO4_27/<br>SDHC_CD_B/SPI2_PCS3                                        | Serial Clock       | K1                 | IO       | DV <sub>DD</sub>  | 7, 8  |
| <b>IIC2_SDA</b> /GPIO4_28/<br>SDHC_WP/SPI2_PCS4                                          | Serial Data        | L1                 | IO       | DV <sub>DD</sub>  | 7, 8  |
| <b>IIC3_SCL/IFC_CS2_B</b> /<br>GPIO2_11/SPI1_SCK/<br>FTM7_CH1                            | Serial Clock       | C18                | IO       | BV <sub>DD</sub>  | ---   |
| <b>IIC3_SDA/IFC_CS3_B</b> /<br>GPIO2_12/QSPI_DIO_B3/<br>FTM7_EXTCLK                      | Serial Data        | F18                | IO       | BV <sub>DD</sub>  | ---   |
| <b>eSDHC</b>                                                                             |                    |                    |          |                   |       |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                   | Signal description       | Package pin number | Pin type | Power supply      | Notes |
|----------------------------------------------------------|--------------------------|--------------------|----------|-------------------|-------|
| SDHC_CD_B/IIC2_SCL/<br>GPIO4_27/SPI2_PCS3                | Command/Response         | K1                 | I        | DV <sub>DD</sub>  | 1     |
| SDHC_CLK/GPIO2_09/<br>LPUART3_CTS_B/<br>LPUART6_SIN      | Host to Card Clock       | D1                 | IO       | EV <sub>DD</sub>  | ---   |
| SDHC_CLK_SYNC_IN/IRQ5/<br>GPIO1_25/SPI2_PCS5             | Clock Synchronizer Input | M2                 | I        | DV <sub>DD</sub>  | 1     |
| SDHC_CLK_SYNC_OUT/<br>SDHC_DAT4/GPIO4_23                 | Clock Synchronous Output | H2                 | O        | DV <sub>DD</sub>  | 1     |
| SDHC_CMD/GPIO2_04/<br>LPUART3_SOUT                       | Command/Response         | E2                 | IO       | EV <sub>DD</sub>  | ---   |
| SDHC_CMD_DIR/<br>SDHC_DAT5/GPIO4_24                      | Command Direction        | H1                 | O        | DV <sub>DD</sub>  | 1     |
| SDHC_DAT0/GPIO2_05/<br>LPUART3_SIN                       | Data                     | E1                 | IO       | EV <sub>DD</sub>  | ---   |
| SDHC_DAT0_DIR/<br>SDHC_DAT6/GPIO4_25/<br>USB1_DRVVBUS    | Data Direction           | J2                 | O        | DV <sub>DD</sub>  | 1     |
| SDHC_DAT1/GPIO2_06/<br>LPUART2_RTS_B/<br>LPUART5_SOUT    | Data                     | F2                 | IO       | EV <sub>DD</sub>  | ---   |
| SDHC_DAT123_DIR/<br>SDHC_DAT7/GPIO4_26/<br>USB1_PWRFAULT | Data Direction           | J1                 | O        | DV <sub>DD</sub>  | 1     |
| SDHC_DAT2/GPIO2_07/<br>LPUART2_CTS_B/<br>LPUART5_SIN     | Data                     | F1                 | IO       | EV <sub>DD</sub>  | ---   |
| SDHC_DAT3/GPIO2_08/<br>LPUART3_RTS_B/<br>LPUART6_SOUT    | Data                     | G1                 | IO       | EV <sub>DD</sub>  | ---   |
| SDHC_DAT4/GPIO4_23/<br>SDHC_CLK_SYNC_OUT                 | Data                     | H2                 | IO       | DV <sub>DD</sub>  | ---   |
| SDHC_DAT5/GPIO4_24/<br>SDHC_CMD_DIR                      | Data                     | H1                 | IO       | DV <sub>DD</sub>  | ---   |
| SDHC_DAT6/GPIO4_25/<br>USB1_DRVVBUS/<br>SDHC_DAT0_DIR    | Data                     | J2                 | IO       | DV <sub>DD</sub>  | ---   |
| SDHC_DAT7/GPIO4_26/<br>USB1_PWRFAULT/<br>SDHC_DAT123_DIR | Data                     | J1                 | IO       | DV <sub>DD</sub>  | ---   |
| SDHC_VS/IRQ4/GPIO1_24                                    | VS                       | L2                 | O        | DV <sub>DD</sub>  | 1     |
| SDHC_WP/IIC2_SDA/<br>GPIO4_28/SPI2_PCS4                  | Write Protect            | L1                 | I        | DV <sub>DD</sub>  | 1     |
| <b>Programmable Interrupt Controller</b>                 |                          |                    |          |                   |       |
| EVT9_B/GPIO2_24                                          | Event 9                  | D7                 | IO       | O1V <sub>DD</sub> | 6, 7  |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                           | Signal description                                 | Package pin number | Pin type | Power supply          | Notes   |
|--------------------------------------------------|----------------------------------------------------|--------------------|----------|-----------------------|---------|
| IRQ0                                             | External Interrupt                                 | G6                 | I        | O1V <sub>DD</sub>     | 1       |
| IRQ1                                             | External Interrupt                                 | G8                 | I        | OV <sub>DD</sub>      | 1       |
| IRQ2                                             | External Interrupt                                 | W7                 | I        | L1V <sub>DD</sub>     | 1       |
| IRQ3/GPIO1_23                                    | External Interrupt                                 | R5                 | I        | LV <sub>DD</sub>      | 1       |
| IRQ4/GPIO1_24/SDHC_VS                            | External Interrupt                                 | L2                 | I        | DV <sub>DD</sub>      | 1       |
| IRQ5/GPIO1_25/<br>SDHC_CLK_SYNC_IN/<br>SPI2_PCS5 | External Interrupt                                 | M2                 | I        | DV <sub>DD</sub>      | 1       |
| <b>Battery Backed Trust</b>                      |                                                    |                    |          |                       |         |
| TA_BB_RTC                                        | Reserved                                           | R6                 | I        | TA_BB_V <sub>DD</sub> | 1, 14   |
| TA_BB_TMP_DETECT_B                               | Battery Backed Tamper Detect                       | U6                 | I        | TA_BB_V <sub>DD</sub> | ---     |
| TA_TMP_DETECT_B                                  | Tamper Detect                                      | F9                 | I        | OV <sub>DD</sub>      | 1       |
| <b>System Control</b>                            |                                                    |                    |          |                       |         |
| HRESET_B                                         | Hard Reset                                         | E5                 | IO       | O1V <sub>DD</sub>     | 6, 7    |
| PORESET_B                                        | Power On Reset                                     | G9                 | I        | O1V <sub>DD</sub>     | 21      |
| RESET_REQ_B                                      | Reset Request (POR or Hard)                        | G5                 | O        | O1V <sub>DD</sub>     | 1, 5    |
| <b>Power Management</b>                          |                                                    |                    |          |                       |         |
| ASLEEP/GPIO1_13                                  | Asleep                                             | E6                 | O        | O1V <sub>DD</sub>     | 1, 5    |
| <b>SYSCLK</b>                                    |                                                    |                    |          |                       |         |
| SYSCLK                                           | System Clock                                       | F5                 | I        | O1V <sub>DD</sub>     | ---     |
| <b>DDR Clocking</b>                              |                                                    |                    |          |                       |         |
| DDRCLK                                           | DDR Controller Clock                               | H18                | I        | OV <sub>DD</sub>      | ---     |
| <b>RTC</b>                                       |                                                    |                    |          |                       |         |
| RTC/GPIO1_14                                     | Real Time Clock                                    | E10                | I        | OV <sub>DD</sub>      | 1       |
| <b>DSYSCLK</b>                                   |                                                    |                    |          |                       |         |
| DIFF_SYSCLK                                      | Single Source System Clock Differential (positive) | F4                 | I        | O1V <sub>DD</sub>     | ---     |
| DIFF_SYSCLK_B                                    | Single Source System Clock Differential (negative) | G4                 | I        | O1V <sub>DD</sub>     | ---     |
| <b>Debug</b>                                     |                                                    |                    |          |                       |         |
| CKSTP_OUT_B                                      | Reserved                                           | E11                | O        | OV <sub>DD</sub>      | 1, 6, 7 |
| CLK_OUT                                          | Clock Out                                          | C6                 | O        | O1V <sub>DD</sub>     | 2       |
| EVT0_B                                           | Event 0                                            | C5                 | IO       | O1V <sub>DD</sub>     | 9       |
| EVT1_B                                           | Event 1                                            | D5                 | IO       | O1V <sub>DD</sub>     | ---     |
| EVT2_B                                           | Event 2                                            | A6                 | IO       | O1V <sub>DD</sub>     | 21      |
| EVT3_B                                           | Event 3                                            | B6                 | IO       | O1V <sub>DD</sub>     | ---     |
| EVT4_B                                           | Event 4                                            | C7                 | IO       | O1V <sub>DD</sub>     | ---     |
| <b>DFT</b>                                       |                                                    |                    |          |                       |         |
| SCAN_MODE_B                                      | Reserved                                           | G3                 | I        | O1V <sub>DD</sub>     | 10, 21  |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                | Signal description                      | Package pin number | Pin type | Power supply         | Notes |
|-----------------------|-----------------------------------------|--------------------|----------|----------------------|-------|
| TEST_SEL_B            | Reserved                                | F3                 | I        | O1V <sub>DD</sub>    | 21    |
| <b>JTAG</b>           |                                         |                    |          |                      |       |
| TCK                   | Test Clock                              | E8                 | I        | O1V <sub>DD</sub>    | ---   |
| TDI                   | Test Data In                            | E7                 | I        | O1V <sub>DD</sub>    | 9     |
| TDO                   | Test Data Out                           | F7                 | O        | O1V <sub>DD</sub>    | 2     |
| TMS                   | Test Mode Select                        | F8                 | I        | O1V <sub>DD</sub>    | 9     |
| TRST_B                | Test Reset                              | F6                 | I        | O1V <sub>DD</sub>    | 9     |
| <b>Analog Signals</b> |                                         |                    |          |                      |       |
| D1_MVREF              | SSTL Reference Voltage                  | L17                | IO       | G1V <sub>DD</sub> /2 | ---   |
| D1_TPA                | DDR Controller 1 Test Point Analog      | N17                | IO       | -                    | 12    |
| FA_ANALOG_G_V         | Reserved                                | G13                | IO       | -                    | 14    |
| FA_ANALOG_PIN         | Reserved                                | F12                | IO       | -                    | 14    |
| TD1_ANODE             | Thermal diode anode                     | J6                 | IO       | -                    | 17    |
| TD1_CATHODE           | Thermal diode cathode                   | K6                 | IO       | -                    | 17    |
| TH_TPA                | Thermal Test Point Analog               | G17                | -        | -                    | 12    |
| <b>Serdes 1</b>       |                                         |                    |          |                      |       |
| SD1_IMP_CAL_RX        | SerDes Receive Impedance Calibration    | U9                 | I        | S1V <sub>DD</sub>    | 11    |
| SD1_IMP_CAL_TX        | SerDes Transmit Impedance Calibration   | T14                | I        | X1V <sub>DD</sub>    | 15    |
| SD1_PLL1_TPA          | SerDes PLL 1 Test Point Analog          | T10                | O        | AVDD_SD1_PLL1        | 12    |
| SD1_PLL1_TPD          | SerDes Test Point Digital               | W8                 | O        | X1V <sub>DD</sub>    | 12    |
| SD1_PLL2_TPA          | SerDes PLL 2 Test Point Analog          | U15                | O        | AVDD_SD1_PLL2        | 12    |
| SD1_PLL2_TPD          | SerDes Test Point Digital               | Y16                | O        | X1V <sub>DD</sub>    | 12    |
| SD1_REF_CLK1_N        | SerDes PLL 1 Reference Clock Complement | AB8                | I        | S1V <sub>DD</sub>    | 18    |
| SD1_REF_CLK1_P        | SerDes PLL 1 Reference Clock            | AC8                | I        | S1V <sub>DD</sub>    | 18    |
| SD1_REF_CLK2_N        | SerDes PLL 2 Reference Clock Complement | AB16               | I        | S1V <sub>DD</sub>    | 18    |
| SD1_REF_CLK2_P        | SerDes PLL 2 Reference Clock            | AC16               | I        | S1V <sub>DD</sub>    | 18    |
| SD1_RX0_N             | SerDes Receive Data (negative)          | AB10               | I        | S1V <sub>DD</sub>    | 18    |
| SD1_RX0_P             | SerDes Receive Data (positive)          | AC10               | I        | S1V <sub>DD</sub>    | 18    |
| SD1_RX1_N             | SerDes Receive Data (negative)          | AB11               | I        | S1V <sub>DD</sub>    | 18    |
| SD1_RX1_P             | SerDes Receive Data (positive)          | AC11               | I        | S1V <sub>DD</sub>    | 18    |

Table continues on the next page...

**Table 1. Pinout list by bus (continued)**

| Signal                                 | Signal description                   | Package pin number | Pin type | Power supply      | Notes |
|----------------------------------------|--------------------------------------|--------------------|----------|-------------------|-------|
| SD1_RX2_N                              | SerDes Receive Data (negative)       | AB13               | I        | S1V <sub>DD</sub> | 18    |
| SD1_RX2_P                              | SerDes Receive Data (positive)       | AC13               | I        | S1V <sub>DD</sub> | 18    |
| SD1_RX3_N                              | SerDes Receive Data (negative)       | AB14               | I        | S1V <sub>DD</sub> | 18    |
| SD1_RX3_P                              | SerDes Receive Data (positive)       | AC14               | I        | S1V <sub>DD</sub> | 18    |
| SD1_TX0_N                              | SerDes Transmit Data (negative)      | Y10                | O        | X1V <sub>DD</sub> | ---   |
| SD1_TX0_P                              | SerDes Transmit Data (positive)      | W10                | O        | X1V <sub>DD</sub> | ---   |
| SD1_TX1_N                              | SerDes Transmit Data (negative)      | Y11                | O        | X1V <sub>DD</sub> | ---   |
| SD1_TX1_P                              | SerDes Transmit Data (positive)      | W11                | O        | X1V <sub>DD</sub> | ---   |
| SD1_TX2_N                              | SerDes Transmit Data (negative)      | Y13                | O        | X1V <sub>DD</sub> | ---   |
| SD1_TX2_P                              | SerDes Transmit Data (positive)      | W13                | O        | X1V <sub>DD</sub> | ---   |
| SD1_TX3_N                              | SerDes Transmit Data (negative)      | Y14                | O        | X1V <sub>DD</sub> | ---   |
| SD1_TX3_P                              | SerDes Transmit Data (positive)      | W14                | O        | X1V <sub>DD</sub> | ---   |
| <b>USB PHY</b>                         |                                      |                    |          |                   |       |
| USB1_D_M                               | USB PHY Data Minus                   | C3                 | IO       | -                 | ---   |
| USB1_D_P                               | USB PHY Data Plus                    | D3                 | IO       | -                 | ---   |
| USB1_ID                                | USB PHY ID Detect                    | E3                 | I        | -                 | ---   |
| USB1_RESREF                            | USB PHY Impedance Calibration        | J7                 | IO       | -                 | ---   |
| USB1_RX_M                              | USB PHY 3.0 Receive Data (negative)  | A4                 | I        | -                 | ---   |
| USB1_RX_P                              | USB PHY 3.0 Receive Data (positive)  | B4                 | I        | -                 | ---   |
| USB1_TX_M                              | USB PHY 3.0 Transmit Data (negative) | A2                 | O        | -                 | ---   |
| USB1_TX_P                              | USB PHY 3.0 Transmit Data (positive) | B2                 | O        | -                 | ---   |
| USB1_VBUS                              | USB PHY VBUS                         | C1                 | I        | -                 | 24    |
| <b>Ethernet Management Interface 1</b> |                                      |                    |          |                   |       |
| EMI1_MDC/GPIO3_00                      | Management Data Clock                | AB2                | O        | L1V <sub>DD</sub> | 1     |
| EMI1_MDIO/GPIO3_01                     | Management Data In/Out               | AB3                | IO       | L1V <sub>DD</sub> | ---   |
| <b>Ethernet Controller 1</b>           |                                      |                    |          |                   |       |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                       | Signal description | Package pin number | Pin type | Power supply      | Notes |
|------------------------------------------------------------------------------|--------------------|--------------------|----------|-------------------|-------|
| <b>EC1_GTX_CLK</b> /GPIO3_07/<br>EC1_TX_CLK/<br>SAI2_TX_BCLK/<br>FTM1_EXTCLK | Transmit Clock Out | Y7                 | O        | L1V <sub>DD</sub> | 1     |
| <b>EC1_GTX_CLK125</b> /<br>GPIO3_08/EC1_RX_ER/<br>EXT_AUDIO_MCLK2            | Reference Clock    | AA4                | I        | L1V <sub>DD</sub> | 1     |
| <b>EC1_RXD0</b> /GPIO3_12/<br>SAI2_RX_SYNC/FTM1_CH0                          | Receive Data       | AB6                | I        | L1V <sub>DD</sub> | 1     |
| <b>EC1_RXD1</b> /GPIO3_11/<br>SAI1_RX_SYNC/FTM1_CH1                          | Receive Data       | AC5                | I        | L1V <sub>DD</sub> | 1     |
| <b>EC1_RXD2</b> /GPIO3_10/<br>SAI2_RX_DATA/FTM1_CH6                          | Receive Data       | AC4                | I        | L1V <sub>DD</sub> | 1     |
| <b>EC1_RXD3</b> /GPIO3_09/<br>SAI1_RX_DATA/FTM1_CH4                          | Receive Data       | AB4                | I        | L1V <sub>DD</sub> | 1     |
| <b>EC1_RX_CLK</b> /GPIO3_13/<br>SAI1_RX_BCLK/<br>FTM1_QD_PHA                 | Receive Clock      | AC3                | I        | L1V <sub>DD</sub> | 1     |
| <b>EC1_RX_DV</b> /GPIO3_14/<br>SAI2_RX_BCLK/<br>FTM1_QD_PHB                  | Receive Data Valid | AC6                | I        | L1V <sub>DD</sub> | 1     |
| <b>EC1_TXD0</b> /GPIO3_05/<br>SAI2_TX_SYNC/FTM1_CH2                          | Transmit Data      | AA6                | O        | L1V <sub>DD</sub> | 1     |
| <b>EC1_TXD1</b> /GPIO3_04/<br>SAI1_TX_SYNC/FTM1_CH3                          | Transmit Data      | Y6                 | O        | L1V <sub>DD</sub> | 1     |
| <b>EC1_TXD2</b> /GPIO3_03/<br>SAI2_TX_DATA/FTM1_CH7                          | Transmit Data      | AA5                | O        | L1V <sub>DD</sub> | 1     |
| <b>EC1_TXD3</b> /GPIO3_02/<br>SAI1_TX_DATA/FTM1_CH5                          | Transmit Data      | W5                 | O        | L1V <sub>DD</sub> | 1     |
| <b>EC1_TX_EN</b> /GPIO3_06/<br>SAI1_TX_BCLK/FTM1_FAULT                       | Transmit Enable    | W6                 | O        | L1V <sub>DD</sub> | 1, 13 |
| <b>Ethernet Controller 2</b>                                                 |                    |                    |          |                   |       |
| <b>EC2_GTX_CLK</b> /GPIO3_20/<br>EC2_TX_CLK/USB2_CLK/<br>FTM2_EXTCLK         | Transmit Clock Out | U3                 | O        | LV <sub>DD</sub>  | 1     |
| <b>EC2_GTX_CLK125</b> /<br>GPIO3_21/EC2_RX_ER/<br>USB2_PWRFAULT              | Reference Clock    | U5                 | I        | LV <sub>DD</sub>  | 1     |
| <b>EC2_RXD0</b> /GPIO3_25/<br>USB2_D0/FTM2_CH0                               | Receive Data       | U2                 | I        | LV <sub>DD</sub>  | 1     |
| <b>EC2_RXD1</b> /GPIO3_24/<br>USB2_D1/FTM2_CH1                               | Receive Data       | U1                 | I        | LV <sub>DD</sub>  | 1     |
| <b>EC2_RXD2</b> /GPIO3_23/<br>USB2_D2/FTM2_CH6                               | Receive Data       | T1                 | I        | LV <sub>DD</sub>  | 1     |

Table continues on the next page...

**Table 1. Pinout list by bus (continued)**

| Signal                                                                     | Signal description | Package pin number | Pin type | Power supply     | Notes |
|----------------------------------------------------------------------------|--------------------|--------------------|----------|------------------|-------|
| <b>EC2_RXD3</b> /GPIO3_22/<br>USB2_D3/FTM2_CH4                             | Receive Data       | R2                 | I        | LV <sub>DD</sub> | 1     |
| <b>EC2_RX_CLK</b> /GPIO3_26/<br>USB2_DIR/FTM2_QD_PHA                       | Receive Clock      | R1                 | I        | LV <sub>DD</sub> | 1     |
| <b>EC2_RX_DV</b> /GPIO3_27/<br>USB2_NXT/FTM2_QD_PHB                        | Receive Data Valid | V1                 | I        | LV <sub>DD</sub> | 1     |
| <b>EC2_TXD0</b> /GPIO3_18/<br>USB2_D4/FTM2_CH2                             | Transmit Data      | T3                 | O        | LV <sub>DD</sub> | 1     |
| <b>EC2_TXD1</b> /GPIO3_17/<br>USB2_D5/FTM2_CH3                             | Transmit Data      | T4                 | O        | LV <sub>DD</sub> | 1     |
| <b>EC2_TXD2</b> /GPIO3_16/<br>USB2_D6/FTM2_CH7                             | Transmit Data      | R3                 | O        | LV <sub>DD</sub> | 1     |
| <b>EC2_TXD3</b> /GPIO3_15/<br>USB2_D7/FTM2_CH5                             | Transmit Data      | R4                 | O        | LV <sub>DD</sub> | 1     |
| <b>EC2_TX_EN</b> /GPIO3_19/<br>USB2_STP/FTM2_FAULT                         | Transmit Enable    | T5                 | O        | LV <sub>DD</sub> | 1, 13 |
| <b>Ethernet Controller 3</b>                                               |                    |                    |          |                  |       |
| <b>EC3_GTX_CLK</b> /GPIO4_01/<br>EC2_TX_ER/FTM3_CH0/<br>EC3_TX_CLK         | Transmit Clock Out | V5                 | O        | LV <sub>DD</sub> | 1     |
| <b>EC3_GTX_CLK125</b> /<br>GPIO4_02/EC2_COL/<br>USB2_DRVVBUS/<br>EC3_RX_ER | Reference Clock    | Y4                 | I        | LV <sub>DD</sub> | 1     |
| <b>EC3_RXD0</b> /GPIO4_06/<br>TSEC_1588_TRIG_IN2/<br>EC2_CRS/FTM3_CH2      | Receive Data       | AA1                | I        | LV <sub>DD</sub> | 1     |
| <b>EC3_RXD1</b> /GPIO4_05/<br>TSEC_1588_PULSE_OUT1/<br>FTM3_CH3            | Receive Data       | Y2                 | I        | LV <sub>DD</sub> | 1     |
| <b>EC3_RXD2</b> /GPIO4_04/<br>EC1_COL/FTM3_EXTCLK                          | Receive Data       | Y1                 | I        | LV <sub>DD</sub> | 1     |
| <b>EC3_RXD3</b> /GPIO4_03/<br>EC1_CRS/FTM3_FAULT                           | Receive Data       | W1                 | I        | LV <sub>DD</sub> | 1     |
| <b>EC3_RX_CLK</b> /GPIO4_07/<br>TSEC_1588_CLK_IN/<br>FTM3_QD_PHA           | Receive Clock      | V2                 | I        | LV <sub>DD</sub> | 1     |
| <b>EC3_RX_DV</b> /GPIO4_08/<br>TSEC_1588_TRIG_IN1/<br>FTM3_QD_PHB          | Receive Data Valid | AA2                | I        | LV <sub>DD</sub> | 1     |
| <b>EC3_TXD0</b> /GPIO3_31/<br>TSEC_1588_PULSE_OUT2/<br>FTM3_CH4            | Transmit Data      | W4                 | O        | LV <sub>DD</sub> | 1     |
| <b>EC3_TXD1</b> /GPIO3_30/<br>TSEC_1588_CLK_OUT/<br>FTM3_CH5               | Transmit Data      | W3                 | O        | LV <sub>DD</sub> | 1     |

Table continues on the next page...

**Table 1. Pinout list by bus (continued)**

| Signal                                                                                      | Signal description | Package pin number | Pin type | Power supply     | Notes |
|---------------------------------------------------------------------------------------------|--------------------|--------------------|----------|------------------|-------|
| <b>EC3_TXD2</b> /GPIO3_29/<br>TSEC_1588_ALARM_OUT1/<br>FTM3_CH6                             | Transmit Data      | V4                 | O        | LV <sub>DD</sub> | 1     |
| <b>EC3_TXD3</b> /GPIO3_28/<br>TSEC_1588_ALARM_OUT2/<br>FTM3_CH7                             | Transmit Data      | V3                 | O        | LV <sub>DD</sub> | 1     |
| <b>EC3_TX_EN</b> /GPIO4_00/<br>EC1_TX_ER/FTM3_CH1                                           | Transmit Enable    | Y3                 | O        | LV <sub>DD</sub> | 1, 13 |
| <b>TDM</b>                                                                                  |                    |                    |          |                  |       |
| <b>CLK09</b> /GPIO4_19/BRGO2/<br>SAI3_RX_BCLK/<br>FTM4_QD_PHA                               | External Clock     | K5                 | I        | DV <sub>DD</sub> | 1     |
| <b>CLK10</b> /GPIO4_20/BRGO3/<br>SAI3_RX_SYNC/<br>FTM4_QD_PHB                               | External Clock     | L5                 | I        | DV <sub>DD</sub> | 1     |
| <b>CLK11</b> /GPIO4_21/BRGO4/<br>SAI4_RX_SYNC/FTM8_CH0                                      | External Clock     | M5                 | I        | DV <sub>DD</sub> | 1     |
| <b>CLK12</b> /GPIO4_22/BRGO1/<br>FTM8_CH1                                                   | External Clock     | N5                 | I        | DV <sub>DD</sub> | 1, 16 |
| <b>TDMA_RQ</b> /GPIO4_13/<br>UC1_CDB_RXER/<br>EXT_AUDIO_MCLK1/<br>FTM4_CH3                  | Request            | H5                 | O        | DV <sub>DD</sub> | 1     |
| <b>TDMA_RSYNC</b> /GPIO4_10/<br>UC1_CTSB_RXDV/<br>SAI3_TX_BCLK/FTM4_CH6                     | Receive Sync       | J3                 | I        | DV <sub>DD</sub> | 1     |
| <b>TDMA_RXD</b> /GPIO4_09/<br>UC1_RXD7/SAI3_RX_DATA/<br>FTM4_CH7                            | Receive Data       | H3                 | I        | DV <sub>DD</sub> | 1     |
| <b>TDMA_TSYNC</b> /GPIO4_12/<br>UC1_RTSB_TXEN/<br>SAI3_TX_SYNC/FTM4_CH4                     | Transmit Sync      | J5                 | I        | DV <sub>DD</sub> | 1     |
| <b>TDMA_TXD</b> /GPIO4_11/<br>UC1_TXD7/SAI3_TX_DATA/<br>FTM4_CH5                            | Transmit Data      | J4                 | O        | DV <sub>DD</sub> | 1     |
| <b>TDMB_RQ</b> /GPIO4_18/<br>UC3_CDB_RXER/<br>SPDIF_EXTCLK/<br>SAI4_RX_BCLK/<br>FTM4_EXTCLK | Request            | K4                 | O        | DV <sub>DD</sub> | 1     |
| <b>TDMB_RSYNC</b> /GPIO4_15/<br>UC3_CTSB_RXDV/<br>SPDIF_PLOCK/<br>SAI4_TX_BCLK/FTM4_CH1     | Receive Sync       | L3                 | I        | DV <sub>DD</sub> | 1     |
| <b>TDMB_RXD</b> /GPIO4_14/<br>UC3_RXD7/SPDIF_IN/<br>SAI4_RX_DATA/FTM4_CH2                   | Receive Data       | K3                 | I        | DV <sub>DD</sub> | 1     |

Table continues on the next page...

**Table 1. Pinout list by bus (continued)**

| Signal                                                                                        | Signal description                  | Package pin number | Pin type | Power supply     | Notes |
|-----------------------------------------------------------------------------------------------|-------------------------------------|--------------------|----------|------------------|-------|
| <b>TDMB_TSYNC</b> /GPIO4_17/<br>UC3_RTSB_TXEN/<br>SPDIF_SRCLK/<br>SAI4_TX_SYNC/<br>FTM4_FAULT | Transmit Sync                       | M4                 | I        | DV <sub>DD</sub> | 1     |
| <b>TDMB_TXD</b> /GPIO4_16/<br>UC3_TXD7/SPDIF_OUT/<br>SAI4_TX_DATA/FTM4_CH0                    | Transmit Data                       | M3                 | O        | DV <sub>DD</sub> | 1     |
| <b>Power-On-Reset Configuration</b>                                                           |                                     |                    |          |                  |       |
| cfg_dram_type/ <b>IFC_A21</b> /<br>QSPI_CK_B                                                  | Power-On-Reset Configuration Signal | D10                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_eng_use0/ <b>IFC_WE0_B</b>                                                                | Power-On-Reset Configuration Signal | F14                | I        | BV <sub>DD</sub> | 1     |
| cfg_gpinut0/ <b>IFC_AD00</b>                                                                  | Power-On-Reset Configuration Signal | A7                 | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_gpinut1/ <b>IFC_AD01</b>                                                                  | Power-On-Reset Configuration Signal | B8                 | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_gpinut2/ <b>IFC_AD02</b>                                                                  | Power-On-Reset Configuration Signal | A8                 | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_gpinut3/ <b>IFC_AD03</b>                                                                  | Power-On-Reset Configuration Signal | B9                 | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_gpinut4/ <b>IFC_AD04</b>                                                                  | Power-On-Reset Configuration Signal | A9                 | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_gpinut5/ <b>IFC_AD05</b>                                                                  | Power-On-Reset Configuration Signal | A10                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_gpinut6/ <b>IFC_AD06</b>                                                                  | Power-On-Reset Configuration Signal | B11                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_gpinut7/ <b>IFC_AD07</b>                                                                  | Power-On-Reset Configuration Signal | A11                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_ifc_te/ <b>IFC_TE</b>                                                                     | Power-On-Reset Configuration Signal | D14                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_rcw_src0/ <b>IFC_AD08</b> /<br>SPI1_PCS1                                                  | Power-On-Reset Configuration Signal | B12                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_rcw_src1/ <b>IFC_AD09</b> /<br>SPI1_PCS2                                                  | Power-On-Reset Configuration Signal | A12                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_rcw_src2/ <b>IFC_AD10</b> /<br>SPI1_PCS3                                                  | Power-On-Reset Configuration Signal | A13                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_rcw_src3/ <b>IFC_AD11</b> /<br>SPI1_PCS4                                                  | Power-On-Reset Configuration Signal | B14                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_rcw_src4/ <b>IFC_AD12</b> /<br>SPI1_PCS5                                                  | Power-On-Reset Configuration Signal | A14                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_rcw_src5/ <b>IFC_AD13</b> /<br>SPI1_SOUT                                                  | Power-On-Reset Configuration Signal | B15                | I        | BV <sub>DD</sub> | 1, 4  |
| cfg_rcw_src6/ <b>IFC_AD14</b>                                                                 | Power-On-Reset Configuration Signal | A15                | I        | BV <sub>DD</sub> | 1, 4  |

Table continues on the next page...

**Table 1. Pinout list by bus (continued)**

| Signal                                                                     | Signal description                  | Package pin number | Pin type | Power supply      | Notes |
|----------------------------------------------------------------------------|-------------------------------------|--------------------|----------|-------------------|-------|
| cfg_rcw_src7/ <b>IFC_AD15</b>                                              | Power-On-Reset Configuration Signal | A16                | I        | BV <sub>DD</sub>  | 1, 4  |
| cfg_rcw_src8/ <b>IFC_CLE</b>                                               | Power-On-Reset Configuration Signal | E17                | I        | BV <sub>DD</sub>  | 1, 4  |
| <b>QSPI</b>                                                                |                                     |                    |          |                   |       |
| QSPI_CK_A/ <b>IFC_A18</b>                                                  | Channel A Clock                     | C9                 | O        | BV <sub>DD</sub>  | 1, 5  |
| QSPI_CK_B/ <b>IFC_A21</b> /<br>cfg_dram_type                               | Channel B Clock                     | D10                | O        | BV <sub>DD</sub>  | 1, 4  |
| QSPI_CS_A0/ <b>IFC_A16</b>                                                 | Channel A Chip Select 0             | C8                 | O        | BV <sub>DD</sub>  | 1, 5  |
| QSPI_CS_A1/ <b>IFC_A17</b>                                                 | Channel A Chip Select 1             | D8                 | O        | BV <sub>DD</sub>  | 1, 5  |
| QSPI_CS_B0/ <b>IFC_A19</b>                                                 | Channel B Chip Select 0             | D9                 | O        | BV <sub>DD</sub>  | 1, 5  |
| QSPI_CS_B1/ <b>IFC_A20</b>                                                 | Channel B Chip Select 1             | C10                | O        | BV <sub>DD</sub>  | 1, 5  |
| QSPI_DIO_A0/ <b>IFC_A22</b> /<br>IFC_WP1_B                                 | Channel A Data I/O 0                | C11                | IO       | BV <sub>DD</sub>  | ---   |
| QSPI_DIO_A1/ <b>IFC_A23</b> /<br>IFC_WP2_B                                 | Channel A Data I/O 1                | D11                | IO       | BV <sub>DD</sub>  | ---   |
| QSPI_DIO_A2/ <b>IFC_A24</b> /<br>IFC_WP3_B                                 | Channel A Data I/O 2                | C12                | IO       | BV <sub>DD</sub>  | ---   |
| QSPI_DIO_A3/ <b>IFC_A25</b> /<br>GPIO2_25/FTM5_CH0/<br>IFC_RB2_B/IFC_CS4_B | Channel A Data I/O 3                | D12                | IO       | BV <sub>DD</sub>  | ---   |
| QSPI_DIO_B0/ <b>IFC_PAR0</b> /<br>GPIO2_13/FTM6_CH0                        | Channel B Data I/O 0                | D15                | IO       | BV <sub>DD</sub>  | ---   |
| QSPI_DIO_B1/ <b>IFC_PAR1</b> /<br>GPIO2_14/FTM6_CH1                        | Channel B Data I/O 1                | E13                | IO       | BV <sub>DD</sub>  | ---   |
| QSPI_DIO_B2/ <b>IFC_PERR_B</b> /<br>GPIO2_15/FTM6_EXTCLK                   | Channel B Data I/O 2                | C15                | IO       | BV <sub>DD</sub>  | ---   |
| QSPI_DIO_B3/ <b>IFC_CS3_B</b> /<br>GPIO2_12/IIC3_SDA/<br>FTM7_EXTCLK       | Channel B Data I/O 3                | F18                | IO       | BV <sub>DD</sub>  | ---   |
| <b>General Purpose Input/Output</b>                                        |                                     |                    |          |                   |       |
| GPIO1_13/ <b>ASLEEP</b>                                                    | General Purpose Input/Output        | E6                 | O        | O1V <sub>DD</sub> | 1, 5  |
| GPIO1_14/ <b>RTC</b>                                                       | General Purpose Input/Output        | E10                | IO       | OV <sub>DD</sub>  | ---   |
| GPIO1_15/ <b>UART1_SOUT</b>                                                | General Purpose Input/Output        | N1                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO1_16/ <b>UART2_SOUT</b> /<br>SPI2_PCS0/LPUART1_SOUT                    | General Purpose Input/Output        | P1                 | IO       | D1V <sub>DD</sub> | ---   |
| GPIO1_17/ <b>UART1_SIN</b>                                                 | General Purpose Input/Output        | M1                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO1_18/ <b>UART2_SIN</b> /<br>LPUART1_SIN/SPI2_PCS1                      | General Purpose Input/Output        | P2                 | IO       | D1V <sub>DD</sub> | ---   |
| GPIO1_19/ <b>UART1_RTS_B</b> /<br>UART3_SOUT/<br>LPUART2_SOUT/SPI2_SOUT    | General Purpose Input/Output        | N3                 | IO       | DV <sub>DD</sub>  | ---   |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                                    | Signal description           | Package pin number | Pin type | Power supply      | Notes |
|-------------------------------------------------------------------------------------------|------------------------------|--------------------|----------|-------------------|-------|
| GPIO1_20/ <b>UART2_RTS_B</b> /<br>UART4_SOUT/<br>LPUART1_RTS_B/<br>LPUART4_SOUT/SPI2_PCS2 | General Purpose Input/Output | P3                 | IO       | D1V <sub>DD</sub> | ---   |
| GPIO1_21/ <b>UART1_CTS_B</b> /<br>UART3_SIN/LPUART2_SIN/<br>SPI2_SIN                      | General Purpose Input/Output | N4                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO1_22/ <b>UART2_CTS_B</b> /<br>UART4_SIN/SPI2_SCK/<br>LPUART1_CTS_B/<br>LPUART4_SIN    | General Purpose Input/Output | P5                 | IO       | D1V <sub>DD</sub> | ---   |
| GPIO1_23/ <b>IRQ3</b>                                                                     | General Purpose Input/Output | R5                 | IO       | LV <sub>DD</sub>  | ---   |
| GPIO1_24/ <b>IRQ4</b> /SDHC_VS                                                            | General Purpose Input/Output | L2                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO1_25/ <b>IRQ5</b> /<br>SDHC_CLK_SYNC_IN/<br>SPI2_PCS5                                 | General Purpose Input/Output | M2                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO2_04/ <b>SDHC_CMD</b> /<br>LPUART3_SOUT                                               | General Purpose Input/Output | E2                 | IO       | EV <sub>DD</sub>  | ---   |
| GPIO2_05/ <b>SDHC_DAT0</b> /<br>LPUART3_SIN                                               | General Purpose Input/Output | E1                 | IO       | EV <sub>DD</sub>  | ---   |
| GPIO2_06/ <b>SDHC_DAT1</b> /<br>LPUART2_RTS_B/<br>LPUART5_SOUT                            | General Purpose Input/Output | F2                 | IO       | EV <sub>DD</sub>  | ---   |
| GPIO2_07/ <b>SDHC_DAT2</b> /<br>LPUART2_CTS_B/<br>LPUART5_SIN                             | General Purpose Input/Output | F1                 | IO       | EV <sub>DD</sub>  | ---   |
| GPIO2_08/ <b>SDHC_DAT3</b> /<br>LPUART3_RTS_B/<br>LPUART6_SOUT                            | General Purpose Input/Output | G1                 | IO       | EV <sub>DD</sub>  | ---   |
| GPIO2_09/ <b>SDHC_CLK</b> /<br>LPUART3_CTS_B/<br>LPUART6_SIN                              | General Purpose Input/Output | D1                 | IO       | EV <sub>DD</sub>  | ---   |
| GPIO2_10/ <b>IFC_CS1_B</b> /<br>SPI1_PCS0/FTM7_CH0                                        | General Purpose Input/Output | D17                | IO       | BV <sub>DD</sub>  | ---   |
| GPIO2_11/ <b>IFC_CS2_B</b> /<br>SPI1_SCK/FTM7_CH1/<br>IIC3_SCL                            | General Purpose Input/Output | C18                | IO       | BV <sub>DD</sub>  | ---   |
| GPIO2_12/ <b>IFC_CS3_B</b> /<br>QSPI_DIO_B3/IIC3_SDA/<br>FTM7_EXTCLK                      | General Purpose Input/Output | F18                | IO       | BV <sub>DD</sub>  | ---   |
| GPIO2_13/ <b>IFC_PAR0</b> /<br>QSPI_DIO_B0/FTM6_CH0                                       | General Purpose Input/Output | D15                | IO       | BV <sub>DD</sub>  | ---   |
| GPIO2_14/ <b>IFC_PAR1</b> /<br>QSPI_DIO_B1/FTM6_CH1                                       | General Purpose Input/Output | E13                | IO       | BV <sub>DD</sub>  | ---   |
| GPIO2_15/ <b>IFC_PERR_B</b> /<br>QSPI_DIO_B2/FTM6_EXTCLK                                  | General Purpose Input/Output | C15                | IO       | BV <sub>DD</sub>  | ---   |

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**Table 1. Pinout list by bus (continued)**

| Signal                                                                        | Signal description           | Package pin number | Pin type | Power supply      | Notes |
|-------------------------------------------------------------------------------|------------------------------|--------------------|----------|-------------------|-------|
| GPIO2_24/ <b>EVT9_B</b>                                                       | General Purpose Input/Output | D7                 | IO       | O1V <sub>DD</sub> | ---   |
| GPIO2_25/ <b>IFC_A25</b> /<br>QSPI_DIO_A3/FTM5_CH0/<br>IFC_RB2_B/IFC_CS4_B    | General Purpose Input/Output | D12                | IO       | BV <sub>DD</sub>  | ---   |
| GPIO2_26/ <b>IFC_A26</b> /<br>FTM5_CH1/IFC_RB3_B/<br>IFC_CS5_B                | General Purpose Input/Output | C13                | IO       | BV <sub>DD</sub>  | ---   |
| GPIO2_27/ <b>IFC_A27</b> /<br>FTM5_EXTCLK/IFC_CS6_B                           | General Purpose Input/Output | D13                | IO       | BV <sub>DD</sub>  | ---   |
| GPIO3_00/ <b>EMI1_MDC</b>                                                     | General Purpose Input/Output | AB2                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_01/ <b>EMI1_MDIO</b>                                                    | General Purpose Input/Output | AB3                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_02/ <b>EC1_TXD3</b> /<br>SAI1_TX_DATA/FTM1_CH5                          | General Purpose Input/Output | W5                 | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_03/ <b>EC1_TXD2</b> /<br>SAI2_TX_DATA/FTM1_CH7                          | General Purpose Input/Output | AA5                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_04/ <b>EC1_TXD1</b> /<br>SAI1_TX_SYNC/FTM1_CH3                          | General Purpose Input/Output | Y6                 | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_05/ <b>EC1_TXD0</b> /<br>SAI2_TX_SYNC/FTM1_CH2                          | General Purpose Input/Output | AA6                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_06/ <b>EC1_TX_EN</b> /<br>SAI1_TX_BCLK/FTM1_FAULT                       | General Purpose Input/Output | W6                 | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_07/ <b>EC1_GTX_CLK</b> /<br>EC1_TX_CLK/<br>SAI2_TX_BCLK/<br>FTM1_EXTCLK | General Purpose Input/Output | Y7                 | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_08/<br><b>EC1_GTX_CLK125</b> /<br>EC1_RX_ER/<br>EXT_AUDIO_MCLK2         | General Purpose Input/Output | AA4                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_09/ <b>EC1_RXD3</b> /<br>SAI1_RX_DATA/FTM1_CH4                          | General Purpose Input/Output | AB4                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_10/ <b>EC1_RXD2</b> /<br>SAI2_RX_DATA/FTM1_CH6                          | General Purpose Input/Output | AC4                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_11/ <b>EC1_RXD1</b> /<br>SAI1_RX_SYNC/FTM1_CH1                          | General Purpose Input/Output | AC5                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_12/ <b>EC1_RXD0</b> /<br>SAI2_RX_SYNC/FTM1_CH0                          | General Purpose Input/Output | AB6                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_13/ <b>EC1_RX_CLK</b> /<br>SAI1_RX_BCLK/<br>FTM1_QD_PHA                 | General Purpose Input/Output | AC3                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_14/ <b>EC1_RX_DV</b> /<br>SAI2_RX_BCLK/<br>FTM1_QD_PHB                  | General Purpose Input/Output | AC6                | IO       | L1V <sub>DD</sub> | ---   |
| GPIO3_15/ <b>EC2_TXD3</b> /<br>USB2_D7/FTM2_CH5                               | General Purpose Input/Output | R4                 | IO       | LV <sub>DD</sub>  | ---   |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                | Signal description           | Package pin number | Pin type | Power supply     | Notes |
|-----------------------------------------------------------------------|------------------------------|--------------------|----------|------------------|-------|
| GPIO3_16/ <b>EC2_TXD2</b> /<br>USB2_D6/FTM2_CH7                       | General Purpose Input/Output | R3                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_17/ <b>EC2_TXD1</b> /<br>USB2_D5/FTM2_CH3                       | General Purpose Input/Output | T4                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_18/ <b>EC2_TXD0</b> /<br>USB2_D4/FTM2_CH2                       | General Purpose Input/Output | T3                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_19/ <b>EC2_TX_EN</b> /<br>USB2_STP/FTM2_FAULT                   | General Purpose Input/Output | T5                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_20/ <b>EC2_GTX_CLK</b> /<br>EC2_TX_CLK/USB2_CLK/<br>FTM2_EXTCLK | General Purpose Input/Output | U3                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_21/<br><b>EC2_GTX_CLK125</b> /<br>EC2_RX_ER/<br>USB2_PWRFAULT   | General Purpose Input/Output | U5                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_22/ <b>EC2_RXD3</b> /<br>USB2_D3/FTM2_CH4                       | General Purpose Input/Output | R2                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_23/ <b>EC2_RXD2</b> /<br>USB2_D2/FTM2_CH6                       | General Purpose Input/Output | T1                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_24/ <b>EC2_RXD1</b> /<br>USB2_D1/FTM2_CH1                       | General Purpose Input/Output | U1                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_25/ <b>EC2_RXD0</b> /<br>USB2_D0/FTM2_CH0                       | General Purpose Input/Output | U2                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_26/ <b>EC2_RX_CLK</b> /<br>USB2_DIR/FTM2_QD_PHA                 | General Purpose Input/Output | R1                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_27/ <b>EC2_RX_DV</b> /<br>USB2_NXT/FTM2_QD_PHB                  | General Purpose Input/Output | V1                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_28/ <b>EC3_TXD3</b> /<br>TSEC_1588_ALARM_OUT2/<br>FTM3_CH7      | General Purpose Input/Output | V3                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_29/ <b>EC3_TXD2</b> /<br>TSEC_1588_ALARM_OUT1/<br>FTM3_CH6      | General Purpose Input/Output | V4                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_30/ <b>EC3_TXD1</b> /<br>TSEC_1588_CLK_OUT/<br>FTM3_CH5         | General Purpose Input/Output | W3                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO3_31/ <b>EC3_TXD0</b> /<br>TSEC_1588_PULSE_OUT2/<br>FTM3_CH4      | General Purpose Input/Output | W4                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_00/ <b>EC3_TX_EN</b> /<br>EC1_TX_ER/FTM3_CH1                    | General Purpose Input/Output | Y3                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_01/ <b>EC3_GTX_CLK</b> /<br>EC2_TX_ER/FTM3_CH0/<br>EC3_TX_CLK   | General Purpose Input/Output | V5                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_02/<br><b>EC3_GTX_CLK125</b> /                                  | General Purpose Input/Output | Y4                 | IO       | LV <sub>DD</sub> | ---   |

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**Table 1. Pinout list by bus (continued)**

| Signal                                                                                  | Signal description           | Package pin number | Pin type | Power supply     | Notes |
|-----------------------------------------------------------------------------------------|------------------------------|--------------------|----------|------------------|-------|
| EC2_COL/USB2_DRVVBUS/<br>EC3_RX_ER                                                      |                              |                    |          |                  |       |
| GPIO4_03/ <b>EC3_RXD3</b> /<br>EC1_CRS/FTM3_FAULT                                       | General Purpose Input/Output | W1                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_04/ <b>EC3_RXD2</b> /<br>EC1_COL/FTM3_EXTCLK                                      | General Purpose Input/Output | Y1                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_05/ <b>EC3_RXD1</b> /<br>TSEC_1588_PULSE_OUT1/<br>FTM3_CH3                        | General Purpose Input/Output | Y2                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_06/ <b>EC3_RXD0</b> /<br>TSEC_1588_TRIG_IN2/<br>EC2_CRS/FTM3_CH2                  | General Purpose Input/Output | AA1                | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_07/ <b>EC3_RX_CLK</b> /<br>TSEC_1588_CLK_IN/<br>FTM3_QD_PHA                       | General Purpose Input/Output | V2                 | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_08/ <b>EC3_RX_DV</b> /<br>TSEC_1588_TRIG_IN1/<br>FTM3_QD_PHB                      | General Purpose Input/Output | AA2                | IO       | LV <sub>DD</sub> | ---   |
| GPIO4_09/ <b>TDMA_RXD</b> /<br>UC1_RXD7/SAI3_RX_DATA/<br>FTM4_CH7                       | General Purpose Input/Output | H3                 | IO       | DV <sub>DD</sub> | ---   |
| GPIO4_10/ <b>TDMA_RSNC</b> /<br>UC1_CTSB_RXDV/<br>SAI3_TX_BCLK/FTM4_CH6                 | General Purpose Input/Output | J3                 | IO       | DV <sub>DD</sub> | ---   |
| GPIO4_11/ <b>TDMA_TXD</b> /<br>UC1_TXD7/SAI3_TX_DATA/<br>FTM4_CH5                       | General Purpose Input/Output | J4                 | IO       | DV <sub>DD</sub> | ---   |
| GPIO4_12/ <b>TDMA_TSYNC</b> /<br>UC1_RTSB_TXEN/<br>SAI3_TX_SYNC/FTM4_CH4                | General Purpose Input/Output | J5                 | IO       | DV <sub>DD</sub> | ---   |
| GPIO4_13/ <b>TDMA_RQ</b> /<br>UC1_CDB_RXER/<br>EXT_AUDIO_MCLK1/<br>FTM4_CH3             | General Purpose Input/Output | H5                 | IO       | DV <sub>DD</sub> | ---   |
| GPIO4_14/ <b>TDMB_RXD</b> /<br>UC3_RXD7/SPDIF_IN/<br>SAI4_RX_DATA/FTM4_CH2              | General Purpose Input/Output | K3                 | IO       | DV <sub>DD</sub> | ---   |
| GPIO4_15/ <b>TDMB_RSNC</b> /<br>UC3_CTSB_RXDV/<br>SPDIF_PLOCK/<br>SAI4_TX_BCLK/FTM4_CH1 | General Purpose Input/Output | L3                 | IO       | DV <sub>DD</sub> | ---   |
| GPIO4_16/ <b>TDMB_TXD</b> /<br>UC3_TXD7/SPDIF_OUT/<br>SAI4_TX_DATA/FTM4_CH0             | General Purpose Input/Output | M3                 | IO       | DV <sub>DD</sub> | ---   |
| GPIO4_17/ <b>TDMB_TSYNC</b> /<br>UC3_RTSB_TXEN/<br>SPDIF_SRCLK/                         | General Purpose Input/Output | M4                 | IO       | DV <sub>DD</sub> | ---   |

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Table 1. Pinout list by bus (continued)

| Signal                                                                              | Signal description           | Package pin number | Pin type | Power supply      | Notes |
|-------------------------------------------------------------------------------------|------------------------------|--------------------|----------|-------------------|-------|
| SAI4_TX_SYNC/<br>FTM4_FAULT                                                         |                              |                    |          |                   |       |
| GPIO4_18/TDMB_RQ/<br>UC3_CDB_RXER/<br>SPDIF_EXTCLK/<br>SAI4_RX_BCLK/<br>FTM4_EXTCLK | General Purpose Input/Output | K4                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_19/CLK09/BRGO2/<br>SAI3_RX_BCLK/<br>FTM4_QD_PHA                               | General Purpose Input/Output | K5                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_20/CLK10/BRGO3/<br>SAI3_RX_SYNC/<br>FTM4_QD_PHB                               | General Purpose Input/Output | L5                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_21/CLK11/BRGO4/<br>SAI4_RX_SYNC/FTM8_CH0                                      | General Purpose Input/Output | M5                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_22/CLK12/BRGO1/<br>FTM8_CH1                                                   | General Purpose Input/Output | N5                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_23/SDHC_DAT4/<br>SDHC_CLK_SYNC_OUT                                            | General Purpose Input/Output | H2                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_24/SDHC_DAT5/<br>SDHC_CMD_DIR                                                 | General Purpose Input/Output | H1                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_25/SDHC_DAT6/<br>USB1_DRVVBUS/<br>SDHC_DAT0_DIR                               | General Purpose Input/Output | J2                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_26/SDHC_DAT7/<br>USB1_PWRFAULT/<br>SDHC_DAT123_DIR                            | General Purpose Input/Output | J1                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_27/IIC2_SCL/<br>SDHC_CD_B/SPI2_PCS3                                           | General Purpose Input/Output | K1                 | IO       | DV <sub>DD</sub>  | ---   |
| GPIO4_28/IIC2_SDA/<br>SDHC_WP/SPI2_PCS4                                             | General Purpose Input/Output | L1                 | IO       | DV <sub>DD</sub>  | ---   |
| <b>FTM1</b>                                                                         |                              |                    |          |                   |       |
| FTM1_CH0/EC1_RXD0/<br>GPIO3_12/SAI2_RX_SYNC                                         | FTM 1 Channel 0              | AB6                | IO       | L1V <sub>DD</sub> | ---   |
| FTM1_CH1/EC1_RXD1/<br>GPIO3_11/SAI1_RX_SYNC                                         | FTM 1 Channel 1              | AC5                | IO       | L1V <sub>DD</sub> | ---   |
| FTM1_CH2/EC1_TXD0/<br>GPIO3_05/SAI2_TX_SYNC                                         | FTM 1 Channel 2              | AA6                | IO       | L1V <sub>DD</sub> | ---   |
| FTM1_CH3/EC1_TXD1/<br>GPIO3_04/SAI1_TX_SYNC                                         | FTM 1 Channel 3              | Y6                 | IO       | L1V <sub>DD</sub> | ---   |
| FTM1_CH4/EC1_RXD3/<br>GPIO3_09/SAI1_RX_DATA                                         | FTM 1 Channel 4              | AB4                | IO       | L1V <sub>DD</sub> | ---   |
| FTM1_CH5/EC1_TXD3/<br>GPIO3_02/SAI1_TX_DATA                                         | FTM 1 Channel 5              | W5                 | IO       | L1V <sub>DD</sub> | ---   |
| FTM1_CH6/EC1_RXD2/<br>GPIO3_10/SAI2_RX_DATA                                         | FTM 1 Channel 6              | AC4                | IO       | L1V <sub>DD</sub> | ---   |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                   | Signal description   | Package pin number | Pin type | Power supply      | Notes |
|--------------------------------------------------------------------------|----------------------|--------------------|----------|-------------------|-------|
| FTM1_CH7/ <b>EC1_TXD2</b> /<br>GPIO3_03/SAI2_TX_DATA                     | FTM 1 Channel 7      | AA5                | IO       | L1V <sub>DD</sub> | ---   |
| FTM1_EXTCLK/<br><b>EC1_GTX_CLK</b> /GPIO3_07/<br>EC1_TX_CLK/SAI2_TX_BCLK | FTM 1 External Clock | Y7                 | I        | L1V <sub>DD</sub> | 1     |
| FTM1_FAULT/ <b>EC1_TX_EN</b> /<br>GPIO3_06/SAI1_TX_BCLK                  | FTM 1 Fault          | W6                 | I        | L1V <sub>DD</sub> | 1     |
| FTM1_QD_PHA/<br><b>EC1_RX_CLK</b> /GPIO3_13/<br>SAI1_RX_BCLK             | FTM 1 QD Phase A     | AC3                | I        | L1V <sub>DD</sub> | 1     |
| FTM1_QD_PHB/ <b>EC1_RX_DV</b> /<br>GPIO3_14/SAI2_RX_BCLK                 | FTM 1 QD Phase B     | AC6                | I        | L1V <sub>DD</sub> | 1     |
| <b>FTM2</b>                                                              |                      |                    |          |                   |       |
| FTM2_CH0/ <b>EC2_RXD0</b> /<br>GPIO3_25/USB2_D0                          | FTM 2 Channel 0      | U2                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM2_CH1/ <b>EC2_RXD1</b> /<br>GPIO3_24/USB2_D1                          | FTM 2 Channel 1      | U1                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM2_CH2/ <b>EC2_TXD0</b> /<br>GPIO3_18/USB2_D4                          | FTM 2 Channel 2      | T3                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM2_CH3/ <b>EC2_TXD1</b> /<br>GPIO3_17/USB2_D5                          | FTM 2 Channel 3      | T4                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM2_CH4/ <b>EC2_RXD3</b> /<br>GPIO3_22/USB2_D3                          | FTM 2 Channel 4      | R2                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM2_CH5/ <b>EC2_TXD3</b> /<br>GPIO3_15/USB2_D7                          | FTM 2 Channel 5      | R4                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM2_CH6/ <b>EC2_RXD2</b> /<br>GPIO3_23/USB2_D2                          | FTM 2 Channel 6      | T1                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM2_CH7/ <b>EC2_TXD2</b> /<br>GPIO3_16/USB2_D6                          | FTM 2 Channel 7      | R3                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM2_EXTCLK/<br><b>EC2_GTX_CLK</b> /GPIO3_20/<br>EC2_TX_CLK/USB2_CLK     | FTM 2 External Clock | U3                 | I        | LV <sub>DD</sub>  | 1     |
| FTM2_FAULT/ <b>EC2_TX_EN</b> /<br>GPIO3_19/USB2_STP                      | FTM 2 Fault          | T5                 | I        | LV <sub>DD</sub>  | 1     |
| FTM2_QD_PHA/<br><b>EC2_RX_CLK</b> /GPIO3_26/<br>USB2_DIR                 | FTM 2 QD Phase A     | R1                 | I        | LV <sub>DD</sub>  | 1     |
| FTM2_QD_PHB/ <b>EC2_RX_DV</b> /<br>GPIO3_27/USB2_NXT                     | FTM 2 QD Phase B     | V1                 | I        | LV <sub>DD</sub>  | 1     |
| <b>FTM3</b>                                                              |                      |                    |          |                   |       |
| FTM3_CH0/ <b>EC3_GTX_CLK</b> /<br>GPIO4_01/EC2_TX_ER/<br>EC3_TX_CLK      | FTM 3 Channel 0      | V5                 | IO       | LV <sub>DD</sub>  | ---   |
| FTM3_CH1/ <b>EC3_TX_EN</b> /<br>GPIO4_00/EC1_TX_ER                       | FTM 3 Channel 1      | Y3                 | IO       | LV <sub>DD</sub>  | ---   |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                                   | Signal description   | Package pin number | Pin type | Power supply     | Notes |
|------------------------------------------------------------------------------------------|----------------------|--------------------|----------|------------------|-------|
| FTM3_CH2/ <b>EC3_RXD0</b> /<br>GPIO4_06/<br>TSEC_1588_TRIG_IN2/<br>EC2_CRS               | FTM 3 Channel 2      | AA1                | IO       | LV <sub>DD</sub> | ---   |
| FTM3_CH3/ <b>EC3_RXD1</b> /<br>GPIO4_05/<br>TSEC_1588_PULSE_OUT1                         | FTM 3 Channel 3      | Y2                 | IO       | LV <sub>DD</sub> | ---   |
| FTM3_CH4/ <b>EC3_TXD0</b> /<br>GPIO3_31/<br>TSEC_1588_PULSE_OUT2                         | FTM 3 Channel 4      | W4                 | IO       | LV <sub>DD</sub> | ---   |
| FTM3_CH5/ <b>EC3_TXD1</b> /<br>GPIO3_30/<br>TSEC_1588_CLK_OUT                            | FTM 3 Channel 5      | W3                 | IO       | LV <sub>DD</sub> | ---   |
| FTM3_CH6/ <b>EC3_TXD2</b> /<br>GPIO3_29/<br>TSEC_1588_ALARM_OUT1                         | FTM 3 Channel 6      | V4                 | IO       | LV <sub>DD</sub> | ---   |
| FTM3_CH7/ <b>EC3_TXD3</b> /<br>GPIO3_28/<br>TSEC_1588_ALARM_OUT2                         | FTM 3 Channel 7      | V3                 | IO       | LV <sub>DD</sub> | ---   |
| FTM3_EXTCLK/ <b>EC3_RXD2</b> /<br>GPIO4_04/EC1_COL                                       | FTM 3 External Clock | Y1                 | I        | LV <sub>DD</sub> | 1     |
| FTM3_FAULT/ <b>EC3_RXD3</b> /<br>GPIO4_03/EC1_CRS                                        | FTM 3 Fault          | W1                 | I        | LV <sub>DD</sub> | 1     |
| FTM3_QD_PHA/<br><b>EC3_RX_CLK</b> /GPIO4_07/<br>TSEC_1588_CLK_IN                         | FTM 3 QD Phase A     | V2                 | I        | LV <sub>DD</sub> | 1     |
| FTM3_QD_PHB/ <b>EC3_RX_DV</b> /<br>GPIO4_08/<br>TSEC_1588_TRIG_IN1                       | FTM 3 QD Phase B     | AA2                | I        | LV <sub>DD</sub> | 1     |
| <b>FTM4</b>                                                                              |                      |                    |          |                  |       |
| FTM4_CH0/ <b>TDMB_TXD</b> /<br>GPIO4_16/UC3_TXD7/<br>SPDIF_OUT/SAI4_TX_DATA              | FTM 4 Channel 0      | M3                 | IO       | DV <sub>DD</sub> | ---   |
| FTM4_CH1/ <b>TDMB_RSYNC</b> /<br>GPIO4_15/UC3_CTSB_RXDV/<br>SPDIF_PLOCK/<br>SAI4_TX_BCLK | FTM 4 Channel 1      | L3                 | IO       | DV <sub>DD</sub> | ---   |
| FTM4_CH2/ <b>TDMB_RXD</b> /<br>GPIO4_14/UC3_RXD7/<br>SPDIF_IN/SAI4_RX_DATA               | FTM 4 Channel 2      | K3                 | IO       | DV <sub>DD</sub> | ---   |
| FTM4_CH3/ <b>TDMA_RQ</b> /<br>GPIO4_13/UC1_CDB_RXER/<br>EXT_AUDIO_MCLK1                  | FTM 4 Channel 3      | H5                 | IO       | DV <sub>DD</sub> | ---   |
| FTM4_CH4/ <b>TDMA_TSYNC</b> /<br>GPIO4_12/UC1_RTSB_TXEN/<br>SAI3_TX_SYNC                 | FTM 4 Channel 4      | J5                 | IO       | DV <sub>DD</sub> | ---   |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                            | Signal description   | Package pin number | Pin type | Power supply     | Notes |
|-----------------------------------------------------------------------------------|----------------------|--------------------|----------|------------------|-------|
| FTM4_CH5/TDMA_TXD/<br>GPIO4_11/UC1_TXD7/<br>SAI3_TX_DATA                          | FTM 4 Channel 5      | J4                 | IO       | DV <sub>DD</sub> | ---   |
| FTM4_CH6/TDMA_RSYNC/<br>GPIO4_10/UC1_CTSB_RXDV/<br>SAI3_TX_BCLK                   | FTM 4 Channel 6      | J3                 | IO       | DV <sub>DD</sub> | ---   |
| FTM4_CH7/TDMA_RXD/<br>GPIO4_09/UC1_RXD7/<br>SAI3_RX_DATA                          | FTM 4 Channel 7      | H3                 | IO       | DV <sub>DD</sub> | ---   |
| FTM4_EXTCLK/TDMB_RQ/<br>GPIO4_18/UC3_CDB_RXER/<br>SPDIF_EXTCLK/<br>SAI4_RX_BCLK   | FTM 4 External Clock | K4                 | I        | DV <sub>DD</sub> | 1     |
| FTM4_FAULT/TDMB_TSYNC/<br>GPIO4_17/UC3_RTSB_TXEN/<br>SPDIF_SRCLK/<br>SAI4_TX_SYNC | FTM 4 Fault          | M4                 | I        | DV <sub>DD</sub> | 1     |
| FTM4_QD_PHA/CLK09/<br>GPIO4_19/BRGO2/<br>SAI3_RX_BCLK                             | FTM 4 QD Phase A     | K5                 | I        | DV <sub>DD</sub> | 1     |
| FTM4_QD_PHB/CLK10/<br>GPIO4_20/BRGO3/<br>SAI3_RX_SYNC                             | FTM 4 QD Phase B     | L5                 | I        | DV <sub>DD</sub> | 1     |
| <b>FTM5</b>                                                                       |                      |                    |          |                  |       |
| FTM5_CH0/IFC_A25/<br>GPIO2_25/QSPI_DIO_A3/<br>IFC_RB2_B/IFC_CS4_B                 | FTM 5 Channel 0      | D12                | IO       | BV <sub>DD</sub> | ---   |
| FTM5_CH1/IFC_A26/<br>GPIO2_26/IFC_RB3_B/<br>IFC_CS5_B                             | FTM 5 Channel 1      | C13                | IO       | BV <sub>DD</sub> | ---   |
| FTM5_EXTCLK/IFC_A27/<br>GPIO2_27/IFC_CS6_B                                        | FTM 5 External Clock | D13                | I        | BV <sub>DD</sub> | 1     |
| <b>FTM6</b>                                                                       |                      |                    |          |                  |       |
| FTM6_CH0/IFC_PAR0/<br>GPIO2_13/QSPI_DIO_B0                                        | FTM 6 Channel 0      | D15                | IO       | BV <sub>DD</sub> | ---   |
| FTM6_CH1/IFC_PAR1/<br>GPIO2_14/QSPI_DIO_B1                                        | FTM 6 Channel 1      | E13                | IO       | BV <sub>DD</sub> | ---   |
| FTM6_EXTCLK/IFC_PERR_B/<br>GPIO2_15/QSPI_DIO_B2                                   | FTM 6 External Clock | C15                | I        | BV <sub>DD</sub> | 1     |
| <b>FTM7</b>                                                                       |                      |                    |          |                  |       |
| FTM7_CH0/IFC_CS1_B/<br>GPIO2_10/SPI1_PCS0                                         | FTM 7 Channel 0      | D17                | IO       | BV <sub>DD</sub> | ---   |
| FTM7_CH1/IFC_CS2_B/<br>GPIO2_11/SPI1_SCK/<br>IIC3_SCL                             | FTM 7 Channel 1      | C18                | IO       | BV <sub>DD</sub> | ---   |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                           | Signal description                                 | Package pin number | Pin type | Power supply      | Notes |
|------------------------------------------------------------------|----------------------------------------------------|--------------------|----------|-------------------|-------|
| FTM7_EXTCLK/IFC_CS3_B/<br>GPIO2_12/QSPI_DIO_B3/<br>IIC3_SDA      | FTM7 External Clock                                | F18                | I        | BV <sub>DD</sub>  | 1     |
| <b>FTM8</b>                                                      |                                                    |                    |          |                   |       |
| FTM8_CH0/CLK11/GPIO4_21/<br>BRGO4/SAI4_RX_SYNC                   | FTM 8 Channel 0                                    | M5                 | IO       | DV <sub>DD</sub>  | ---   |
| FTM8_CH1/CLK12/GPIO4_22/<br>BRGO1                                | FTM 8 Channel 1                                    | N5                 | IO       | DV <sub>DD</sub>  | ---   |
| <b>SAI1</b>                                                      |                                                    |                    |          |                   |       |
| EXT_AUDIO_MCLK2/<br>EC1_GTX_CLK125/<br>GPIO3_08/EC1_RX_ER        | External Audio Clock (used for both SAI1 and SAI2) | AA4                | I        | L1V <sub>DD</sub> | 1     |
| SAI1_RX_BCLK/<br>EC1_RX_CLK/GPIO3_13/<br>FTM1_QD_PHA             | Receive Bit Clock                                  | AC3                | IO       | L1V <sub>DD</sub> | ---   |
| SAI1_RX_DATA/EC1_RXD3/<br>GPIO3_09/FTM1_CH4                      | Receive Data                                       | AB4                | I        | L1V <sub>DD</sub> | 1     |
| SAI1_RX_SYNC/EC1_RXD1/<br>GPIO3_11/FTM1_CH1                      | Receive Sync                                       | AC5                | IO       | L1V <sub>DD</sub> | ---   |
| SAI1_TX_BCLK/EC1_TX_EN/<br>GPIO3_06/FTM1_FAULT                   | Transmit Bit Clock                                 | W6                 | IO       | L1V <sub>DD</sub> | ---   |
| SAI1_TX_DATA/EC1_TXD3/<br>GPIO3_02/FTM1_CH5                      | Transmit Data                                      | W5                 | O        | L1V <sub>DD</sub> | 1     |
| SAI1_TX_SYNC/EC1_TXD1/<br>GPIO3_04/FTM1_CH3                      | Transmit Sync                                      | Y6                 | IO       | L1V <sub>DD</sub> | ---   |
| <b>SAI2</b>                                                      |                                                    |                    |          |                   |       |
| SAI2_RX_BCLK/EC1_RX_DV/<br>GPIO3_14/FTM1_QD_PHB                  | Receive Bit Clock                                  | AC6                | IO       | L1V <sub>DD</sub> | ---   |
| SAI2_RX_DATA/EC1_RXD2/<br>GPIO3_10/FTM1_CH6                      | Receive Data                                       | AC4                | I        | L1V <sub>DD</sub> | 1     |
| SAI2_RX_SYNC/EC1_RXD0/<br>GPIO3_12/FTM1_CH0                      | Receive Sync                                       | AB6                | IO       | L1V <sub>DD</sub> | ---   |
| SAI2_TX_BCLK/<br>EC1_GTX_CLK/GPIO3_07/<br>EC1_TX_CLK/FTM1_EXTCLK | Transmit Bit Clock                                 | Y7                 | IO       | L1V <sub>DD</sub> | ---   |
| SAI2_TX_DATA/EC1_TXD2/<br>GPIO3_03/FTM1_CH7                      | Transmit Data                                      | AA5                | O        | L1V <sub>DD</sub> | 1     |
| SAI2_TX_SYNC/EC1_TXD0/<br>GPIO3_05/FTM1_CH2                      | Transmit Sync                                      | AA6                | IO       | L1V <sub>DD</sub> | ---   |
| <b>SAI3</b>                                                      |                                                    |                    |          |                   |       |
| EXT_AUDIO_MCLK1/<br>TDMA_RQ/GPIO4_13/<br>UC1_CDB_RXER/FTM4_CH3   | External Audio Clock (used for both SAI3 and SAI4) | H5                 | I        | DV <sub>DD</sub>  | 1     |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                                    | Signal description | Package pin number | Pin type | Power supply     | Notes |
|-------------------------------------------------------------------------------------------|--------------------|--------------------|----------|------------------|-------|
| SAI3_RX_BCLK/ <b>CLK09</b> /<br>GPIO4_19/BRGO2/<br>FTM4_QD_PHA                            | Receive Bit Clock  | K5                 | IO       | DV <sub>DD</sub> | ---   |
| SAI3_RX_DATA/ <b>TDMA_RXD</b> /<br>GPIO4_09/UC1_RXD7/<br>FTM4_CH7                         | Receive Data       | H3                 | I        | DV <sub>DD</sub> | 1     |
| SAI3_RX_SYNC/ <b>CLK10</b> /<br>GPIO4_20/BRGO3/<br>FTM4_QD_PHB                            | Receive Sync       | L5                 | IO       | DV <sub>DD</sub> | ---   |
| SAI3_TX_BCLK/<br><b>TDMA_RSINC</b> /GPIO4_10/<br>UC1_CTSB_RXDV/<br>FTM4_CH6               | Transmit Bit Clock | J3                 | IO       | DV <sub>DD</sub> | ---   |
| SAI3_TX_DATA/ <b>TDMA_TXD</b> /<br>GPIO4_11/UC1_TXD7/<br>FTM4_CH5                         | Transmit Data      | J4                 | O        | DV <sub>DD</sub> | 1     |
| SAI3_TX_SYNC/<br><b>TDMA_TSYNC</b> /GPIO4_12/<br>UC1_RTSB_TXEN/FTM4_CH4                   | Transmit Sync      | J5                 | IO       | DV <sub>DD</sub> | ---   |
| <b>SAI4</b>                                                                               |                    |                    |          |                  |       |
| SAI4_RX_BCLK/ <b>TDMB_RQ</b> /<br>GPIO4_18/UC3_CDB_RXER/<br>SPDIF_EXTCLK/<br>FTM4_EXTCLK  | Receive Bit Clock  | K4                 | IO       | DV <sub>DD</sub> | ---   |
| SAI4_RX_DATA/ <b>TDMB_RXD</b> /<br>GPIO4_14/UC3_RXD7/<br>SPDIF_IN/FTM4_CH2                | Receive Data       | K3                 | I        | DV <sub>DD</sub> | 1     |
| SAI4_RX_SYNC/ <b>CLK11</b> /<br>GPIO4_21/BRGO4/<br>FTM8_CH0                               | Receive Sync       | M5                 | IO       | DV <sub>DD</sub> | ---   |
| SAI4_TX_BCLK/<br><b>TDMB_RSINC</b> /GPIO4_15/<br>UC3_CTSB_RXDV/<br>SPDIF_PLOCK/FTM4_CH1   | Transmit Bit Clock | L3                 | IO       | DV <sub>DD</sub> | ---   |
| SAI4_TX_DATA/ <b>TDMB_TXD</b> /<br>GPIO4_16/UC3_TXD7/<br>SPDIF_OUT/FTM4_CH0               | Transmit Data      | M3                 | O        | DV <sub>DD</sub> | 1     |
| SAI4_TX_SYNC/<br><b>TDMB_TSYNC</b> /GPIO4_17/<br>UC3_RTSB_TXEN/<br>SPDIF_SRCLK/FTM4_FAULT | Transmit Sync      | M4                 | IO       | DV <sub>DD</sub> | ---   |
| <b>MII1</b>                                                                               |                    |                    |          |                  |       |
| EC1_COL/ <b>EC3_RXD2</b> /<br>GPIO4_04/FTM3_EXTCLK                                        | Collision          | Y1                 | I        | LV <sub>DD</sub> | 1     |
| EC1_CRS/ <b>EC3_RXD3</b> /<br>GPIO4_03/FTM3_FAULT                                         | Carrier Sense      | W1                 | I        | LV <sub>DD</sub> | 1     |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                       | Signal description    | Package pin number | Pin type | Power supply      | Notes |
|------------------------------------------------------------------------------|-----------------------|--------------------|----------|-------------------|-------|
| EC1_RX_ER/<br><b>EC1_GTX_CLK125</b> /<br>GPIO3_08/<br>EXT_AUDIO_MCLK2        | Receive Error         | AA4                | I        | L1V <sub>DD</sub> | 1     |
| EC1_TX_CLK/<br><b>EC1_GTX_CLK</b> /GPIO3_07/<br>SAI2_TX_BCLK/<br>FTM1_EXTCLK | Transmit Clock        | Y7                 | I        | L1V <sub>DD</sub> | 1     |
| EC1_TX_ER/ <b>EC3_TX_EN</b> /<br>GPIO4_00/FTM3_CH1                           | Transmit Error        | Y3                 | O        | LV <sub>DD</sub>  | 1     |
| <b>MII2</b>                                                                  |                       |                    |          |                   |       |
| EC2_COL/<br><b>EC3_GTX_CLK125</b> /<br>GPIO4_02/USB2_DRVVBUS/<br>EC3_RX_ER   | Collision             | Y4                 | I        | LV <sub>DD</sub>  | 1     |
| EC2_CRS/ <b>EC3_RXD0</b> /<br>GPIO4_06/<br>TSEC_1588_TRIG_IN2/<br>FTM3_CH2   | Carrier Sense         | AA1                | I        | LV <sub>DD</sub>  | 1     |
| EC2_RX_ER/<br><b>EC2_GTX_CLK125</b> /<br>GPIO3_21/USB2_PWRFAULT              | Receive Error         | U5                 | I        | LV <sub>DD</sub>  | 1     |
| EC2_TX_CLK/<br><b>EC2_GTX_CLK</b> /GPIO3_20/<br>USB2_CLK/FTM2_EXTCLK         | Transmit Clock        | U3                 | I        | LV <sub>DD</sub>  | 1     |
| EC2_TX_ER/ <b>EC3_GTX_CLK</b> /<br>GPIO4_01/FTM3_CH0/<br>EC3_TX_CLK          | Transmit Error        | V5                 | O        | LV <sub>DD</sub>  | 1     |
| <b>RMII3</b>                                                                 |                       |                    |          |                   |       |
| EC3_RX_ER/<br><b>EC3_GTX_CLK125</b> /<br>GPIO4_02/EC2_COL/<br>USB2_DRVVBUS   | Reserved              | Y4                 | I        | LV <sub>DD</sub>  | 1     |
| EC3_TX_CLK/<br><b>EC3_GTX_CLK</b> /GPIO4_01/<br>EC2_TX_ER/FTM3_CH0           | Reserved              | V5                 | I        | LV <sub>DD</sub>  | 1     |
| <b>USB Host Port 1</b>                                                       |                       |                    |          |                   |       |
| USB1_DRVVBUS/<br><b>SDHC_DAT6</b> /GPIO4_25/<br>SDHC_DAT0_DIR                | USB1 5V Supply Enable | J2                 | O        | DV <sub>DD</sub>  | 1     |
| USB1_PWRFAULT/<br><b>SDHC_DAT7</b> /GPIO4_26/<br>SDHC_DAT123_DIR             | USB1 Power Fault      | J1                 | I        | DV <sub>DD</sub>  | 1     |
| <b>USB Host Port 2</b>                                                       |                       |                    |          |                   |       |
| USB2_CLK/ <b>EC2_GTX_CLK</b> /<br>GPIO3_20/EC2_TX_CLK/<br>FTM2_EXTCLK        | USB2 Clock            | U3                 | I        | LV <sub>DD</sub>  | 1     |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                    | Signal description    | Package pin number | Pin type | Power supply     | Notes |
|---------------------------------------------------------------------------|-----------------------|--------------------|----------|------------------|-------|
| USB2_D0/ <b>EC2_RXD0</b> /<br>GPIO3_25/FTM2_CH0                           | Data                  | U2                 | IO       | LV <sub>DD</sub> | ---   |
| USB2_D1/ <b>EC2_RXD1</b> /<br>GPIO3_24/FTM2_CH1                           | Data                  | U1                 | IO       | LV <sub>DD</sub> | ---   |
| USB2_D2/ <b>EC2_RXD2</b> /<br>GPIO3_23/FTM2_CH6                           | Data                  | T1                 | IO       | LV <sub>DD</sub> | ---   |
| USB2_D3/ <b>EC2_RXD3</b> /<br>GPIO3_22/FTM2_CH4                           | Data                  | R2                 | IO       | LV <sub>DD</sub> | ---   |
| USB2_D4/ <b>EC2_TXD0</b> /<br>GPIO3_18/FTM2_CH2                           | Data                  | T3                 | IO       | LV <sub>DD</sub> | ---   |
| USB2_D5/ <b>EC2_TXD1</b> /<br>GPIO3_17/FTM2_CH3                           | Data                  | T4                 | IO       | LV <sub>DD</sub> | ---   |
| USB2_D6/ <b>EC2_TXD2</b> /<br>GPIO3_16/FTM2_CH7                           | Data                  | R3                 | IO       | LV <sub>DD</sub> | ---   |
| USB2_D7/ <b>EC2_TXD3</b> /<br>GPIO3_15/FTM2_CH5                           | Data                  | R4                 | IO       | LV <sub>DD</sub> | ---   |
| USB2_DIR/ <b>EC2_RX_CLK</b> /<br>GPIO3_26/FTM2_QD_PHA                     | USB2 Direction        | R1                 | I        | LV <sub>DD</sub> | 1     |
| USB2_DRVBUS/<br><b>EC3_GTX_CLK125</b> /<br>GPIO4_02/EC2_COL/<br>EC3_RX_ER | USB2 5V Supply Enable | Y4                 | O        | LV <sub>DD</sub> | 1     |
| USB2_NXT/ <b>EC2_RX_DV</b> /<br>GPIO3_27/FTM2_QD_PHB                      | USB2 Next             | V1                 | I        | LV <sub>DD</sub> | 1     |
| USB2_PWRFAULT/<br><b>EC2_GTX_CLK125</b> /<br>GPIO3_21/EC2_RX_ER           | USB2 Power Fault      | U5                 | I        | LV <sub>DD</sub> | 1     |
| USB2_STP/ <b>EC2_TX_EN</b> /<br>GPIO3_19/FTM2_FAULT                       | USB2 Stop             | T5                 | O        | LV <sub>DD</sub> | 1     |
| <b>IEEE1588</b>                                                           |                       |                    |          |                  |       |
| TSEC_1588_ALARM_OUT1/<br><b>EC3_TXD2</b> /GPIO3_29/<br>FTM3_CH6           | Alarm Out 1           | V4                 | O        | LV <sub>DD</sub> | 1     |
| TSEC_1588_ALARM_OUT2/<br><b>EC3_TXD3</b> /GPIO3_28/<br>FTM3_CH7           | Alarm Out 2           | V3                 | O        | LV <sub>DD</sub> | 1     |
| TSEC_1588_CLK_IN/<br><b>EC3_RX_CLK</b> /GPIO4_07/<br>FTM3_QD_PHA          | Clock In              | V2                 | I        | LV <sub>DD</sub> | 1     |
| TSEC_1588_CLK_OUT/<br><b>EC3_TXD1</b> /GPIO3_30/<br>FTM3_CH5              | Clock Out             | W3                 | O        | LV <sub>DD</sub> | 1     |
| TSEC_1588_PULSE_OUT1/<br><b>EC3_RXD1</b> /GPIO4_05/<br>FTM3_CH3           | Pulse Out 1           | Y2                 | O        | LV <sub>DD</sub> | 1     |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                                | Signal description | Package pin number | Pin type | Power supply     | Notes |
|---------------------------------------------------------------------------------------|--------------------|--------------------|----------|------------------|-------|
| TSEC_1588_PULSE_OUT2/<br>EC3_TXD0/GPIO3_31/<br>FTM3_CH4                               | Pulse Out 2        | W4                 | O        | LV <sub>DD</sub> | 1     |
| TSEC_1588_TRIG_IN1/<br>EC3_RX_DV/GPIO4_08/<br>FTM3_QD_PHB                             | Trigger In 1       | AA2                | I        | LV <sub>DD</sub> | 1     |
| TSEC_1588_TRIG_IN2/<br>EC3_RXD0/GPIO4_06/<br>EC2_CRS/FTM3_CH2                         | Trigger In 2       | AA1                | I        | LV <sub>DD</sub> | 1     |
| <b>BRGO</b>                                                                           |                    |                    |          |                  |       |
| BRGO1/CLK12/GPIO4_22/<br>FTM8_CH1                                                     | BRGO               | N5                 | O        | DV <sub>DD</sub> | 1     |
| BRGO2/CLK09/GPIO4_19/<br>SAI3_RX_BCLK/<br>FTM4_QD_PHA                                 | BRGO               | K5                 | O        | DV <sub>DD</sub> | 1     |
| BRGO3/CLK10/GPIO4_20/<br>SAI3_RX_SYNC/<br>FTM4_QD_PHB                                 | BRGO               | L5                 | O        | DV <sub>DD</sub> | 1     |
| BRGO4/CLK11/GPIO4_21/<br>SAI4_RX_SYNC/FTM8_CH0                                        | BRGO               | M5                 | O        | DV <sub>DD</sub> | 1     |
| <b>SPDIF</b>                                                                          |                    |                    |          |                  |       |
| SPDIF_EXTCLK/TDMB_RQ/<br>GPIO4_18/UC3_CDB_RXER/<br>SAI4_RX_BCLK/<br>FTM4_EXTCLK       | External Clock     | K4                 | I        | DV <sub>DD</sub> | 1     |
| SPDIF_IN/TDMB_RXD/<br>GPIO4_14/UC3_RXD7/<br>SAI4_RX_DATA/FTM4_CH2                     | SPDIF Input Line   | K3                 | I        | DV <sub>DD</sub> | 1     |
| SPDIF_OUT/TDMB_TXD/<br>GPIO4_16/UC3_TXD7/<br>SAI4_TX_DATA/FTM4_CH0                    | SPDIF Output Line  | M3                 | O        | DV <sub>DD</sub> | 1     |
| SPDIF_PLOCK/<br>TDMB_RSYNC/GPIO4_15/<br>UC3_CTSB_RXDV/<br>SAI4_TX_BCLK/FTM4_CH1       | P Lock             | L3                 | O        | DV <sub>DD</sub> | 1     |
| SPDIF_SRCLK/<br>TDMB_TSYNC/GPIO4_17/<br>UC3_RTSB_TXEN/<br>SAI4_TX_SYNC/<br>FTM4_FAULT | SR Clock           | M4                 | O        | DV <sub>DD</sub> | 1     |
| <b>SPI Interface</b>                                                                  |                    |                    |          |                  |       |
| SPI1_PCS0/IFC_CS1_B/<br>GPIO2_10/FTM7_CH0                                             | Chip Select 0      | D17                | IO       | BV <sub>DD</sub> | ---   |
| SPI1_PCS1/IFC_AD08/<br>cfg_rcw_src0                                                   | Chip Select 1      | B12                | O        | BV <sub>DD</sub> | 1, 4  |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal                                                                           | Signal description | Package pin number | Pin type | Power supply      | Notes |
|----------------------------------------------------------------------------------|--------------------|--------------------|----------|-------------------|-------|
| SPI1_PCS2/IFC_AD09/<br>cfg_rcw_src1                                              | Chip Select 2      | A12                | O        | BV <sub>DD</sub>  | 1, 4  |
| SPI1_PCS3/IFC_AD10/<br>cfg_rcw_src2                                              | Chip Select 3      | A13                | O        | BV <sub>DD</sub>  | 1, 4  |
| SPI1_PCS4/IFC_AD11/<br>cfg_rcw_src3                                              | Chip Select 4      | B14                | O        | BV <sub>DD</sub>  | 1, 4  |
| SPI1_PCS5/IFC_AD12/<br>cfg_rcw_src4                                              | Chip Select 5      | A14                | O        | BV <sub>DD</sub>  | 1, 4  |
| SPI1_SCK/IFC_CS2_B/<br>GPIO2_11/FTM7_CH1/<br>IIC3_SCL                            | SPI Clock          | C18                | IO       | BV <sub>DD</sub>  | ---   |
| SPI1_SIN/IFC_RB1_B                                                               | Serial Input       | F15                | I        | BV <sub>DD</sub>  | ---   |
| SPI1_SOUT/IFC_AD13/<br>cfg_rcw_src5                                              | Serial Output      | B15                | O        | BV <sub>DD</sub>  | 1, 4  |
| SPI2_PCS0/UART2_SOUT/<br>GPIO1_16/LPUART1_SOUT                                   | Chip Select 0      | P1                 | IO       | D1V <sub>DD</sub> | ---   |
| SPI2_PCS1/UART2_SIN/<br>GPIO1_18/LPUART1_SIN                                     | Chip Select 1      | P2                 | O        | D1V <sub>DD</sub> | 1     |
| SPI2_PCS2/UART2_RTS_B/<br>GPIO1_20/UART4_SOUT/<br>LPUART1_RTS_B/<br>LPUART4_SOUT | Chip Select 2      | P3                 | O        | D1V <sub>DD</sub> | 1     |
| SPI2_PCS3/IIC2_SCL/<br>GPIO4_27/SDHC_CD_B                                        | Chip Select 3      | K1                 | O        | DV <sub>DD</sub>  | 1     |
| SPI2_PCS4/IIC2_SDA/<br>GPIO4_28/SDHC_WP                                          | Chip Select 4      | L1                 | O        | DV <sub>DD</sub>  | 1     |
| SPI2_PCS5/IRQ5/GPIO1_25/<br>SDHC_CLK_SYNC_IN                                     | Chip Select 5      | M2                 | O        | DV <sub>DD</sub>  | 1     |
| SPI2_SCK/UART2_CTS_B/<br>GPIO1_22/UART4_SIN/<br>LPUART1_CTS_B/<br>LPUART4_SIN    | SPI Clock          | P5                 | IO       | D1V <sub>DD</sub> | ---   |
| SPI2_SIN/UART1_CTS_B/<br>GPIO1_21/UART3_SIN/<br>LPUART2_SIN                      | Serial Input       | N4                 | I        | DV <sub>DD</sub>  | 1     |
| SPI2_SOUT/UART1_RTS_B/<br>GPIO1_19/UART3_SOUT/<br>LPUART2_SOUT                   | Serial Output      | N3                 | O        | DV <sub>DD</sub>  | 1     |
| <b>Power and Ground Signals</b>                                                  |                    |                    |          |                   |       |
| GND001                                                                           | GND                | A3                 | ---      | ---               | ---   |
| GND002                                                                           | GND                | A5                 | ---      | ---               | ---   |
| GND003                                                                           | GND                | A18                | ---      | ---               | ---   |
| GND004                                                                           | GND                | A22                | ---      | ---               | ---   |
| GND005                                                                           | GND                | B1                 | ---      | ---               | ---   |

Table continues on the next page...

**Table 1. Pinout list by bus (continued)**

| Signal | Signal description | Package pin number | Pin type | Power supply | Notes |
|--------|--------------------|--------------------|----------|--------------|-------|
| GND006 | GND                | B3                 | ---      | ---          | ---   |
| GND007 | GND                | B5                 | ---      | ---          | ---   |
| GND008 | GND                | B7                 | ---      | ---          | ---   |
| GND009 | GND                | B10                | ---      | ---          | ---   |
| GND010 | GND                | B13                | ---      | ---          | ---   |
| GND011 | GND                | B16                | ---      | ---          | ---   |
| GND012 | GND                | B18                | ---      | ---          | ---   |
| GND013 | GND                | B20                | ---      | ---          | ---   |
| GND014 | GND                | C2                 | ---      | ---          | ---   |
| GND015 | GND                | C4                 | ---      | ---          | ---   |
| GND016 | GND                | C19                | ---      | ---          | ---   |
| GND017 | GND                | C22                | ---      | ---          | ---   |
| GND018 | GND                | D2                 | ---      | ---          | ---   |
| GND019 | GND                | D6                 | ---      | ---          | ---   |
| GND020 | GND                | D18                | ---      | ---          | ---   |
| GND021 | GND                | D20                | ---      | ---          | ---   |
| GND022 | GND                | E4                 | ---      | ---          | ---   |
| GND023 | GND                | E9                 | ---      | ---          | ---   |
| GND024 | GND                | E12                | ---      | ---          | ---   |
| GND025 | GND                | E15                | ---      | ---          | ---   |
| GND026 | GND                | E19                | ---      | ---          | ---   |
| GND027 | GND                | E22                | ---      | ---          | ---   |
| GND028 | GND                | F17                | ---      | ---          | ---   |
| GND029 | GND                | F20                | ---      | ---          | ---   |
| GND030 | GND                | G2                 | ---      | ---          | ---   |
| GND031 | GND                | G7                 | ---      | ---          | ---   |
| GND032 | GND                | G19                | ---      | ---          | ---   |
| GND033 | GND                | G22                | ---      | ---          | ---   |
| GND034 | GND                | H4                 | ---      | ---          | ---   |
| GND035 | GND                | H6                 | ---      | ---          | ---   |
| GND036 | GND                | H8                 | ---      | ---          | ---   |
| GND037 | GND                | H9                 | ---      | ---          | ---   |
| GND038 | GND                | H10                | ---      | ---          | ---   |
| GND039 | GND                | H11                | ---      | ---          | ---   |
| GND040 | GND                | H12                | ---      | ---          | ---   |
| GND041 | GND                | H13                | ---      | ---          | ---   |
| GND042 | GND                | H14                | ---      | ---          | ---   |
| GND043 | GND                | H15                | ---      | ---          | ---   |

*Table continues on the next page...*

**Table 1. Pinout list by bus (continued)**

| Signal | Signal description | Package pin number | Pin type | Power supply | Notes |
|--------|--------------------|--------------------|----------|--------------|-------|
| GND044 | GND                | H17                | ---      | ---          | ---   |
| GND045 | GND                | H20                | ---      | ---          | ---   |
| GND046 | GND                | J16                | ---      | ---          | ---   |
| GND047 | GND                | J18                | ---      | ---          | ---   |
| GND048 | GND                | J19                | ---      | ---          | ---   |
| GND049 | GND                | J22                | ---      | ---          | ---   |
| GND050 | GND                | K2                 | ---      | ---          | ---   |
| GND051 | GND                | K7                 | ---      | ---          | ---   |
| GND052 | GND                | K9                 | ---      | ---          | ---   |
| GND053 | GND                | K10                | ---      | ---          | ---   |
| GND054 | GND                | K13                | ---      | ---          | ---   |
| GND055 | GND                | K16                | ---      | ---          | ---   |
| GND056 | GND                | K18                | ---      | ---          | ---   |
| GND057 | GND                | K20                | ---      | ---          | ---   |
| GND058 | GND                | L4                 | ---      | ---          | ---   |
| GND059 | GND                | L7                 | ---      | ---          | ---   |
| GND060 | GND                | L10                | ---      | ---          | ---   |
| GND061 | GND                | L12                | ---      | ---          | ---   |
| GND062 | GND                | L14                | ---      | ---          | ---   |
| GND063 | GND                | L16                | ---      | ---          | ---   |
| GND064 | GND                | L18                | ---      | ---          | ---   |
| GND065 | GND                | L22                | ---      | ---          | ---   |
| GND066 | GND                | M7                 | ---      | ---          | ---   |
| GND067 | GND                | M9                 | ---      | ---          | ---   |
| GND068 | GND                | M11                | ---      | ---          | ---   |
| GND069 | GND                | M13                | ---      | ---          | ---   |
| GND070 | GND                | M16                | ---      | ---          | ---   |
| GND071 | GND                | M17                | ---      | ---          | ---   |
| GND072 | GND                | M18                | ---      | ---          | ---   |
| GND073 | GND                | M21                | ---      | ---          | ---   |
| GND074 | GND                | N2                 | ---      | ---          | ---   |
| GND075 | GND                | N7                 | ---      | ---          | ---   |
| GND076 | GND                | N10                | ---      | ---          | ---   |
| GND077 | GND                | N12                | ---      | ---          | ---   |
| GND078 | GND                | N14                | ---      | ---          | ---   |
| GND079 | GND                | N16                | ---      | ---          | ---   |
| GND080 | GND                | N18                | ---      | ---          | ---   |
| GND081 | GND                | P4                 | ---      | ---          | ---   |

*Table continues on the next page...*

Table 1. Pinout list by bus (continued)

| Signal  | Signal description      | Package pin number | Pin type | Power supply | Notes |
|---------|-------------------------|--------------------|----------|--------------|-------|
| GND082  | GND                     | P7                 | ---      | ---          | ---   |
| GND083  | GND                     | P9                 | ---      | ---          | ---   |
| GND084  | GND                     | P11                | ---      | ---          | ---   |
| GND085  | GND                     | P13                | ---      | ---          | ---   |
| GND086  | GND                     | P16                | ---      | ---          | ---   |
| GND087  | GND                     | P18                | ---      | ---          | ---   |
| GND088  | GND                     | P20                | ---      | ---          | ---   |
| GND089  | GND                     | P22                | ---      | ---          | ---   |
| GND090  | GND                     | R7                 | ---      | ---          | ---   |
| GND091  | GND                     | R10                | ---      | ---          | ---   |
| GND092  | GND                     | R14                | ---      | ---          | ---   |
| GND093  | GND                     | R16                | ---      | ---          | ---   |
| GND094  | GND                     | R17                | ---      | ---          | ---   |
| GND095  | GND                     | T2                 | ---      | ---          | ---   |
| GND096  | GND                     | T7                 | ---      | ---          | ---   |
| GND097  | GND                     | T16                | ---      | ---          | ---   |
| GND098  | GND                     | T22                | ---      | ---          | ---   |
| GND099  | GND                     | U4                 | ---      | ---          | ---   |
| GND100  | GND                     | U8                 | ---      | ---          | ---   |
| GND101  | GND                     | U23                | ---      | ---          | ---   |
| GND102  | GND                     | V6                 | ---      | ---          | ---   |
| GND103  | GND                     | W2                 | ---      | ---          | ---   |
| GND104  | GND                     | Y5                 | ---      | ---          | ---   |
| GND105  | GND                     | Y17                | ---      | ---          | ---   |
| GND106  | GND                     | AA3                | ---      | ---          | ---   |
| GND107  | GND                     | AB1                | ---      | ---          | ---   |
| GND108  | GND                     | AB5                | ---      | ---          | ---   |
| GND109  | GND                     | AC2                | ---      | ---          | ---   |
| X1GND01 | Serdes1 transceiver GND | V10                | ---      | ---          | ---   |
| X1GND02 | Serdes1 transceiver GND | V11                | ---      | ---          | ---   |
| X1GND03 | Serdes1 transceiver GND | V13                | ---      | ---          | ---   |
| X1GND04 | Serdes1 transceiver GND | V14                | ---      | ---          | ---   |
| X1GND05 | Serdes1 transceiver GND | W9                 | ---      | ---          | ---   |
| X1GND06 | Serdes1 transceiver GND | W12                | ---      | ---          | ---   |
| X1GND07 | Serdes1 transceiver GND | W15                | ---      | ---          | ---   |
| X1GND08 | Serdes1 transceiver GND | Y9                 | ---      | ---          | ---   |
| X1GND09 | Serdes1 transceiver GND | Y12                | ---      | ---          | ---   |
| X1GND10 | Serdes1 transceiver GND | Y15                | ---      | ---          | ---   |

Table continues on the next page...

**Table 1. Pinout list by bus (continued)**

| Signal        | Signal description                    | Package pin number | Pin type | Power supply      | Notes |
|---------------|---------------------------------------|--------------------|----------|-------------------|-------|
| S1GND01       | Serdes core logic GND                 | T9                 | ---      | ---               | ---   |
| S1GND02       | Serdes core logic GND                 | T11                | ---      | ---               | ---   |
| S1GND03       | Serdes core logic GND                 | T12                | ---      | ---               | ---   |
| S1GND04       | Serdes core logic GND                 | T13                | ---      | ---               | ---   |
| S1GND05       | Serdes core logic GND                 | T15                | ---      | ---               | ---   |
| S1GND06       | Serdes core logic GND                 | U12                | ---      | ---               | ---   |
| S1GND07       | Serdes core logic GND                 | AA7                | ---      | ---               | ---   |
| S1GND08       | Serdes core logic GND                 | AA8                | ---      | ---               | ---   |
| S1GND09       | Serdes core logic GND                 | AA9                | ---      | ---               | ---   |
| S1GND10       | Serdes core logic GND                 | AA10               | ---      | ---               | ---   |
| S1GND11       | Serdes core logic GND                 | AA11               | ---      | ---               | ---   |
| S1GND12       | Serdes core logic GND                 | AA12               | ---      | ---               | ---   |
| S1GND13       | Serdes core logic GND                 | AA13               | ---      | ---               | ---   |
| S1GND14       | Serdes core logic GND                 | AA14               | ---      | ---               | ---   |
| S1GND15       | Serdes core logic GND                 | AA15               | ---      | ---               | ---   |
| S1GND16       | Serdes core logic GND                 | AA16               | ---      | ---               | ---   |
| S1GND17       | Serdes core logic GND                 | AA17               | ---      | ---               | ---   |
| S1GND18       | Serdes core logic GND                 | AB7                | ---      | ---               | ---   |
| S1GND19       | Serdes core logic GND                 | AB9                | ---      | ---               | ---   |
| S1GND20       | Serdes core logic GND                 | AB12               | ---      | ---               | ---   |
| S1GND21       | Serdes core logic GND                 | AB15               | ---      | ---               | ---   |
| S1GND22       | Serdes core logic GND                 | AB17               | ---      | ---               | ---   |
| S1GND23       | Serdes core logic GND                 | AC7                | ---      | ---               | ---   |
| S1GND24       | Serdes core logic GND                 | AC9                | ---      | ---               | ---   |
| S1GND25       | Serdes core logic GND                 | AC12               | ---      | ---               | ---   |
| S1GND26       | Serdes core logic GND                 | AC15               | ---      | ---               | ---   |
| S1GND27       | Serdes core logic GND                 | AC17               | ---      | ---               | ---   |
| AGND_SD1_PLL1 | Serdes1 PLL 1 GND                     | U10                | ---      | ---               | ---   |
| AGND_SD1_PLL2 | Serdes1 PLL 2 GND                     | U13                | ---      | ---               | ---   |
| SENSEGND      | GND Sense pin                         | G16                | ---      | ---               | ---   |
| SENSEGNDC     | GND Sense pin for VDDC domain         | U7                 | ---      | ---               | ---   |
| O1VDD1        | General I/O supply - always on        | J10                | ---      | O1V <sub>DD</sub> | ---   |
| O1VDD2        | General I/O supply - always on        | J11                | ---      | O1V <sub>DD</sub> | ---   |
| OVDD          | General I/O supply - switchable       | J12                | ---      | OV <sub>DD</sub>  | ---   |
| BVDD1         | IFC/QSPI/SPI1 I/O supply - switchable | J13                | ---      | BV <sub>DD</sub>  | ---   |
| BVDD2         | IFC/QSPI/SPI1 I/O supply - switchable | J14                | ---      | BV <sub>DD</sub>  | ---   |

Table continues on the next page...

**Table 1. Pinout list by bus (continued)**

| Signal  | Signal description                            | Package pin number | Pin type | Power supply      | Notes |
|---------|-----------------------------------------------|--------------------|----------|-------------------|-------|
| BVDD3   | IFC/QSPI/SPI1 I/O supply - switchable         | J15                | ---      | BV <sub>DD</sub>  | ---   |
| D1VDD   | UART/I2C supply - always on                   | M8                 | ---      | D1V <sub>DD</sub> | ---   |
| DVDD1   | UART/I2C/QE supply - switchable               | L8                 | ---      | DV <sub>DD</sub>  | ---   |
| DVDD2   | UART/I2C/QE supply - switchable               | L9                 | ---      | DV <sub>DD</sub>  | ---   |
| EVDD    | eSDHC supply - switchable                     | K8                 | ---      | EV <sub>DD</sub>  | ---   |
| L1VDD1  | Ethernet controller 1 supply - always on      | R8                 | ---      | L1V <sub>DD</sub> | ---   |
| L1VDD2  | Ethernet controller 1 supply - always on      | T8                 | ---      | L1V <sub>DD</sub> | ---   |
| LVDD1   | Ethernet controller 2 & 3 supply - switchable | N8                 | ---      | LV <sub>DD</sub>  | ---   |
| LVDD2   | Ethernet controller 2 & 3 supply - switchable | P8                 | ---      | LV <sub>DD</sub>  | ---   |
| G1VDD01 | DDR supply - switchable                       | K15                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD02 | DDR supply - switchable                       | L15                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD03 | DDR supply - switchable                       | M15                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD04 | DDR supply - switchable                       | N15                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD05 | DDR supply - switchable                       | P15                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD06 | DDR supply - switchable                       | P17                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD07 | DDR supply - switchable                       | P19                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD08 | DDR supply - switchable                       | R15                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD09 | DDR supply - switchable                       | R21                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD10 | DDR supply - switchable                       | T17                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD11 | DDR supply - switchable                       | T19                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD12 | DDR supply - switchable                       | V18                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD13 | DDR supply - switchable                       | V20                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD14 | DDR supply - switchable                       | V22                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD15 | DDR supply - switchable                       | Y18                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD16 | DDR supply - switchable                       | Y20                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD17 | DDR supply - switchable                       | Y22                | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD18 | DDR supply - switchable                       | AB18               | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD19 | DDR supply - switchable                       | AB20               | ---      | G1V <sub>DD</sub> | ---   |
| G1VDD20 | DDR supply - switchable                       | AB22               | ---      | G1V <sub>DD</sub> | ---   |
| S1VDD1  | SerDes1 core logic supply                     | R11                | ---      | S1V <sub>DD</sub> | ---   |
| S1VDD2  | SerDes1 core logic supply                     | R12                | ---      | S1V <sub>DD</sub> | ---   |
| S1VDD3  | SerDes1 core logic supply                     | R13                | ---      | S1V <sub>DD</sub> | ---   |
| X1VDD1  | SerDes1 transceiver supply                    | V9                 | ---      | X1V <sub>DD</sub> | ---   |

*Table continues on the next page...*

**Table 1. Pinout list by bus (continued)**

| Signal                    | Signal description                     | Package pin number | Pin type | Power supply           | Notes |
|---------------------------|----------------------------------------|--------------------|----------|------------------------|-------|
| X1VDD2                    | SerDes1 transceiver supply             | V12                | ---      | X1V <sub>DD</sub>      | ---   |
| X1VDD3                    | SerDes1 transceiver supply             | V15                | ---      | X1V <sub>DD</sub>      | ---   |
| X1VDD4                    | SerDes1 transceiver supply             | Y8                 | ---      | X1V <sub>DD</sub>      | ---   |
| FA_VL                     | Reserved                               | G12                | ---      | FA_VL                  | 14    |
| PROG_MTR                  | Reserved                               | F10                | ---      | PROG_MTR               | 14    |
| TA_PROG_SFP               | SFP Fuse Programming                   | F11                | ---      | TA_PROG_SFP            | 20    |
| TH_VDD                    | Thermal monitor unit supply            | G15                | ---      | TH_V <sub>DD</sub>     | 23    |
| VDD01                     | Supply for cores and platform          | K12                | ---      | V <sub>DD</sub>        | ---   |
| VDD02                     | Supply for cores and platform          | K14                | ---      | V <sub>DD</sub>        | ---   |
| VDD03                     | Supply for cores and platform          | L11                | ---      | V <sub>DD</sub>        | ---   |
| VDD04                     | Supply for cores and platform          | L13                | ---      | V <sub>DD</sub>        | ---   |
| VDD05                     | Supply for cores and platform          | M12                | ---      | V <sub>DD</sub>        | ---   |
| VDD06                     | Supply for cores and platform          | M14                | ---      | V <sub>DD</sub>        | ---   |
| VDD07                     | Supply for cores and platform          | N9                 | ---      | V <sub>DD</sub>        | ---   |
| VDD08                     | Supply for cores and platform          | N11                | ---      | V <sub>DD</sub>        | ---   |
| VDD09                     | Supply for cores and platform          | N13                | ---      | V <sub>DD</sub>        | ---   |
| VDD10                     | Supply for cores and platform          | P12                | ---      | V <sub>DD</sub>        | ---   |
| VDD11                     | Supply for cores and platform          | P14                | ---      | V <sub>DD</sub>        | ---   |
| VDDC1                     | Always ON supply                       | K11                | ---      | V <sub>DD</sub> C      | ---   |
| VDDC2                     | Always ON supply                       | M10                | ---      | V <sub>DD</sub> C      | ---   |
| VDDC3                     | Always ON supply                       | P10                | ---      | V <sub>DD</sub> C      | ---   |
| VDDC4                     | Always ON supply                       | R9                 | ---      | V <sub>DD</sub> C      | ---   |
| TA_BB_VDD                 | Battery Backed Security Monitor Supply | T6                 | ---      | TA_BB_V <sub>DD</sub>  | ---   |
| AVDD_CGA1                 | CPU Cluster Group A PLL1 supply        | G11                | ---      | AVDD_CGA1              | ---   |
| AVDD_PLAT                 | Platform PLL supply                    | G10                | ---      | AVDD_PLAT              | ---   |
| AVDD_D1                   | DDR1 PLL supply                        | K17                | ---      | AVDD_D1                | ---   |
| AVDD_SD1_PLL1             | SerDes1 PLL 1 supply                   | U11                | ---      | AVDD_SD1_PLL1          | ---   |
| AVDD_SD1_PLL2             | SerDes1 PLL 2 supply                   | U14                | ---      | AVDD_SD1_PLL2          | ---   |
| SENSEVDD                  | Vdd Sense pin                          | H16                | ---      | SENSEVDD               | ---   |
| SENSEVDDC                 | Vddc Sense pin                         | V8                 | ---      | SENSEVDDC              | ---   |
| USB_HVDD                  | 3.3V High Supply                       | D4                 | ---      | USB_HV <sub>DD</sub>   | ---   |
| USB1_SDVDD                | Analog and digital HS supply           | H7                 | ---      | USB1_SDV <sub>DD</sub> | ---   |
| USB1_SPVDD                | Analog and digital SS supply           | J9                 | ---      | USB1_SPV <sub>DD</sub> | ---   |
| USB1_SXVDD                | Transmit supply                        | J8                 | ---      | USB1_SXV <sub>DD</sub> | ---   |
| <b>No Connection Pins</b> |                                        |                    |          |                        |       |
| NC_F19                    | No Connection                          | F19                | ---      | ---                    | 12    |
| NC_G18                    | No Connection                          | G18                | ---      | ---                    | 12    |

Table continues on the next page...

Table 1. Pinout list by bus (continued)

| Signal        | Signal description | Package pin number | Pin type | Power supply | Notes |
|---------------|--------------------|--------------------|----------|--------------|-------|
| NC_H19        | No Connection      | H19                | ---      | ---          | 12    |
| NC_J17        | No Connection      | J17                | ---      | ---          | 12    |
| NC_L6         | No Connection      | L6                 | ---      | ---          | 12    |
| NC_M6         | No Connection      | M6                 | ---      | ---          | 12    |
| NC_U16        | No Connection      | U16                | ---      | ---          | 12    |
| NC_V7         | No Connection      | V7                 | ---      | ---          | 12    |
| NC_V16        | No Connection      | V16                | ---      | ---          | 12    |
| NC_W16        | No Connection      | W16                | ---      | ---          | 12    |
| NC_W17        | No Connection      | W17                | ---      | ---          | 12    |
| NC_DET        | No Connection      | AB23               | ---      | ---          | 12    |
| Reserved Pins |                    |                    |          |              |       |
| SPARE1        | ---                | G14                | ---      | ---          | 17    |
| SPARE2        | ---                | F13                | ---      | ---          | 17    |

1. Functionally, this pin is an output or an input, but structurally it is an I / O because it either sample configuration input during reset, is a muxed pin, or has other manufacturing test functions. This pin will therefore be described as an I / O for boundary scan.

2. This output is actively driven during reset rather than being tri-stated during reset.

3. MDIC[0] is grounded through an 162Ω precision 1% resistor and MDIC[1] is connected to  $GV_{DD}$  through an 162Ω precision 1% resistor. For either full or half driver strength calibration of DDR IOs, use the same MDIC resistor value of 162Ω. Memory controller register setting can be used to determine automatic calibration is done to full or half drive strength. These pins are used for automatic calibration of the DDR3L/DDR4 IOs. The MDIC[0:1] pins must be connected to 162Ω precision 1% resistors.

4. This pin is a reset configuration pin. It has a weak (~20 kΩ) internal pull-up P-FET that is enabled only when the processor is in its reset state. The internal pull-up resistor value for applicable IFC pins is ~33kΩ. This pull-up is designed such that it can be overpowered by an external 4.7 kΩ resistor. However, if the signal is intended to be high after reset, and if there is any device on the net that might pull down the value of the net at reset, a pull-up or active driver is needed.

5. Pin must **NOT** be pulled down during power-on reset. This pin may be pulled up, driven high, or if there are any externally connected devices, left in tristate. If this pin is connected to a device that pulls down during reset, an external pull-up is required to drive this pin to a safe state during reset.

6. Recommend that a weak pull-up resistor (2-10 k $\Omega$ ) be placed on this pin to the respective power supply.
7. This pin is an open-drain signal.
8. Recommend that a weak pull-up resistor (1 k $\Omega$ ) be placed on this pin to the respective power supply.
9. This pin has a weak (~20 k $\Omega$ ) internal pull-up P-FET that is always enabled.
10. These are test signals for factory use only and must be pulled up (100 $\Omega$  to 1-k $\Omega$ ) to the respective power supply for normal operation.
11. This pin requires a 200 $\Omega$  pull-up to respective power-supply.
12. Do not connect. These pins should be left floating.
13. This pin requires an external 1-k $\Omega$  pull-down resistor to prevent PHY from seeing a valid Transmit Enable before it is actively driven.
14. These pins must be pulled to ground (GND).
15. This pin requires a 698 $\Omega$  pull-up to respective power-supply.
16. CLK12 is connected to CLK8 internally.
17. Do not connect.
18. These pins must be connected to S1GND.
19. This pin has a weak (~20 k $\Omega$ ) internal pull-up P-FET that is enabled only when the processor is in its reset state. This pin should have an optional pull down resistor 4.7 k $\Omega$  on board. This is required to support DIFF\_SYSCLK/DIFF\_SYSCLK\_B.
20. Connect to ground when fuses are read-only.
21. For boundary scan, TEST\_SEL\_B and PORESET\_B pins must be pulled to ground (GND), and SCAN\_MODE\_B and EVT2\_B pins must be pulled up.
22. The prime DQ bit of the DRAM must connect to 1 of the ECC[0:3] pins. In addition, if using a 16-bit data bus in DDR4 mode, then DQ[0:1] of the DRAM must connect to ECC[0:1] pins. The prime DQ bit of the DRAM is defined as DQ[0] for some DRAM vendors and any of DQ bits for other DRAM vendors.
23. TH\_V<sub>DD</sub> must be tied to the recommended supply level per the Recommended operating conditions section.
24. The permissible voltage range is 0-5.5 V.

25. When using discrete DRAM, the MAPAR\_ERR pin needs a 50  $\Omega$  to 100  $\Omega$  pull-up resistor to G1VDD.

### Warning

See "**Connection Recommendations**" for additional details on properly connecting these pins for specific applications.

## 3 Electrical characteristics

This section describes the DC and AC electrical specifications for the chip. The chip is currently targeted to these specifications, some of which are independent of the I/O cell but are included for a more complete reference. These are not purely I/O buffer design specifications.

### 3.1 Overall DC electrical characteristics

This section describes the ratings, conditions, and other characteristics.

#### 3.1.1 Absolute maximum ratings

This table provides the absolute maximum ratings.

**Table 2. Absolute maximum ratings<sup>1</sup>**

| Characteristic                                                                                                               | Symbol                                                                | Max Value                    | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------|------------------------------|------|-------|
| Core and platform supply voltage                                                                                             | V <sub>DD</sub>                                                       | -0.3 to 1.08                 | V    | 9     |
| Always ON supply voltage                                                                                                     | V <sub>DDC</sub>                                                      | -0.3 to 1.08                 | V    | —     |
| PLL supply voltage (core PLL/eSDHC, platform, DDR)                                                                           | AV <sub>DD_CGA1</sub><br>AV <sub>DD_PLAT</sub><br>AV <sub>DD_D1</sub> | -0.3 to 1.98                 | V    | —     |
| PLL supply voltage (SerDes, filtered from X1V <sub>DD</sub> )                                                                | AVDD_SD1_PLL1<br>AVDD_SD1_PLL2                                        | -0.3 to 1.48                 | V    | —     |
| SFP Fuse Programming                                                                                                         | TA_PROG_SFP                                                           | -0.3 to 1.98                 | V    | —     |
| Thermal monitor unit supply                                                                                                  | TH_VDD                                                                | -0.3 to 1.98                 | V    | —     |
| System control and power management, GPIO1, GPIO2, debug, and IRQ                                                            | O1V <sub>DD</sub>                                                     | -0.3 to 1.98                 | V    | —     |
| Clocking, debug, DDRCLK supply, JTAG, RTC, and IRQ                                                                           | OV <sub>DD</sub>                                                      | -0.3 to 1.98                 | V    | —     |
| DUART, I <sup>2</sup> C, DMA, TDM, QE, LPUART1, 2, 4, GPIO1, eSDHC, SAI(I <sup>2</sup> S) 3, 4, SPDIF, FTM4, FTM8, SPI2, IRQ | D1V <sub>DD</sub><br>DV <sub>DD</sub>                                 | -0.3 to 3.63<br>-0.3 to 1.98 | V    | 10    |
| QSPI, SPI1, IFC, GPIO2, FTM5, FTM6, FTM7, I <sup>2</sup> C                                                                   | BV <sub>DD</sub>                                                      | -0.3 to 3.63                 | V    | —     |

*Table continues on the next page...*

**Table 2. Absolute maximum ratings<sup>1</sup> (continued)**

| Characteristic                                                                                           |                                                                                                                              | Symbol                                | Max Value                                    | Unit | Notes    |
|----------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------|---------------------------------------|----------------------------------------------|------|----------|
|                                                                                                          |                                                                                                                              |                                       | -0.3 to 1.98                                 |      |          |
| GPIO2, eSDHC, LPUART3, 5, 6                                                                              |                                                                                                                              | EV <sub>DD</sub>                      | -0.3 to 3.63<br>-0.3 to 1.98                 | V    | —        |
| DDR4 and DDR3L DRAM I/O voltage                                                                          |                                                                                                                              | G1V <sub>DD</sub>                     | -0.3 to 1.48<br>-0.3 to 1.32                 | V    | —        |
| Main power supply for internal circuitry of SerDes and pad power supply for SerDes receivers             |                                                                                                                              | S1V <sub>DD</sub>                     | -0.3 to 1.03                                 | V    | —        |
| Pad power supply for SerDes transmitter                                                                  |                                                                                                                              | X1V <sub>DD</sub>                     | -0.3 to 1.48                                 | V    | —        |
| Ethernet interface 2 and 3, 1588, GPIO1, GPIO3, USB2, FTM2, FTM3, Ethernet management interface 1 (EMI1) |                                                                                                                              | LV <sub>DD</sub>                      | -0.3 to 3.63<br>-0.3 to 2.75<br>-0.3 to 1.98 | V    | —        |
| Ethernet interface 1, GPIO3, SAI(I <sup>2</sup> S) 1, 2, FTM1                                            |                                                                                                                              | L1V <sub>DD</sub>                     | -0.3 to 3.63<br>-0.3 to 2.75<br>-0.3 to 1.98 | V    | —        |
| USB PHY Transceiver supply voltage                                                                       |                                                                                                                              | USB_HV <sub>DD</sub>                  | -0.3 to 3.63                                 | V    | —        |
|                                                                                                          |                                                                                                                              | USB1_SDV <sub>DD</sub>                | -0.3 to 1.03                                 | V    | —        |
|                                                                                                          |                                                                                                                              | USB1_SXV <sub>DD</sub>                | -0.3 to 1.03                                 | V    | —        |
| USB PHY Analog supply voltage                                                                            |                                                                                                                              | USB1_SPV <sub>DD</sub>                | -0.3 to 1.03                                 | V    | —        |
| Battery Backed Security Monitor supply                                                                   |                                                                                                                              | TA_BB_V <sub>DD</sub>                 | -0.3 to 1.03                                 | V    | —        |
| Input voltage                                                                                            | DDR4 and DDR3L DRAM signals                                                                                                  | MV <sub>IN</sub>                      | -0.3 to (G1V <sub>DD</sub> + 0.3)            | V    | 2, 11    |
|                                                                                                          | DDR4 and DDR3L DRAM reference                                                                                                | D1_MV <sub>REF</sub>                  | -0.3 to (G1V <sub>DD</sub> /2 + 0.3)         | V    | 5        |
|                                                                                                          | Ethernet interface 2 and 3, Ethernet management interface 1 (EMI1), 1588, GPIO1, GPIO3, USB2, FTM2, FTM3                     | LV <sub>IN</sub>                      | -0.3 to (LV <sub>DD</sub> + 0.3)             | V    | 4, 5     |
|                                                                                                          | Ethernet interface 1, GPIO3, SAI(I <sup>2</sup> S) 1, 2, FTM1                                                                | L1V <sub>IN</sub>                     | -0.3 to (L1V <sub>DD</sub> + 0.3)            | V    | 4, 5     |
|                                                                                                          | Clocking, debug, DDRCLK supply, JTAG, RTC, IRQ                                                                               | OV <sub>IN</sub>                      | -0.3 to (OV <sub>DD</sub> + 0.3)             | V    | 3, 5     |
|                                                                                                          | System control and power management, GPIO1, GPIO2, debug, IRQ                                                                | O1V <sub>IN</sub>                     | -0.3 to (O1V <sub>DD</sub> + 0.3)            | V    | 3, 5     |
|                                                                                                          | GPIO2, eSDHC, LPUART3, 5, 6 signals                                                                                          | EV <sub>IN</sub>                      | -0.3 to (EV <sub>DD</sub> + 0.3)             | V    | 5, 6, 7  |
|                                                                                                          | QSPI, SPI1, IFC, GPIO2, FTM5, FTM6, FTM7, I <sup>2</sup> C signals                                                           | BV <sub>IN</sub>                      | -0.3 to (BV <sub>DD</sub> + 0.3)             | V    | 5, 8     |
|                                                                                                          | DUART, I <sup>2</sup> C, DMA, TDM, QE, LPUART1, 2, 4, GPIO1, eSDHC, SAI(I <sup>2</sup> S) 3, 4, SPDIF, FTM4, FTM8, SPI2, IRQ | DV <sub>IN</sub><br>D1V <sub>IN</sub> | -0.3 to (DnV <sub>DD</sub> + 0.3)            | V    | 5, 6, 10 |
|                                                                                                          | SerDes signals                                                                                                               | S1V <sub>IN</sub>                     | -0.4 to (S1V <sub>DD</sub> + 0.3)            | V    | 5        |
|                                                                                                          | USB PHY Transceiver signals                                                                                                  | USB_HV <sub>IN</sub>                  | -0.3 to (USB_HV <sub>DD</sub> + 0.3)         | V    | 5        |
| Storage temperature range                                                                                |                                                                                                                              | T <sub>STG</sub>                      | -55 to 150                                   | °C   | —        |
| <b>Notes:</b>                                                                                            |                                                                                                                              |                                       |                                              |      |          |

**Table 2. Absolute maximum ratings<sup>1</sup>**

| Characteristic                                                                                                                                                                                                                                                                                             | Symbol | Max Value | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----------|------|-------|
| 1. Functional operating conditions are given in <a href="#">Table 3</a> . Absolute maximum ratings are stress ratings only, and functional operation at the maximums is not guaranteed. Stresses beyond those listed may affect device reliability or cause permanent damage to the device.                |        |           |      |       |
| 2. <b>Caution:</b> $MV_{IN}$ must not exceed $GV_{DD}$ by more than 0.3 V. This limit may be exceeded for a maximum of 20 ms during power-on reset and power-down sequences.                                                                                                                               |        |           |      |       |
| 3. <b>Caution:</b> $OV_{IN}$ must not exceed $OV_{DD}$ by more than 0.3 V. This limit may be exceeded for a maximum of 20 ms during power-on reset and power-down sequences.                                                                                                                               |        |           |      |       |
| 4. <b>Caution:</b> $LV_{IN}$ must not exceed $LV_{DD}$ by more than 0.3 V. This limit may be exceeded for a maximum of 20 ms during power-on reset and power-down sequences.                                                                                                                               |        |           |      |       |
| 5. (S,B,L,O,D,E) $V_{IN}$ , USBn_HV <sub>IN</sub> , and Dn_MV <sub>REF</sub> may overshoot/undershoot to a voltage and for a maximum duration as shown in <a href="#">Figure 7</a> .                                                                                                                       |        |           |      |       |
| 6. <b>Caution:</b> $DV_{IN}$ must not exceed $DV_{DD}$ by more than 0.3 V. This limit may be exceeded for a maximum of 20 ms during power-on reset and power-down sequences.                                                                                                                               |        |           |      |       |
| 7. <b>Caution:</b> $EV_{IN}$ must not exceed $EV_{DD}$ by more than 0.3 V. This limit may be exceeded for a maximum of 20 ms during power-on reset and power-down sequences.                                                                                                                               |        |           |      |       |
| 8. <b>Caution:</b> $BV_{IN}$ must not exceed $BV_{DD}$ by more than 0.3 V. This limit may be exceeded for a maximum of 20 ms during power-on reset and power-down sequences.                                                                                                                               |        |           |      |       |
| 9. Supply voltage specified at the voltage sense pin. Voltage input pins should be regulated to provide specified voltage at the sense pin.                                                                                                                                                                |        |           |      |       |
| 10. See the power supply column in <a href="#">Table 1</a> to determine which power supply rail is used for each interface.                                                                                                                                                                                |        |           |      |       |
| 11. Typical DDR interface uses ODT enabled mode. For tests purposes with ODT off mode, simulation should be done first so as to make sure that the overshoot signal level at the input pin does not exceed $GV_{DD}$ by more than 10%. The overshoot/undershoot period should comply with JEDEC standards. |        |           |      |       |

### 3.1.2 Recommended operating conditions

This table provides the recommended operating conditions for this chip.

#### NOTE

The values shown are the recommended operating conditions and proper device operation outside these conditions is not guaranteed.

**Table 3. Recommended operating conditions**

| Characteristic                                     | Symbol                 | Power domain in deep sleep | Recommended Value | Unit | Notes   |
|----------------------------------------------------|------------------------|----------------------------|-------------------|------|---------|
| Core and platform supply voltage                   | $V_{DD}$               | OFF                        | 1.0 V $\pm$ 30 mV | V    | 3, 4, 5 |
| Always ON core and platform supply                 | $V_{DDC}$              | ON                         | 1.0 V $\pm$ 30 mV | V    |         |
| Battery backed security monitor supply             | TA_BB_ $V_{DD}$        | OFF                        | 1.0 V $\pm$ 30 mV | V    | —       |
| PLL supply voltage (core PLL/eSDHC, platform, DDR) | AV <sub>DD</sub> _CGA1 | OFF                        | 1.8 V $\pm$ 90 mV | V    | 8       |
|                                                    | AV <sub>DD</sub> _PLAT | ON                         |                   |      |         |

Table continues on the next page...

**Table 3. Recommended operating conditions (continued)**

| Characteristic                                                                                                               |                                                           | Symbol                      | Power domain in deep sleep | Recommended Value                                 | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------|-----------------------------|----------------------------|---------------------------------------------------|------|-------|
|                                                                                                                              |                                                           | AV <sub>DD</sub> _D1        | OFF                        |                                                   |      |       |
| PLL supply voltage (SerDes, filtered from X1V <sub>DD</sub> )                                                                |                                                           | AV <sub>DD</sub> _SD1_PLL 1 | OFF                        | 1.35 V ± 67 mV                                    | V    | —     |
|                                                                                                                              |                                                           | AV <sub>DD</sub> _SD1_PLL 2 | OFF                        |                                                   |      |       |
| SFP Fuse Programming                                                                                                         |                                                           | TA_PROG_SFP                 | Refer to table note        | 1.8 V ± 90 mV                                     | V    | 2     |
| Thermal monitor unit supply                                                                                                  |                                                           | TH_VDD                      | OFF                        | 1.8 V ± 90 mV                                     | V    |       |
| Clocking, debug, DDRCLK supply, JTAG, RTC, IRQ                                                                               |                                                           | OV <sub>DD</sub>            | OFF                        | 1.8 V ± 90 mV                                     | V    | —     |
| System control and power management, GPIO1, GPIO2, debug, IRQ                                                                |                                                           | O1V <sub>DD</sub>           | ON                         | 1.8 V ± 90 mV                                     | V    | —     |
| DUART, I <sup>2</sup> C, DMA, QE, TDM, LPUART1, 2, 4, GPIO1, eSDHC, SAI(I <sup>2</sup> S) 3, 4, SPDIF, FTM4, FTM8, SPI2, IRQ |                                                           | D1V <sub>DD</sub>           | ON                         | 3.3 V ± 165 mV                                    | V    | 6, 7  |
|                                                                                                                              |                                                           | DV <sub>DD</sub>            | OFF                        | 1.8 V ± 90 mV                                     |      |       |
| QSPI, SPI1, IFC, FTM5, FTM6, FTM7, I <sup>2</sup> C, GPIO3                                                                   |                                                           | BV <sub>DD</sub>            | OFF                        | 3.3 V ± 165mV<br>1.8 V ± 90mV                     | V    | —     |
| GPIO2, eSDHC, LPUART3, 5, 6                                                                                                  |                                                           | EV <sub>DD</sub>            | OFF                        | 3.3 V ± 165 mV<br>1.8 V ± 90 mV                   | V    | —     |
| DDR DRAM I/O voltage                                                                                                         | DDR4                                                      | G1V <sub>DD</sub>           | OFF                        | 1.2V ± 60 mV                                      | V    | —     |
|                                                                                                                              | DDR3L                                                     |                             | OFF                        | 1.35 V ± 67 mV                                    |      |       |
| Main power supply for internal circuitry of SerDes and pad power supply for SerDes receivers                                 |                                                           | S1V <sub>DD</sub>           | OFF                        | 1.0 V ± 30 mV                                     | V    | —     |
| Pad power supply for SerDes transmitters                                                                                     |                                                           | X1V <sub>DD</sub>           | OFF                        | 1.35 V ± 67 mV                                    | V    | —     |
| Ethernet interface 2 and 3, Ethernet management interface 1 (EMI1), 1588, GPIO1, GPIO3, USB2, FTM2, FTM3                     |                                                           | LV <sub>DD</sub>            | OFF                        | 3.3 V ± 165 mV<br>2.5 V ± 125 mV<br>1.8 V ± 90 mV | V    | 1, 7  |
| Ethernet interface 1, GPIO3, SAI(I <sup>2</sup> S) 1, 2, FTM1                                                                |                                                           | L1V <sub>DD</sub>           | ON                         | 3.3 V ± 165 mV<br>2.5 V ± 125 mV<br>1.8 V ± 90 mV | V    | 1, 7  |
| USB PHY Transceiver supply voltage                                                                                           |                                                           | USB_HV <sub>DD</sub>        | OFF                        | 3.3 V ± 165 mV                                    | V    | —     |
|                                                                                                                              |                                                           | USB1_SDV <sub>DD</sub>      | OFF                        | 1.0 V ± 30 mV                                     | V    | —     |
|                                                                                                                              |                                                           | USB1_SXV <sub>DD</sub>      | OFF                        | 1.0 V ± 30 mV                                     | V    | —     |
| USB PHY Analog supply voltage                                                                                                |                                                           | USB1_SPV <sub>DD</sub>      | OFF                        | 1.0 V ± 30 mV                                     | V    | —     |
| Input voltage                                                                                                                | DDR3L and DDR4 DRAM signals                               | MV <sub>IN</sub>            | —                          | GND to G1V <sub>DD</sub>                          | V    | —     |
|                                                                                                                              | DDR3L and DDR4 DRAM reference                             | D1_MV <sub>REF</sub>        | —                          | G1V <sub>DD</sub> /2                              | V    | —     |
|                                                                                                                              | Ethernet interface 2 and 3, Ethernet management interface | LV <sub>IN</sub>            | —                          | GND to LV <sub>DD</sub>                           | V    | —     |

Table continues on the next page...

**Table 3. Recommended operating conditions (continued)**

| Characteristic                                                                                                               | Symbol                                | Power domain in deep sleep         | Recommended Value                                             | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------|---------------------------------------|------------------------------------|---------------------------------------------------------------|------|-------|
| 1 (EMI1), 1588, GPIO1, GPIO3, USB2, FTM2, FTM3                                                                               |                                       |                                    |                                                               |      |       |
| Ethernet interface 1, GPIO3, SAI(I <sup>2</sup> S), FTM1                                                                     | L1V <sub>IN</sub>                     | —                                  | GND to L1V <sub>DD</sub>                                      | V    | —     |
| Clocking, debug, DDRCLK supply, JTAG, RTC, IRQ                                                                               | OV <sub>IN</sub>                      | —                                  | GND to OV <sub>DD</sub>                                       | V    | —     |
| System control and power management, debug, GPIO1, GPIO2, IRQ                                                                | O1V <sub>IN</sub>                     | —                                  | GND to O1V <sub>DD</sub>                                      | V    | —     |
| QSPI, SPI1, IFC, GPIO3, FTM5, FTM6, FTM7, I <sup>2</sup> C                                                                   | BV <sub>IN</sub>                      | —                                  | GND to BV <sub>DD</sub>                                       | V    | —     |
| DUART, I <sup>2</sup> C, DMA, TDM, QE, eSDHC, LPUART1, 2, 4, GPIO1, SAI(I <sup>2</sup> S) 3, 4, SPDIF, FTM4, FTM8, SPI2, IRQ | DV <sub>IN</sub><br>D1V <sub>IN</sub> | —                                  | GND to DV <sub>DD</sub><br>GND to D1V <sub>DD</sub>           | V    | 6     |
| GPIO, eSDHC                                                                                                                  | EV <sub>IN</sub>                      | —                                  | GND to EV <sub>DD</sub>                                       | V    | —     |
| SerDes signals                                                                                                               | SV <sub>IN</sub>                      | —                                  | GND to S1V <sub>DD</sub>                                      | V    | —     |
| USB PHY Transceiver signals                                                                                                  | USB_HV <sub>IN</sub>                  | —                                  | GND to USB_HV <sub>DD</sub>                                   | V    | —     |
| Operating temperature range                                                                                                  | Normal operation                      | T <sub>A</sub> ,<br>T <sub>J</sub> | T <sub>A</sub> = 0 (min) to<br>T <sub>J</sub> = 105(max)      | °C   | —     |
|                                                                                                                              | Extended temperature                  | T <sub>A</sub> ,<br>T <sub>J</sub> | T <sub>A</sub> = -40 (min) to<br>T <sub>J</sub> = 105(max)    | °C   | —     |
|                                                                                                                              | Secure boot fuse programming          | T <sub>A</sub> ,<br>T <sub>J</sub> | T <sub>A</sub> = 0°C (min) to<br>T <sub>J</sub> = 105°C (max) | °C   | 2     |

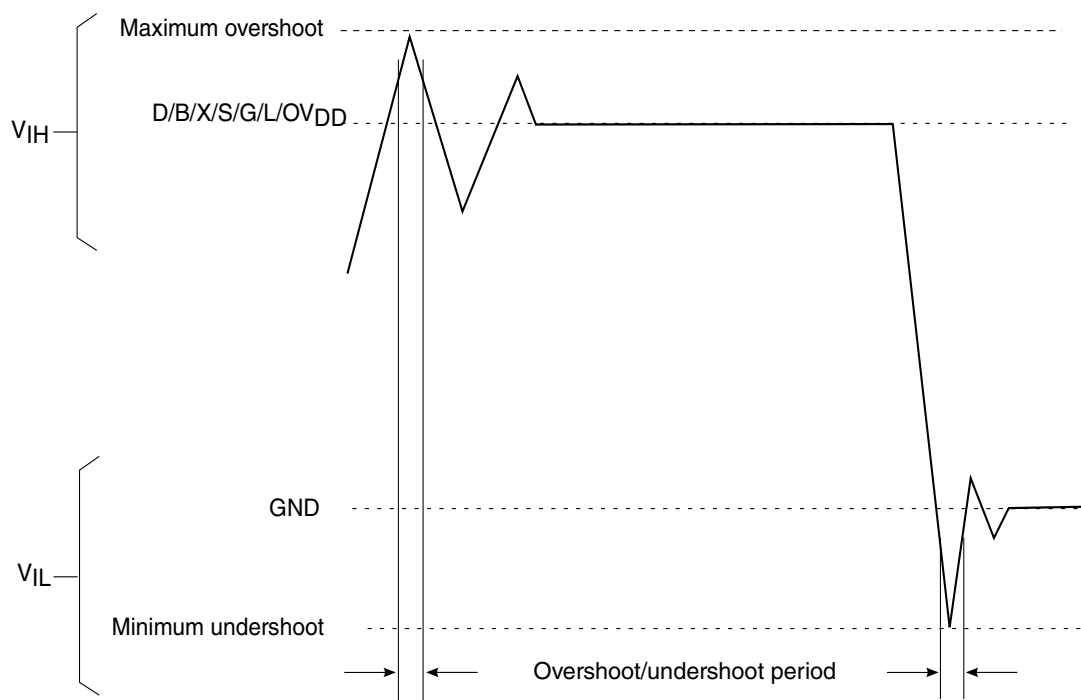
**Notes:**

1. RGMII is supported at 2.5 V or 1.8 V. RMII/MII are supported at 3.3 V.
2. TA\_PROG\_SFP must be supplied 1.8 V and the chip must operate in the specified fuse programming temperature range only during secure boot fuse programming. For all other operating conditions, TA\_PROG\_SFP must be tied to GND, subject to the power sequencing constraints shown in [Power sequencing](#).
3. Refer to [Core and platform supply voltage filtering](#) for additional information.
4. Supply voltage specified at the voltage sense pin. Voltage input pins should be regulated to provide specified voltage at the sense pin.
5. Operation at 1.1 V is allowable for up to 25 ms at initial power on.
6. See the power supply column in [Table 1](#) to determine which power supply rail is used for each interface.
7. LV<sub>DD</sub> and L1V<sub>DD</sub> must always be the same voltage. This also applies to DV<sub>DD</sub> and D1V<sub>DD</sub>

**Table 3. Recommended operating conditions**

| Characteristic                                                                                                                     | Symbol | Power domain in deep sleep | Recommended Value | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------------|--------|----------------------------|-------------------|------|-------|
| 8. AVDD_PLAT, AVDD_CGA1 and AVDD_D1 are measured at the input to the filter (as shown in AN4971) and not at the pin of the device. |        |                            |                   |      |       |

This figure shows the undershoot and overshoot voltages at the interfaces of the chip.

**Notes:**

The overshoot/undershoot period should be less than 10% of shortest possible toggling period of the input signal or per input signal specific protocol requirement. For GPIO input signal overshoot/undershoot period, it should be less than 10% of the SYSCLK period.

**Figure 7. Overshoot/undershoot voltage for G1V<sub>DD</sub>/L1V<sub>DD</sub>/O1V<sub>DD</sub>/OV<sub>DD</sub>/X1V<sub>DD</sub>/S1V<sub>DD</sub>/D1V<sub>DD</sub>/DV<sub>DD</sub>/BV<sub>DD</sub>/LV<sub>DD</sub>/EV<sub>DD</sub>**

See [Table 3](#) for actual recommended core voltage. Voltage to the processor interface I/Os are provided through separate sets of supply pins and must be provided at the voltages shown in [Table 3](#). The input voltage threshold scales with respect to the associated I/O supply voltage. DV<sub>DD</sub>-, OV<sub>DD</sub>-, and LV<sub>DD</sub>-based receivers are simple CMOS I/O circuits and satisfy appropriate LVCMOS type specifications. The DDR SDRAM interface uses differential receivers referenced by the externally supplied Dn\_MV<sub>REF</sub> signal (nominally set to G1V<sub>DD</sub>/2) as is appropriate for the SSTL\_1.35/SSTL\_1.2 electrical signaling standard. The DDR DQS receivers cannot be operated in single-ended fashion. The complement signal must be properly driven and cannot be grounded.

### 3.1.3 Output driver characteristics

This table provides information on the characteristics of the output driver strengths. Note that these values are preliminary estimates.

**Table 4. Output driver capability**

| Driver type                                                                                                                              | Output impedance ( $\Omega$ ) |                                                    |                  | Supply voltage                               | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|----------------------------------------------------|------------------|----------------------------------------------|-------|
|                                                                                                                                          | Min <sup>2</sup>              | Typical                                            | Max <sup>3</sup> |                                              |       |
| DDR3L signal                                                                                                                             | —                             | 18 (full-strength mode)<br>27 (half-strength mode) | —                | G1V <sub>DD</sub> = 1.35 V                   | 1     |
| DDR4 signal                                                                                                                              | —                             | 18 (full-strength mode)<br>27 (half-strength mode) | —                | G1V <sub>DD</sub> = 1.2 V                    | 1     |
| Ethernet signals                                                                                                                         | 45                            | —                                                  | 90               | L1V <sub>DD</sub> /LV <sub>DD</sub> = 3.3V   | —     |
|                                                                                                                                          | 40                            |                                                    | 90               | L1V <sub>DD</sub> /LV <sub>DD</sub> = 2.5V   |       |
|                                                                                                                                          | 40                            |                                                    | 75               | L1V <sub>DD</sub> /LV <sub>DD</sub> = 1.8V   |       |
| GPIO, system control and power management, clocking, debug, DDRCLK supply, and JTAG I/O voltage                                          | 23                            | —                                                  | 51               | OV <sub>DD</sub> , O1V <sub>DD</sub> = 1.8 V | —     |
| DUART, QE, TDM, I <sup>2</sup> C, LPUART, GPIO, eSDHC, SAI(I <sup>2</sup> S), SPDIF, FTM                                                 | 40                            | —                                                  | 75               | D1V <sub>DD</sub> /DV <sub>DD</sub> = 1.8V   | —     |
|                                                                                                                                          | 45                            |                                                    | 90               | D1V <sub>DD</sub> /DV <sub>DD</sub> = 3.3V   |       |
| QSPI, IFC, FTM, I <sup>2</sup> C                                                                                                         | 40                            | —                                                  | 75               | BV <sub>DD</sub> = 1.8V                      | —     |
|                                                                                                                                          | 45                            | —                                                  | 90               | BV <sub>DD</sub> = 3.3V                      | —     |
| eSDHC                                                                                                                                    | 40                            | —                                                  | 75               | EV <sub>DD</sub> = 1.8V                      | —     |
| GPIO                                                                                                                                     | 45                            | —                                                  | 90               | EV <sub>DD</sub> = 3.3V                      |       |
| <b>Note:</b>                                                                                                                             |                               |                                                    |                  |                                              |       |
| 1. The drive strength of the DDR4 or DDR3L interface in half-strength mode is at T <sub>j</sub> = 105 °C and at G1V <sub>DD</sub> (min). |                               |                                                    |                  |                                              |       |
| 2. Estimated number based on best case processed device.                                                                                 |                               |                                                    |                  |                                              |       |
| 3. Estimated number based on worst case processed device.                                                                                |                               |                                                    |                  |                                              |       |

## 3.2 Power sequencing

Apply the power rails in a specific sequence to ensure proper device operation. The required power-up sequence is as follows:

**Table 5. Power-up sequence**

| Step                                                                                                                                                                                                                                                                                              | Procedure                                                                                                                                                                                                                                                                             | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| 1.                                                                                                                                                                                                                                                                                                | BV <sub>DD</sub> , AV <sub>DD</sub> _CGA1, AV <sub>DD</sub> _PLAT, AV <sub>DD</sub> _D1, O1V <sub>DD</sub> , OV <sub>DD</sub> , D1V <sub>DD</sub> , DV <sub>DD</sub> , L1V <sub>DD</sub> , LV <sub>DD</sub> , EV <sub>DD</sub> , TH_VDD, USB_HV <sub>DD</sub> . Drive PROG_SFP = GND. | 1     |
| 2.                                                                                                                                                                                                                                                                                                | V <sub>DDC</sub> , V <sub>DD</sub> , S1V <sub>DD</sub> , TA_BB_V <sub>DD</sub> , USB1_SPV <sub>DD</sub> , USB1_SDV <sub>DD</sub> , USB1_SXV <sub>DD</sub>                                                                                                                             | 2, 3  |
| 3.                                                                                                                                                                                                                                                                                                | G1V <sub>DD</sub> , AV <sub>DD</sub> _SD1_PLL1, AV <sub>DD</sub> _SD1_PLL2, X1V <sub>DD</sub>                                                                                                                                                                                         | 4, 5  |
| Notes:                                                                                                                                                                                                                                                                                            |                                                                                                                                                                                                                                                                                       |       |
| 1. PORESET_B should be driven, asserted, and held during this step.                                                                                                                                                                                                                               |                                                                                                                                                                                                                                                                                       |       |
| 2. When deep sleep mode is used, V <sub>DDC</sub> should ramp up before V <sub>DD</sub> . Alternatively, V <sub>DD</sub> may ramp up together with V <sub>DDC</sub> provided that the relative timing between V <sub>DDC</sub> and V <sub>DD</sub> ramp up conforms to <a href="#">Figure 8</a> . |                                                                                                                                                                                                                                                                                       |       |
| 3. When deep sleep is not used, it is recommended source VDD and VDDC from the same power supply.                                                                                                                                                                                                 |                                                                                                                                                                                                                                                                                       |       |
| 4. When using DDR4, AVDD_SD1_PLL1, AVDD_SD1_PLL2, X1VDD may ramp up with step 1 supplies.                                                                                                                                                                                                         |                                                                                                                                                                                                                                                                                       |       |
| 5. When using DDR3L, all supplies in step 3 above may be sourced from the same supply.                                                                                                                                                                                                            |                                                                                                                                                                                                                                                                                       |       |
| 6. While X1VDD is ramping, current may be supplied from X1VDD through chip to S1VDD.                                                                                                                                                                                                              |                                                                                                                                                                                                                                                                                       |       |

Required sequence for exiting deep sleep mode:

**Table 6. Sequence for exiting deep sleep mode**

| Step                                                                                      | Procedure                                                                                                                                               | Notes |
|-------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| 1.                                                                                        | USB_HV <sub>DD</sub> , BV <sub>DD</sub> , AV <sub>DD</sub> _CGA1, AV <sub>DD</sub> _D1, DV <sub>DD</sub> , LV <sub>DD</sub> , EV <sub>DD</sub> , TH_VDD | 1     |
| 2.                                                                                        | V <sub>DD</sub> , S1V <sub>DD</sub> , TA_BB_V <sub>DD</sub> , USB1_SPV <sub>DD</sub> , USB1_SDV <sub>DD</sub> , USB1_SXV <sub>DD</sub>                  |       |
| 3.                                                                                        | G1V <sub>DD</sub> , AV <sub>DD</sub> _SD1_PLL1, AV <sub>DD</sub> _SD1_PLL2, X1V <sub>DD</sub>                                                           | 2, 3  |
| Notes:                                                                                    |                                                                                                                                                         |       |
| 1. PORESET_B should be driven, asserted, and held during this step.                       |                                                                                                                                                         |       |
| 2. When using DDR4, AVDD_SD1_PLL1, AVDD_SD1_PLL2, X1VDD may ramp up with step 1 supplies. |                                                                                                                                                         |       |
| 3. When using DDR3L, all supplies in step 3 above may be sourced from the same supply.    |                                                                                                                                                         |       |

Items on the same line have no ordering requirement with respect to one another. Items on separate lines must be ordered sequentially such that voltage rails on a previous step must reach 90% of their value before the voltage rails on the current step reach 10% of their value.

All supplies must be at their stable values within 400 ms.

Negate PORESET\_B input when the required assertion/hold time has been met per the table in section [Power-on ramp rate](#).

The supplies mentioned as OFF in the "Power Domain in Deep Sleep" column of [Table 3](#) are switched ON during exit from deep sleep power management mode. These supplies should also follow the same power up sequence as mentioned above.

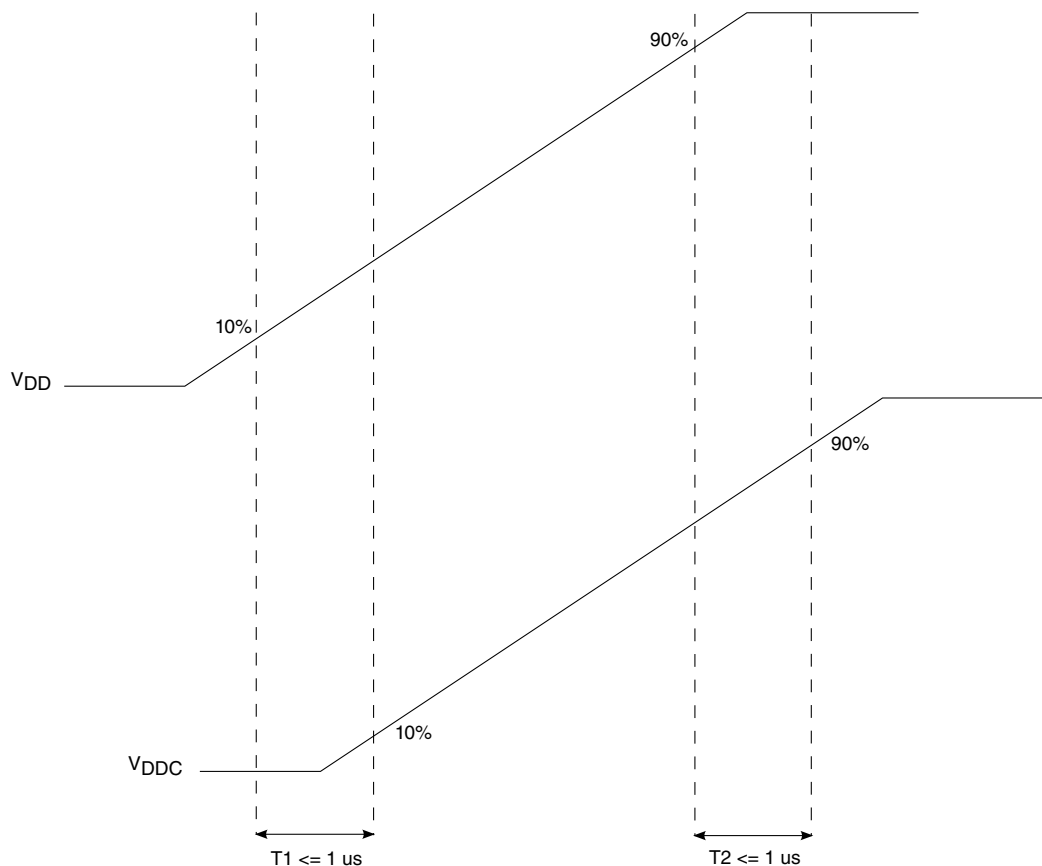
### NOTE

- While VDD is ramping, current may be supplied from VDD through the LS1021A to G1VDD.
- EVT2\_B may be unstable when PORESET\_B is asserted. The signal should not be used to enable switchable power supplies during this period.
- Ramp rate requirements should be met per section [Power-on ramp rate](#).

### NOTE

Only 300,000 POR cycles are permitted per lifetime of a device. Note that this value is based on design estimates and is preliminary.

This figure shows the V<sub>DDC</sub> and V<sub>DD</sub> ramp-up diagram.



**Figure 8. V<sub>DDC</sub> and V<sub>DD</sub> ramp-up diagram**

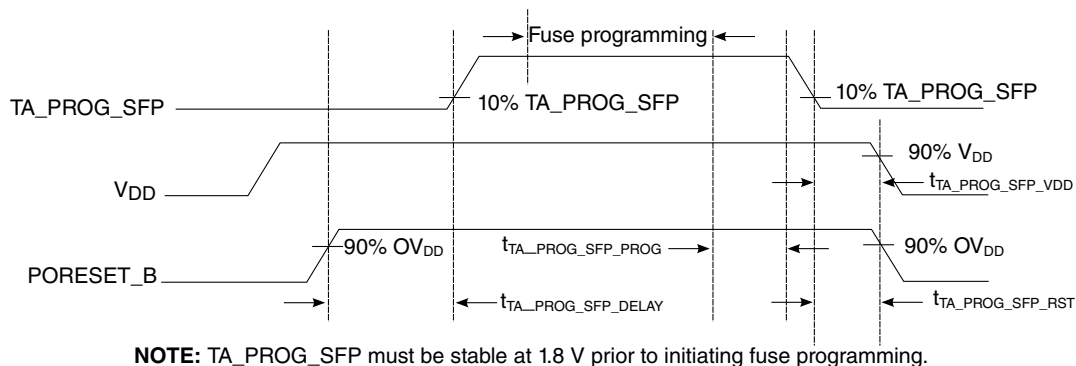
For secure boot fuse programming, use the following steps:

1. After negation of PORESET\_B, drive TA\_PROG\_SFP = 1.8 V after a required minimum delay per [Table 7](#).
2. After fuse programming is complete, it is required to return TA\_PROG\_SFP = GND before the system is power cycled (PORESET\_B assertion) or powered down (V<sub>DD</sub> ramp down) per the required timing specified in [Table 7](#). See [Security fuse processor](#) for additional details.
3. If using trust architecture security monitor battery backed features, prior to VDD ramping up to the 0.5V level, ensure that OVDD is ramped to recommended operational voltage and SYSCLK or DIFF\_SYSCLK/DIFF\_SYSCLK\_B is running. These clocks should have a minimum frequency of 800Hz and a maximum frequency no greater than the supported system clock frequency for the device.

### Warning

No activity other than that required for secure boot fuse programming is permitted while TA\_PROG\_SFP is driven to any voltage above GND, including the reading of the fuse block. The reading of the fuse block may only occur while TA\_PROG\_SFP = GND.

This figure shows the TA\_PROG\_SFP timing diagram.



**Figure 9. TA\_PROG\_SFP timing diagram**

This table provides information on the power-down and power-up sequence parameters for TA\_PROG\_SFP.

**Table 7. TA\_PROG\_SFP timing <sup>5</sup>**

| Driver type                    | Min | Max | Unit    | Notes |
|--------------------------------|-----|-----|---------|-------|
| t <sub>TA_PROG_SFP_DELAY</sub> | 100 | —   | SYSCLKs | 1     |
| t <sub>TA_PROG_SFP_PROG</sub>  | 0   | —   | us      | 2     |
| t <sub>TA_PROG_SFP_VDD</sub>   | 0   | —   | us      | 3     |

Table continues on the next page...

**Table 7. TA\_PROG\_SFP timing <sup>5</sup> (continued)**

| Driver type                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | Min | Max | Unit | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------|-------|
| $t_{TA\_PROG\_SFP\_RST}$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | 0   | —   | us   | 4     |
| <b>Notes:</b> <ol style="list-style-type: none"> <li>1. Delay required from the deassertion of PORESET_B to driving TA_PROG_SFP ramp up. Delay measured from PORESET_B deassertion at 90% <math>OV_{DD}</math> to 10% TA_PROG_SFP ramp up.</li> <li>2. Delay required from fuse programming completion to TA_PROG_SFP ramp down start. Fuse programming must complete while TA_PROG_SFP is stable at 1.8 V. No activity other than that required for secure boot fuse programming is permitted while TA_PROG_SFP is driven to any voltage above GND, including the reading of the fuse block. The reading of the fuse block may only occur while TA_PROG_SFP = GND. After fuse programming is complete, it is required to return TA_PROG_SFP = GND.</li> <li>3. Delay required from TA_PROG_SFP ramp-down complete to <math>V_{DD}</math> ramp-down start. TA_PROG_SFP must be grounded to minimum 10% TA_PROG_SFP before <math>V_{DD}</math> reaches 90% <math>V_{DD}</math>.</li> <li>4. Delay required from TA_PROG_SFP ramp-down complete to PORESET_B assertion. TA_PROG_SFP must be grounded to minimum 10% TA_PROG_SFP before PORESET_B assertion reaches 90% <math>OV_{DD}</math>.</li> <li>5. Only two secure boot fuse programming events are permitted per lifetime of a device.</li> </ol> |     |     |      |       |

### 3.3 Power-down requirements

The power-down cycle must complete such that power supply values are below 0.4 V before a new power-up cycle can be started.

If performing secure boot fuse programming per the requirements in [Power sequencing](#), it is required that TA\_PROG\_SFP = GND before the system is power cycled (PORESET\_B assertion) or powered down ( $V_{DD}$  ramp down) per the required timing specified in [Power sequencing](#).

### 3.4 Power characteristics

This table provides the power dissipations of the  $V_{DD}$  and  $V_{DDC}$  supply for various operating platform clock frequencies versus the core and DDR clock frequencies.

**Table 8. Core power dissipation**

| Power mode | Core freq (MHz) | Platform freq (MHz) | DDR data rate (MT/s) | $V_{DDC}$ , $V_{DD}$ , $S1V_{DD}$ , TA_BB_ $V_D$ (V) | Junction temperature (°C) | Total core and platform power (W) <sup>1</sup> | Power (W) |           |            |                 | Notes |
|------------|-----------------|---------------------|----------------------|------------------------------------------------------|---------------------------|------------------------------------------------|-----------|-----------|------------|-----------------|-------|
|            |                 |                     |                      |                                                      |                           |                                                | $V_{DD}$  | $V_{DDC}$ | $S1V_{DD}$ | TA_BB_ $V_{DD}$ |       |
| Typical    | 1200            | 300                 | 1600                 | 1.0                                                  | 65                        | 2.14                                           | 1.61      | 0.22      | 0.29       | 0.01            | 2, 3  |

Table continues on the next page...

**Table 8. Core power dissipation (continued)**

| Power mode | Core freq (MHz) | Platform freq (MHz) | DDR data rate (MT/s) | V <sub>DDC</sub> , V <sub>DD</sub> , S1V <sub>DD</sub> , TA_BB_V <sub>D</sub> <sub>D</sub> (V) | Junction temperature (°C) | Total core and platform power (W) <sup>1</sup> | Power (W)       |                  |                   |                       | Notes |
|------------|-----------------|---------------------|----------------------|------------------------------------------------------------------------------------------------|---------------------------|------------------------------------------------|-----------------|------------------|-------------------|-----------------------|-------|
|            |                 |                     |                      |                                                                                                |                           |                                                | V <sub>DD</sub> | V <sub>DDC</sub> | S1V <sub>DD</sub> | TA_BB_V <sub>DD</sub> |       |
| Thermal    |                 |                     |                      |                                                                                                | 105                       | 3.72                                           | 2.95            | 0.42             | 0.32              | 0.02                  | 6, 7  |
| Maximum    |                 |                     |                      |                                                                                                |                           | 3.86                                           | 3.08            | 0.44             | 0.32              | 0.02                  | 4, 5  |
| Typical    | 1000            | 300                 | 1600                 | 1.0                                                                                            | 65                        | 2.09                                           | 1.59            | 0.20             | 0.29              | 0.01                  | 2, 3  |
| Thermal    |                 |                     |                      |                                                                                                | 105                       | 3.68                                           | 2.94            | 0.40             | 0.32              | 0.02                  | 6, 7  |
| Maximum    |                 |                     |                      |                                                                                                | 3.82                      | 3.06                                           | 0.41            | 0.32             | 0.02              | 4, 5                  |       |
| Typical    | 800             | 300                 | 1300                 | 1.0                                                                                            | 65                        | 1.97                                           | 1.49            | 0.18             | 0.29              | 0.01                  | 2, 3  |
| Thermal    |                 |                     |                      |                                                                                                | 105                       | 3.56                                           | 2.84            | 0.38             | 0.32              | 0.02                  | 6, 7  |
| Maximum    |                 |                     |                      |                                                                                                | 3.68                      | 2.95                                           | 0.39            | 0.32             | 0.02              | 4, 5                  |       |

**Notes:**

1. Combined power of V<sub>DD</sub>, V<sub>DDC</sub>, S1V<sub>DD</sub>, and TA\_BB\_V<sub>DD</sub> with DDR controller and all SerDes banks active. Does not include I/O power.
2. Typical power assumes Dhrystone running with activity factor of 80% (on all cores) and executing DMA on the platform with 100% activity factor.
3. Typical power based on nominal processed device.
4. Maximum power assumes multicore Dhrystone running with a 100% activity factor and executing DMA on the platform with a 115% activity factor.
5. Maximum power is provided for power supply design sizing.
6. Thermal power assumes multicore Dhrystone running with an 80% activity factor and executing DMA on the platform with a 115% activity factor.
7. Thermal and maximum power are based on worst-case processed device.

### 3.4.1 Low power mode saving estimation

Refer to this table for low power mode savings.

**Table 9. Low power mode savings, 1.0 V, 65°C<sup>1, 2, 3</sup>**

| Mode                  | Core Frequency = 800 MHz | Core Frequency = 1.0 GHz | Core Frequency = 1.2 GHz | Units | Notes |
|-----------------------|--------------------------|--------------------------|--------------------------|-------|-------|
| PW15                  | 0.04                     | 0.05                     | 0.06                     | Watts | 4     |
| PCL10                 | 0.06                     | 0.07                     | 0.08                     | Watts |       |
| LMP20                 | 0.33                     | 0.39                     | 0.45                     | Watts | 5     |
| Notes:                |                          |                          |                          |       |       |
| 1. Power for VDD only |                          |                          |                          |       |       |

**Table 9. Low power mode savings, 1.0 V, 65C<sup>1, 2, 3</sup>**

2. Typical power assumes Dhrystone running with activity factor of 80%  
 3. Typical power based on nominal process distribution for this device.  
 4. PW15 power savings with 1 core. Maximum savings would be N times, where N is the number of used cores.  
 5. LPM20 has all platform clocks disabled.

### 3.4.2 LPM35 Deep sleep power dissipation, 1.0 V, 35C<sup>1</sup>

| Power (W)                                                                         |                  |                   | Total core and platform power (W) |
|-----------------------------------------------------------------------------------|------------------|-------------------|-----------------------------------|
| V <sub>DD</sub>                                                                   | V <sub>DDC</sub> | S1V <sub>DD</sub> |                                   |
| -                                                                                 | 0.15             | -                 | 0.15                              |
| Notes:                                                                            |                  |                   |                                   |
| 1. V <sub>DD</sub> and S1V <sub>DD</sub> are switched off during deep sleep mode. |                  |                   |                                   |

## 3.5 I/O DC power supply recommendation

The following table provides the estimated I/O power numbers for each block. The numbers listed below are based on design estimates only.

**Table 10. Estimated I/O power supply values values**

| Interface                                                                                       | I/O Power supply |                 | Parameter | Typical (W) | Max (W) <sup>8</sup> | Notes   |
|-------------------------------------------------------------------------------------------------|------------------|-----------------|-----------|-------------|----------------------|---------|
| System control and power management, clocking, debug, DDRCLK supply, GPIO, and JTAG I/O voltage | LVC MOS          | OVDD/O1VDD 1.8V |           | 0.015       | 0.021                | 1,3,4,6 |
| QSPI                                                                                            | LVC MOS          | BVDD 1.8V       |           | 0.038       | 0.038                | 1,3,4,6 |
|                                                                                                 | LVC MOS          | BVDD 3.3V       |           | 0.101       | 0.101                | 1,3,4,6 |
| SPI                                                                                             | LVC MOS          | BVDD 1.8V       |           | 0.012       | 0.015                | 1,3,4,6 |
|                                                                                                 | LVC MOS          | BVDD 3.3V       |           | 0.026       | 0.032                | 1,3,4,6 |
| IFC                                                                                             | LVC MOS          | BVDD 1.8V       |           | 0.094       | 0.097                | 1,3,4,6 |
|                                                                                                 | LVC MOS          | BVDD 3.3V       |           | 0.245       | 0.250                | 1,3,4,6 |
| Ethernet interface                                                                              | LVC MOS          | LVDD/L1VDD 1.8V |           | 0.103       | 0.104                | 1,3,4,6 |
|                                                                                                 | LVC MOS          | LVDD/L1VDD 2.5V |           | 0.169       | 0.171                | 1,3,4,6 |
|                                                                                                 | LVC MOS          | LVDD/L1VDD      |           | 0.275       | 0.278                | 1,3,4,6 |

Table continues on the next page...

**Table 10. Estimated I/O power supply values values (continued)**

| Interface                        | I/O Power supply |                                  | Parameter | Typical (W) | Max (W) <sup>8</sup> | Notes   |
|----------------------------------|------------------|----------------------------------|-----------|-------------|----------------------|---------|
|                                  |                  | 3.3V                             |           |             |                      |         |
| 1588                             | LVC MOS          | LVDD 1.8V                        |           | 0.012       | 0.014                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD 2.5V                        |           | 0.019       | 0.022                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD 3.3V                        |           | 0.030       | 0.034                | 1,3,4,6 |
| GPIO                             | LVC MOS          | LVDD/L1VDD/<br>DVDD/EVDD<br>1.8V |           | 0.009       | 0.013                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD/L1VDD<br>2.5V               |           | 0.013       | 0.018                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD/L1VDD/<br>DVDD/EVDD<br>3.3V |           | 0.019       | 0.026                | 1,3,4,6 |
| USB2                             | LVC MOS          | LVDD 1.8V                        |           | 0.015       | 0.018                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD 2.5V                        |           | 0.022       | 0.026                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD 3.3V                        |           | 0.033       | 0.040                | 1,3,4,6 |
| FlexTimer                        | LVC MOS          | LVDD/L1VDD/<br>DVDD<br>1.8V      |           | 0.019       | 0.026                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD/L1VDD/<br>DVDD<br>2.5V      |           | 0.026       | 0.036                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD/L1VDD/<br>DVDD<br>3.3V      |           | 0.038       | 0.052                | 1,3,4,6 |
| Ethernet Management<br>Interface | LVC MOS          | LVDD 1.8V                        |           | 0.002       | 0.003                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD 2.5V                        |           | 0.003       | 0.004                | 1,3,4,6 |
|                                  | LVC MOS          | LVDD 3.3V                        |           | 0.005       | 0.006                | 1,3,4,6 |
| SAI(I2S)                         | LVC MOS          | L1VDD/DVDD<br>1.8V               |           | 0.016       | 0.019                | 1,3,4,6 |
|                                  | LVC MOS          | L1VDD<br>2.5V                    |           | 0.024       | 0.029                | 1,3,4,6 |
|                                  | LVC MOS          | L1VDD/DVDD<br>3.3V               |           | 0.037       | 0.044                | 1,3,4,6 |
| DUART                            | LVC MOS          | DVDD 1.8V                        |           | 0.004       | 0.005                | 1,3,4,6 |
|                                  | LVC MOS          | DVDD 3.3V                        |           | 0.008       | 0.010                | 1,3,4,6 |
| I2C                              | LVC MOS          | DVDD/BVDD<br>1.8V                |           | 0.003       | 0.004                | 1,3,4,6 |
|                                  | LVC MOS          | DVDD/BVDD                        |           | 0.006       | 0.009                | 1,3,4,6 |

Table continues on the next page...

**Table 10. Estimated I/O power supply values values (continued)**

| Interface | I/O Power supply    |                             | Parameter      | Typical (W) | Max (W) <sup>8</sup> | Notes   |
|-----------|---------------------|-----------------------------|----------------|-------------|----------------------|---------|
|           |                     | 3.3V                        |                |             |                      |         |
| QE        | LVC MOS             | DVDD 1.8V                   |                | 0.014       | 0.018                | 1,3,4,6 |
|           | LVC MOS             | DVDD 3.3V                   |                | 0.033       | 0.040                | 1,3,4,6 |
| LPUART    | LVC MOS             | DVDD 1.8V                   |                | 0.009       | 0.012                | 1,3,4,6 |
|           | LVC MOS             | DVDD 3.3V                   |                | 0.019       | 0.024                | 1,3,4,6 |
| SPDIF     | LVC MOS             | DVDD 1.8V                   |                | 0.006       | 0.007                | 1,3,4,6 |
|           | LVC MOS             | DVDD 3.3V                   |                | 0.015       | 0.017                | 1,3,4,6 |
| eSDHC     | LVC MOS             | EVDD/DVDD<br>1.8V           |                | 0.026       | 0.027                | 1,3,4,6 |
|           | LVC MOS             | EVDD/DVDD<br>3.3V           |                | 0.071       | 0.075                | 1,3,4,6 |
| DDR3L     | DDR I/O             | GVDD 1.35V                  | 1000 MT/s      | 0.350       | 0.684                | 1,2,5,6 |
|           | DDR I/O             | GVDD 1.35V                  | 1300 MT/s      | 0.393       | 0.772                | 1,2,5,6 |
|           | DDR I/O             | GVDD 1.35V                  | 1600 MT/s      | 0.448       | 0.883                | 1,2,5,6 |
| DDR4      | DDR I/O             | GVDD 1.2V                   | 1300 MT/s      | 0.311       | 0.619                | 1,2,5,6 |
|           | DDR I/O             | GVDD 1.2V                   | 1600 MT/s      | 0.354       | 0.698                | 1,2,5,6 |
| USB PHY   | USB_PHY             | USB1_SXVDD<br>1.0V          |                | 0.019       | 0.026                | 1,6     |
|           | USB_PHY             | USB1_SPVDD<br>1.0V          |                | 0.032       | 0.044                | 1,6     |
|           | USB_PHY             | USB_SDVDD<br>1.0V           |                | 0.006       | 0.011                | 1,6     |
|           | USB_PHY             | USB_HVDD 3.3V               |                | 0.125       | 0.146                | 1,6     |
| PLL       | PLL core and system | AVDD_CGA1<br>AVDD_PLAT 1.8V |                | 0.02        | 0.02                 | 3,6     |
|           | PLL DDR             | AVDD_D1 1.8V                |                | 0.02        | 0.02                 | 3,6     |
|           | PLL LYNX            | AVDD_D1_PLL<br>1.35V        |                | 0.03        | 0.04                 | 3,6     |
| SGMII     | SerDes<br>1.35V     | X1VDD                       | (x1)1.25G-baud | 0.076       | 0.084                | 1,6,7   |
| SATA      | SerDes<br>1.35V     | X1VDD                       | (x1)3.0G-baud  | 0.076       | 0.083                | 1,6,7   |
| PEX       | SerDes<br>1.35V     | X1VDD                       | (x1)5.0G-baud  | 0.082       | 0.090                | 1,6,7   |
|           | SerDes<br>1.35V     | X1VDD                       | (x2)5.0G-baud  | 0.115       | 0.122                | 1,6,7   |
|           | SerDes<br>1.35V     | X1VDD                       | (x4)5.0G-baud  | 0.179       | 0.187                | 1,6,7   |

Notes:

**Table 10. Estimated I/O power supply values**

| Interface                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | I/O Power supply | Parameter | Typical (W) | Max (W) <sup>8</sup> | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|-----------|-------------|----------------------|-------|
| <p>1. The maximum values are dependent on actual use case such as what application, external components used, environmental conditions such as temperature voltage and frequency. This is not intended to be the maximum guaranteed power. Expect different results depending on the use case. The maximum values are estimated and they are based on simulations at 105 °C junction temperature.</p> <p>2. Typical DDR power numbers are based on one 2-rank DIMM with 40% utilization.</p> <p>3. Assuming 15pF total capacitance load.</p> <p>4. GPIOs are supported on 1.8 V, 2.5 V, and 3.3 V rails as specified in the hardware specification.</p> <p>5. Maximum DDR power numbers are based on one 2-rank DIMM with 100% utilization.</p> <p>6. The typical values are estimates and based on simulations at nominal recommended voltage for the IO power supply and assuming at 65° C junction temperature.</p> <p>7. The total power numbers of X1VDD is dependent on customer application use case. This table lists all the SerDes configurations possible for the device. To get the X1VDD power numbers, the user should add the combined lanes to match to the total SerDes Lanes used, not simply multiply the power numbers by the number of lanes.</p> <p>8. The maximum values are dependent on actual use case such as what application, external components used, environmental conditions such as temperature voltage and frequency. This is not intended to be the maximum guaranteed power. Expect different results depending on the use case. The maximum values are estimated and they are based on simulations at 105°C junction temperature.</p> |                  |           |             |                      |       |

This table shows the estimated power dissipation on the TA\_BB\_VDD supply at allowable voltage levels.

**Table 11. TA\_BB\_VDD power dissipation**

| Supply                                                                                                                                                                                                                                                                                                                                | Maximum | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|------|-------|
| TA_BB_VDD (SoC off, 40 °C)                                                                                                                                                                                                                                                                                                            | 40      | μW   | 1     |
| TA_BB_VDD (SoC off, 70 °C)                                                                                                                                                                                                                                                                                                            | 55      | μW   | 1     |
| <p>Note:</p> <p>1. When SoC is off, TA_BB_VDD may be supplied by battery power to retain the Zeroizable Master Key and other trust architecture state. Board should implement a PMIC, which switches TA_BB_VDD to battery when SoC powered down. See the Device reference manual trust architecture chapter for more information.</p> |         |      |       |

### 3.6 Power-on ramp rate

This section describes the AC electrical specifications for the power-on ramp rate requirements. Controlling the maximum power-on ramp rate is required to avoid excess in-rush current.

This table provides the power supply ramp rate specifications.

**Table 12. Power supply ramp rate**

| Parameter                                                                                                                                                                                                                                                                                                                                  | Min | Max  | Unit | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|------|-------|
| Required ramp rate for all voltage supplies (except for TA_PROG_SFP and USB_HVDD)                                                                                                                                                                                                                                                          | —   | 25   | V/ms | 1, 2  |
| TA_PROG_SFP                                                                                                                                                                                                                                                                                                                                | —   | 25   | V/ms | 1, 2  |
| USB_HVDD                                                                                                                                                                                                                                                                                                                                   | —   | 26.7 | V/ms | 1, 2  |
| <b>Notes:</b><br>1. Ramp rate is specified as a linear ramp from 10% to 90%. If non-linear (for example, exponential), the maximum rate of change from 200 mV to 500 mV is the most critical as this range might falsely trigger the ESD circuitry.<br>2. Over full recommended operating temperature range. See <a href="#">Table 3</a> . |     |      |      |       |

## 3.7 Input clocks

### 3.7.1 System clock (SYSCLK)

This section describes the system clock DC electrical characteristics and AC timing specifications.

#### 3.7.1.1 SYSCLK DC electrical characteristics

This table provides the SYSCLK DC characteristics.

**Table 13. SYSCLK DC electrical characteristics<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                                      | Symbol   | Min                   | Typical | Max                   | Unit    | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----------------------|---------|-----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                             | $V_{IH}$ | $0.7 \times O1V_{DD}$ | —       | —                     | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                              | $V_{IL}$ | —                     | —       | $0.2 \times O1V_{DD}$ | V       | 1     |
| Input capacitance                                                                                                                                                                                                                                                                                                                                                              | $C_{IN}$ | —                     | 7       | 12                    | pF      | —     |
| Input current ( $O1V_{IN} = 0$ V or $O1V_{IN} = O1V_{DD}$ )                                                                                                                                                                                                                                                                                                                    | $I_{IN}$ | —                     | —       | $\pm 50$              | $\mu A$ | 2     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $O1V_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $OV_{IN}$ , in this case, represents the $O1V_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. At recommended operating conditions with $O1V_{DD} = 1.8$ V. See <a href="#">Table 3</a> . |          |                       |         |                       |         |       |

#### 3.7.1.2 SYSCLK AC timing specifications

This table provides the SYSCLK AC timing specifications.

**Table 14. SYSCLK AC timing specifications<sup>1, 5</sup>**

| Parameter/condition                                 | Symbol                             | Min  | Typ | Max   | Unit | Notes |
|-----------------------------------------------------|------------------------------------|------|-----|-------|------|-------|
| SYSCLK frequency                                    | $f_{\text{SYSCLK}}$                | 64.0 | —   | 133.3 | MHz  | 2     |
| SYSCLK cycle time                                   | $t_{\text{SYSCLK}}$                | 7.5  | —   | 15.6  | ns   | 1, 2  |
| SYSCLK duty cycle                                   | $t_{\text{KHK}}/t_{\text{SYSCLK}}$ | 40   | —   | 60    | %    | 2     |
| SYSCLK slew rate                                    | —                                  | 1    | —   | 4     | V/ns | 3     |
| SYSCLK peak period jitter                           | —                                  | —    | —   | ± 150 | ps   | —     |
| SYSCLK jitter phase noise at -56 dBc                | —                                  | —    | —   | 500   | kHz  | 4     |
| AC Input Swing Limits at 1.8 V<br>O1V <sub>DD</sub> | $\Delta V_{\text{AC}}$             | 1.08 | —   | 1.8   | V    | —     |

**Notes:**

- Caution:** The relevant clock ratio settings must be chosen such that the resulting SYSCLK frequencies do not exceed their respective maximum or minimum operating frequencies.
- Measured at the rising edge and/or the falling edge at O1V<sub>DD</sub>/2.
- Slew rate as measured from 0.35 x O1V<sub>DD</sub> to 0.65 x O1V<sub>DD</sub>.
- Phase noise is calculated as FFT of TIE jitter.
- At recommended operating conditions with O1V<sub>DD</sub> = 1.8 V. See [Table 3](#).

### 3.7.2 Spread-spectrum sources

Spread-spectrum clock sources are an increasingly popular way to control electromagnetic interference emissions (EMI) by spreading the emitted noise to a wider spectrum and reducing the peak noise magnitude in order to meet industry and government requirements. These clock sources intentionally add long-term jitter to diffuse the EMI spectral content.

The jitter specification given in this table considers short-term (cycle-to-cycle) jitter only. The clock generator's cycle-to-cycle output jitter should meet the chip's input cycle-to-cycle jitter requirement.

Frequency modulation and spread are separate concerns; the chip is compatible with spread-spectrum sources if the recommendations listed in this table are observed.

**Table 15. Spread-spectrum clock source recommendations<sup>3</sup>**

| Parameter            | Min | Max | Unit | Notes |
|----------------------|-----|-----|------|-------|
| Frequency modulation | —   | 60  | kHz  | —     |
| Frequency spread     | —   | 1.0 | %    | 1, 2  |

**Notes:**

- SYSCLK frequencies that result from frequency spreading and the resulting core frequency must meet the minimum and maximum specifications given in [Table 14](#).

**Table 15. Spread-spectrum clock source recommendations<sup>3</sup>**

| Parameter                                                                                                       | Min | Max | Unit | Notes |
|-----------------------------------------------------------------------------------------------------------------|-----|-----|------|-------|
| 2. Maximum spread-spectrum frequency may not result in exceeding any maximum operating frequency of the device. |     |     |      |       |
| 3. At recommended operating conditions with O1VDD = 1.8 V. See <a href="#">Table 3</a> .                        |     |     |      |       |

**CAUTION**

The processor's minimum and maximum SYSCLK and core/platform/DDR frequencies must not be exceeded, regardless of the type of clock source. Therefore, systems in which the processor is operated at its maximum rated core/platform/DDR frequency should use only down-spreading to avoid violating the stated limits.

**3.7.3 Real-time clock timing (RTC)**

This table provides the real-time clock recommendations.

**Table 16. Real-time clock recommendations**

| Parameter | Min             | Typical | Max             | Unit | Notes |
|-----------|-----------------|---------|-----------------|------|-------|
| RTC       | 32.000 -100 ppm | 32.000  | 32.768 +100 ppm | kHz  | 1     |

**3.7.4 Gigabit Ethernet reference clock timing**

This table provides the Ethernet gigabit reference clock DC electrical characteristics with  $L1V_{DD}/LV_{DD} = 1.8$  V.

**Table 17. ECn\_GTX\_CLK125 DC electrical characteristics (L1VDD/LVDD = 1.8 V)<sup>1</sup>**

| Parameter                                                                                                                              | Symbol   | Min                   | Typical | Max                   | Unit    | Notes |
|----------------------------------------------------------------------------------------------------------------------------------------|----------|-----------------------|---------|-----------------------|---------|-------|
| Input high voltage                                                                                                                     | $V_{IH}$ | $0.7 \times L1V_{DD}$ | —       | —                     | V       | 2     |
| Input low voltage                                                                                                                      | $V_{IL}$ | —                     | —       | $0.2 \times L1V_{DD}$ | V       | 2     |
| Input capacitance                                                                                                                      | $C_{IN}$ | —                     | —       | 6                     | pF      | —     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = L1V_{DD}/LV_{DD}$ )                                                                        | $I_{IN}$ | —                     | —       | $\pm 50$              | $\mu$ A | 3     |
| <b>Notes:</b>                                                                                                                          |          |                       |         |                       |         |       |
| 1. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                 |          |                       |         |                       |         |       |
| 2. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $V_{IN}$ values found in <a href="#">Table 3</a> . |          |                       |         |                       |         |       |
| 3. The symbol $V_{IN}$ , in this case, represents the $L1V_{IN}/LV_{IN}$ symbol referenced in <a href="#">Table 3</a> .                |          |                       |         |                       |         |       |

This table provides the Ethernet gigabit reference clock DC electrical characteristics with  $L1V_{DD}/LV_{DD} = 2.5$  V.

**Table 18. ECn\_GTX\_CLK125 DC electrical characteristics ( $L1V_{DD}/LV_{DD} = 2.5$  V)<sup>1</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                    | Symbol   | Min                   | Typical | Max                   | Unit    | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----------------------|---------|-----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                           | $V_{IH}$ | $0.7 \times L1V_{DD}$ | —       | —                     | V       | 2     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                            | $V_{IL}$ | —                     | —       | $0.2 \times L1V_{DD}$ | V       | 2     |
| Input capacitance                                                                                                                                                                                                                                                                                                                                            | $C_{IN}$ | —                     | —       | 6                     | pF      | —     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = L1V_{DD}/LV_{DD}$ )                                                                                                                                                                                                                                                                                              | $I_{IN}$ | —                     | —       | $\pm 50$              | $\mu$ A | 3     |
| <b>Notes:</b><br>1. For recommended operating conditions, see <a href="#">Table 3</a> .<br>2. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $V_{IN}$ values found in <a href="#">Table 3</a> .<br>3. The symbol $V_{IN}$ , in this case, represents the $L1V_{IN}/LV_{IN}$ symbol referenced in <a href="#">Table 3</a> . |          |                       |         |                       |         |       |

This table provides the Ethernet gigabit reference clock AC timing specifications.

**Table 19. ECn\_GTX\_CLK125 AC timing specifications<sup>1, 4</sup>**

| Parameter/Condition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | Symbol                | Min        | Typical | Max          | Unit | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|------------|---------|--------------|------|-------|
| ECn_GTX_CLK125 frequency                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | $t_{G125}$            | 125-100ppm | 125     | 125+100ppm   | MHz  | —     |
| ECn_GTX_CLK125 cycle time                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | $t_{G125}$            | —          | 8       | —            | ns   | —     |
| ECn_GTX_CLK125 rise and fall time<br>$L1/LV_{DD} = 1.8$ V<br>$L1/LV_{DD} = 2.5$ V                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | $t_{G125R}/t_{G125F}$ | —          | —       | 0.54<br>0.75 | ns   | 2     |
| ECn_GTX_CLK125 duty cycle<br>1000Base-T for RGMII                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | $t_{G125H}/t_{G125}$  | 40         | —       | 60           | %    | 3     |
| <b>Notes:</b><br>1. At recommended operating conditions with $L1/LV_{DD} = 1.8$ V $\pm$ 90mV / $2.5$ V $\pm$ 125 mV. See <a href="#">Table 3</a> .<br>2. Rise and fall times for ECn_GTX_CLK125 are measured from 0.5 and 2.0 V for $L1/LV_{DD} = 2.5$ V.<br>3. ECn_GTX_CLK125 is used to generate the GTX clock for the Ethernet transmitter with 2% degradation. The ECn_GTX_CLK125 duty cycle can be loosened from 47% to 53%, as long as the PHY device can tolerate the duty cycle generated by the GTX_CLK. See <a href="#">RGMII AC timing specifications</a> for duty cycle for the 10Base-T and 100Base-T reference clocks.<br>4. The frequency of ECn_RX_CLK (input) should not exceed the frequency of EC_GTX_CLK125/ECn_TX_CLK (input) by more than 300 ppm. |                       |            |         |              |      |       |

### 3.7.5 DDR clock (DDRCLK)

This section provides the DDRCLK DC electrical characteristics and AC timing specifications.

### 3.7.5.1 DDRCLK DC electrical characteristics

This table provides the DDRCLK DC electrical characteristics.

**Table 20. DDRCLK DC electrical characteristics<sup>3</sup>**

| Parameter                                                | Symbol   | Min                  | Typical | Max                  | Unit    | Notes |
|----------------------------------------------------------|----------|----------------------|---------|----------------------|---------|-------|
| Input high voltage                                       | $V_{IH}$ | $0.7 \times OV_{DD}$ | —       | —                    | V       | 1     |
| Input low voltage                                        | $V_{IL}$ | —                    | —       | $0.2 \times OV_{DD}$ | V       | 1     |
| Input capacitance                                        | $C_{IN}$ | —                    | 7       | 12                   | pF      | —     |
| Input current ( $OV_{IN} = 0$ V or $OV_{IN} = OV_{DD}$ ) | $I_{IN}$ | —                    | —       | $\pm 100$            | $\mu$ A | 2     |

**Notes:**

1. The min  $V_{IL}$  and max  $V_{IH}$  values are based on the respective min and max  $OV_{IN}$  values found in [Table 3](#).
2. The symbol  $OV_{IN}$ , in this case, represents the  $OV_{IN}$  symbol referenced in [Table 3](#).
3. At recommended operating conditions with  $OV_{DD} = 1.8$  V. See [Table 3](#).

### 3.7.5.2 DDRCLK AC timing specifications

This table provides the DDRCLK AC timing specifications.

**Table 21. DDRCLK AC timing specifications<sup>5</sup>**

| Parameter/Condition                      | Symbol               | Min  | Typ | Max       | Unit | Notes |
|------------------------------------------|----------------------|------|-----|-----------|------|-------|
| DDRCLK frequency                         | $f_{DDRCLK}$         | 64.0 | —   | 133.3     | MHz  | 1, 2  |
| DDRCLK cycle time                        | $t_{DDRCLK}$         | 7.5  | —   | 15.6      | ns   | 1, 2  |
| DDRCLK duty cycle                        | $t_{KHK}/t_{DDRCLK}$ | 40   | —   | 60        | %    | 2     |
| DDRCLK slew rate                         | —                    | 1    | —   | 4         | V/ns | 3     |
| DDRCLK peak period jitter                | —                    | —    | —   | $\pm 150$ | ps   | —     |
| DDRCLK jitter phase noise at -56 dBc     | —                    | —    | —   | 500       | kHz  | 4     |
| AC input swing limits at 1.8 V $OV_{DD}$ | $\Delta V_{AC}$      | 1.08 | —   | 1.8       | V    | —     |

**Notes:**

1. **Caution:** The relevant clock ratio settings must be chosen such that the resulting DDRCLK frequencies do not exceed their respective maximum or minimum operating frequencies.
2. Measured at the rising edge and/or the falling edge at  $OV_{DD}/2$ .
3. Slew rate as measured from  $0.35 \times OV_{DD}$  to  $0.65 \times OV_{DD}$ .
4. Phase noise is calculated as FFT of TIE jitter.
5. At recommended operating conditions with  $OV_{DD} = 1.8$  V. See [Table 3](#).

### 3.7.6 Differential system clock (DIFF\_SYSCLK/DIFF\_SYSCLK\_B) timing specifications

Single-source clocking mode requires the single onboard oscillator to provide reference clock input to the differential system clock pair, DIFF\_SYSCLK/DIFF\_SYSCLK\_B. This differential clock pair input provides clocking to the core, platform, DDR, and USB PLLs. The following figure shows a receiver reference diagram of the differential system clock.

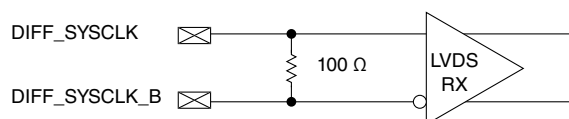


Figure 10. LVDS receiver

This section provides the differential system clock DC electrical characteristics and AC timing specifications.

#### 3.7.6.1 Differential system clock DC electrical characteristics

The differential system clock receiver's core power supply voltage requirements ( $O1V_{DD}$ ) are specified in [Recommended operating conditions](#).

The differential system clock can also be single-ended. For this, DIFF\_SYSCLK\_B should be connected to  $O1V_{DD}/2$ .

Table 22. Differential system clock DC electrical characteristics

| Parameter                                                                                                                                                                                                                       | Symbol    | Min | Typical | Max  | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|-----|---------|------|------|-------|
| Input differential voltage swing                                                                                                                                                                                                | $V_{id}$  | 100 | —       | 600  | mV   | 3     |
| Input common mode voltage                                                                                                                                                                                                       | $V_{icm}$ | 50  | —       | 1570 | mV   | —     |
| Power supply current                                                                                                                                                                                                            | $I_{cc}$  | —   | —       | 5    | mA   | —     |
| Input capacitance                                                                                                                                                                                                               | $C_{in}$  | —   | 4       | —    | pF   | 2     |
| Note:                                                                                                                                                                                                                           |           |     |         |      |      |       |
| 1. At recommended operation conditions with $O1V_{DD}=1.8V$ .                                                                                                                                                                   |           |     |         |      |      |       |
| 2. The die capacitance may cause reflection of the clock signal through the package back to the pin. This should not affect the signal quality seen by internal PLL. Recommend verifying signal quality using IBIS simulations. |           |     |         |      |      |       |
| 3. Input differential voltage swing ( $V_{id}$ ) specified is equal to $IV_{DIFF\_SYSCLK\_P} - V_{DIFF\_SYSCLK\_NI}$                                                                                                            |           |     |         |      |      |       |

### 3.7.6.2 Differential system clock AC timing specifications

The DIFF\_SYSCLK/DIFF\_SYSCLK\_B input pair supports an input clock frequency of 100 MHz.

Spread-spectrum clocking is not supported on differential system clock pair input.

**Table 23. Differential system clock AC electrical characteristics<sup>2, 3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                | Symbol                    | Min  | Typical | Max  | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------|------|---------|------|------|-------|
| DIFF_SYSCLK/<br>DIFF_SYSCLK_<br>B frequency<br>range                                                                                                                                                                                                                                                                                                                                     | $t_{\text{DIFF\_SYSCLK}}$ | —    | 100     | —    | MHz  | —     |
| DIFF_SYSCLK/<br>DIFF_SYSCLK_<br>B frequency<br>tolerance                                                                                                                                                                                                                                                                                                                                 | $t_{\text{DIFF\_TOL}}$    | -300 | —       | -300 | ppm  | —     |
| Duty cycle                                                                                                                                                                                                                                                                                                                                                                               | $t_{\text{DIFF\_DUTY}}$   | 40   | 50      | 60   | %    | —     |
| Clock period<br>jitter (peak to<br>peak)                                                                                                                                                                                                                                                                                                                                                 | $t_{\text{DIFF\_TJ}}$     | —    | —       | 100  | ps   | 2     |
| Notes:<br>1. At recommended operating conditions with $O1V_{\text{DD}}=1.8\text{ V}$ .<br>2. This is evaluated with supply noise profile at $\pm 5\%$ sine wave.<br>3. The 100 MHz reference frequency is needed if USB is used. The reference clock to USB PHY is selectable between SYSCLK or DIFF_SYSCLK/DIF_SYSCLK_B. The selected clock must meet the clock specifications for USB. |                           |      |         |      |      |       |

### 3.7.7 Other input clocks

A description of the overall clocking of this device is available in the chip reference manual in the form of a clock subsystem block diagram. For information about the input clock requirements of functional modules sourced external of the chip, such as SerDes, Ethernet management, eSDHC, and IFC, see the specific interface section.

## 3.8 RESET initialization

This table provides the AC timing specifications for the RESET initialization timing.

**Table 24. RESET initialization timing specifications**

| Parameter/Condition                       | Min | Max | Unit    | Notes |
|-------------------------------------------|-----|-----|---------|-------|
| Required assertion time of PORESET_B      | 1   | —   | ms      | 1     |
| Required input assertion time of HRESET_B | 32  | —   | SYSCLKs | 2, 3  |

*Table continues on the next page...*

**Table 24. RESET initialization timing specifications  
(continued)**

| Parameter/Condition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | Min | Max | Unit    | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|---------|-------|
| Maximum rise/fall time of HRESET_B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | —   | 10  | SYSCLKs | 4, 5  |
| Maximum rise/fall time of PORESET_B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | —   | 1   | SYSCLKs | 4, 6  |
| Input setup time for POR configs (other than cfg_eng_use0) with respect to negation of PORESET_B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | 4   | —   | SYSCLKs | 2, 7  |
| Input hold time for all POR configs with respect to negation of PORESET_B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | 2   | —   | SYSCLKs | 2     |
| Maximum valid-to-high impedance time for actively driven POR configs with respect to negation of PORESET_B                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | —   | 5   | SYSCLKs | 2     |
| <b>Notes:</b><br>1. PORESET_B must be driven asserted before the core and platform power supplies are powered up.<br>2. SYSCLK is the primary clock input for the chip.<br>3. The device asserts HRESET_B as an output when PORESET_B is asserted to initiate the power-on reset process. The device releases HRESET_B sometime after PORESET_B is deasserted. The exact sequencing of HRESET_B deassertion is documented in the reference manual's "Power-on Reset Sequence" section.<br>4. The system/board must be designed to ensure the input requirement to the device is achieved. Proper device operation is guaranteed for inputs meeting this requirement by design, simulation, characterization, or functional testing.<br>5. For HRESET_B the rise/fall time should not exceed 10 SYSCLKs. Rise time refers to signal transitions from 20% to 70% of O1VDD. Fall time refers to transitions from 70% to 20% of O1VDD.<br>6. For PORESET_B the rise/fall time should not exceed 1 SYSCLK. Rise time refers to signal transitions from 20% to 70% of O1VDD. Fall time refers to transitions from 70% to 20% of O1VDD.<br>7. For proper clock selection, terminate cfg_eng_use0 with a pull up or pull down of 4.7 k $\Omega$ to ensure that the signal has a valid state as soon as the IO voltage reaches its operating condition. |     |     |         |       |

## 3.9 DDR3L and DDR4 SDRAM controller

This section describes the DC and AC electrical specifications for the DDR3L and DDR4 SDRAM controller interface. Note that the required  $G1V_{DD}(\text{typ})$  voltage is 1.35 V when interfacing to DDR3L SDRAM, and the required  $G1V_{DD}(\text{typ})$  voltage is 1.2 V when interfacing to DDR4 SDRAM.

### 3.9.1 DDR3L and DDR4 SDRAM interface DC electrical characteristics

This table provides the recommended operating conditions for the DDR SDRAM controller when interfacing to DDR3L SDRAM.

**Table 25. DDR3L SDRAM interface DC electrical characteristics ( $G1V_{DD} = 1.35\text{ V}$ )<sup>1, 8</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Symbol         | Min                    | Max                    | Unit          | Note    |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|------------------------|------------------------|---------------|---------|
| I/O reference voltage                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | $Dn\_MV_{REF}$ | $0.49 \times G1V_{DD}$ | $0.51 \times G1V_{DD}$ | V             | 2, 3, 4 |
| Input high voltage                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | $V_{IH}$       | $Dn\_MV_{REF} + 0.090$ | $G1V_{DD}$             | V             | 5       |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | $V_{IL}$       | GND                    | $Dn\_MV_{REF} - 0.090$ | V             | 5       |
| I/O leakage current                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | $I_{OZ}$       | -165                   | 165                    | $\mu\text{A}$ | 6       |
| <b>Notes:</b><br>1. $G1V_{DD}$ is expected to be within 50 mV of the DRAM's voltage supply at all times. The DRAM's and memory controller's voltage supply may or may not be from the same source.<br>2. $Dn\_MV_{REF}$ is expected to be equal to $0.5 \times G1V_{DD}$ and to track $G1V_{DD}$ DC variations as measured at the receiver. Peak-to-peak noise on $Dn\_MV_{REF}$ may not exceed the $Dn\_MV_{REF}$ DC level by more than $\pm 1\%$ of $G1V_{DD}$ (that is, $\pm 13.5\text{ mV}$ ).<br>3. $V_{TT}$ is not applied directly to the device. It is the supply to which far-end signal termination is made, and it is expected to be equal to $Dn\_MV_{REF}$ with a min value of $Dn\_MV_{REF} - 0.04$ and a max value of $Dn\_MV_{REF} + 0.04$ . $V_{TT}$ should track variations in the DC level of $Dn\_MV_{REF}$ .<br>4. The voltage regulator for $Dn\_MV_{REF}$ must meet the specifications stated in <a href="#">Table 27</a> .<br>5. Input capacitance load for DQ, DQS, and DQS_B are available in the IBIS models.<br>6. Output leakage is measured with all outputs disabled ( $0\text{ V} \leq V_{OUT} \leq G1V_{DD}$ ).<br>7. Refer to the IBIS model for the complete output IV curve characteristics.<br>8. For recommended operating conditions, see <a href="#">Table 3</a> . |                |                        |                        |               |         |

This table provides the recommended operating conditions for the DDR SDRAM controller when interfacing to DDR4 SDRAM.

**Table 26. DDR4 SDRAM interface DC electrical characteristics ( $G1V_{DD} = 1.2\text{ V}$ )<sup>1, 5</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | Symbol   | Min                           | Max                           | Unit          | Note |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-------------------------------|-------------------------------|---------------|------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | $V_{IH}$ | $0.7 \times G1V_{DD} + 0.175$ | —                             | V             | 2, 7 |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | $V_{IL}$ | —                             | $0.7 \times G1V_{DD} - 0.175$ | V             | 2, 7 |
| I/O leakage current                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | $I_{OZ}$ | -165                          | 165                           | $\mu\text{A}$ | 3    |
| <b>Notes:</b><br>1. $G1V_{DD}$ is expected to be within 60 mV of the DRAM's voltage supply at all times. The DRAM's and memory controller's voltage supply may or may not be from the same source.<br>2. Input capacitance load for MDQ, MDQS, and MDQS_B are available in the IBIS models.<br>3. Output leakage is measured with all outputs disabled ( $0\text{ V} \leq V_{OUT} \leq G1V_{DD}$ ).<br>4. Refer to the IBIS model for the complete output IV curve characteristics.<br>5. For recommended operating conditions, see <a href="#">Table 3</a> .<br>6. $V_{TT}$ and $V_{REFCA}$ are applied directly to the DRAM device. Both $V_{TT}$ and $V_{REFCA}$ voltages must track $G1V_{DD}/2$ .<br>7. Internal Vref for data bus must be set to $0.7 \times G1V_{DD}$ . |          |                               |                               |               |      |

This table provides the current draw characteristics for  $Dn\_MV_{REF}$ .

**Table 27. Current draw characteristics for  $Dn\_MV_{REF}$ <sup>1</sup>**

| Parameter                                                              | Symbol          | Min | Max | Unit    | Notes |
|------------------------------------------------------------------------|-----------------|-----|-----|---------|-------|
| Current draw for DDR3L SDRAM for $Dn\_MV_{REF}$                        | $I_{Dn\_MVREF}$ | —   | 500 | $\mu A$ | —     |
| <b>Note:</b>                                                           |                 |     |     |         |       |
| 1. For recommended operating conditions, see <a href="#">Table 3</a> . |                 |     |     |         |       |

### 3.9.2 DDR3L and DDR4 SDRAM interface AC timing specifications

This section provides the AC timing specifications for the DDR SDRAM controller interface. The DDR controller supports DDR3L and DDR4 memories. Note that the required  $G1V_{DD}(typ)$  voltage is 1.35 V or 1.2 V when interfacing to DDR3L or DDR4 SDRAM respectively.

#### 3.9.2.1 DDR3L and DDR4 SDRAM interface input AC timing specifications

This table provides the input AC timing specifications for the DDR controller when interfacing to DDR4 SDRAM.

**Table 29. DDR4 SDRAM interface input AC timing specifications ( $GV_{DD} = 1.2 V \pm 5\%$ )<sup>4</sup>**

|                       |                           | Symbol     | Min                          | Max                          | Unit | Notes |
|-----------------------|---------------------------|------------|------------------------------|------------------------------|------|-------|
| AC input low voltage  | $\leq 1600MT/s$ data rate | $V_{ILAC}$ | —                            | $0.7 \times GV_{DD} + 0.175$ | V    | —     |
| AC input high voltage | $\leq 1600MT/s$ data rate | $V_{IHAC}$ | $0.7 \times GV_{DD} + 0.175$ | —                            | V    | —     |

This table provides the input AC timing specifications for the DDR controller when interfacing to DDR3L and DDR4 SDRAM.

**Table 30. DDR3L and DDR4 SDRAM interface input AC timing specifications<sup>3</sup>**

| Parameter                         | Symbol       | Min  | Max | Unit | Notes |
|-----------------------------------|--------------|------|-----|------|-------|
| Controller skew for MDQS-MDQ/MECC | $t_{CISKEW}$ | —    | —   | ps   | 1     |
| 1600 MT/s data rate               |              | -112 | 112 |      | 1     |
| 1333 MT/s data rate               |              | -125 | 125 |      | 1     |
| 1200 MT/s data rate               |              | -142 | 142 |      | 1, 3  |
| 1000 MT/s data rate               |              | -170 | 170 |      | 1, 3  |
| Tolerated skew for MDQS-MDQ/MECC  | $t_{DISKEW}$ | —    | —   | ps   | 2     |
| 1600 MT/s data rate               |              | -200 | 200 |      | 2     |

Table continues on the next page...

**Table 30. DDR3L and DDR4 SDRAM interface input AC timing specifications<sup>3</sup> (continued)**

| Parameter           | Symbol | Min  | Max | Unit | Notes |
|---------------------|--------|------|-----|------|-------|
| 1333 MT/s data rate |        | -250 | 250 |      | 2     |
| 1200 MT/s data rate |        | -275 | 275 |      | 2, 3  |
| 1000 MT/s data rate |        | -300 | 300 |      | 2, 3  |

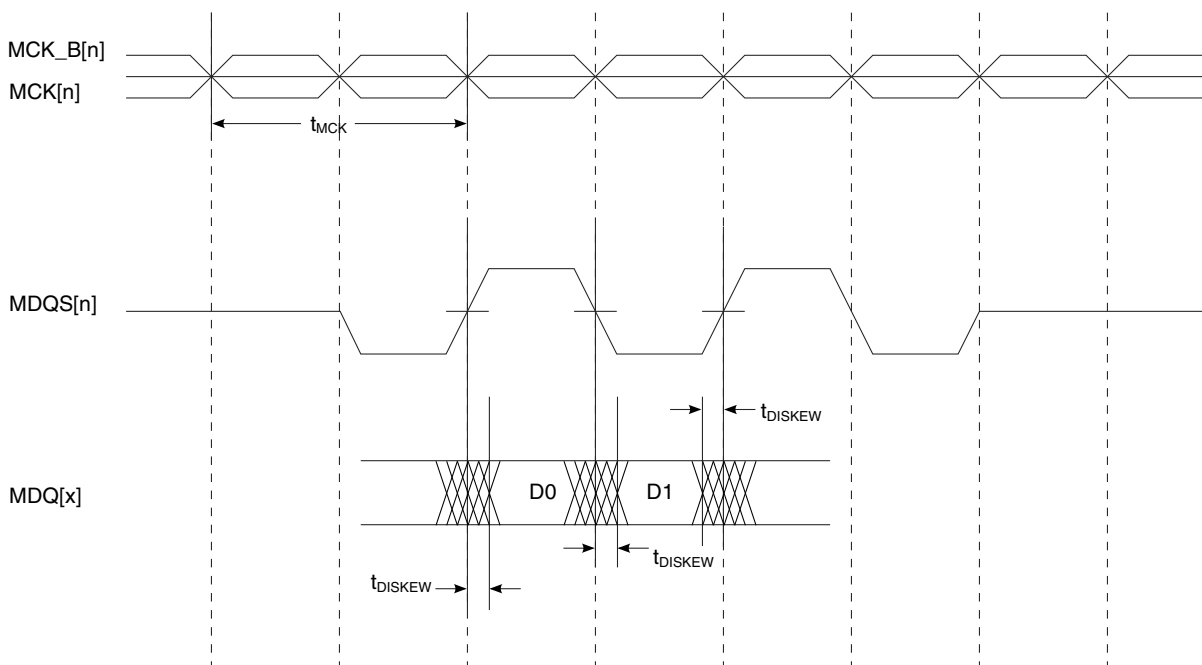
**Notes:**

1.  $t_{CISKEW}$  represents the total amount of skew consumed by the controller between MDQS[n] and any corresponding bit that is captured with MDQS[n]. This must be subtracted from the total timing budget.

2. The amount of skew that can be tolerated from MDQS to a corresponding MDQ signal is called  $t_{DISKEW}$ . This can be determined by the following equation:  $t_{DISKEW} = \pm(T \div 4 - \text{abs}(t_{CISKEW}))$  where T is the clock period and  $\text{abs}(t_{CISKEW})$  is the absolute value of  $t_{CISKEW}$ .

3. DDR3L only

This figure shows the DDR3L and DDR4 SDRAM interface input timing diagram.

**Figure 11. DDR3L and DDR4 SDRAM interface input timing diagram**

### 3.9.2.2 DDR3L and DDR4 SDRAM interface output AC timing specifications

This table provides the output AC timing targets for the DDR3L and DDR4 SDRAM interface.

**Table 31. DDR3L and DDR4 SDRAM interface output AC timing specifications<sup>7</sup>**

| Parameter                                      | Symbol <sup>1</sup> | Min                  | Max                  | Unit | Notes |
|------------------------------------------------|---------------------|----------------------|----------------------|------|-------|
| MCK[n] cycle time                              | $t_{MCK}$           | 1250                 | 2000                 | ps   | 2     |
| ADDR/CMD/CNTL output setup with respect to MCK | $t_{DDKHAS}$        | —                    | —                    | ps   | 3     |
| 1600 MT/s data rate                            |                     | 495                  | —                    |      | 3     |
| 1333 MT/s data rate                            |                     | 606                  | —                    |      | 3     |
| 1200 MT/s data rate                            |                     | 675                  | —                    |      | 3, 6  |
| 1000 MT/s data rate                            |                     | 744                  | —                    |      | 3, 6  |
| ADDR/CMD/CNTL output hold with respect to MCK  | $t_{DDKHAX}$        | —                    | —                    | ps   | 3     |
| 1600 MT/s data rate                            |                     | 495                  | —                    |      | 3     |
| 1333 MT/s data rate                            |                     | 606                  | —                    |      | 3     |
| 1200 MT/s data rate                            |                     | 675                  | —                    |      | 3, 6  |
| 1000 MT/s data rate                            |                     | 744                  | —                    |      | 3, 6  |
| MCK to MDQS skew                               | $t_{DDKMH}$         | —                    | —                    | ps   | 4     |
| 1000 MT/s data rate, $\leq$ 1600MT/s data rate |                     | -245                 | 245                  |      | 4, 7  |
| MDQ/MECC/MDM output data eye                   | $t_{DDKXDEYE}$      | —                    | —                    | ps   | 5     |
| 1600 MT/s data rate                            |                     | 400                  | —                    |      | 5     |
| 1333 MT/s data rate                            |                     | 500                  | —                    |      | 5     |
| 1200 MT/s data rate                            |                     | 550                  | —                    |      | 5, 6  |
| 1000 MT/s data rate                            |                     | 600                  | —                    |      | 5, 6  |
| MDQS preamble                                  | $t_{DDKHMP}$        | $0.9 \times t_{MCK}$ | —                    | ps   | —     |
| MDQS postamble                                 | $t_{DDKHME}$        | $0.4 \times t_{MCK}$ | $0.6 \times t_{MCK}$ | ps   | —     |

**Notes:**

1. The symbols used for timing specifications follow these patterns:  $t_{(\text{first two letters of functional block})(\text{signal})(\text{state})(\text{reference})(\text{state})}$  for inputs and  $t_{(\text{first two letters of functional block})(\text{reference})(\text{state})(\text{signal})(\text{state})}$  for outputs. Output hold time can be read as DDR timing (DD) from the rising or falling edge of the reference clock (KH or KL) until the output went invalid (AX or DX). For example,  $t_{DDKHAS}$  symbolizes DDR timing (DD) for the time  $t_{MCK}$  memory clock reference (K) goes from the high (H) state until outputs (A) are setup (S) or output valid time. Also,  $t_{DDKLDX}$  symbolizes DDR timing (DD) for the time  $t_{MCK}$  memory clock reference (K) goes low (L) until data outputs (D) are invalid (X) or data output hold time.

2. All MCK/MCK\_B and MDQS/MDQS\_B referenced measurements are made from the crossing of the two signals. Note: The range of operating frequency for MCK are part dependent, enter the range that applies to your part.

3. ADDR/CMD includes all DDR SDRAM output signals except MCK/MCK\_B, MCS\_B, and MDQ/MECC/MDM/MDQS.

4.  $t_{DDKMH}$  follows the symbol conventions described in note 1. For example,  $t_{DDKMH}$  describes the DDR timing (DD) from the rising edge of the MCK[n] clock (KH) until the MDQS signal is valid (MH).  $t_{DDKMH}$  can be modified through control of the MDQS override bits (called WR\_DATA\_DELAY) in the TIMING\_CFG\_2 register. This is typically set to the same delay as in DDR\_SDRAM\_CLK\_CNTL[CLK\_ADJUST]. The timing parameters listed in the table assume that these two parameters have been set to the same adjustment value. See the chip reference manual for a description and explanation of the timing modifications enabled by the use of these bits.

5. Available eye for data (MDQ), ECC (MECC), and data mask (MDM) outputs at the pin of the processor. Memory controller will center the strobe (MDQS) in the available data eye at the DRAM (end point) during the initialization.

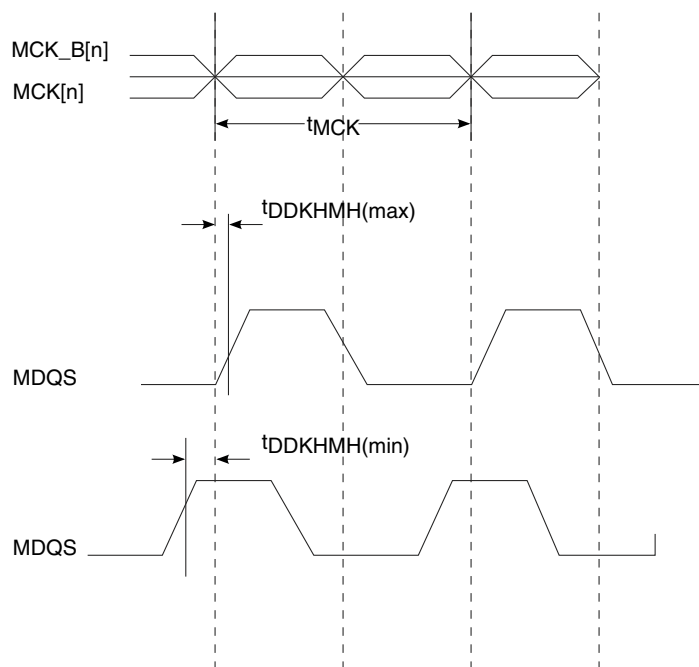
6. DDR3L only

7. It is required to program the start value of the DQS adjust for write leveling. Note:  $t_{DDKMH}$  is required to program the start value of the DQS adjust for write leveling. This is a more relaxed timing window than meeting  $t_{DQSS}$  at the DRAM. This is why the  $t_{DDKMH}$  numbers for 1200/1333/1600 consume a higher percentage of the timing budget.

**NOTE**

For the ADDR/CMD setup and hold specifications in [Table 3](#), it is assumed that the clock control register is set to adjust the memory clocks by ½ applied cycle.

This figure shows the DDR3L and DDR4 SDRAM interface output timing for the MCK to MDQS skew measurement ( $t_{DDKMHM}$ ).



**Figure 12.  $t_{DDKMHM}$  timing diagram**

This figure shows the DDR3L and DDR4 SDRAM output timing diagram.

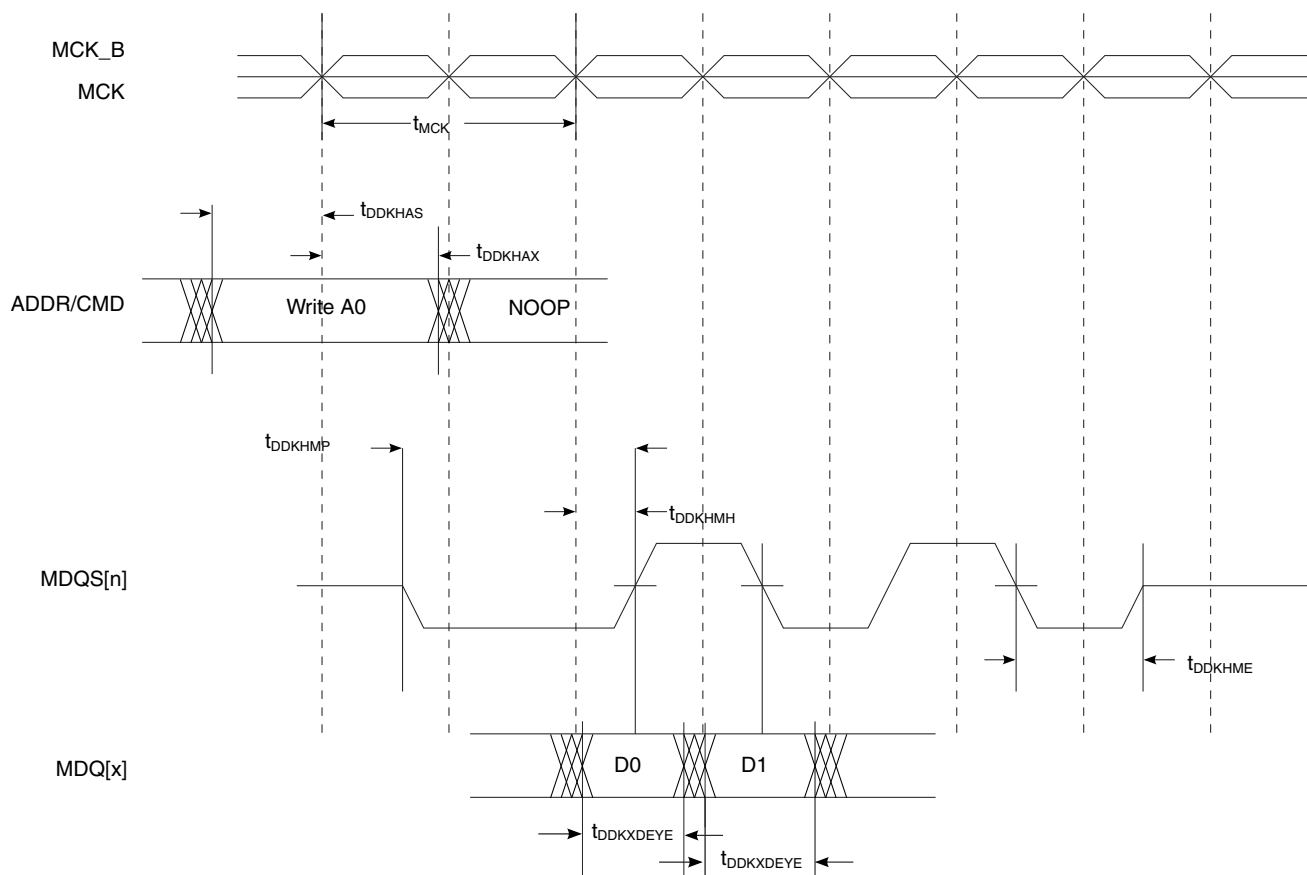


Figure 13. DDR3L and DDR4 output timing diagram

### 3.10 DUART interface

This section describes the DC and AC electrical specifications for the DUART interface.

#### 3.10.1 DUART DC electrical characteristics

This table provides the DC electrical characteristics for the DUART interface at  $DV_{DD}/D1V_{DD} = 3.3\text{ V}$ .

Table 32. DUART DC electrical characteristics (3.3 V)<sup>3</sup>

| Parameter                                                                         | Symbol   | Min                   | Max                   | Unit          | Notes |
|-----------------------------------------------------------------------------------|----------|-----------------------|-----------------------|---------------|-------|
| Input high voltage                                                                | $V_{IH}$ | $0.7 \times D1V_{DD}$ | —                     | V             | 1     |
| Input low voltage                                                                 | $V_{IL}$ | —                     | $0.2 \times D1V_{DD}$ | V             | 1     |
| Input current ( $DV_{IN}/D1V_{IN} = 0\text{ V}$ or $DV_{IN} = DV_{DD}/D1V_{DD}$ ) | $I_{IN}$ | —                     | $\pm 50$              | $\mu\text{A}$ | 2     |

Table continues on the next page...

**Table 32. DUART DC electrical characteristics (3.3 V)<sup>3</sup> (continued)**

| Parameter                                                                                                                                                                                                                                                                                                                                                          | Symbol   | Min | Max | Unit | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----|-----|------|-------|
| Output high voltage ( $I_{OH} = -2.0$ mA)                                                                                                                                                                                                                                                                                                                          | $V_{OH}$ | 2.4 | —   | V    | —     |
| Output low voltage ( $I_{OL} = 2.0$ mA)                                                                                                                                                                                                                                                                                                                            | $V_{OL}$ | —   | 0.4 | V    | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $DV_{IN}/D1V_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $DV_{IN}/D1V_{IN}$ represents the input voltage of the supply referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |     |     |      |       |

This table provides the DC electrical characteristics for the DUART interface at  $DV_{DD}/D1V_{DD} = 1.8$  V.

**Table 33. DUART DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                          | Symbol   | Min                   | Max                   | Unit    | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----------------------|-----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                 | $V_{IH}$ | $0.7 \times D1V_{DD}$ | —                     | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                  | $V_{IL}$ | —                     | $0.2 \times D1V_{DD}$ | V       | 1     |
| Input current ( $DV_{IN} = 0$ V or $DV_{IN} = DV_{DD}/D1V_{DD}$ )                                                                                                                                                                                                                                                                                                  | $I_{IN}$ | —                     | $\pm 50$              | $\mu A$ | 2     |
| Output high voltage ( $DV_{DD}/D1V_{DD} = \text{min}$ , $I_{OH} = -0.5$ mA)                                                                                                                                                                                                                                                                                        | $V_{OH}$ | 1.35                  | —                     | V       | —     |
| Output low voltage ( $DV_{DD}/D1V_{DD} = \text{min}$ , $I_{OL} = 0.5$ mA)                                                                                                                                                                                                                                                                                          | $V_{OL}$ | —                     | 0.4                   | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the min and max $DV_{IN}/D1V_{IN}$ respective values found in <a href="#">Table 3</a> .<br>2. The symbol $DV_{IN}/D1V_{IN}$ represents the input voltage of the supply referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                       |                       |         |       |

### 3.10.2 DUART AC timing specifications

This table provides the AC timing specifications for the DUART interface.

**Table 34. DUART AC timing specifications**

| Parameter                                                                                                                                                                                                                                                                                                                                        | Value                           | Unit | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|------|-------|
| Minimum baud rate                                                                                                                                                                                                                                                                                                                                | $f_{PLAT}/(2 \times 1,048,576)$ | baud | 1, 3  |
| Maximum baud rate                                                                                                                                                                                                                                                                                                                                | $f_{PLAT}/(2 \times 16)$        | baud | 1, 2  |
| <b>Notes:</b><br>1. $f_{PLAT}$ refers to the internal platform clock.<br>2. The actual attainable baud rate is limited by the latency of interrupt processing.<br>3. The middle of a start bit is detected as the eighth sampled 0 after the 1-to-0 transition of the start bit. Subsequent bit values are sampled each 16 <sup>th</sup> sample. |                                 |      |       |

### 3.11 Ethernet interface, Ethernet management interface, IEEE Std 1588™

This section describes the DC and AC electrical characteristics for the Ethernet controller, Ethernet management, and IEEE Std 1588 interfaces.

#### 3.11.1 SGMII interface

Each SGMII port features a 4-wire AC-coupled serial link from the SerDes interface of the chip, as shown in [Figure 14](#), where  $C_{TX}$  is the external (on board) AC-coupled capacitor. Each SerDes transmitter differential pair features 100- $\Omega$  output impedance. Each input of the SerDes receiver differential pair features 50- $\Omega$  on-die termination to  $XGND_n$ . The reference circuit of the SerDes transmitter and receiver is shown in [Figure 79](#).

##### 3.11.1.1 SGMII clocking requirements for SD1\_REF\_CLK1\_P and SD1\_REF\_CLK1\_N

When operating in SGMII mode, the  $EC_n\_GTX\_CLK125$  clock is not required for this port. Instead, a SerDes reference clock is required on SD1\_REF\_CLK[1:2]\_P and SD1\_REF\_CLK[1:2]\_N pins. SerDes lanes may be used for SerDes SGMII configurations based on the RCW Configuration field SRDS\_PRTCL.

For more information on these specifications, see [SerDes reference clocks](#).

##### 3.11.1.2 SGMII DC electrical characteristics

This section describes the electrical characteristics for the SGMII interface.

###### 3.11.1.2.1 SGMII transmit DC electrical characteristics

This table provides the SGMII SerDes transmitter AC-coupled DC electrical characteristics. Transmitter DC characteristics are measured at the transmitter outputs ( $SD_n\_TX_n\_P$  and  $SD_n\_TX_n\_N$ ), as shown in [Figure 15](#).

**Table 35. SGMII DC transmitter electrical characteristics ( $X1V_{DD} = 1.35\text{ V}$ )<sup>4</sup>**

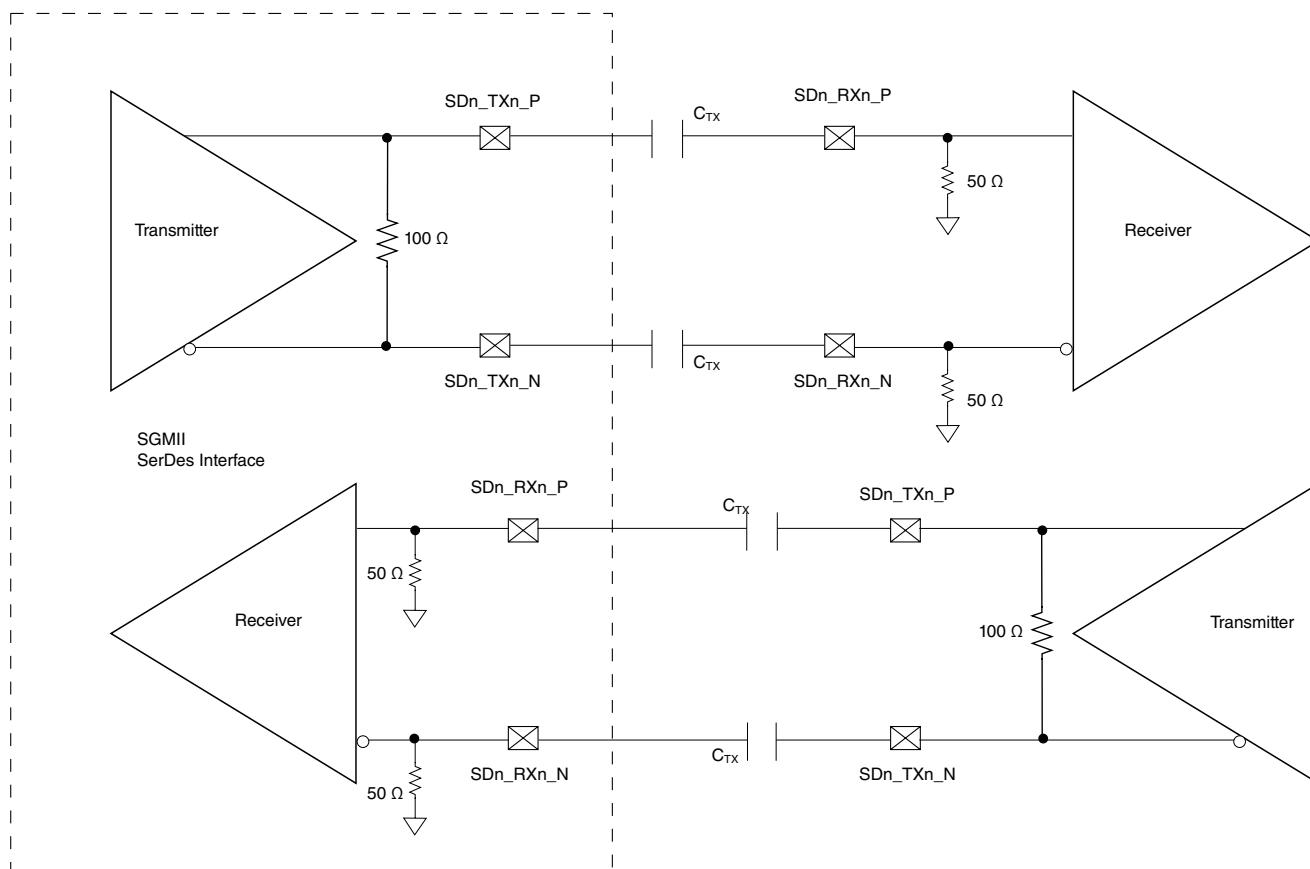
| Parameter           | Symbol   | Min                | Typ | Max                          | Unit | Notes |
|---------------------|----------|--------------------|-----|------------------------------|------|-------|
| Output high voltage | $V_{OH}$ | —                  | —   | $1.35 \times  V_{OD} _{max}$ | mV   | 1     |
| Output low voltage  | $V_{OL}$ | $ V_{OD} _{min}/2$ | —   | —                            | mV   | 1     |

*Table continues on the next page...*

**Table 35. SGMII DC transmitter electrical characteristics (X1V<sub>DD</sub> = 1.35 V)<sup>4</sup> (continued)**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | Symbol          | Min   | Typ   | Max   | Unit | Notes                                 |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-------|-------|-------|------|---------------------------------------|
| Output differential voltage<br>(XV <sub>DD-Typ</sub> at 1.35 V)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | V <sub>OD</sub> | 320   | 500.0 | 725.0 | mV   | 2, 3, 5<br>LNmTECR0[AMP_RED]=0b000000 |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                 | 293.8 | 459.0 | 665.6 |      | 2, 3, 5<br>LNmTECR0[AMP_RED]=0b000001 |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                 | 266.9 | 417.0 | 604.7 |      | 2, 3, 5<br>LNmTECR0[AMP_RED]=0b000011 |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                 | 240.6 | 376.0 | 545.2 |      | 2, 3, 5<br>LNmTECR0[AMP_RED]=0b000010 |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                 | 213.1 | 333.0 | 482.9 |      | 2, 3, 5<br>LNmTECR0[AMP_RED]=0b000110 |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                 | 186.9 | 292.0 | 423.4 |      | 2, 3, 5<br>LNmTECR0[AMP_RED]=0b000111 |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                 | 160.0 | 250.0 | 362.5 |      | 2, 3, 5<br>LNmTECR0[AMP_RED]=0b010000 |
| Output impedance (differential)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | R <sub>O</sub>  | 80    | 100   | 120   | Ω    | —                                     |
| <b>Notes:</b><br>1. This does not align to DC-coupled SGMII.<br>2. $ V_{OD}  =  V_{SD\_TXn\_P} - V_{SD\_TXn\_N} $ .  V <sub>OD</sub>   is also referred to as output differential peak voltage. V <sub>TX-DIFFP-P</sub> = 2 ×  V <sub>OD</sub>  .<br>3. The  V <sub>OD</sub>   value shown in the Typ column is based on the condition of X1V <sub>DD-Typ</sub> = 1.35 V, no common mode offset variation. SerDes transmitter is terminated with 100-Ω differential load between SDn_TXn_P and SDn_TXn_N.<br>4. For recommended operating conditions, see <a href="#">Table 3</a> .<br>5. Example amplitude reduction setting for SGMII on SerDes1 lane E: SRDS1LN4TECR0[AMP_RED] = 0b000001 for an output differential voltage of 459 mV typical. |                 |       |       |       |      |                                       |

This figure shows an example of a 4-wire AC-coupled SGMII serial link connection.



**Figure 14. 4-wire AC-coupled SGMII serial link connection example**

This figure shows the SGMII transmitter DC measurement circuit.

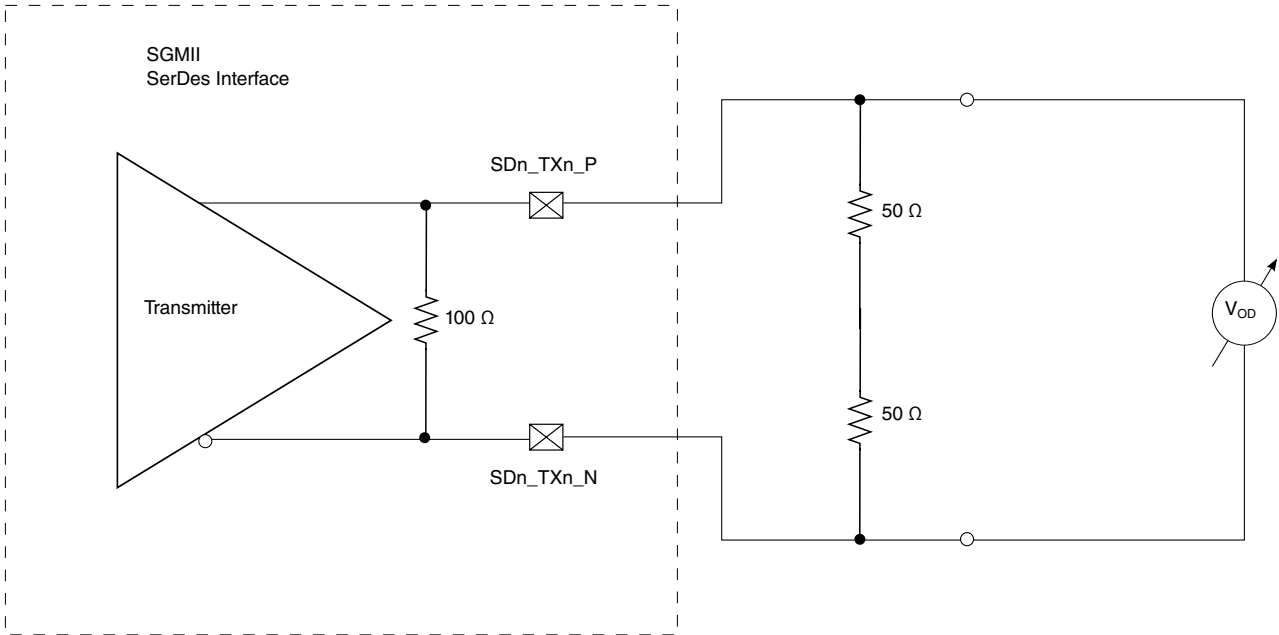


Figure 15. SGMII transmitter DC measurement circuit

3.11.1.2.2 SGMII receiver DC electrical characteristics

This table provides the SGMII receiver DC electrical characteristics. Source-synchronous clocking is not supported. Clock is recovered from the data.

Table 36. SGMII receiver DC electrical characteristics (S1V<sub>DD</sub> = 1.0V)<sup>4</sup>

| Parameter                                                                                                                                                                                                                                                                                         |   | Symbol                  | Min | Typ | Max  | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|-------------------------|-----|-----|------|------|-------|
| DC input voltage range                                                                                                                                                                                                                                                                            |   | —                       | N/A |     |      | —    | 1     |
| Input differential voltage                                                                                                                                                                                                                                                                        | — | V <sub>RX_DIFFp-p</sub> | 100 | —   | 1200 | mV   | 2     |
|                                                                                                                                                                                                                                                                                                   | — |                         | 175 | —   |      |      |       |
| Loss of signal threshold                                                                                                                                                                                                                                                                          | — | V <sub>LOS</sub>        | 30  | —   | 100  | mV   | 3     |
|                                                                                                                                                                                                                                                                                                   | — |                         | 65  | —   | 175  |      |       |
| Receiver differential input impedance                                                                                                                                                                                                                                                             |   | Z <sub>RX_DIFF</sub>    | 80  | —   | 120  | Ω    | —     |
| <b>Notes:</b>                                                                                                                                                                                                                                                                                     |   |                         |     |     |      |      |       |
| 1. Input must be externally AC coupled.                                                                                                                                                                                                                                                           |   |                         |     |     |      |      |       |
| 2. V <sub>RX_DIFFp-p</sub> is also referred to as peak-to-peak input differential voltage.                                                                                                                                                                                                        |   |                         |     |     |      |      |       |
| 3. The concept of this parameter is equivalent to the electrical idle detect threshold parameter in PCI Express. For further explanation, see <a href="#">PCI Express DC physical layer receiver specifications</a> , and <a href="#">PCI Express AC physical layer receiver specifications</a> . |   |                         |     |     |      |      |       |
| 4. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                                                                                                                                                                            |   |                         |     |     |      |      |       |

### 3.11.1.3 SGMII AC timing specifications

This section describes the AC timing specifications for the SGMII interface.

#### 3.11.1.3.1 SGMII transmit AC timing specifications

This table provides the SGMII transmit AC timing specifications. Source-synchronous clocking is not supported. The AC timing specifications do not include RefClk jitter.

**Table 37. SGMII transmit AC timing specifications<sup>4</sup>**

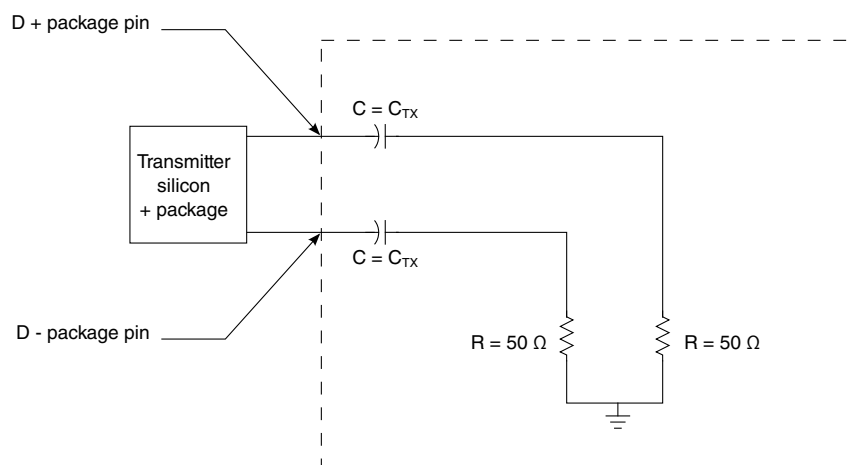
| Parameter                         | Symbol          | Min           | Typ | Max           | Unit   | Notes |
|-----------------------------------|-----------------|---------------|-----|---------------|--------|-------|
| Deterministic jitter              | JD              | —             | —   | 0.17          | UI p-p | —     |
| Total jitter                      | JT              | —             | —   | 0.35          | UI p-p | 2     |
| Unit Interval: 1.25 GBaud (SGMII) | UI              | 800 - 100 ppm | 800 | 800 + 100 ppm | ps     | 1     |
| AC coupling capacitor             | C <sub>TX</sub> | 10            | —   | 200           | nF     | 3     |

**Notes:**

- Each UI is 800 ps ± 100 ppm or 320 ps ± 100 ppm.
- See [Figure 17](#) for single frequency sinusoidal jitter measurements.
- The external AC coupling capacitor of 100 nF is required. It is recommended to place it near the device transmitter outputs.
- For recommended operating conditions, see [Table 3](#).

#### 3.11.1.3.2 SGMII AC measurement details

Transmitter and receiver AC characteristics are measured at the transmitter outputs (SDn\_TXn\_P and SDn\_TXn\_N) or at the receiver inputs (SDn\_RXn\_P and SDn\_RXn\_N) respectively, as shown in this figure.



**Figure 16. SGMII AC test/measurement load**

### 3.11.1.3.3 SGMII receiver AC timing specifications

This table provides the SGMII receiver AC timing specifications. Source-synchronous clocking is not supported. Clock is recovered from the data. These AC timing specifications do not include RefClk jitter.

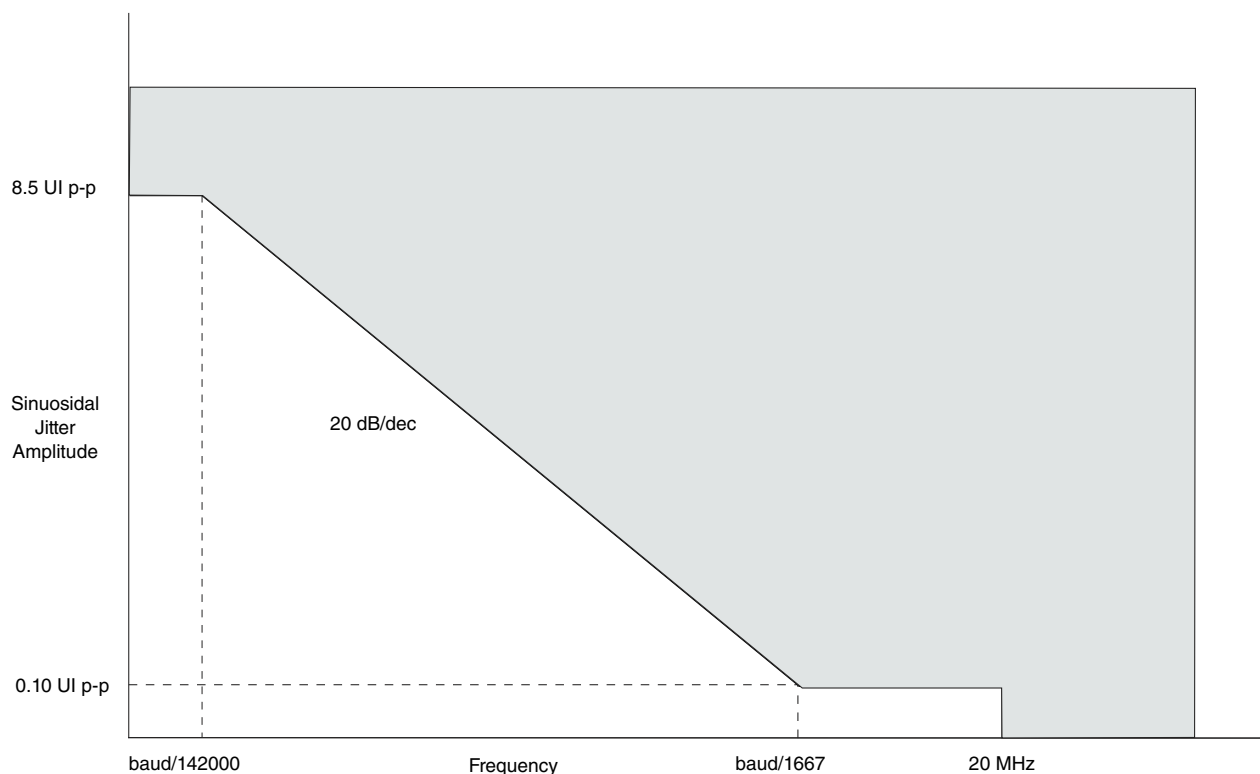
**Table 38. SGMII Receive AC timing specifications<sup>3</sup>**

| Parameter                                          | Symbol          | Min           | Typ | Max               | Unit   | Notes |
|----------------------------------------------------|-----------------|---------------|-----|-------------------|--------|-------|
| Deterministic jitter tolerance                     | J <sub>D</sub>  | —             | —   | 0.37              | UI p-p | 1     |
| Combined deterministic and random jitter tolerance | J <sub>DR</sub> | —             | —   | 0.55              | UI p-p | 1     |
| Total jitter tolerance                             | J <sub>T</sub>  | —             | —   | 0.65              | UI p-p | 1, 2  |
| Bit error ratio                                    | BER             | —             | —   | 10 <sup>-12</sup> | —      | —     |
| Unit Interval: 1.25 GBaud (SGMII)                  | UI              | 800 - 100 ppm | 800 | 800 + 100 ppm     | ps     | 1     |

**Notes:**

1. Measured at the receiver.
2. Total jitter tolerance is composed of three components: deterministic jitter, random jitter, and single-frequency sinusoidal jitter. The sinusoidal jitter may have any amplitude and frequency in the unshaded region of [Figure 17](#). The sinusoidal jitter component is included to ensure margin for low frequency jitter, wander, noise, crosstalk, and other variable system effects.
3. For recommended operating conditions, see [Table 3](#).

The sinusoidal jitter in the total jitter tolerance may have any amplitude and frequency in the unshaded region of this figure.



**Figure 17. Single-frequency sinusoidal jitter limits**

### 3.11.2 RGMII electrical specifications

This section describes the electrical characteristics for the RGMII interface.

#### 3.11.2.1 RGMII DC electrical characteristics

This table provides the DC electrical characteristics for the RGMII interface at  $LV_{DD}$ ,  $L1V_{DD} = 2.5\text{ V}$ .

**Table 39. RGMII DC electrical characteristics ( $LV_{DD}$ ,  $L1V_{DD} = 2.5\text{ V}$ )<sup>4</sup>**

| Parameters                                                                 | Symbol   | Min                   | Max                   | Unit          | Notes |
|----------------------------------------------------------------------------|----------|-----------------------|-----------------------|---------------|-------|
| Input high voltage                                                         | $V_{IH}$ | $0.7 \times L1V_{DD}$ | —                     | V             | 1     |
| Input low voltage                                                          | $V_{IL}$ | —                     | $0.2 \times L1V_{DD}$ | V             | 1     |
| Input current ( $LV_{IN}=0\text{ V}$ or $LV_{IN}=LV_{DD}$ )                | $I_{IH}$ | —                     | $\pm 50$              | $\mu\text{A}$ | 2, 3  |
| Output high voltage ( $LV_{DD} = \text{min}$ , $I_{OH} = -1.0\text{ mA}$ ) | $V_{OH}$ | 2.00                  | —                     | V             | 3     |
| Output low voltage ( $LV_{DD} = \text{min}$ , $I_{OL} = 1.0\text{ mA}$ )   | $V_{OL}$ | —                     | 0.4                   | V             | 3     |

**Notes:**

1. The min  $V_{IL}$  and max  $V_{IH}$  values are based on the respective min and max  $LV_{IN}$  values found in [Table 3](#).
2. The symbol  $LV_{IN}$ , in this case, represents the  $LV_{IN}$  and  $L1V_{IN}$  symbol referenced in [Table 3](#).

**Table 39. RGMII DC electrical characteristics (LV<sub>DD</sub>, L1V<sub>DD</sub> = 2.5 V)<sup>4</sup>**

| Parameters                                                                                                                                          | Symbol | Min | Max | Unit | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|-----|------|-------|
| 3. The symbol LV <sub>DD</sub> , in this case, represents the LV <sub>DD</sub> and L1V <sub>DD</sub> symbol referenced in <a href="#">Table 3</a> . |        |     |     |      |       |
| 4. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                              |        |     |     |      |       |

This table provides the DC electrical characteristics for the RGMII interface at LV<sub>DD</sub>, L1V<sub>DD</sub> = 1.8 V.

**Table 40. RGMII DC electrical characteristics (LV<sub>DD</sub>, L1V<sub>DD</sub> = 1.8 V)<sup>4</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Symbol          | Min                     | Max                     | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-------------------------|-------------------------|------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | V <sub>IH</sub> | 0.7 x L1V <sub>DD</sub> | —                       | V    | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | V <sub>IL</sub> | —                       | 0.2 x L1V <sub>DD</sub> | V    | 1     |
| Input current (LV <sub>IN</sub> = 0 V or L1V <sub>IN</sub> = LV <sub>DD</sub> )                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | I <sub>IN</sub> | —                       | ±50                     | μA   | 2, 3  |
| Output high voltage (LV <sub>DD</sub> = min, I <sub>OH</sub> = -0.5 mA)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | V <sub>OH</sub> | 1.35                    | —                       | V    | 3     |
| Output low voltage (LV <sub>DD</sub> = min, I <sub>OL</sub> = 0.5 mA)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | V <sub>OL</sub> | —                       | 0.4                     | V    | 3     |
| <b>Notes:</b><br>1. The min V <sub>IL</sub> and max V <sub>IH</sub> values are based on the min and max LV <sub>IN</sub> values found in <a href="#">Table 3</a> .<br>2. The symbol LV <sub>IN</sub> , in this case, represents the LV <sub>IN</sub> and L1V <sub>IN</sub> symbol referenced in <a href="#">Table 3</a> .<br>3. The symbol LV <sub>DD</sub> , in this case, represents the LV <sub>DD</sub> and L1V <sub>DD</sub> symbol referenced in <a href="#">Table 3</a> .<br>4. For recommended operating conditions, see <a href="#">Table 3</a> . |                 |                         |                         |      |       |

### 3.11.2.2 RGMII AC timing specifications

This table provides the RGMII AC timing specifications.

**Table 41. RGMII AC timing specifications (LV<sub>DD</sub>, L1V<sub>DD</sub> = 2.5 / 1.8 V)<sup>8</sup>**

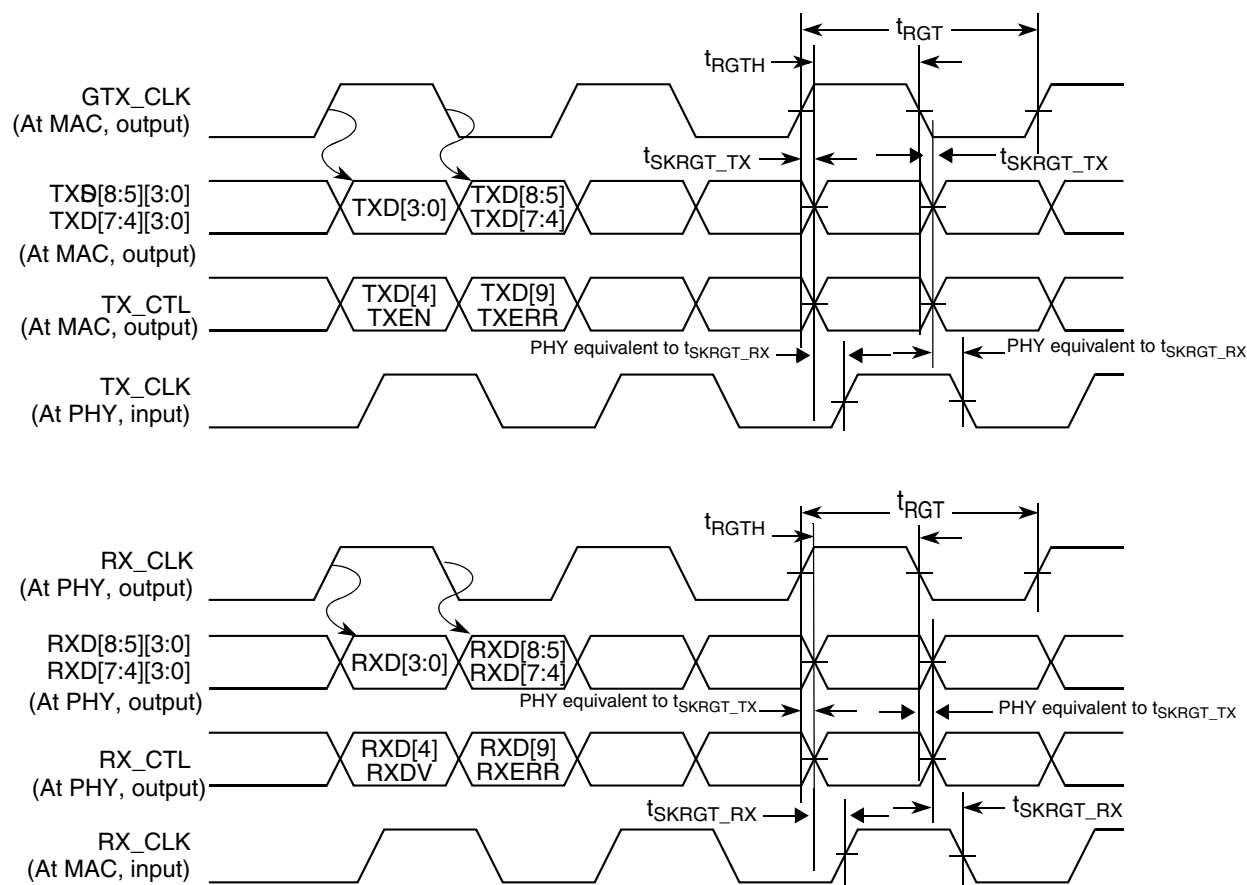
| Parameter/Condition                        | Symbol <sup>1</sup>                 | Min  | Typ | Max  | Unit | Notes |
|--------------------------------------------|-------------------------------------|------|-----|------|------|-------|
| Data to clock output skew (at transmitter) | t <sub>SKRGT_TX</sub>               | -770 | 0   | 700  | ps   | 7     |
| Data to clock input skew (at receiver)     | t <sub>SKRGT_RX</sub>               | 1.4  | —   | 2.6  | ns   | 2     |
| Clock period duration                      | t <sub>RGT</sub>                    | 7.2  | 8.0 | 8.8  | ns   | 3     |
| Duty cycle for 10BASE-T and 100BASE-TX     | t <sub>RGTH</sub> /t <sub>RGT</sub> | 40   | 50  | 60   | %    | 3, 4  |
| Duty cycle for Gigabit                     | t <sub>RGTH</sub> /t <sub>RGT</sub> | 45   | 50  | 55   | %    | —     |
| Rise time (20%-80%)                        | t <sub>RGTR</sub>                   | —    | —   | —    | ns   | 5, 6  |
| L1/LV <sub>DD</sub> = 2.5V                 |                                     |      |     | 0.75 |      |       |
| L1/LV <sub>DD</sub> = 1.8V                 |                                     |      |     | 0.54 |      |       |
| Fall time (20%-80%)                        | t <sub>RGTF</sub>                   | —    | —   | —    | ns   | 5, 6  |
| L1/LV <sub>DD</sub> = 2.5V                 |                                     |      |     | 0.75 |      |       |
| L1/LV <sub>DD</sub> = 1.8V                 |                                     |      |     | 0.54 |      |       |

Table continues on the next page...

**Table 41. RGMII AC timing specifications ( $LV_{DD}$ ,  $L1V_{DD}$  = 2.5 / 1.8 V)<sup>8</sup> (continued)**

| Parameter/Condition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | Symbol <sup>1</sup> | Min | Typ | Max | Unit | Notes |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|-----|-----|-----|------|-------|
| <b>Notes:</b><br>1. In general, the clock reference symbol representation for this section is based on the symbols RGT to represent RGMII timing. Note that the notation for rise (R) and fall (F) times follows the clock symbol that is being represented. For symbols representing skews, the subscript is skew (SK) followed by the clock that is being skewed (RGT).<br>2. This implies that PC board design will require clocks to be routed such that an additional trace delay of greater than 1.5 ns is added to the associated clock signal. Many PHY vendors already incorporate the necessary delay inside their device. If so, additional PCB delay is probably not needed.<br>3. For 10 and 100 Mbps, $t_{RGT}$ scales to 400 ns $\pm$ 40 ns and 40 ns $\pm$ 4 ns, respectively.<br>4. Duty cycle may be stretched/shrunk during speed changes or while transitioning to a received packet's clock domains as long as the minimum duty cycle is not violated and stretching occurs for no more than three $t_{RGT}$ of the lowest speed transitioned between.<br>5. Applies to inputs and outputs.<br>6. The system/board must be designed to ensure this input requirement to the chip is achieved. Proper device operation is guaranteed for inputs meeting this requirement by design, simulation, characterization, or functional testing.<br>7. The frequency of ECn_RX_CLK (input) should not exceed the frequency of ECn_GTX_CLK (output) by more than 300 ppm.<br>8. For recommended operating conditions, see <a href="#">Table 3</a> . |                     |     |     |     |      |       |

This figure shows the RGMII AC timing and multiplexing diagrams.



**Figure 18. RGMII AC timing and multiplexing diagrams**

### Warning

NXP guarantees timings generated from the MAC. Board designers must ensure delays needed at the PHY or the MAC.

## 3.11.3 MII, RMII electrical specifications

This section describes the electrical characteristics for the MII and RMII interfaces.

### 3.11.3.1 MII, RMII DC electrical characteristics

This table provides the MII and RMII DC electrical characteristics when operating at  $LV_{DD}$ ,  $L1V_{DD} = 3.3$  V.

**Table 42. MII and RMI DC electrical characteristics**

| Parameter                                                                                                                                                                                                                                                                | Symbol   | Min                   | Max                   | Unit    | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----------------------|-----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                       | $V_{IH}$ | $0.7 \times L1V_{DD}$ | —                     | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                        | $V_{IL}$ | —                     | $0.2 \times L1V_{DD}$ | V       | —     |
| Input high current ( $V_{IN} = L1V_{DD}$ )                                                                                                                                                                                                                               | $I_{IH}$ | —                     | 50                    | $\mu A$ | 2     |
| Input low current ( $V_{IN} = GND$ )                                                                                                                                                                                                                                     | $I_{IL}$ | -50                   | —                     | $\mu A$ | 2     |
| Output high voltage ( $L1V_{DD} = \min$ , $I_{OH} = -2.0 \text{ mA}$ )                                                                                                                                                                                                   | $V_{OH}$ | 2.4                   | —                     | V       | —     |
| Output low voltage ( $L1V_{DD} = \min$ , $I_{OL} = 2.0 \text{ mA}$ )                                                                                                                                                                                                     | $V_{OL}$ | —                     | 0.40                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $L1V_{IN}$ values found in <a href="#">Table 3</a><br>2. The symbol $V_{IN}$ , in this case, represents the $L1V_{IN}$ symbol referenced in <a href="#">Table 3</a> |          |                       |                       |         |       |

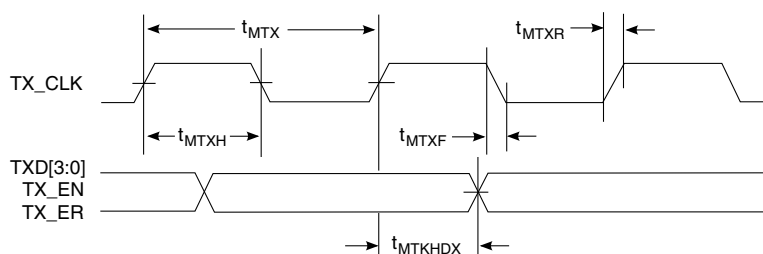
### 3.11.3.2 MII AC timing specifications

This table describes the MII transmit and receive AC timing specifications.

**Table 43. MII transmit AC timing specifications**

| Parameter                                       | Symbol             | Min | Typ | Max | Unit |
|-------------------------------------------------|--------------------|-----|-----|-----|------|
| TX_CLK clock period 10 Mbps                     | $t_{MTX}$          | —   | 400 | —   | ns   |
| TX_CLK clock period 100 Mbps                    | $t_{MTX}$          | —   | 40  | —   | ns   |
| TX_CLK duty cycle                               | $t_{MTXH}/t_{MTX}$ | 35  | —   | 65  | %    |
| TX_CLK to MII data TXD[3:0], TX_ER, TX_EN delay | $t_{MTKHDX}$       | 0   | —   | 25  | ns   |
| TX_CLK data clock rise (20%-80%)                | $t_{MTXR}$         | 1.0 | —   | 4.0 | ns   |
| TX_CLK data clock fall (80%-20%)                | $t_{MTXF}$         | 1.0 | —   | 4.0 | ns   |

This figure shows the MII transmit AC timing diagram.

**Figure 19. MII transmit AC timing diagram**

This table provides the MII receive AC timing specifications.

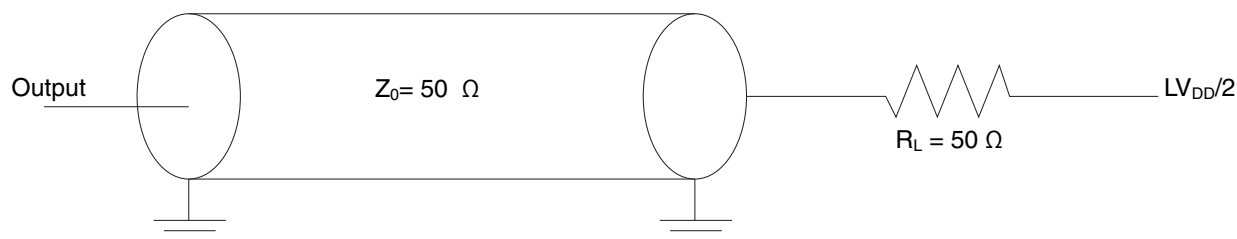
**Table 44. MII receive AC timing specifications<sup>1</sup>**

| Parameter                                   | Symbol             | Min  | Typ | Max | Unit |
|---------------------------------------------|--------------------|------|-----|-----|------|
| RX_CLK clock period 10 Mbps                 | $t_{MRX}$          | —    | 400 | —   | ns   |
| RX_CLK clock period 100 Mbps                | $t_{MRX}$          | —    | 40  | —   | ns   |
| RX_CLK duty cycle                           | $t_{MRXH}/t_{MRX}$ | 35   | —   | 65  | %    |
| RXD[3:0], RX_DV, RX_ER setup time to RX_CLK | $t_{MRDVKH}$       | 10.0 | —   | —   | ns   |
| RXD[3:0], RX_DV, RX_ER hold time to RX_CLK  | $t_{MRDXKH}$       | 10.0 | —   | —   | ns   |
| RX_CLK clock rise (20%-80%)                 | $t_{MRXR}$         | 1.0  | —   | 4.0 | ns   |
| RX_CLK clock fall time (80%-20%)            | $t_{MRXF}$         | 1.0  | —   | 4.0 | ns   |

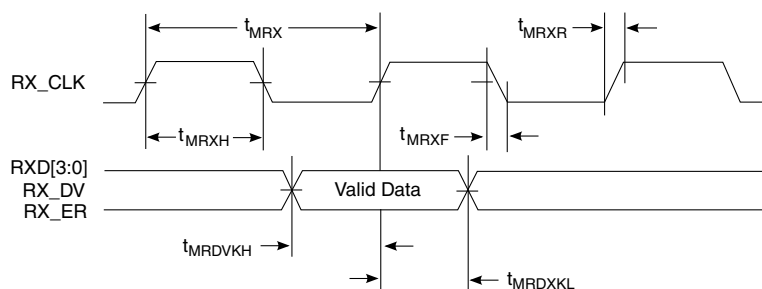
**Note:**

1. The frequency of RX\_CLK (input) should not exceed the frequency of TX\_CLK (input) by more than 300 ppm.

This figure shows the AC test load for the Ethernet controller.

**Figure 20. Ethernet controller AC test load**

This figure shows the MII receive AC timing diagram.

**Figure 21. MII receive AC timing diagram**

### 3.11.4 RMI AC timing specifications

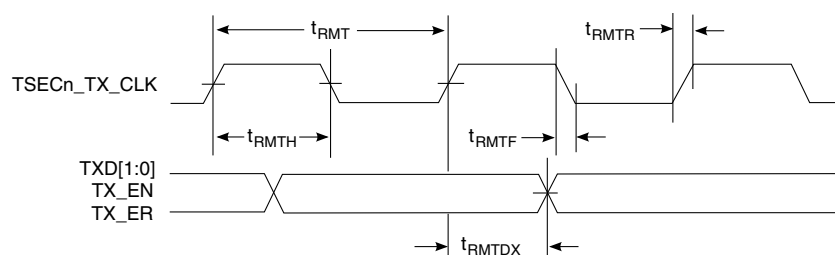
In RMI mode, the reference clock should be fed to TSEC<sub>n</sub>\_TX\_CLK. This section describes the RMI transmit and receive AC timing specifications.

This table provides the RMI transmit AC timing specifications.

**Table 45. RMI transmit AC timing specifications<sup>1</sup>**

| Parameter                                                   | Symbol      | Min | Typ  | Max  | Unit |
|-------------------------------------------------------------|-------------|-----|------|------|------|
| TSEC <sub>n</sub> _TX_CLK clock period                      | $t_{RMT}$   | —   | 20.0 | —    | ns   |
| TSEC <sub>n</sub> _TX_CLK duty cycle                        | $t_{RMTH}$  | 35  | —    | 65   | %    |
| TSEC <sub>n</sub> _TX_CLK peak-to-peak jitter               | $t_{RMTJ}$  | —   | —    | 250  | ps   |
| Rise time TSEC <sub>n</sub> _TX_CLK (20%-80%)               | $t_{RMTR}$  | 1.0 | —    | 5.0  | ns   |
| Fall time TSEC <sub>n</sub> _TX_CLK (80%-20%)               | $t_{RMTRF}$ | 1.0 | —    | 5.0  | ns   |
| TSEC <sub>n</sub> _TX_CLK to RMI data TXD[1:0], TX_EN delay | $t_{RMTDX}$ | 2.0 | —    | 10.0 | ns   |

This figure shows the RMI transmit AC timing diagram.



**Figure 22. RMI transmit AC timing diagram**

This table provides the RMI receive AC timing specifications.

**Table 46. RMI receive AC timing specifications<sup>1</sup>**

| Parameter                                                                    | Symbol      | Min | Typ  | Max | Unit |
|------------------------------------------------------------------------------|-------------|-----|------|-----|------|
| TSEC <sub>n</sub> _TX_CLK clock period                                       | $t_{RMR}$   | —   | 20.0 | —   | ns   |
| TSEC <sub>n</sub> _TX_CLK duty cycle                                         | $t_{RMRH}$  | 35  | —    | 65  | %    |
| TSEC <sub>n</sub> _TX_CLK peak-to-peak jitter                                | $t_{RMRJ}$  | —   | —    | 250 | ps   |
| Rise time TSEC <sub>n</sub> _TX_CLK (20%-80%)                                | $t_{RMRR}$  | 1.0 | —    | 5.0 | ns   |
| Fall time TSEC <sub>n</sub> _TX_CLK (80%-20%)                                | $t_{RMRF}$  | 1.0 | —    | 5.0 | ns   |
| RXD[1:0], CRS_DV, RX_ER set-up time to TSEC <sub>n</sub> _TX_CLK rising edge | $t_{RMRDV}$ | 4.0 | —    | —   | ns   |
| RXD[1:0], CRS_DV, RX_ER hold time to TSEC <sub>n</sub> _TX_CLK rising edge   | $t_{RMRDX}$ | 2.0 | —    | —   | ns   |

This figure shows the AC test load for Ethernet controller.

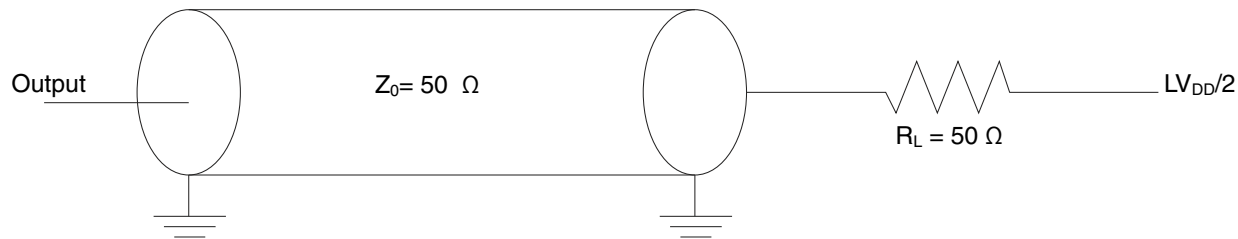


Figure 23. Ethernet controller AC test load

This figure shows the RMI receive AC timing diagram.

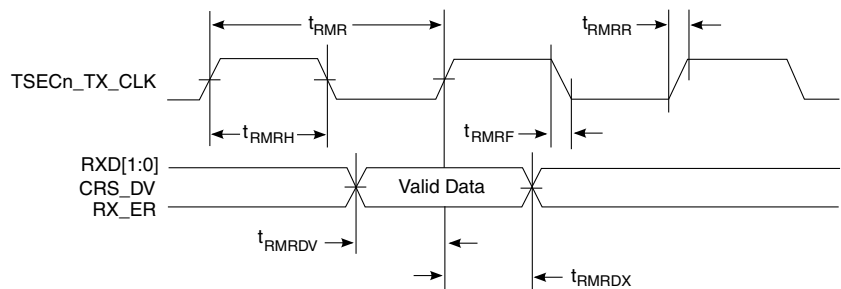


Figure 24. RMI receive AC timing diagram

3.11.5 Ethernet management interface 1 (EMI1)

This section describes the electrical characteristics for the EMI1 interface.

The EMI1 interface timing is compatible with IEEE Std 802.3™ clause 22.

3.11.5.1 EMI1 DC electrical characteristics

This section describes the DC electrical characteristics for EMI1\_MDIO and EMI1\_MDC. The pins are available on L1V<sub>DD</sub>. Please refer to [Table 3](#) for operating voltages.

This table provides the EMI1 DC electrical characteristics when L1V<sub>DD</sub> = 3.3 V.

Table 47. EMI1 DC electrical characteristics (L1V<sub>DD</sub> = 3.3 V) <sup>2</sup>

| Parameter                                                                         | Symbol          | Min                     | Max                     | Unit | Notes |
|-----------------------------------------------------------------------------------|-----------------|-------------------------|-------------------------|------|-------|
| Input high voltage                                                                | V <sub>IH</sub> | 0.7 x L1V <sub>DD</sub> | —                       | V    | 1     |
| Input low voltage                                                                 | V <sub>IL</sub> | —                       | 0.2 x L1V <sub>DD</sub> | V    | 1     |
| Input current (L1V <sub>IN</sub> = 0 V or L1V <sub>IN</sub> = L1V <sub>DD</sub> ) | I <sub>IN</sub> | —                       | ±50                     | μA   | —     |

Table continues on the next page...

**Table 47. EMI1 DC electrical characteristics ( $L1V_{DD} = 3.3\text{ V}$ )<sup>2</sup> (continued)**

| Parameter                                                                                                                                                                                                                           | Symbol   | Min | Max | Unit | Notes |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----|-----|------|-------|
| Output high voltage ( $L1V_{DD} = \text{min}$ , $I_{OH} = -2\text{ mA}$ )                                                                                                                                                           | $V_{OH}$ | 2.4 | —   | V    | —     |
| Output low voltage ( $L1V_{DD} = \text{min}$ , $I_{OL} = 2\text{ mA}$ )                                                                                                                                                             | $V_{OL}$ | —   | 0.4 | V    | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $L1V_{IN}$ values found in <a href="#">Table 3</a> .<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |          |     |     |      |       |

This table provides the EMI1 DC electrical characteristics when  $L1V_{DD} = 2.5\text{ V}$ .

**Table 48. EMI1 DC electrical characteristics ( $L1V_{DD} = 2.5\text{ V}$ )<sup>2</sup>**

| Parameters                                                                                                                                                                                                                          | Symbol   | Min                   | Max                   | Unit          | Notes |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----------------------|-----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                  | $V_{IH}$ | $0.7 \times L1V_{DD}$ | —                     | V             | 1     |
| Input low voltage                                                                                                                                                                                                                   | $V_{IL}$ | —                     | $0.2 \times L1V_{DD}$ | V             | 1     |
| Input current ( $L1V_{IN} = 0$ or $L1V_{IN} = L1V_{DD}$ )                                                                                                                                                                           | $I_{IN}$ | —                     | $\pm 50$              | $\mu\text{A}$ | —     |
| Output high voltage ( $L1V_{DD} = \text{min}$ , $I_{OH} = -1.0\text{ mA}$ )                                                                                                                                                         | $V_{OH}$ | 2.00                  | —                     | V             | —     |
| Output low voltage ( $L1V_{DD} = \text{min}$ , $I_{OL} = 1.0\text{ mA}$ )                                                                                                                                                           | $V_{OL}$ | —                     | 0.40                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $L1V_{IN}$ values found in <a href="#">Table 3</a> .<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                       |                       |               |       |

This table provides the EMI1 DC electrical characteristics when  $L1V_{DD} = 1.8\text{ V}$ .

**Table 49. EMI1 DC electrical characteristics ( $L1V_{DD} = 1.8\text{ V}$ )<sup>2</sup>**

| Parameter                                                                                                                                                                                                                           | Symbol   | Min                   | Max                   | Unit          | Notes |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----------------------|-----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                  | $V_{IH}$ | $0.7 \times L1V_{DD}$ | —                     | V             | 1     |
| Input low voltage                                                                                                                                                                                                                   | $V_{IL}$ | —                     | $0.2 \times L1V_{DD}$ | V             | 1     |
| Input current ( $L1V_{IN} = 0\text{ V}$ or $L1V_{IN} = L1V_{DD}$ )                                                                                                                                                                  | $I_{IN}$ | —                     | $\pm 50$              | $\mu\text{A}$ | —     |
| Output high voltage ( $L1V_{DD} = \text{min}$ , $I_{OH} = -0.5\text{ mA}$ )                                                                                                                                                         | $V_{OH}$ | 1.35                  | —                     | V             | —     |
| Output low voltage ( $L1V_{DD} = \text{min}$ , $I_{OL} = 0.5\text{ mA}$ )                                                                                                                                                           | $V_{OL}$ | —                     | 0.4                   | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the min and max $L1V_{IN}$ respective values found in <a href="#">Table 3</a> .<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                       |                       |               |       |

### 3.11.5.2 EMI1 AC timing specifications

This table provides the EMI1 AC timing specifications.

**Table 50. EMI1 AC timing specifications<sup>5</sup>**

| Parameter/Condition        | Symbol <sup>1</sup> | Min                            | Typ | Max                            | Unit | Notes |
|----------------------------|---------------------|--------------------------------|-----|--------------------------------|------|-------|
| MDC frequency              | $f_{MDC}$           | —                              | —   | 2.5                            | MHz  | 2     |
| MDC clock pulse width high | $t_{MDCH}$          | 160                            | —   | —                              | ns   | —     |
| MDC to MDIO delay          | $t_{MDKHDX}$        | $(3 \times t_{enet\_clk}) - 3$ | —   | $(5 \times t_{enet\_clk}) + 3$ | ns   | 3, 4  |
| MDIO to MDC setup time     | $t_{MDDVKH}$        | 8                              | —   | —                              | ns   | —     |
| MDIO to MDC hold time      | $t_{MDDXKH}$        | 0                              | —   | —                              | ns   | —     |

**Notes:**

1. The symbols used for timing specifications follow these patterns:  $t_{(first\ two\ letters\ of\ functional\ block)(signal)(state)(reference)(state)}$  for inputs and  $t_{(first\ two\ letters\ of\ functional\ block)(reference)(state)(signal)(state)}$  for outputs. For example,  $t_{MDKHDX}$  symbolizes management data timing (MD) for the time  $t_{MDC}$  from clock reference (K) high (H) until data outputs (D) are invalid (X) or data hold time. Also,  $t_{MDDVKH}$  symbolizes management data timing (MD) with respect to the time data input signals (D) reach the valid state (V) relative to the  $t_{MDC}$  clock reference (K) going to the high (H) state or setup time.
2. This parameter is dependent on the Ethernet clock frequency. The eTSEC\_MDIO\_MIIMCFG[MgmtClk] field determines the clock frequency of the MII management clock.
3. This parameter is dependent on the Ethernet clock frequency (CCB clock)/2. The delay is equal to 3 Ethernet clock periods  $\pm 3$  ns. For example, with an Ethernet clock of 400 MHz, the min/max delay is 12.5 ns  $\pm 3$  ns.
4.  $t_{enet\_clk}$  is the Ethernet clock period (Ethernet clock period  $\times 2$ ).
5. For recommended operating conditions, see [Table 3](#).

### 3.11.6 IEEE 1588 electrical specifications

#### 3.11.6.1 IEEE 1588 DC electrical characteristics

This table provides the IEEE 1588 DC electrical characteristics when operating at  $LV_{DD} = 2.5$  V supply.

**Table 51. IEEE 1588 DC electrical characteristics( $LV_{DD} = 2.5$  V)<sup>3</sup>**

| Parameters                                                   | Symbol   | Min                  | Max                  | Unit    | Notes |
|--------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                           | $V_{IH}$ | $0.7 \times LV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                            | $V_{IL}$ | —                    | $0.2 \times LV_{DD}$ | V       | 1     |
| Input current ( $LV_{IN} = 0$ V or $LV_{IN} = LV_{DD}$ )     | $I_{IH}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage ( $LV_{DD} = \min$ , $I_{OH} = -1.0$ mA) | $V_{OH}$ | 2.00                 | —                    | V       | —     |
| Output low voltage ( $LV_{DD} = \min$ , $I_{OL} = 1.0$ mA)   | $V_{OL}$ | —                    | 0.40                 | V       | —     |

**Notes:**

1. The min  $V_{IL}$  and max  $V_{IH}$  values are based on the respective min and max  $LV_{IN}$  values found in [Table 3](#).
2. The symbol  $LV_{IN}$ , in this case, represents the  $LV_{IN}$  symbol referenced in [Table 3](#).
3. For recommended operating conditions, see [Table 3](#).

This table provides the IEEE 1588 DC electrical characteristics when operating at  $LV_{DD} = 1.8$  V supply.

**Table 52. IEEE 1588 DC electrical characteristics(LV<sub>DD</sub> = 1.8 V)<sup>3</sup>**

| Parameters                                                                     | Symbol          | Min                    | Max                    | Unit | Notes |
|--------------------------------------------------------------------------------|-----------------|------------------------|------------------------|------|-------|
| Input high voltage                                                             | V <sub>IH</sub> | 0.7 x LV <sub>DD</sub> | —                      | V    | 1     |
| Input low voltage                                                              | V <sub>IL</sub> | —                      | 0.2 x LV <sub>DD</sub> | V    | 1     |
| Input current (LV <sub>IN</sub> = 0 V or LV <sub>IN</sub> = LV <sub>DD</sub> ) | I <sub>IH</sub> | —                      | ±50                    | μA   | 2     |
| Output high voltage (LV <sub>DD</sub> = min, I <sub>OH</sub> = -0.5 mA)        | V <sub>OH</sub> | 1.35                   | —                      | V    | —     |
| Output low voltage (LV <sub>DD</sub> = min, I <sub>OL</sub> = 0.5 mA)          | V <sub>OL</sub> | —                      | 0.40                   | V    | —     |

**Notes:**

1. The min V<sub>IL</sub> and max V<sub>IH</sub> values are based on the respective min and max LV<sub>IN</sub> values found in [Table 3](#).
2. The symbol LV<sub>IN</sub>, in this case, represents the LV<sub>IN</sub> symbol referenced in [Table 3](#).
3. For recommended operating conditions, see [Table 3](#).

### 3.11.6.2 IEEE 1588 AC timing specifications

This table provides the IEEE 1588 AC timing specifications.

**Table 53. IEEE 1588 AC timing specifications<sup>5</sup>**

| Parameter/Condition                               | Symbol                                                 | Min                           | Typ | Max                     | Unit | Notes   |
|---------------------------------------------------|--------------------------------------------------------|-------------------------------|-----|-------------------------|------|---------|
| TSEC_1588_CLK_IN clock period                     | t <sub>T1588CLK</sub>                                  | FM_CLK/2                      | —   | T <sub>RX_CLK</sub> × 7 | ns   | 1, 3, 6 |
| TSEC_1588_CLK_IN duty cycle                       | t <sub>T1588CLKH</sub> /<br>t <sub>T1588CLK</sub>      | 40                            | 50  | 60                      | %    | 2       |
| TSEC_1588_CLK_IN peak-to-peak jitter              | t <sub>T1588CLKINJ</sub>                               | —                             | —   | 250                     | ps   | —       |
| Rise time TSEC_1588_CLK_IN (20%-80%)              | t <sub>T1588CLKINR</sub>                               | 1.0                           | —   | 2.0                     | ns   | —       |
| Fall time TSEC_1588_CLK_IN (80%-20%)              | t <sub>T1588CLKINF</sub>                               | 1.0                           | —   | 2.0                     | ns   | —       |
| TSEC_1588_CLK_OUT clock period                    | t <sub>T1588CLKOUT</sub>                               | 5.0                           | —   | —                       | ns   | 4       |
| TSEC_1588_CLK_OUT duty cycle                      | t <sub>T1588CLKOTH</sub> /<br>t <sub>T1588CLKOUT</sub> | 30                            | 50  | 70                      | %    | —       |
| TSEC_1588_PULSE_OUT1/2,<br>TSEC_1588_ALARM_OUT1/2 | t <sub>T1588OV</sub>                                   | -0.85                         | —   | 3.8                     | ns   | —       |
| TSEC_1588_TRIG_IN1/2 pulse width                  | t <sub>T1588TRIGH</sub>                                | 2 x t <sub>T1588CLK_MAX</sub> | —   | —                       | ns   | 3       |

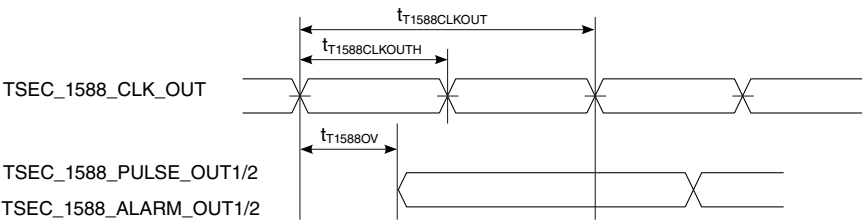
**Notes:**

1. T<sub>RX\_CLK</sub> is the maximum clock period of the ethernet receiving clock selected by TMR\_CTRL[CKSEL]. See the chip reference manual for a description of TMR\_CTRL registers.
2. This needs to be at least two times the clock period of the clock selected by TMR\_CTRL[CKSEL]. See the chip reference manual for a description of TMR\_CTRL registers.
3. The maximum value of t<sub>T1588CLK</sub> is not only defined by the value of T<sub>RX\_CLK</sub>, but also defined by the recovered clock. For example, for 10/100/1000 Mbps modes, the maximum value of t<sub>T1588CLK</sub> will be 2800, 280, and 56 ns, respectively.
4. There are three input clock sources for 1588: TSEC\_1588\_CLK\_IN, RTC, and MAC clock / 2. When using TSEC\_1588\_CLK\_IN, the minimum clock period is 2 x t<sub>T1588CLK</sub>.

Table 53. IEEE 1588 AC timing specifications<sup>5</sup>

| Parameter/Condition                                   | Symbol | Min | Typ | Max | Unit | Notes |
|-------------------------------------------------------|--------|-----|-----|-----|------|-------|
| 5. For recommended operating conditions, see Table 3. |        |     |     |     |      |       |
| 6. FM_CLK = platform clock                            |        |     |     |     |      |       |

This figure shows the data and command output AC timing diagram.



**Note:** The output delay is counted starting at the rising edge if  $t_{T1588CLKOUT}$  is non-inverting. Otherwise, it is counted starting at the falling edge.

Figure 25. IEEE 1588 output AC timing

This figure shows the data and command input AC timing diagram.

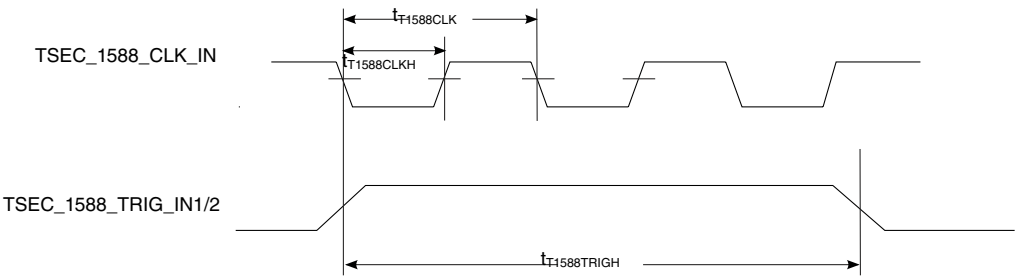


Figure 26. IEEE 1588 input AC timing

3.12 QUICC engine specifications

3.12.1 HDLC interface

This section describes the DC and AC electrical specifications for the high-level data link control (HDLC) interface.

### 3.12.1.1 HDLC, transparent, and synchronous UART DC electrical characteristics

This table provides the DC electrical characteristics for the HDLC, transparent, and synchronous UART protocols when  $DV_{DD} = 3.3\text{ V}$ .

**Table 54. HDLC, transparent, and synchronous UART DC electrical characteristics ( $DV_{DD} = 3.3\text{ V}$ )<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                       | Symbol   | Min                  | Max                  | Unit          | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                              | $V_{IH}$ | $0.7 \times DV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                               | $V_{IL}$ | —                    | $0.2 \times DV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = DV_{DD}$ )                                                                                                                                                                                                                                                                                                   | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = -2\text{ mA}$ )                                                                                                                                                                                                                                                                                        | $V_{OH}$ | 2.4                  | —                    | V             | —     |
| Output low voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = 2\text{ mA}$ )                                                                                                                                                                                                                                                                                          | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $DV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the input voltage of the supply referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |               |       |

This table provides the DC electrical characteristics for the HDLC, transparent, and synchronous UART protocols when  $DV_{DD} = 1.8\text{ V}$ .

**Table 55. HDLC, transparent, and synchronous UART DC electrical characteristics ( $DV_{DD} = 1.8\text{ V}$ )<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                       | Symbol   | Min                  | Max                  | Unit          | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                              | $V_{IH}$ | $0.7 \times DV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                               | $V_{IL}$ | —                    | $0.2 \times DV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = DV_{DD}$ )                                                                                                                                                                                                                                                                                                   | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = -0.5\text{ mA}$ )                                                                                                                                                                                                                                                                                      | $V_{OH}$ | 1.35                 | —                    | V             | —     |
| Output low voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = 0.5\text{ mA}$ )                                                                                                                                                                                                                                                                                        | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $DV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the input voltage of the supply referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |               |       |

### 3.12.1.2 HDLC, transparent, and synchronous UART AC timing specifications

This table provides the input and output AC timing specifications for HDLC and transparent UART protocols.

**Table 56. HDLC and transparent AC timing specifications<sup>2</sup>**

| Parameter                              | Symbol       | Min | Max  | Unit | Notes |
|----------------------------------------|--------------|-----|------|------|-------|
| Outputs-Internal clock delay           | $t_{HIKHOV}$ | 0   | 5.5  | ns   | 1     |
| Outputs-External clock delay           | $t_{HEKHOV}$ | 1   | 9.15 | ns   | 1     |
| Outputs-Internal clock high impedance  | $t_{HIKHOX}$ | 0   | 5.5  | ns   | 1     |
| Outputs-External clock high impedance  | $t_{HEKHOX}$ | 1   | 8    | ns   | 1     |
| Inputs-Internal clock input setup time | $t_{HIIVKH}$ | 8   | —    | ns   | —     |
| Inputs-External clock input setup time | $t_{HEIVKH}$ | 4   | —    | ns   | —     |
| Inputs-Internal clock input hold time  | $t_{HIIXKH}$ | 0   | —    | ns   | —     |
| Inputs-External clock input hold time  | $t_{HEIXKH}$ | 1.1 | —    | ns   | —     |

**Notes:**

1. Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.
2. For recommended operating conditions, see [Table 3](#).

This table provides the input and output AC timing specifications for the synchronous UART protocols.

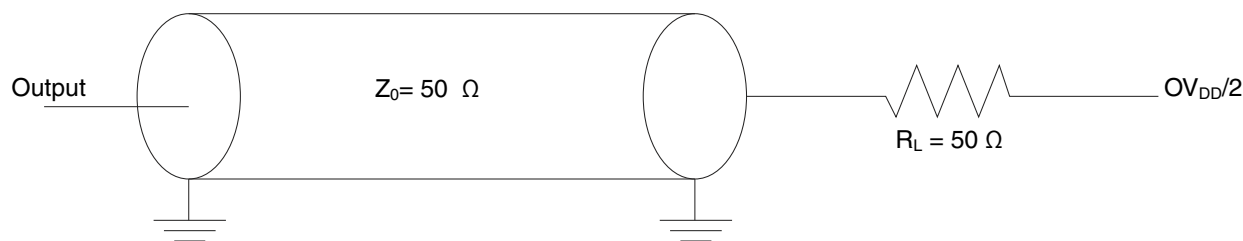
**Table 57. Synchronous UART AC timing specifications<sup>2</sup>**

| Parameter                              | Symbol       | Min | Max | Unit | Notes |
|----------------------------------------|--------------|-----|-----|------|-------|
| Outputs-Internal clock delay           | $t_{HIKHOV}$ | 0   | 11  | ns   | 1     |
| Outputs-External clock delay           | $t_{HEKHOV}$ | 1   | 14  | ns   | 1     |
| Outputs-Internal clock High Impedance  | $t_{HIKHOX}$ | 0   | 11  | ns   | 1     |
| Outputs-External clock High Impedance  | $t_{HEKHOX}$ | 1   | 14  | ns   | 1     |
| Inputs-Internal clock input setup time | $t_{HIIVKH}$ | 10  | —   | ns   | —     |
| Inputs-External clock input setup time | $t_{HEIVKH}$ | 8   | —   | ns   | —     |
| Inputs-Internal clock input Hold time  | $t_{HIIXKH}$ | 0   | —   | ns   | —     |
| Inputs-External clock input hold time  | $t_{HEIXKH}$ | 1.1 | —   | ns   | —     |

**Notes:**

1. Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.
2. For recommended operating conditions, see [Table 3](#).

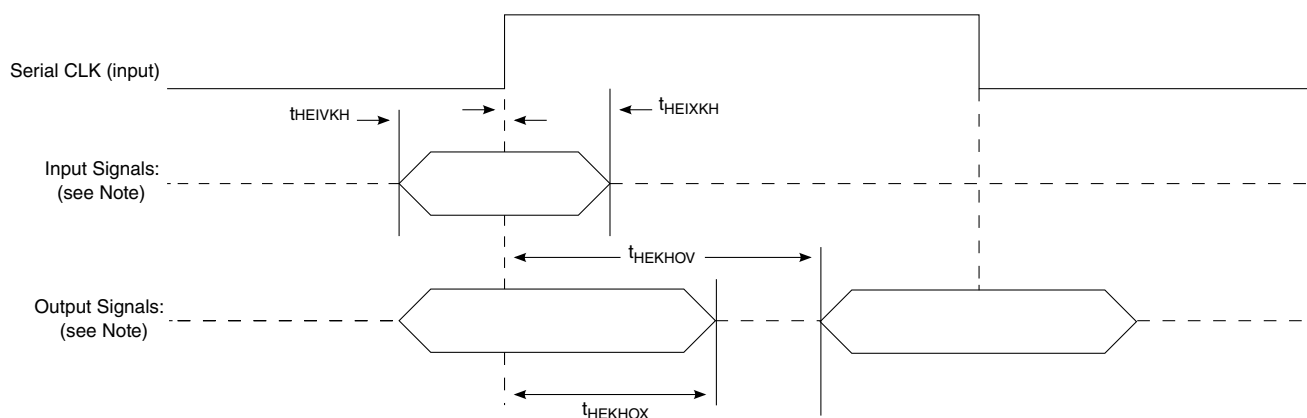
This figure shows the AC test load.



**Figure 27. AC test load**

These figures represent the AC timing from [Table 56](#) and [Table 57](#). Note that, although the specifications generally reference the rising edge of the clock, these AC timing diagrams also apply when the falling edge is the active edge.

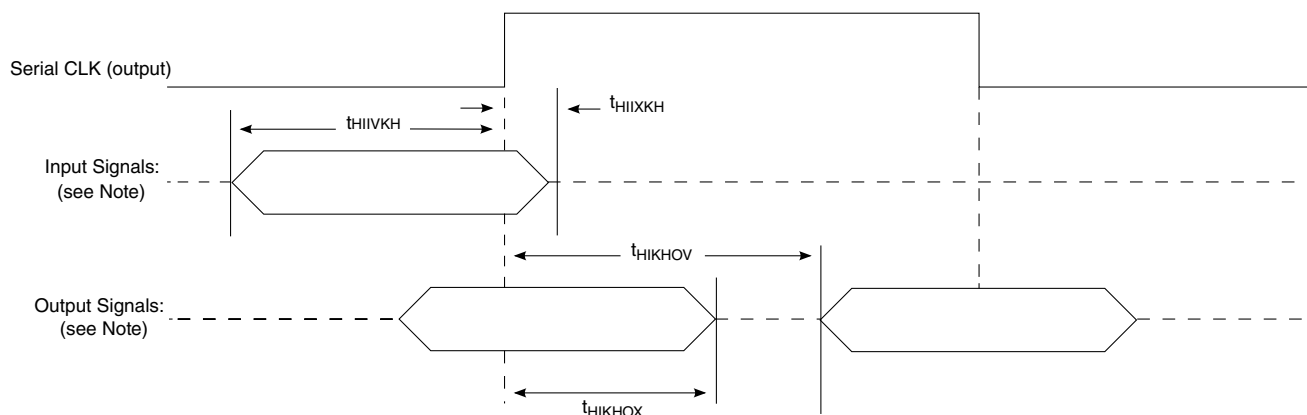
This figure shows the timing with an external clock.



**Note:** The clock edge is selectable.

**Figure 28. AC timing (external clock) diagram**

This figure shows the timing with an internal clock.



**Note:** The clock edge is selectable.

**Figure 29. AC timing (internal clock) diagram**

### 3.12.2 Time-division-multiplexed and serial interface (TDM/SI)

This section describes the DC and AC electrical specifications for the TDM/SI.

#### 3.12.2.1 TDM/SI DC electrical characteristics

This table provides the TDM/SI DC electrical characteristics when  $DV_{DD} = 3.3\text{ V}$ .

**Table 58. TDM/SI DC electrical characteristics ( $DV_{DD} = 3.3\text{ V}$ )<sup>3</sup>**

| Parameter                                                                | Symbol   | Min                  | Max                  | Unit          | Notes |
|--------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                       | $V_{IH}$ | $0.7 \times DV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                        | $V_{IL}$ | —                    | $0.2 \times DV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = DV_{DD}$ )            | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = -2\text{ mA}$ ) | $V_{OH}$ | 2.4                  | —                    | V             | —     |
| Output low voltage ( $DV_{DD} = \text{min}$ , $I_{OL} = 2\text{ mA}$ )   | $V_{OL}$ | —                    | 0.4                  | V             | —     |

**Notes:**

1. The min  $V_{IL}$  and max  $V_{IH}$  values are based on the respective min and max  $BV_{IN}$  values found in [Table 3](#).
2. The symbol  $V_{IN}$ , in this case, represents the input voltage of the supply referenced in [Table 3](#).
3. For recommended operating conditions, see [Table 3](#).

This table provides the TDM/SI DC electrical characteristics when  $DV_{DD} = 1.8\text{ V}$ .

**Table 59. TDM/SI DC electrical characteristics ( $DV_{DD} = 1.8\text{ V}$ )<sup>3</sup>**

| Parameter          | Symbol   | Min                  | Max | Unit | Notes |
|--------------------|----------|----------------------|-----|------|-------|
| Input high voltage | $V_{IH}$ | $0.7 \times DV_{DD}$ | —   | V    | 1     |

Table continues on the next page...

**Table 59. TDM/SI DC electrical characteristics ( $DV_{DD} = 1.8\text{ V}$ )<sup>3</sup> (continued)**

| Parameter                                                                                                                                                                                                                                                                                                                                                       | Symbol   | Min  | Max                  | Unit          | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|----------------------|---------------|-------|
| Input low voltage                                                                                                                                                                                                                                                                                                                                               | $V_{IL}$ | —    | $0.2 \times DV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = DV_{DD}$ )                                                                                                                                                                                                                                                                                                   | $I_{IN}$ | —    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = -0.5\text{ mA}$ )                                                                                                                                                                                                                                                                                      | $V_{OH}$ | 1.35 | —                    | V             | —     |
| Output low voltage ( $DV_{DD} = \text{min}$ , $I_{OL} = 0.5\text{ mA}$ )                                                                                                                                                                                                                                                                                        | $V_{OL}$ | —    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $BV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the input voltage of the supply referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |      |                      |               |       |

### 3.12.2.2 TDM/SI AC timing specifications

This table provides the TDM/SI input and output AC timing specifications.

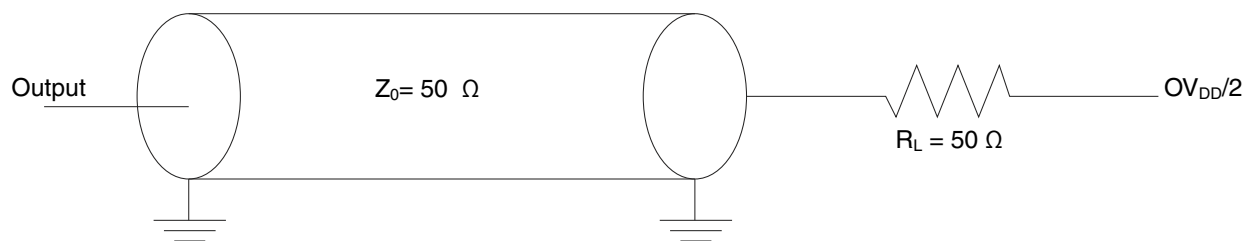
**Table 60. TDM/SI AC timing specifications <sup>1</sup>**

| Parameter                                                                                                                                                              | Symbol <sup>1</sup> | Min | Max | Unit |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|-----|-----|------|
| TDM/SI outputs-External clock delay                                                                                                                                    | $t_{SEKHOV}$        | 2   | 11  | ns   |
| TDM/SI outputs-External clock High Impedance                                                                                                                           | $t_{SEKHOX}$        | 2   | 10  | ns   |
| TDM/SI inputs-External clock input setup time                                                                                                                          | $t_{SEIVKH}$        | 5   | —   | ns   |
| TDM/SI inputs-External clock input hold time                                                                                                                           | $t_{SEIXKH}$        | 2   | —   | ns   |
| <b>Notes:</b><br>1. Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin. |                     |     |     |      |

#### NOTE

The rise/fall time on QUICC engine block input pins should not exceed 5 ns. This should be enforced especially on clock signals. Rise time refers to signal transitions from 10% to 90% of  $V_{DD}$ . Fall time refers to transitions from 90% to 10% of  $V_{DD}$ .

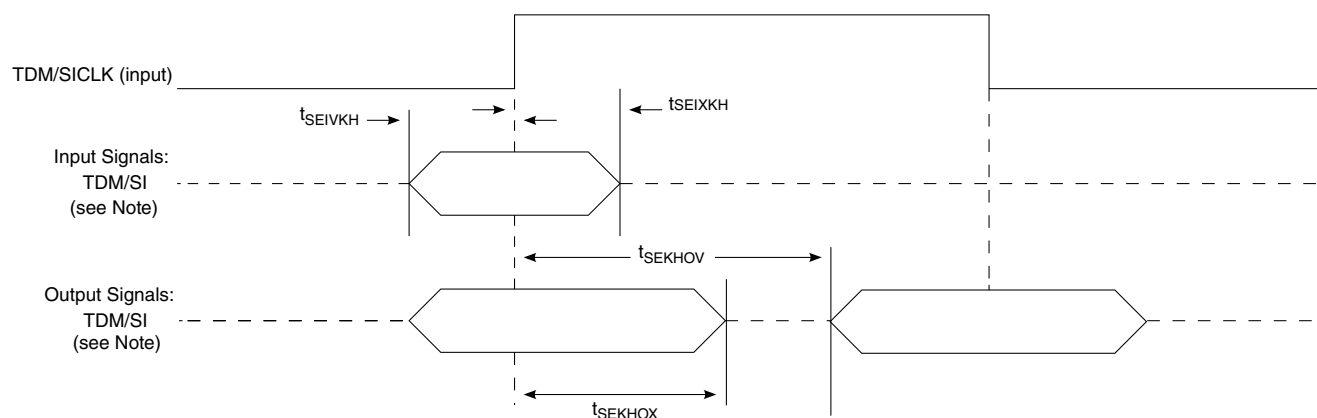
This figure shows the AC test load for the TDM/SI.



**Figure 30. TDM/SI AC test load**

This figure represents the AC timing from [Table 60](#). Note that, although the specifications generally reference the rising edge of the clock, these AC timing diagrams also apply when the falling edge is the active edge.

This figure shows the TDM/SI timing with an external clock.



**Note:** The clock edge is selectable on TDM/SI.

**Figure 31. TDM/SI AC timing (external clock) diagram**

### 3.13 USB 2.0 interface

This section describes the AC and DC electrical specifications for the USB 2.0 interface.

#### 3.13.1 USB 2.0 DC electrical characteristics

This table provides the DC electrical characteristics for the USB 2.0 interface when operating at  $LV_{DD} = 3.3\text{ V}$ .

**Table 61. USB 2.0 DC electrical characteristics (3.3 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                            | Symbol   | Min                  | Max                  | Unit    | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                   | $V_{IH}$ | $0.7 \times LV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                    | $V_{IL}$ | —                    | $0.2 \times LV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = LV_{DD}$ )                                                                                                                                                                                                                                                                                               | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage<br>( $LV_{DD} = \min$ , $I_{OH} = -2$ mA)                                                                                                                                                                                                                                                                                        | $V_{OH}$ | 2.4                  | —                    | V       | —     |
| Output low voltage<br>( $LV_{DD} = \min$ , $I_{OL} = 2$ mA)                                                                                                                                                                                                                                                                                          | $V_{OL}$ | —                    | 0.4                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $LV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $LV_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |         |       |

This table provides the DC electrical characteristics for the USB 2.0 interface when operating at  $LV_{DD} = 2.5$  V.

**Table 62. USB 2.0 DC electrical characteristics (2.5 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                              | Symbol   | Min                  | Max                  | Unit    | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                     | $V_{IH}$ | $0.7 \times LV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                      | $V_{IL}$ | —                    | $0.2 \times LV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = LV_{DD}/L1V_{DD}$ )                                                                                                                                                                                                                                                                                                        | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage<br>( $LV_{DD}/L1V_{DD} = \min$ , $I_{OH} = -1$ mA)                                                                                                                                                                                                                                                                                                 | $V_{OH}$ | 2.0                  | —                    | V       | —     |
| Output low voltage<br>( $LV_{DD}/L1V_{DD} = \min$ , $I_{OL} = 1$ mA)                                                                                                                                                                                                                                                                                                   | $V_{OL}$ | —                    | 0.4                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $LV_{IN}/L1V_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $LV_{IN}/L1V_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |         |       |

This table provides the DC electrical characteristics for the USB 2.0 interface when operating at  $LV_{DD} = 1.8$  V.

**Table 63. USB 2.0 DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                              | Symbol   | Min                  | Max                  | Unit    | Notes |
|--------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                     | $V_{IH}$ | $0.7 \times LV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                      | $V_{IL}$ | —                    | $0.2 \times LV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = LV_{DD}$ ) | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |

Table continues on the next page...

**Table 63. USB 2.0 DC electrical characteristics (1.8 V)<sup>3</sup> (continued)**

| Parameter                                                                                                                                                                                                                                                                                                                                          | Symbol   | Min  | Max | Unit | Notes |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|-----|------|-------|
| Output high voltage<br>( $V_{DD} = \min$ , $I_{OH} = -0.5 \text{ mA}$ )                                                                                                                                                                                                                                                                            | $V_{OH}$ | 1.35 | —   | V    | —     |
| Output low voltage<br>( $V_{DD} = \min$ , $I_{OL} = 0.5 \text{ mA}$ )                                                                                                                                                                                                                                                                              | $V_{OL}$ | —    | 0.4 | V    | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $V_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $V_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |      |     |      |       |

### 3.13.2 USB 2.0 AC timing specifications

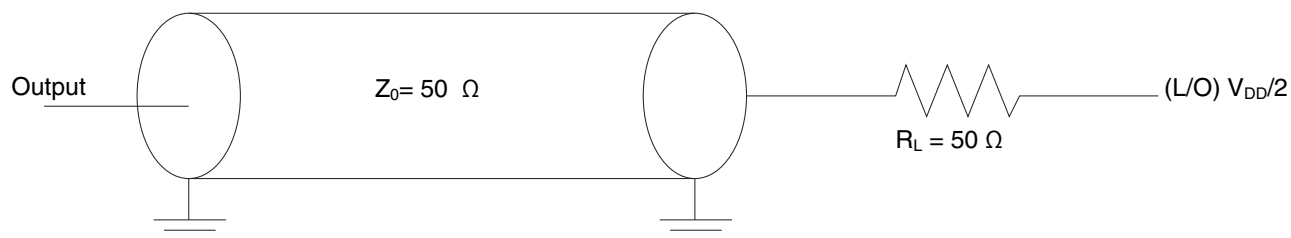
#### 3.13.2.1 USB 2.0 AC timing specifications for ULPI mode

This table provides the general timing parameters of the USB 2.0 interface for ULPI mode.

**Table 64. USB 2.0 general timing parameters (ULPI mode only)<sup>1, 6, 7</sup>**

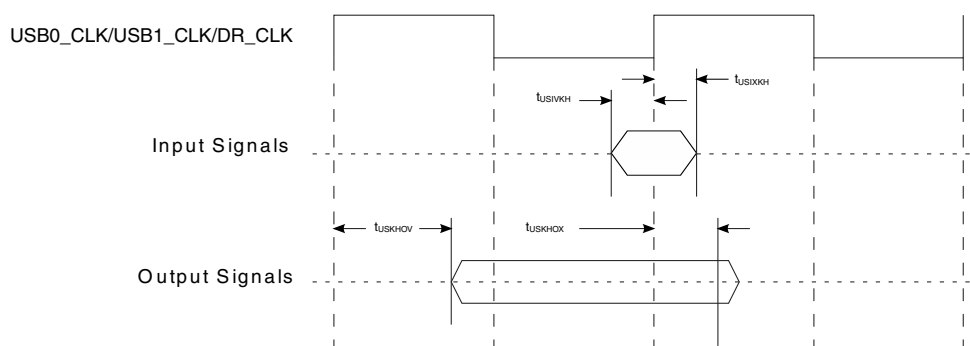
| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | Symbol <sup>1, 6</sup> | Min | Max | Unit | Notes      |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|-----|-----|------|------------|
| USB clock cycle time                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | $t_{USCK}$             | 15  | —   | ns   | 2, 3, 4, 5 |
| Input setup to USB clock--all inputs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | $t_{USIVKH}$           | 4   | —   | ns   | 2, 3, 4, 5 |
| Input hold to USB clock--all inputs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | $t_{USIXKH}$           | 1   | —   | ns   | 2, 3, 4, 5 |
| USB clock to output valid--all outputs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | $t_{USKHOV}$           | —   | 7   | ns   | 2, 3, 4, 5 |
| Output hold from USB clock--all outputs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | $t_{USKHOX}$           | 2   | —   | ns   | 2, 3, 4, 5 |
| <b>Notes:</b><br>1. The symbols for timing specifications follow these patterns: $t_{(\text{First two letters of functional block})(\text{signal})(\text{state})(\text{reference})(\text{state})}$ for inputs and $t_{(\text{First two letters of functional block})(\text{reference})(\text{state})(\text{signal})(\text{state})}$ for outputs. For example, $t_{USIXKH}$ symbolizes USB timing (US) for the input (I) to go invalid (X) with respect of the time the USB clock reference (K) goes high (H). Also, $t_{USKHOX}$ symbolizes USB timing (US) for the USB clock reference (K) to go high (H) with respect to the output (O) going invalid (X) or output hold time.<br>2. All timings are in reference to the USB 2.0 clock.<br>3. All signals are measured from $OV_{DD}/2$ of the rising edge of the USB 2.0 clock to $0.4 \times OV_{DD}$ of the signal in question for 3.3 V signaling levels.<br>4. Input timings are measured at the pin.<br>5. For active/float timing measurements, the high impedance or off state is defined to be when the total current delivered through the component pin is less than or equal to that of the leakage current specification.<br>6. When switching the data pins from outputs to inputs using the $USBn\_DIR$ pin, the output timings will be violated on that cycle because the output buffers are tristated asynchronously. This should not be a problem, because the PHY should not be functionally looking at these signals on that cycle as per ULPI specifications.<br>7. For recommended operating conditions, see <a href="#">Table 3</a> . |                        |     |     |      |            |

This figure provides the AC test load for the USB 2.0.



**Figure 32. USB 2.0 AC test load**

This figure provides the AC signals for the USB 2.0 interface for ULPI mode.



**Figure 33. USB 2.0 ULPI mode AC Signals**

This table provides the USB 2.0 clock input (USB\_CLK\_IN) AC timing specifications.

**Table 65. USB\_CLK\_IN AC timing specifications**

| Parameter                              | Condition                                                                              | Symbol                    | Min    | Typ | Max   | Unit |
|----------------------------------------|----------------------------------------------------------------------------------------|---------------------------|--------|-----|-------|------|
| Frequency range                        | Steady state                                                                           | $f_{\text{USB\_CLK\_IN}}$ | 59.97  | 60  | 60.03 | MHz  |
| Clock frequency tolerance              | —                                                                                      | $t_{\text{CLK\_TOL}}$     | - 0.05 | 0   | 0.05  | %    |
| Reference clock duty cycle             | Measured at rising edge and/or falling edge at $LV_{\text{DD}}/2$                      | $t_{\text{CLK\_DUTY}}$    | 40     | 50  | 60    | %    |
| Total input jitter time interval error | Peak-to-peak value measured with a second-order, high-pass filter of 500-kHz bandwidth | $t_{\text{CLK\_PJ}}$      | —      | —   | 200   | ps   |

### 3.14 USB 3.0 interface

This section describes the DC and AC electrical specifications for the USB 3.0 interface.

#### 3.14.1 USB 3.0 PHY transceiver supply DC voltage

This table provides the DC electrical characteristics for the USB 3.0 interface when operating at  $USB\_HV_{DD} = 3.3\text{ V}$ .

**Table 66. USB 3.0 PHY transceiver supply DC voltage ( $USB\_HV_{DD} = 3.3\text{ V}$ )<sup>2</sup>**

| Parameter                                                                                                                                                                                                                               | Symbol   | Min | Max | Unit | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|-----|-----|------|-------|
| Input high voltage                                                                                                                                                                                                                      | $V_{IH}$ | 2.0 | —   | V    | 1     |
| Input low voltage                                                                                                                                                                                                                       | $V_{IL}$ | —   | 0.8 | V    | 1     |
| Output high voltage ( $USB\_HV_{DD} = \text{min}$ , $I_{OH} = -2\text{ mA}$ )                                                                                                                                                           | $V_{OH}$ | 2.8 | —   | V    | —     |
| Output low voltage ( $USB\_HV_{DD} = \text{min}$ , $I_{OL} = 2\text{ mA}$ )                                                                                                                                                             | $V_{OL}$ | —   | 0.3 | V    | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $USB\_HV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |          |     |     |      |       |

#### 3.14.2 USB 3.0 DC electrical characteristics

This table provides the USB 3.0 transmitter DC electrical characteristics at package pins.

**Table 67. USB 3.0 transmitter DC electrical characteristics<sup>1</sup>**

| Characteristic                                                                         | Symbol                          | Min | Nom  | Max  | Unit              |
|----------------------------------------------------------------------------------------|---------------------------------|-----|------|------|-------------------|
| Differential output voltage                                                            | $V_{tx\text{-diff-pp}}$         | 800 | 1000 | 1200 | $\text{mV}_{p-p}$ |
| Low power differential output voltage                                                  | $V_{tx\text{-diff-pp-low}}$     | 400 | —    | 1200 | $\text{mV}_{p-p}$ |
| Tx de-emphasis                                                                         | $V_{tx\text{-de-ratio}}$        | 3   | —    | 4    | dB                |
| Differential impedance                                                                 | $Z_{diffTX}$                    | 72  | 100  | 120  | Ohm               |
| Tx common mode impedance                                                               | $R_{TX-DC}$                     | 18  | —    | 30   | Ohm               |
| Absolute DC common mode voltage between U1 and U0                                      | $T_{TX-CM-DC-ACTIVEIDLE-DELTA}$ | —   | —    | 200  | mV                |
| DC electrical idle differential output voltage                                         | $V_{TX-IDLE-DIFF-DC}$           | 0   | —    | 10   | mV                |
| <b>Note:</b><br>1. For recommended operating conditions, see <a href="#">Table 3</a> . |                                 |     |      |      |                   |

This table provides the USB 3.0 receiver DC electrical characteristics at the Rx package pins.

**Table 68. USB 3.0 receiver DC electrical characteristics**

| Characteristic                                                                 | Symbol                                        | Min  | Nom | Max | Unit | Notes |
|--------------------------------------------------------------------------------|-----------------------------------------------|------|-----|-----|------|-------|
| Differential Rx input impedance                                                | R <sub>RX-DIFF-DC</sub>                       | 72   | 100 | 120 | Ohm  | —     |
| Receiver DC common mode impedance                                              | R <sub>RX-DC</sub>                            | 18   | —   | 30  | Ohm  | —     |
| DC input CM input impedance for V > 0 during reset or power down               | Z <sub>RX-HIGH-IMP-DC</sub>                   | 25 K | —   | —   | Ohm  | —     |
| LFPS detect threshold                                                          | V <sub>RX-IDLE-DET-DC-DIFF<sub>pp</sub></sub> | 100  | —   | 300 | mV   | 1     |
| <b>Note:</b><br>1. Below the minimum is noise. Must wake up above the maximum. |                                               |      |     |     |      |       |

### 3.14.3 USB 3.0 AC timing specifications

This table provides the USB 3.0 transmitter AC timing specifications at package pins.

**Table 69. USB 3.0 transmitter AC timing specifications<sup>1</sup>**

| Parameter                                                                                                                                   | Symbol                | Min    | Nom | Max    | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|--------|-----|--------|------|-------|
| Speed                                                                                                                                       | —                     | —      | 5.0 | —      | Gb/s | —     |
| Transmitter eye                                                                                                                             | t <sub>TX-Eye</sub>   | 0.625  | —   | —      | UI   | —     |
| Unit interval                                                                                                                               | UI                    | 199.94 | —   | 200.06 | ps   | 2     |
| AC coupling capacitor                                                                                                                       | AC coupling capacitor | 75     | —   | 200    | nF   | —     |
| <b>Note:</b><br>1. For recommended operating conditions, see <a href="#">Table 3</a> .<br>2. UI does not account for SSC-caused variations. |                       |        |     |        |      |       |

This table provides the USB 3.0 receiver AC timing specifications at Rx package pins.

**Table 70. USB 3.0 receiver AC timing specifications<sup>1</sup>**

| Parameter                                                                                                                                    | Symbol | Min    | Nom | Max    | Unit | Notes |
|----------------------------------------------------------------------------------------------------------------------------------------------|--------|--------|-----|--------|------|-------|
| Unit interval                                                                                                                                | UI     | 199.94 | —   | 200.06 | ps   | 2     |
| <b>Notes:</b><br>1. For recommended operating conditions, see <a href="#">Table 3</a> .<br>2. UI does not account for SSC-caused variations. |        |        |     |        |      |       |

### 3.14.4 USB 3.0 reference clock requirements

This table summarizes the requirements of the reference clock provided to the USB 3.0 SSPHY. There are two options for the reference clock of USB PHY: SYSCLK or DIFF\_SYSCLK/DIFF\_SYSCLK\_B. The following table provides the additional requirements when SYSCLK or DIFF\_SYSCLK/DIFF\_SYSCLK\_B is used as USB REFCLK. This table can also be used for 100 MHz reference clock requirements.

**Table 71. Reference clock requirements**

| Parameter                                                                                                                                                                                                                                                     | Symbol      | Min  | Typ | Max | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|------|-----|-----|------|-------|
| Reference clock frequency offset                                                                                                                                                                                                                              | FREF_OFFSET | -300 | —   | 300 | ppm  | —     |
| Reference clock random jitter (RMS)                                                                                                                                                                                                                           | RMSJREF_CLK | —    | —   | 3   | ps   | 1, 2  |
| Reference clock deterministic jitter                                                                                                                                                                                                                          | DJREF_CLK   | —    | —   | 150 | ps   | 3     |
| Duty cycle                                                                                                                                                                                                                                                    | DCREF_CLK   | 40   | —   | 60  | %    | —     |
| <b>Notes:</b><br>1. 1.5 MHz to Nyquist frequency. For example, for 100 MHz reference clock, the Nyquist frequency is 50 MHz.<br>2. The peak-to-peak Rj specification is calculated as 14.069 times the RMS Rj for 10-12 BER.<br>3. DJ across all frequencies. |             |      |     |     |      |       |

### 3.14.5 USB 3.0 LFPS specifications

This table provides the key LFPS electrical specifications at the transmitter.

**Table 72. LFPS electrical specifications at the transmitter**

| Parameter                                                                                 | Symbol                          | Min | Typ | Max  | Unit | Notes |
|-------------------------------------------------------------------------------------------|---------------------------------|-----|-----|------|------|-------|
| Period                                                                                    | tPeriod                         | 20  | —   | 100  | ns   | —     |
| Peak-to-peak differential amplitude                                                       | V <sub>TX-DIFF-PP-LFPS</sub>    | 800 | —   | 1200 | mV   | —     |
| Low-power peak-to-peak differential amplitude                                             | V <sub>TX-DIFF-PP-LFPS-LP</sub> | 400 | —   | 600  | mV   | —     |
| Rise/fall time                                                                            | t <sub>RiseFall2080</sub>       | —   | —   | 4    | ns   | 1     |
| Duty cycle                                                                                | Duty cycle                      | 40  | —   | 60   | %    | 1     |
| <b>Note:</b><br>1. Measured at compliance TP1. See <a href="#">Figure 34</a> for details. |                                 |     |     |      |      |       |

This figure shows the Tx normative setup with reference channel as per USB 3.0 specifications.

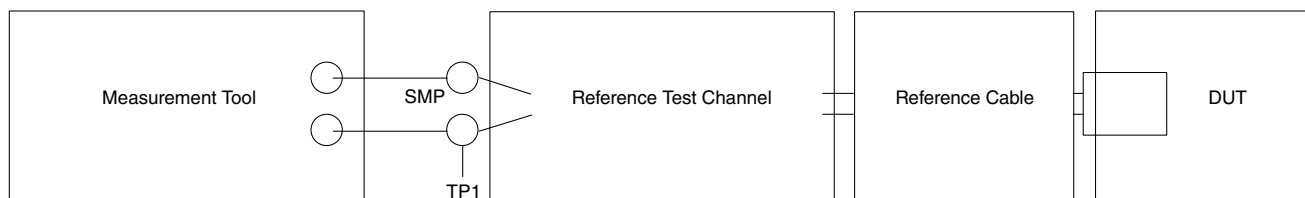


Figure 34. Tx normative setup

## 3.15 Integrated flash controller (IFC)

This section describes the DC and AC electrical specifications for the integrated flash controller (IFC).

### 3.15.1 IFC DC electrical characteristics

This table provides the DC electrical characteristics for the IFC when operating at  $BV_{DD} = 3.3\text{ V}$ .

Table 73. IFC DC electrical characteristics (3.3 V)<sup>3</sup>

| Parameter                                                                                                                                                                                                                                                                                                                                            | Symbol   | Min                  | Max                  | Unit          | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                   | $V_{IH}$ | $0.7 \times BV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                    | $V_{IL}$ | —                    | $0.2 \times BV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = BV_{DD}$ )                                                                                                                                                                                                                                                                                        | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage<br>( $BV_{DD} = \text{min}$ , $I_{OH} = -2\text{ mA}$ )                                                                                                                                                                                                                                                                          | $V_{OH}$ | 2.4                  | —                    | V             | —     |
| Output low voltage<br>( $BV_{DD} = \text{min}$ , $I_{OL} = 2\text{ mA}$ )                                                                                                                                                                                                                                                                            | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $BV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $BV_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |               |       |

This table provides the DC electrical characteristics for the IFC when operating at  $BV_{DD} = 1.8\text{ V}$ .

Table 74. IFC DC electrical characteristics (1.8 V)<sup>3</sup>

| Parameter          | Symbol   | Min                  | Max                  | Unit | Note |
|--------------------|----------|----------------------|----------------------|------|------|
| Input high voltage | $V_{IH}$ | $0.7 \times BV_{DD}$ | —                    | V    | 1    |
| Input low voltage  | $V_{IL}$ | —                    | $0.2 \times BV_{DD}$ | V    | 1    |

Table continues on the next page...

**Table 74. IFC DC electrical characteristics (1.8 V)<sup>3</sup> (continued)**

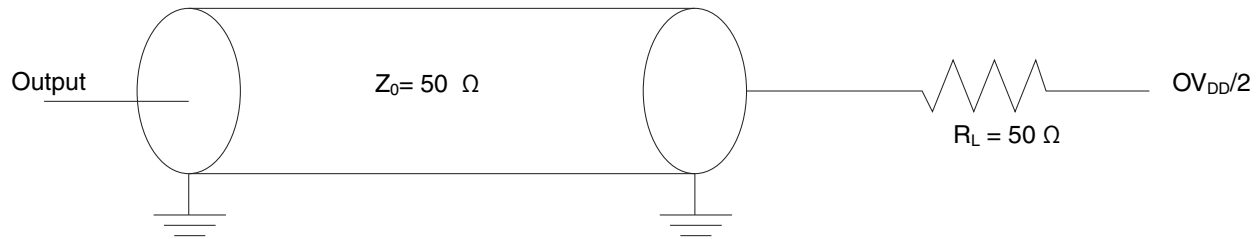
| Parameter                                                                                                                                                                                                                                                                                                                                            | Symbol   | Min  | Max      | Unit          | Note |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------|----------|---------------|------|
| Input current<br>( $V_{IN} = 0\text{ V}$ or $V_{IN} = BV_{DD}$ )                                                                                                                                                                                                                                                                                     | $I_{IN}$ | —    | $\pm 50$ | $\mu\text{A}$ | 2    |
| Output high voltage<br>( $BV_{DD} = \text{min}$ , $I_{OH} = -0.5\text{ mA}$ )                                                                                                                                                                                                                                                                        | $V_{OH}$ | 1.35 | —        | V             | —    |
| Output low voltage<br>( $BV_{DD} = \text{min}$ , $I_{OL} = 0.5\text{ mA}$ )                                                                                                                                                                                                                                                                          | $V_{OL}$ | —    | 0.4      | V             | —    |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $BV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $BV_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |      |          |               |      |

### 3.15.2 IFC AC timing specifications

This section describes the AC timing specifications for the IFC.

#### 3.15.2.1 Test condition

This figure shows the AC test load for the IFC.

**Figure 35. IFC AC test load**

#### 3.15.2.2 IFC input AC timing specifications

This table provides the input AC timing specifications of the IFC-GPCM and IFC-GASIC interfaces.

**Table 75. IFC input timing specifications for GPCM and GASIC mode ( $BV_{DD} = 1.8/3.3\text{ V}$ )**

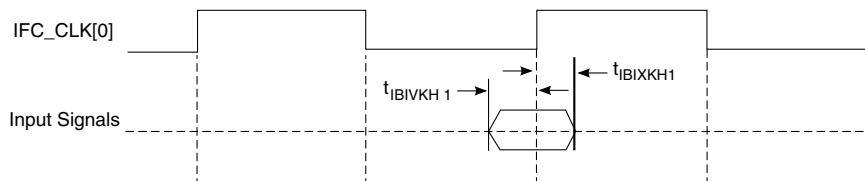
| Parameter   | Symbol       | Min | Max | Unit | Notes |
|-------------|--------------|-----|-----|------|-------|
| Input setup | $t_{BIVKH1}$ | 4   | —   | ns   | —     |

Table continues on the next page...

**Table 75. IFC input timing specifications for GPCM and GASIC mode ( $BV_{DD} = 1.8/3.3\text{ V}$ ) (continued)**

| Parameter  | Symbol       | Min | Max | Unit | Notes |
|------------|--------------|-----|-----|------|-------|
| Input hold | $t_{BIXKH1}$ | 1   | —   | ns   | —     |

This figure shows the input AC timing diagram for the IFC-GPCM and IFC-GASIC interfaces.

**Figure 36. IFC-GPCM and IFC-GASIC input AC timings**

This table provides the input timing specifications of the IFC-NOR interface.

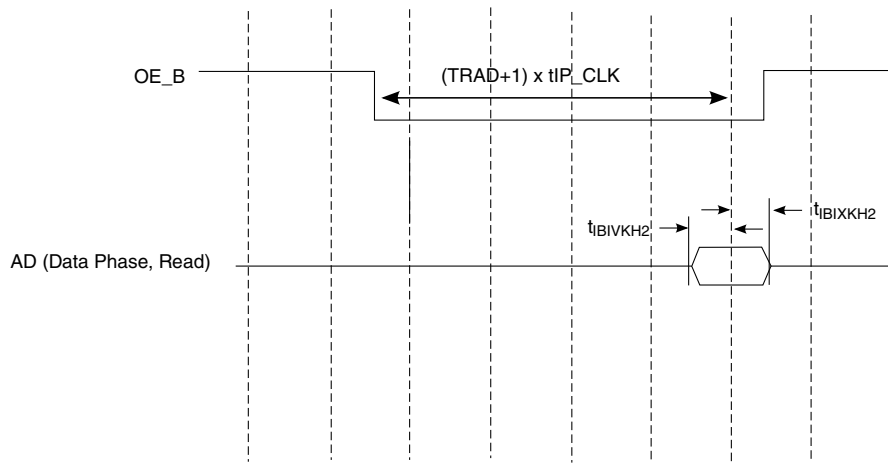
**Table 76. IFC input timing specifications for NOR mode ( $BV_{DD} = 1.8/3.3\text{ V}$ )<sup>2</sup>**

| Parameter   | Symbol       | Min                          | Max | Unit | Notes |
|-------------|--------------|------------------------------|-----|------|-------|
| Input setup | $t_{BIVKH2}$ | $(2 \times t_{IP\_CLK}) + 2$ | —   | ns   | 1     |
| Input hold  | $t_{BIXKH2}$ | $1 \times t_{IP\_CLK}$       | —   | ns   | 1     |

**Notes:**

- $t_{IP\_CLK}$  is the period of ip clock (not the IFC\_CLK) on which IFC is running.
- For recommended operating conditions, see [Table 3](#).

This figure shows the AC input timing diagram for input signals of the IFC-NOR interface. Here, TRAD is a programmable delay parameter. Refer to the IFC section of LS1020A QorIQ Advanced Multicore Processor Reference Manual for more information.



Note: IP\_CLK is the internal clock on which IFC is running. It is not available on interface pins.

**Figure 37. IFC-NOR interface input AC timings**

This table provides the input timing specifications of the IFC-NAND interface.

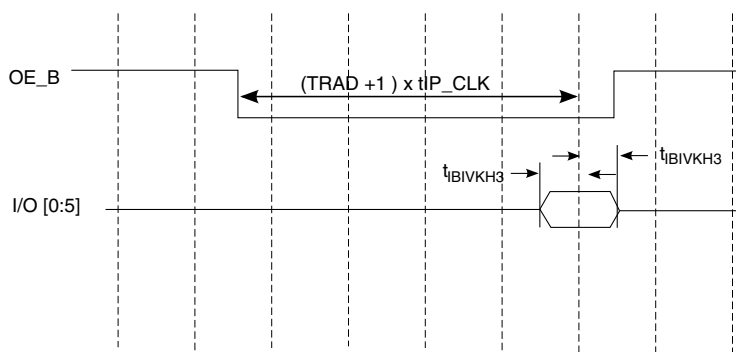
**Table 77. IFC input timing specifications for NAND mode ( $BV_{DD} = 1.8/3.3\text{ V}$ )<sup>2</sup>**

| Parameter            | Symbol       | Min                          | Max | Unit          | Notes |
|----------------------|--------------|------------------------------|-----|---------------|-------|
| Input setup          | $t_{BIVKH3}$ | $(2 \times t_{IP\_CLK}) + 2$ | —   | ns            | 1     |
| Input hold           | $t_{BIXKH3}$ | $1 \times t_{IP\_CLK}$       | —   | ns            | 1     |
| IFC_RB_B pulse width | $t_{BCH}$    | 2                            | —   | $t_{IP\_CLK}$ | 1     |

**Notes:**

- $t_{IP\_CLK}$  is the period of ip clock on which IFC is running.
- For recommended operating conditions, see [Table 3](#).

This figure shows the AC input timing diagram for input signals of the IFC-NAND interface. Here, TRAD is a programmable delay parameter. Refer to the IFC section of LS1020A QorIQ Advanced Multicore Processor Reference Manual for more information.



Note:  $t_{IP\_CLK}$  is the period of IP clock (not the IFC\_CLK) on which IFC is running.

**Figure 38. IFC-NAND interface input AC timings**

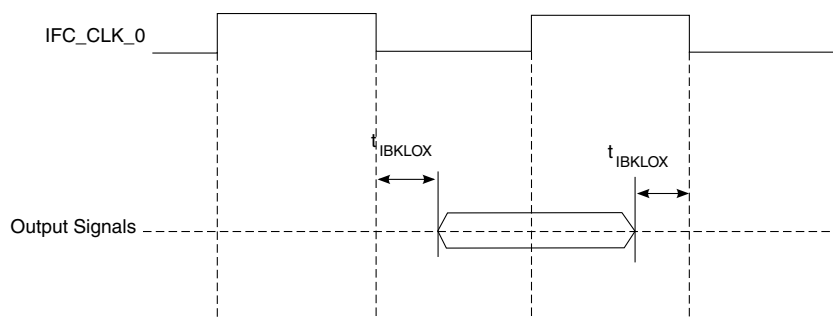
### 3.15.2.3 IFC output AC timing specifications

This table provides the output AC timing specifications of the IFC-GPCM and IFC-GASIC interface.

**Table 78. IFC-GPCM and IFC-GASIC interface output timing specifications ( $BV_{DD} = 1.8/3.3$  V)<sup>2</sup>**

| Parameter                                                                                                                                                                                                  | Symbol             | Min | Max       | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|-----|-----------|------|-------|
| IFC_CLK cycle time                                                                                                                                                                                         | $t_{IBK}$          | 10  | —         | ns   | —     |
| IFC_CLK duty cycle                                                                                                                                                                                         | $t_{IBKH}/t_{IBK}$ | 45  | 55        | %    | —     |
| Output delay                                                                                                                                                                                               | $t_{IBKLOV1}$      | —   | 1.5       | ns   | —     |
| Output hold                                                                                                                                                                                                | $t_{IBKLOX}$       | —   | -2        | ns   | 1     |
| IFC_CLK[0] to IFC_CLK[m] skew                                                                                                                                                                              | $t_{IBKSKEW}$      | 0   | $\pm 150$ | ps   | —     |
| <b>Notes:</b><br>1. Output hold is negative. This means that output transition happens earlier than the falling edge of IFC_CLK.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |                    |     |           |      |       |

This figure shows the output AC timing diagram for the IFC-GPCM and IFC-GASIC interfaces.



**Figure 39. IFC-GPCM and IFC-GASIC signals**

This table provides the output AC timing specifications of the IFC-NOR interface.

**Table 79. IFC-NOR interface output timing specifications ( $BV_{DD} = 1.8/3.3$  V)**

| Parameter     | Symbol        | Min | Max       | Unit | Notes |
|---------------|---------------|-----|-----------|------|-------|
| Output delay  | $t_{IBKLOV2}$ | —   | $\pm 1.5$ | ns   | 1     |
| <b>Notes:</b> |               |     |           |      |       |

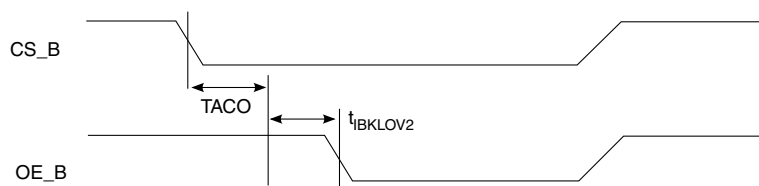
**Table 79. IFC-NOR interface output timing specifications ( $BV_{DD} = 1.8/3.3\text{ V}$ )**

| Parameter                                                                                                                                                  | Symbol | Min | Max | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|-----|------|-------|
| 1. This effectively means that a signal change may appear anywhere within $\pm t_{IBKLOV2}$ (max) duration, from the point where it is expected to change. |        |     |     |      |       |
| 2. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                                     |        |     |     |      |       |

This figure shows the AC timing diagram for output signals of the IFC-NOR interface.

The timing specifications have been illustrated here by taking timings between two signals, CS\_B and OE\_B, as an example. OE\_B is intended to change TACO (a programmable delay) time after CS\_B. Refer to the IFC section of LS1020A QorIQ Advanced Multicore Processor Reference Manual for more information.

Because of skew between the signals, OE\_B may change anywhere within the time window  $t_{IBKLOV2}$  (min) and  $t_{IBKLOV2}$  (max). This concept applies to other output signals of the IFC-NOR interface, as well.

**Figure 40. IFC-NOR Interface output AC timings**

This table provides the output AC timing specifications of the IFC-NAND interface.

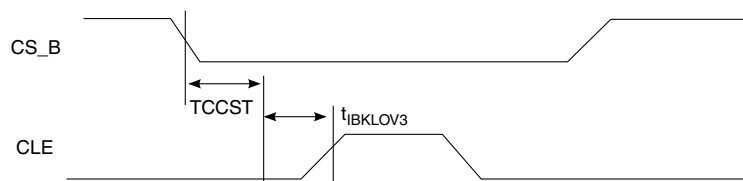
**Table 80. IFC-NAND interface output timing specifications ( $BV_{DD} = 1.8/3.3\text{ V}$ )<sup>2</sup>**

| Parameter                                                                                                                                                                     | Symbol        | Min | Max    | Unit | Notes |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|-----|--------|------|-------|
| Output delay                                                                                                                                                                  | $t_{IBKLOV3}$ | —   | +/-1.5 | ns   | 1     |
| <b>Notes:</b>                                                                                                                                                                 |               |     |        |      |       |
| 1. This effectively means that a signal change may appear anywhere within $t_{IBKLOV3}$ (min) to $t_{IBKLOV3}$ (max) duration, from the point where it is expected to change. |               |     |        |      |       |
| 2. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                                                        |               |     |        |      |       |

This figure shows the AC timing diagram for output signals of the IFC-NAND interface.

The timing specifications have been illustrated here by taking timings between two signals, CS\_B and CLE, as an example. CLE is intended to change TCCST (a programmable delay) time after CS\_B. Refer to the IFC section of LS1020A QorIQ Advanced Multicore Processor Reference Manual for more information.

Because of skew between the signals, CLE may change anywhere within the time window  $t_{IBKLOV3}(\text{min})$  and  $t_{IBKLOV3}(\text{max})$ . This concept applies to other output signals of the IFC-NAND interface, as well.



**Figure 41. IFC-NAND interface output AC timings**

### 3.15.3 IFC NAND Source Synchronous interface AC timing specifications

This table describes the AC timing specifications of the IFC-NAND Source Synchronous interface.

**Table 81. IFC-NAND Source Synchronous interface AC timing specifications ( $BV_{DD} = 1.8/3.3V$ )<sup>4</sup>**

| Parameter                                                          | Symbol                    | I/O | Min                 | Max                    | Unit     | Notes |
|--------------------------------------------------------------------|---------------------------|-----|---------------------|------------------------|----------|-------|
| Command/address DQ hold time                                       | $t_{CAH}$                 | O   | 2.5                 | —                      | ns       | —     |
| CLE and ALE hold time                                              | $t_{CALH}$                | O   | 2.5                 | —                      | ns       | —     |
| CLE and ALE setup time                                             | $t_{CALS}$                | O   | 2.5                 | —                      | ns       | —     |
| Command/address DQ setup time                                      | $t_{CAS}$                 | O   | 2.5                 | —                      | ns       | —     |
| CE# hold time                                                      | $t_{CH}$                  | O   | 2.5                 | —                      | ns       | —     |
| Data DQ setup time                                                 | $t_{DS}$                  | O   | 1                   | —                      | ns       | —     |
| Data DQ hold time                                                  | $t_{DH}$                  | O   | 1                   | —                      | ns       | —     |
| Average clock cycle time (reference signal pin name IFC_NDDDR_CLK) | $t_{CK(avg)}$ or $t_{CK}$ | O   | 13.33               | —                      | ns       | 1     |
| Absolute clock period                                              | $t_{CK(abs)}$             | O   | $t_{CK(avg)} - 0.5$ | $t_{CK(avg)} + 0.5$    | ns       | —     |
| Clock cycle high                                                   | $t_{CKH(abs)}$            | O   | 0.44                | 0.56                   | $t_{CK}$ | 2     |
| Clock cycle low                                                    | $t_{CKL(abs)}$            | O   | 0.44                | 0.56                   | $t_{CK}$ | —     |
| DQS output high pulse width                                        | $t_{DQSH}$                | O   | 0.43                | 0.57                   | $t_{CK}$ | 3     |
| DQS output low pulse width                                         | $t_{DQSL}$                | O   | 0.43                | 0.57                   | $t_{CK}$ | 3     |
| DQS-DQ skew, DQS to last DQ valid, per access                      | $t_{DQSQ}$                | I   | —                   | 1ns=1.8V<br>570ps=3.3V | —        | 5     |

Table continues on the next page...

**Table 81. IFC-NAND Source Synchronous interface AC timing specifications ( $BV_{DD} = 1.8/3.3$  V)<sup>4</sup> (continued)**

| Parameter                                                 | Symbol         | I/O | Min                       | Max                       | Unit     | Notes |
|-----------------------------------------------------------|----------------|-----|---------------------------|---------------------------|----------|-------|
| Data output to first DQS latching transition              | $t_{DQSS}$     | O   | $(0.75 * t_{CK}) + 150ps$ | $(1.25 * t_{CK}) - 150ps$ | $t_{CK}$ | —     |
| DQS cycle time                                            | $t_{DSC}$      | O   | 10                        | —                         | ns       | —     |
| DQS falling edge to CLK rising – hold time                | $t_{DSH}$      | O   | $(0.2 * t_{CK}) + 150ps$  | —                         | $t_{CK}$ | —     |
| DQS falling edge to CLK rising – setup time               | $t_{DSS}$      | O   | 0.3                       | —                         | $t_{CK}$ | —     |
| Input data valid window                                   | $t_{DVW}$      | I   | 2.1ns=1.8V<br>2.95ns=3.3V | —                         | ns       | 5     |
| Half-clock period                                         | $t_{HP}$       | O   | 4.4                       | —                         | ns       | —     |
| The deviation of a given $t_{CK}(abs)$ from $t_{CK}(avg)$ | $t_{JIT}(per)$ | O   | -0.5                      | 0.5                       | ns       | —     |
| DQ-DQS hold, DQS to first DQ to go non-valid, per access  | $t_{QH}$       | I   | 4.64                      | —                         | ns       | —     |

**Notes:**

1.  $t_{CK}(avg)$  is the average clock period over any consecutive 200 cycle window.
2.  $t_{CKH}(abs)$  and  $t_{CKL}(abs)$  include static off set and duty cycle jitter.
3.  $t_{DQSL}$  and  $t_{DQSH}$  are relative to  $t_{CK}$  when CLK is running . If CLK is stopped during data input, then  $t_{DQSL}$  and  $t_{DQSH}$  are relative to  $t_{DSC}$ .
4. For recommended operating conditions, see [Table 3](#)
5. These AC parameters do not meet ONFI standard. The board designer needs to take into account trace length for these signals to meet the timing requirement.

These figures show the AC timing diagram for IFC-NAND source synchronous interface.

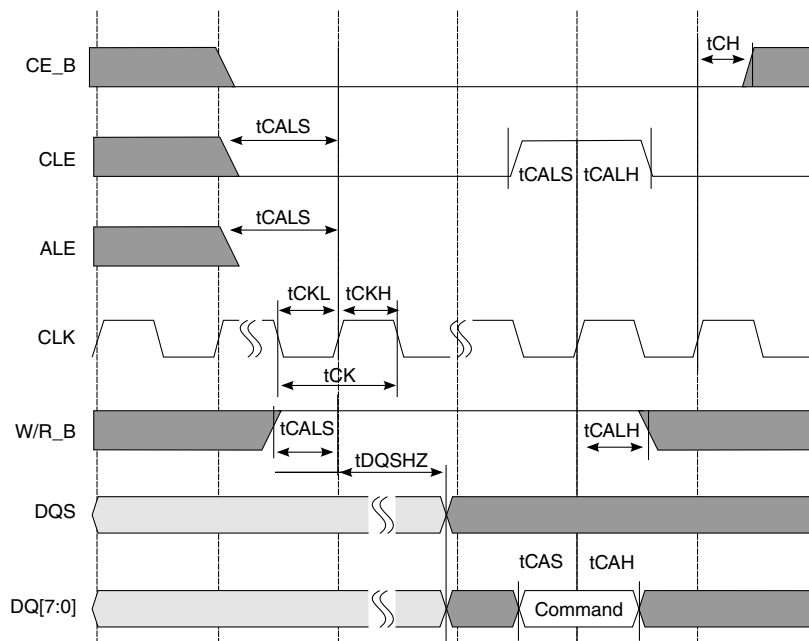


Figure 42. Command cycle

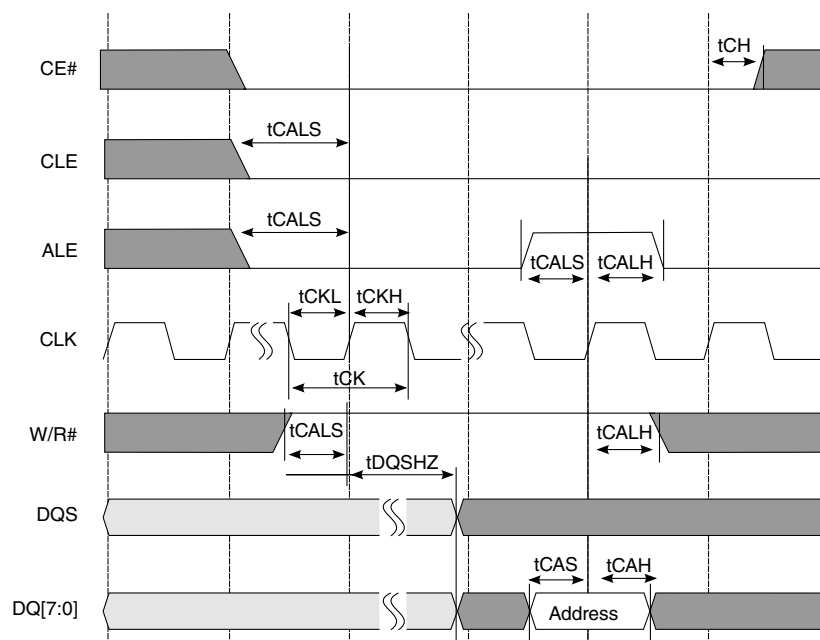


Figure 43. Address cycle

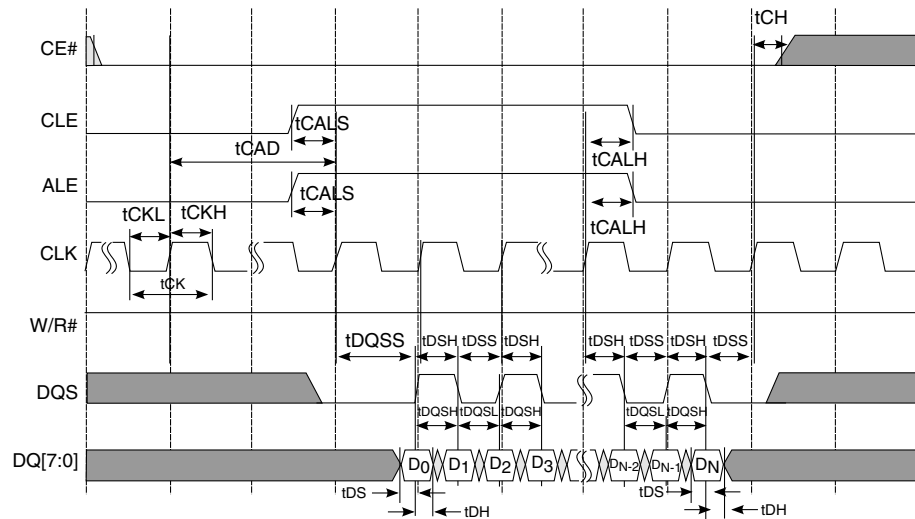


Figure 44. Write cycle

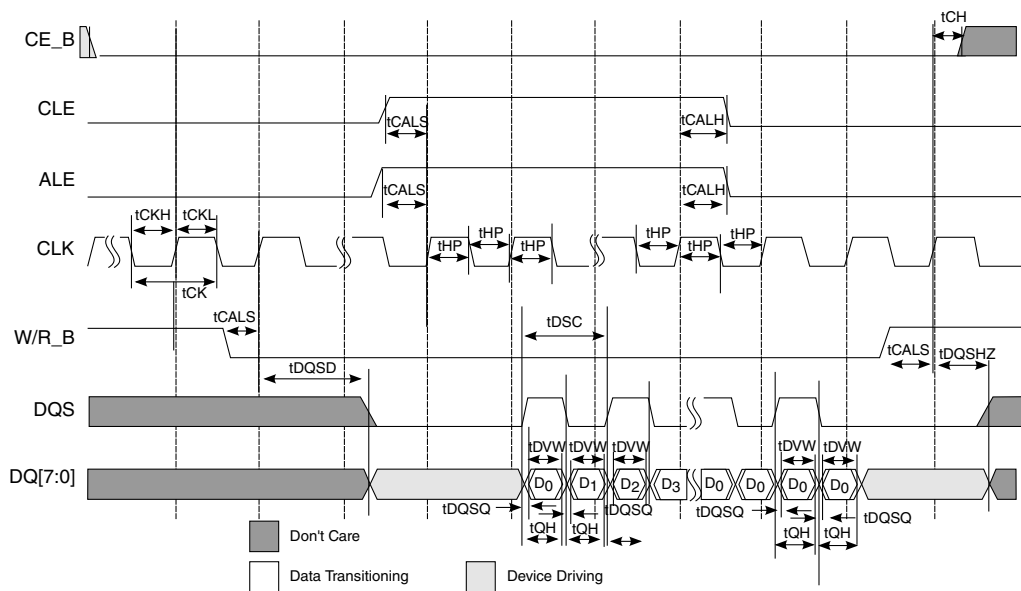


Figure 45. Read cycle

### 3.16 LPUART interface

This section describes the DC and AC electrical specifications for the LPUART interface.

### 3.16.1 LPUART DC electrical characteristics

This table provides the DC electrical characteristics for the LPUART interface when operating at  $DV_{DD} = 3.3\text{ V}$ .

**Table 82. LPUART DC electrical characteristics (3.3 V)<sup>2</sup>**

| Parameter                                                                                                                                                                                                                          | Symbol   | Min                  | Max                  | Unit          | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                 | $V_{IH}$ | $0.7 \times DV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                                                                                                                                  | $V_{IL}$ | —                    | $0.2 \times DV_{DD}$ | V             | 1     |
| Input current ( $DV_{IN} = 0\text{ V}$ or $DV_{IN} = DV_{DD}$ )                                                                                                                                                                    | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | —     |
| Output high voltage ( $I_{OH} = -2.0\text{ mA}$ )                                                                                                                                                                                  | $V_{OH}$ | 2.4                  | —                    | V             | —     |
| Output low voltage ( $I_{OL} = 2.0\text{ mA}$ )                                                                                                                                                                                    | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the min and max $DV_{DD}$ respective values found in <a href="#">Table 3</a> .<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |               |       |

This table provides the DC electrical characteristics for the LPUART interface when operating at  $DV_{DD} = 1.8\text{ V}$ .

**Table 83. LPUART DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                        | Symbol   | Min                  | Max                  | Unit          | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                               | $V_{IH}$ | $0.7 \times DV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                | $V_{IL}$ | —                    | $0.2 \times DV_{DD}$ | V             | 1     |
| Input current ( $DV_{IN} = 0\text{ V}$ or $DV_{IN} = DV_{DD}$ )                                                                                                                                                                                                                                                                                  | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = -0.5\text{ mA}$ )                                                                                                                                                                                                                                                                       | $V_{OH}$ | 1.35                 | —                    | V             | —     |
| Output low voltage ( $DV_{DD} = \text{min}$ , $I_{OL} = 0.5\text{ mA}$ )                                                                                                                                                                                                                                                                         | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the min and max $DV_{DD}$ respective values found in <a href="#">Table 3</a> .<br>2. The symbol $DV_{IN}$ represents the input voltage of the supply referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |               |       |

### 3.16.2 LPUART AC timing specifications

This table provides the AC timing specifications for the LPUART interface.

**Table 84. LPUART AC timing specifications**

| Parameter         | Value                                | Unit | Notes   |
|-------------------|--------------------------------------|------|---------|
| Minimum baud rate | $f_{PLAT}/(2 \times 32 \times 8192)$ | baud | 1, 3, 4 |

Table continues on the next page...

**Table 84. LPUART AC timing specifications  
(continued)**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | Value                          | Unit | Notes   |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|------|---------|
| Maximum baud rate                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | $f_{\text{PLAT}}/(2 \times 4)$ | baud | 1, 2, 4 |
| <b>Notes:</b><br>1. $f_{\text{PLAT}}$ refers to the internal platform clock.<br>2. The actual attainable baud rate is limited by the latency of interrupt processing.<br>3. Every bit can be over sampled with a sample clock rate of 8 and 64 times (software configurable) and each bit is the majority of the values sampled at the sample rate divided by two, (sample rate/2)+1 and (sample rate/2)+2.<br>4. The 1-to-0 transition during a data word can cause a resynchronization of the sample point. |                                |      |         |

## 3.17 Flextimer interface

This section describes the DC and AC electrical characteristics for the Flextimer interface. There are Flextimer pins on various power supplies in this device.

### 3.17.1 Flextimer DC electrical characteristics

This table provides the DC electrical characteristics for Flextimer pins operating at  $L/L1/D/BV_{\text{DD}} = 3.3 \text{ V}$ .

**Table 85. Flextimer DC electrical characteristics (3.3 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                             | Symbol          | Min                         | Max                         | Unit          | Notes |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----------------------------|-----------------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                                                    | $V_{\text{IH}}$ | $0.7 \times nV_{\text{DD}}$ | —                           | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                                                     | $V_{\text{IL}}$ | —                           | $0.2 \times nV_{\text{DD}}$ | V             | 1     |
| Input current ( $V_{\text{IN}} = 0 \text{ V}$ or $V_{\text{IN}} = L/L1/D/BV_{\text{DD}}$ )                                                                                                                                                                                                                                                                                                            | $I_{\text{IN}}$ | —                           | $\pm 50$                    | $\mu\text{A}$ | 2     |
| Output high voltage<br>( $L/L1/D/BV_{\text{DD}} = \text{min}$ , $I_{\text{OH}} = -2 \text{ mA}$ )                                                                                                                                                                                                                                                                                                     | $V_{\text{OH}}$ | 2.4                         | —                           | V             | —     |
| Output low voltage<br>( $L/L1/D/BV_{\text{DD}} = \text{min}$ , $I_{\text{OL}} = 2 \text{ mA}$ )                                                                                                                                                                                                                                                                                                       | $V_{\text{OL}}$ | —                           | 0.4                         | V             | —     |
| <b>Notes:</b><br>1. The min $V_{\text{IL}}$ and max $V_{\text{IH}}$ values are based on the respective min and max $L/L1/D/BV_{\text{IN}}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{\text{IN}}$ , in this case, represents the $L/L1/D/BV_{\text{IN}}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |                 |                             |                             |               |       |

This table provides the DC electrical characteristics for Flextimer pins operating at  $LV_{\text{DD}}/L1V_{\text{DD}} = 2.5 \text{ V}$ .

**Table 86. Flextimer DC electrical characteristics (2.5 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                              | Symbol   | Min                  | Max                  | Unit    | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                     | $V_{IH}$ | $0.7 \times nV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                      | $V_{IL}$ | —                    | $0.2 \times nV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = LV_{DD}/L1V_{DD}$ )                                                                                                                                                                                                                                                                                                        | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage<br>( $LV_{DD}/L1V_{DD} = \min$ , $I_{OH} = -1$ mA)                                                                                                                                                                                                                                                                                                 | $V_{OH}$ | 2.0                  | —                    | V       | —     |
| Output low voltage<br>( $LV_{DD}/L1V_{DD} = \min$ , $I_{OL} = 1$ mA)                                                                                                                                                                                                                                                                                                   | $V_{OL}$ | —                    | 0.4                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $LV_{IN}/L1V_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $LV_{IN}/L1V_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |         |       |

This table provides the DC electrical characteristics for Flextimer pins operating at  $L/L1/D/BV_{DD} = 1.8$  V.

**Table 87. Flextimer DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                          | Symbol   | Min                  | Max                  | Unit    | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                 | $V_{IH}$ | $0.7 \times nV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                  | $V_{IL}$ | —                    | $0.2 \times nV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = L/L1/D/BV_{DD}$ )                                                                                                                                                                                                                                                                                                      | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage<br>( $L/L1/D/BV_{DD} = \min$ , $I_{OH} = -0.5$ mA)                                                                                                                                                                                                                                                                                             | $V_{OH}$ | 1.35                 | —                    | V       | —     |
| Output low voltage<br>( $L/L1/D/BV_{DD} = \min$ , $I_{OL} = 0.5$ mA)                                                                                                                                                                                                                                                                                               | $V_{OL}$ | —                    | 0.4                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $L/L1/D/BV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $L/L1/D/BV_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |         |       |

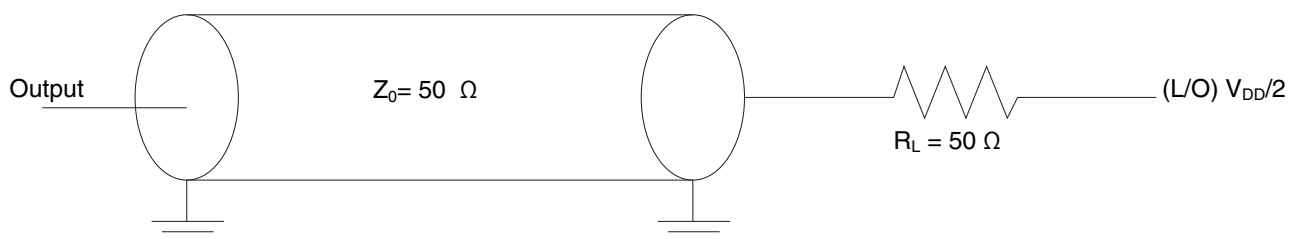
### 3.17.2 Flextimer AC timing specifications

This table provides the Flextimer AC timing specifications.

**Table 88. Flextimer AC timing specifications<sup>2</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                               | Symbol      | Min | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|-----|------|-------|
| Flextimer inputs—minimum pulse width                                                                                                                                                                                                                                                                                                                    | $t_{PIWID}$ | 20  | ns   | 1     |
| <b>Notes:</b><br>1. Flextimer inputs and outputs are asynchronous to any visible clock. Flextimer outputs should be synchronized before use by any external synchronous logic. Flextimer inputs are required to be valid for at least $t_{PIWID}$ to ensure proper operation.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |             |     |      |       |

This figure provides the AC test load for the Flextimer.

**Figure 46. Flextimer AC test load**

### 3.18 SAI/I<sup>2</sup>S interface

This section describes the DC and AC electrical characteristics for the SAI/I<sup>2</sup>S interface. There are SAI/I<sup>2</sup>S pins on various power supplies in this device.

#### 3.18.1 SAI/I<sup>2</sup>S DC electrical characteristics

This table provides the SAI/I<sup>2</sup>S DC electrical characteristics when  $L1V_{DD}/DV_{DD} = 3.3 \text{ V}$ .

**Table 89. SAI/I<sup>2</sup>S DC electrical characteristics ( $L1V_{DD}/DV_{DD} = 3.3 \text{ V}$ )<sup>4</sup>**

| Parameter                                                                                                                                                                                                                                                                                      | Symbol   | Min                  | Max                  | Unit          | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                             | $V_{IH}$ | $0.7 \times nV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                                              | $V_{IL}$ | —                    | $0.2 \times nV_{DD}$ | V             | 1     |
| Input current ( $L1V_{IN} = 0 \text{ V}$ or $L1V_{IN} = L1V_{DD}$ )                                                                                                                                                                                                                            | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2, 3  |
| Output high voltage ( $L1V_{DD} = \text{min}$ , $I_{OH} = -2 \text{ mA}$ )                                                                                                                                                                                                                     | $V_{OH}$ | 2.4                  | —                    | V             | —     |
| Output low voltage ( $L1V_{DD} = \text{min}$ , $I_{OL} = 2 \text{ mA}$ )                                                                                                                                                                                                                       | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $L1V_{IN}/DV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $L1V_{IN}$ , in this case, represents the $L1V_{IN}/DV_{IN}$ symbol referenced in <a href="#">Table 3</a> . |          |                      |                      |               |       |

**Table 89. SAI/I<sup>2</sup>S DC electrical characteristics (L1V<sub>DD</sub>/DV<sub>DD</sub> = 3.3 V)<sup>4</sup>**

| Parameter                                                                                                                                          | Symbol | Min | Max | Unit | Notes |
|----------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|-----|------|-------|
| 3. The symbol L1V <sub>DD</sub> , in this case, represents the L1V <sub>DD</sub> /DV <sub>DD</sub> symbols referenced in <a href="#">Table 3</a> . |        |     |     |      |       |
| 4. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                             |        |     |     |      |       |

This table provides the SAI/I<sup>2</sup>S DC electrical characteristics when L1V<sub>DD</sub> = 2.5 V.

**Table 90. SAI/I<sup>2</sup>S DC electrical characteristics (L1V<sub>DD</sub>/DV<sub>DD</sub> = 2.5 V)<sup>4</sup>**

| Parameters                                                                                                                                                                      | Symbol          | Min                    | Max                    | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------------------------|------------------------|------|-------|
| Input high voltage                                                                                                                                                              | V <sub>IH</sub> | 0.7 x nV <sub>DD</sub> | —                      | V    | 1     |
| Input low voltage                                                                                                                                                               | V <sub>IL</sub> | —                      | 0.2 x nV <sub>DD</sub> | V    | 1     |
| Input current (L1V <sub>IN</sub> = 0 or L1V <sub>IN</sub> = L1V <sub>DD</sub> /DV <sub>DD</sub> )                                                                               | I <sub>IN</sub> | —                      | ±50                    | μA   | 2, 3  |
| Output high voltage (L1V <sub>DD</sub> = min, I <sub>OH</sub> = -1.0 mA)                                                                                                        | V <sub>OH</sub> | 2.00                   | —                      | V    | —     |
| Output low voltage (L1V <sub>DD</sub> = min, I <sub>OL</sub> = 1.0 mA)                                                                                                          | V <sub>OL</sub> | —                      | 0.40                   | V    | —     |
| <b>Notes:</b>                                                                                                                                                                   |                 |                        |                        |      |       |
| 1. The min V <sub>IL</sub> and max V <sub>IH</sub> values are based on the respective min and max L1V <sub>IN</sub> /DV <sub>DD</sub> values found in <a href="#">Table 3</a> . |                 |                        |                        |      |       |
| 2. The symbol V <sub>IN</sub> , in this case, represents the L1V <sub>IN</sub> /DV <sub>DD</sub> symbols referenced in <a href="#">Table 3</a> .                                |                 |                        |                        |      |       |
| 3. The symbol L1V <sub>DD</sub> , in this case, represents the L1V <sub>DD</sub> /DV <sub>DD</sub> symbols referenced in <a href="#">Table 3</a> .                              |                 |                        |                        |      |       |
| 4. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                                                          |                 |                        |                        |      |       |

This table provides the SAI/I<sup>2</sup>S DC electrical characteristics when L1V<sub>DD</sub>/DV<sub>DD</sub> = 1.8 V.

**Table 91. SAI/I<sup>2</sup>S DC electrical characteristics (L1V<sub>DD</sub>/DV<sub>DD</sub> = 1.8 V)<sup>4</sup>**

| Parameter                                                                                                                                                                       | Symbol          | Min                    | Max                    | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------------------------|------------------------|------|-------|
| Input high voltage                                                                                                                                                              | V <sub>IH</sub> | 0.7 x nV <sub>DD</sub> | —                      | V    | 1     |
| Input low voltage                                                                                                                                                               | V <sub>IL</sub> | —                      | 0.2 x nV <sub>DD</sub> | V    | 1     |
| Input current (L1V <sub>IN</sub> = 0 V or L1V <sub>IN</sub> = L1V <sub>DD</sub> )                                                                                               | I <sub>IN</sub> | —                      | ±50                    | μA   | 2, 3  |
| Output high voltage (L1V <sub>DD</sub> = min, I <sub>OH</sub> = -0.5 mA)                                                                                                        | V <sub>OH</sub> | 1.35                   | —                      | V    | 3     |
| Output low voltage (L1V <sub>DD</sub> = min, I <sub>OL</sub> = 0.5 mA)                                                                                                          | V <sub>OL</sub> | —                      | 0.4                    | V    | 3     |
| <b>Notes:</b>                                                                                                                                                                   |                 |                        |                        |      |       |
| 1. The min V <sub>IL</sub> and max V <sub>IH</sub> values are based on the min and max L1V <sub>IN</sub> /DV <sub>DD</sub> respective values found in <a href="#">Table 3</a> . |                 |                        |                        |      |       |
| 2. The symbol L1V <sub>IN</sub> represents the L1V <sub>IN</sub> /DV <sub>DD</sub> symbols referenced in <a href="#">Table 3</a> .                                              |                 |                        |                        |      |       |
| 3. The symbol L1V <sub>DD</sub> , in this case, represents the L1V <sub>DD</sub> /DV <sub>DD</sub> symbols referenced in <a href="#">Table 3</a> .                              |                 |                        |                        |      |       |
| 4. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                                                          |                 |                        |                        |      |       |

### 3.18.2 SAI/I<sup>2</sup>S AC timing specifications

This section provides the AC timings for the synchronous audio interface (SAI) in master (clocks driven) and slave (clocks input) modes.

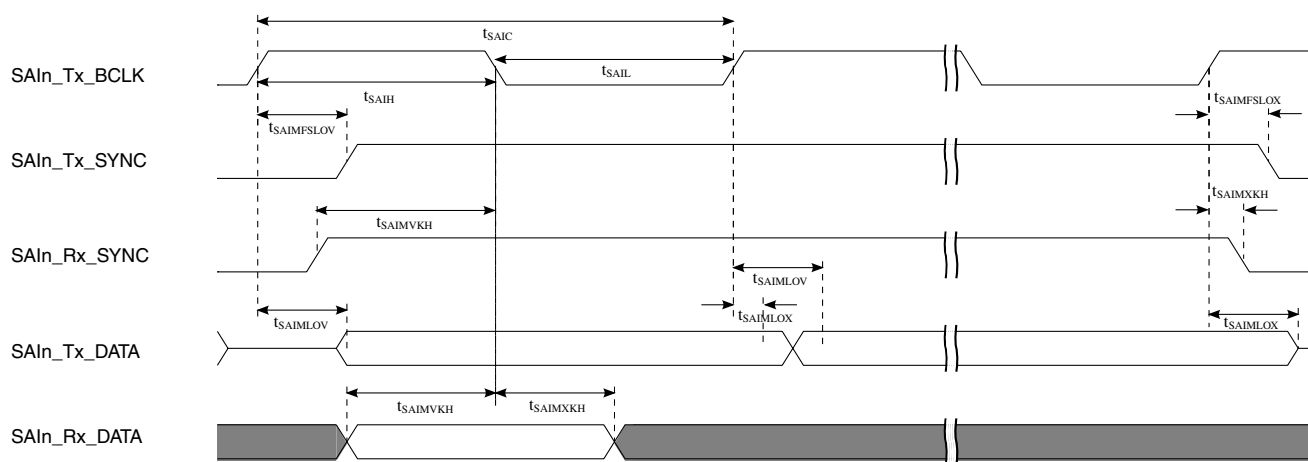
## Electrical characteristics

This table provides the SAI timing in master mode.

**Table 92. Master mode SAI timing**

| Parameter                                                              | Symbol              | Min | Max | Unit        |
|------------------------------------------------------------------------|---------------------|-----|-----|-------------|
| SAIn_TX_BCLK/SAIn_RX_BCLK cycle time                                   | $t_{SAIC}$          | 20  | -   | ns          |
| SAIn_TX_BCLK/SAIn_RX_BCLK pulse width high/low                         | $t_{SAIL}/t_{SAIH}$ | 35% | 65% | BCLK period |
| SAIn_TX_BCLK to SAI <sub>n</sub> _TX_SYNC output valid                 | $t_{SAIMFSLOV}$     | -   | 15  | ns          |
| SAIn_TX_BCLK to SAI <sub>n</sub> _TX_SYNC output invalid               | $t_{SAIMFSLOX}$     | 0   | -   | ns          |
| SAIn_TX_BCLK to SAI <sub>n</sub> _TX_DATA valid                        | $t_{SAIMLDV}$       | -   | 15  | ns          |
| SAIn_TX_BCLK to SAI <sub>n</sub> _TX_DATA invalid                      | $t_{SAIMLDX}$       | 0   | -   | ns          |
| SAIn_RX_DATA/SAIn_RX_SYNC input setup before SAI <sub>n</sub> _RX_BCLK | $t_{SAIMVKH}$       | 15  | -   | ns          |
| SAIn_RX_DATA/SAIn_RX_SYNC input hold after SAI <sub>n</sub> _RX_BCLK   | $t_{SAIMXKH}$       | 0   | -   | ns          |

This figure shows the SAI timing in master modes.



**Figure 47. SAI timing — master modes**

This table provides the SAI timing in slave mode.

**Table 93. Slave mode SAI timing**

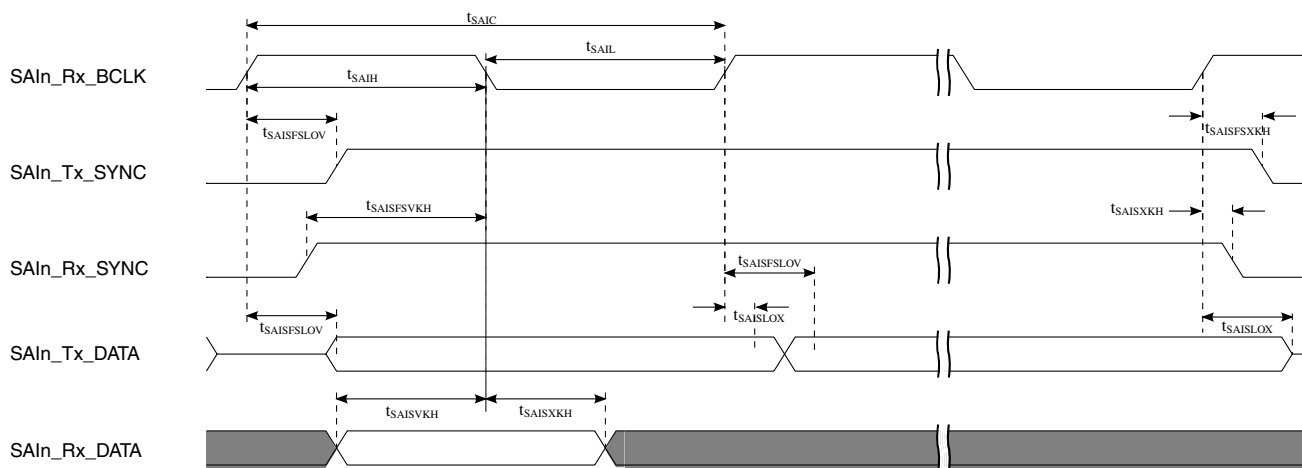
| Parameter                                              | Symbol              | Min | Max | Unit        |
|--------------------------------------------------------|---------------------|-----|-----|-------------|
| SAIn_TX_BCLK/SAIn_RX_BCLK cycle time (input)           | $t_{SAIC}$          | 20  | -   | ns          |
| SAIn_TX_BCLK/SAIn_RX_BCLK pulse width high/low (input) | $t_{SAIL}/t_{SAIH}$ | 35% | 65% | BCLK period |

*Table continues on the next page...*

**Table 93. Slave mode SAI timing (continued)**

|                                                                                      |                 |     |    |    |
|--------------------------------------------------------------------------------------|-----------------|-----|----|----|
| SAIn_RX_SYNC input setup before SAI <sub>n</sub> _RX_BCLK                            | $t_{SAISFSVKH}$ | 10  | -  | ns |
| SAIn_RX_SYNC input hold after SAI <sub>n</sub> _RX_BCLK                              | $t_{SAISFSXKH}$ | 2.1 | -  | ns |
| SAIn_TX_BCLK to SAI <sub>n</sub> _TX_DATA / SAI <sub>n</sub> _TX_SYNC output valid   | $t_{SAISLOV}$   | -   | 20 | ns |
| SAIn_TX_BCLK to SAI <sub>n</sub> _TX_DATA / SAI <sub>n</sub> _TX_SYNC output invalid | $t_{SAISLOX}$   | 0   | -  | ns |
| SAIn_RX_DATA setup before SAI <sub>n</sub> _RX_BCLK                                  | $t_{SAISVKH}$   | 10  | -  | ns |
| SAIn_RX_DATA hold after SAI <sub>n</sub> _RX_BCLK                                    | $t_{SAISXKH}$   | 2.1 | -  | ns |

This figure shows the SAI timing in slave modes.

**Figure 48. SAI timing — slave modes**

## 3.19 SPDIF interface

This section describes the DC and AC electrical characteristics for the Sony/Philips Digital Interconnect Format (SPDIF) interface.

### 3.19.1 SPDIF DC electrical characteristics

This table provides the DC electrical characteristics for the SPDIF interface when operating at  $DV_{DD} = 3.3$  V.

**Table 94. SPDIF DC electrical characteristics ( $DV_{DD} = 3.3\text{ V}$ )<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                       | Symbol   | Min                  | Max                  | Unit          | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                              | $V_{IH}$ | $0.7 \times DV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                               | $V_{IL}$ | —                    | $0.2 \times DV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = DV_{DD}$ )                                                                                                                                                                                                                                                                                                   | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = -2\text{ mA}$ )                                                                                                                                                                                                                                                                                        | $V_{OH}$ | 2.4                  | —                    | V             | —     |
| Output low voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = 2\text{ mA}$ )                                                                                                                                                                                                                                                                                          | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $DV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the input voltage of the supply referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |               |       |

This table provides the DC electrical characteristics for the SPDIF interface when operating at  $DV_{DD} = 1.8\text{ V}$ .

**Table 95. SPDIF DC electrical characteristics ( $DV_{DD} = 1.8\text{ V}$ )<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                       | Symbol   | Min                  | Max                  | Unit          | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                              | $V_{IH}$ | $0.7 \times DV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                               | $V_{IL}$ | —                    | $0.2 \times DV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = DV_{DD}$ )                                                                                                                                                                                                                                                                                                   | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = -0.5\text{ mA}$ )                                                                                                                                                                                                                                                                                      | $V_{OH}$ | 1.35                 | —                    | V             | —     |
| Output low voltage ( $DV_{DD} = \text{min}$ , $I_{OH} = 0.5\text{ mA}$ )                                                                                                                                                                                                                                                                                        | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $DV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the input voltage of the supply referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |               |       |

### 3.19.2 SPDIF AC timing specifications

This table provides the AC timing specifications for the SPDIF interface.

**Table 96. SPDIF AC timing specifications**

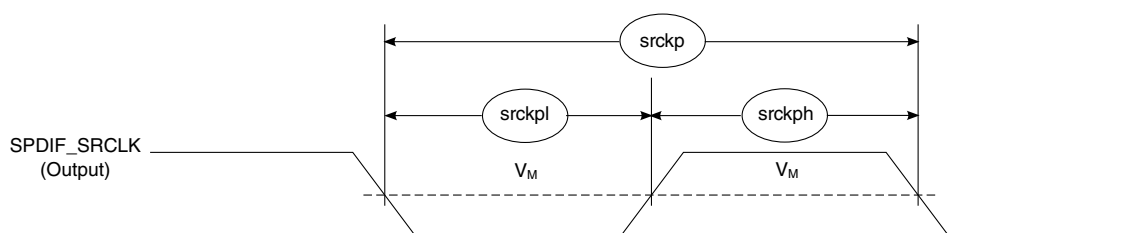
| Characteristics                                    | Symbol             | Min | Max | Unit |
|----------------------------------------------------|--------------------|-----|-----|------|
| SPDIF_IN                                           | —                  | —   | 0.7 | ns   |
| Skew: Asynchronous inputs, no specifications apply |                    |     |     |      |
| SPDIF_OUT output (load = 50 pf)                    | Skew               | —   | —   | 1.5  |
|                                                    | Transition rising  | —   | —   | 24.2 |
|                                                    | Transition falling | —   | —   | 31.3 |

Table continues on the next page...

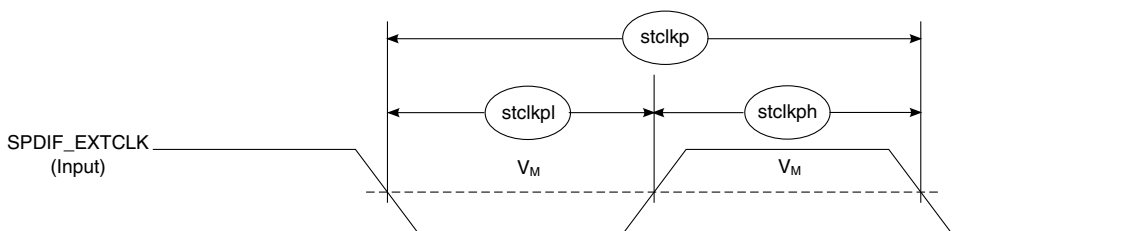
**Table 96. SPDIF AC timing specifications  
(continued)**

| Characteristics          | Symbol | Min  | Max | Unit |
|--------------------------|--------|------|-----|------|
| SPDIF_SRCLK period       | srckp  | 40.0 | —   | ns   |
| SPDIF_SRCLK high period  | srckph | 16.0 | —   | ns   |
| SPDIF_SRCLK low period   | srckpl | 16.0 | —   | ns   |
| SPDIF_EXTCLK period      | stckp  | 40.0 | —   | ns   |
| SPDIF_EXTCLK high period | stckph | 16.0 | —   | ns   |
| SPDIF_EXTCLK low period  | stckpl | 16.0 | —   | ns   |

This figure shows the timing for SPDIF\_SRCLK.

**Figure 49. SPDIF\_SRCLK timing**

This figure shows the timing for SPDIF\_EXTCLK.

**Figure 50. SPDIF\_EXTCLK timing**

## 3.20 SPI interface

This section describes the DC and AC electrical characteristics for the SPI interface.

### 3.20.1 SPI DC electrical characteristics

This table provides the DC electrical characteristics for the SPI interface operating at  $BV_{DD} = 3.3\text{ V}$ .

**Table 97. SPI DC electrical characteristics (3.3 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                            | Symbol   | Min                  | Max                  | Unit    | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                   | $V_{IH}$ | $0.7 \times BV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                    | $V_{IL}$ | —                    | $0.2 \times BV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = BV_{DD}$ )                                                                                                                                                                                                                                                                                               | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage<br>( $BV_{DD} = \text{min}$ , $I_{OH} = -2$ mA)                                                                                                                                                                                                                                                                                  | $V_{OH}$ | 2.4                  | —                    | V       | —     |
| Output low voltage<br>( $BV_{DD} = \text{min}$ , $I_{OL} = 2$ mA)                                                                                                                                                                                                                                                                                    | $V_{OL}$ | —                    | 0.4                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $BV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $BV_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |         |       |

This table provides the DC electrical characteristics for the SPI interface operating at  $BV_{DD} = 1.8$  V.

**Table 98. SPI DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                            | Symbol   | Min                  | Max                  | Unit    | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                   | $V_{IH}$ | $0.7 \times BV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                    | $V_{IL}$ | —                    | $0.2 \times BV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = BV_{DD}$ )                                                                                                                                                                                                                                                                                               | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage<br>( $BV_{DD} = \text{min}$ , $I_{OH} = -0.5$ mA)                                                                                                                                                                                                                                                                                | $V_{OH}$ | 1.35                 | —                    | V       | —     |
| Output low voltage<br>( $BV_{DD} = \text{min}$ , $I_{OL} = 0.5$ mA)                                                                                                                                                                                                                                                                                  | $V_{OL}$ | —                    | 0.4                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $BV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $BV_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |         |       |

### 3.20.2 SPI AC timing specifications

This table provides the SPI timing specifications.

**Table 99. SPI AC timing specifications**

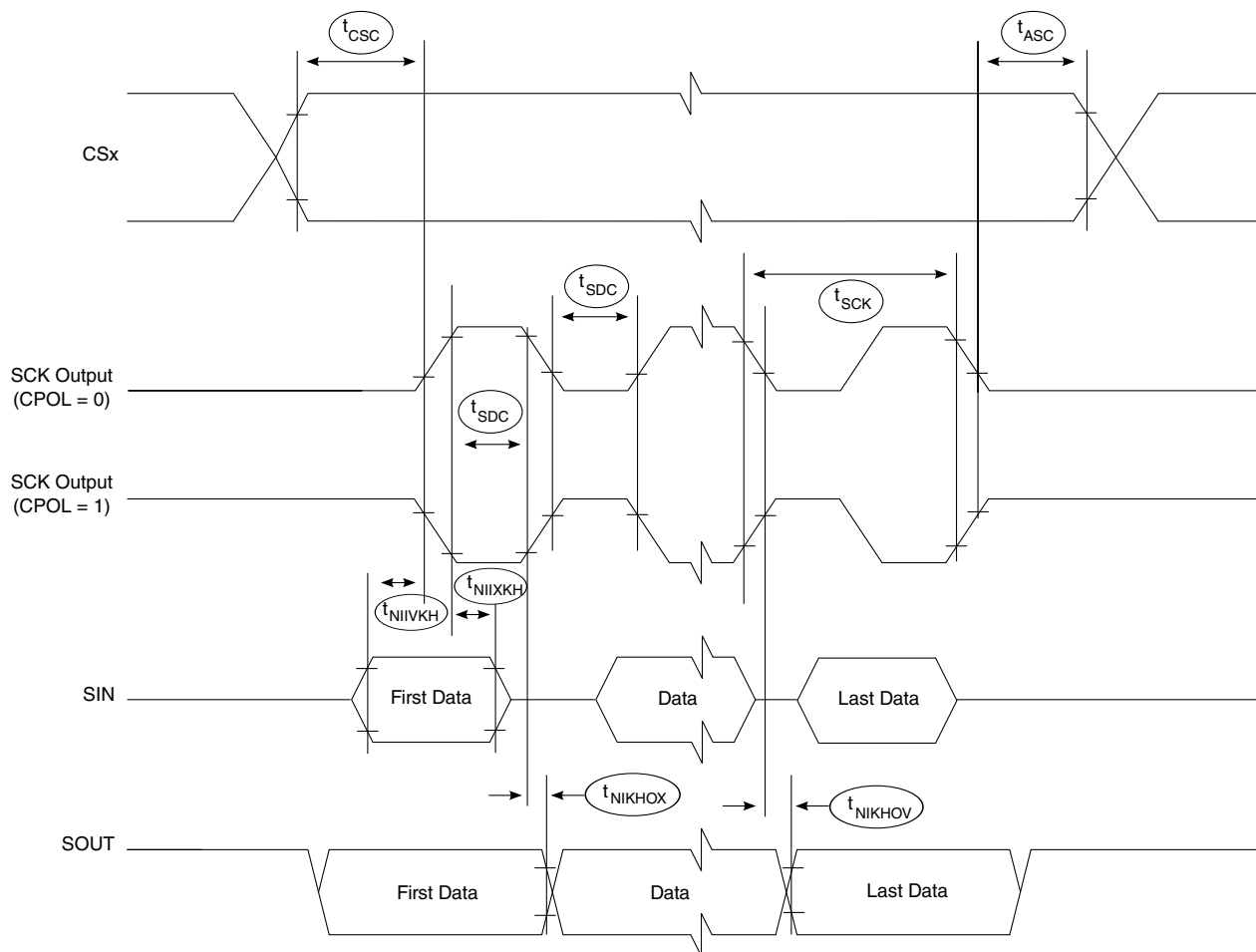
| Parameter      | Symbol    | Condition | Min                 | Max | Unit | Notes |
|----------------|-----------|-----------|---------------------|-----|------|-------|
| SCK Cycle Time | $t_{SCK}$ | —         | $T_{Plat} \times 8$ | —   | ns   | —     |

Table continues on the next page...

**Table 99. SPI AC timing specifications  
(continued)**

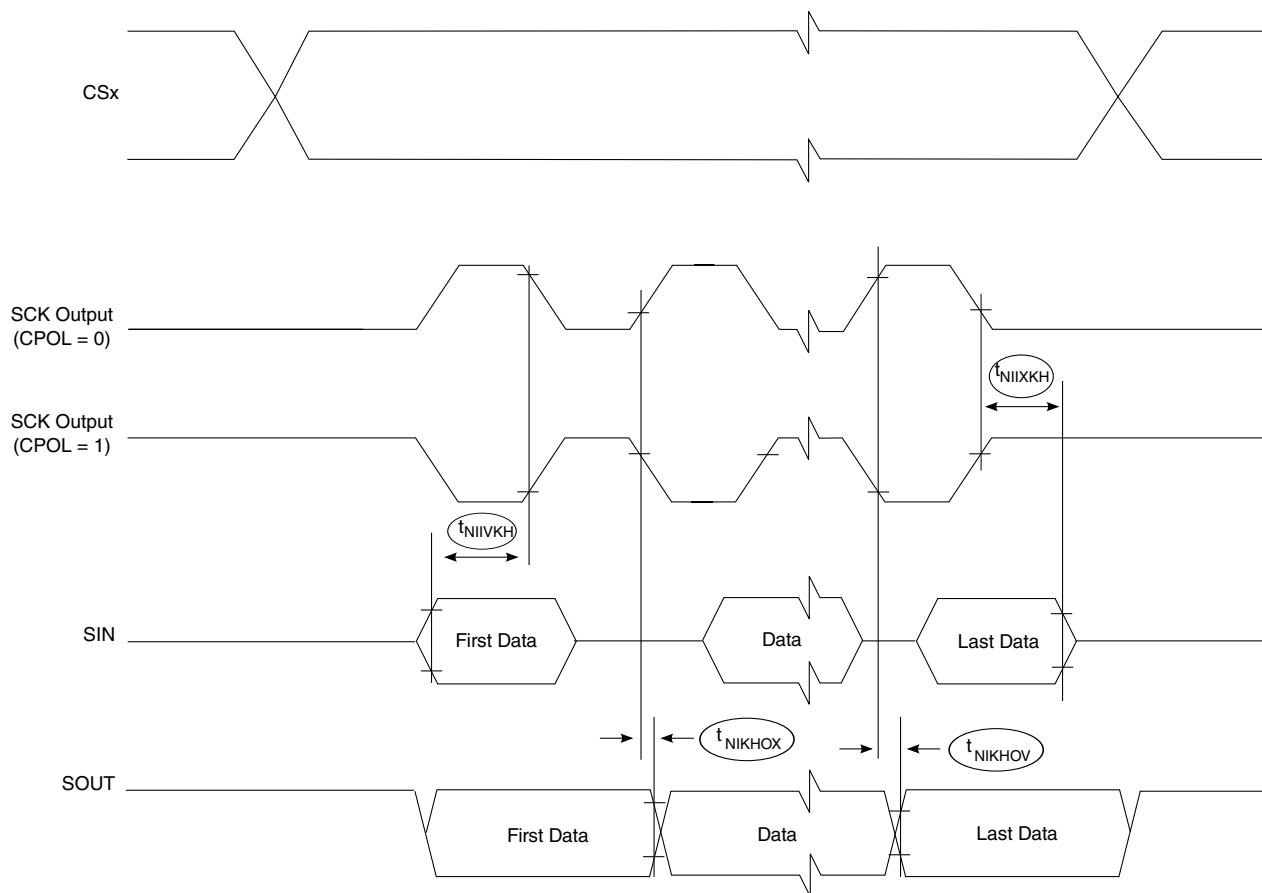
| Parameter                                                                                     | Symbol              | Condition | Min         | Max | Unit             | Notes |
|-----------------------------------------------------------------------------------------------|---------------------|-----------|-------------|-----|------------------|-------|
| SCK Clock Pulse Width                                                                         | t <sub>SDC</sub>    | —         | 40%         | 60% | t <sub>SCK</sub> | —     |
| CS to SCK Delay                                                                               | t <sub>CSC</sub>    | Master    | tp*2 – 5 ns | —   | ns               | 1     |
| After SCK Delay                                                                               | t <sub>ASC</sub>    | Master    | tp*2 – 1 ns | —   | ns               | 1     |
| Slave Access Time (SS active to SOUT driven)                                                  | t <sub>A</sub>      | Slave     | —           | 15  | ns               | —     |
| Slave Disable Time (SS inactive to SOUT High-Z or invalid)                                    | t <sub>DI</sub>     | Slave     | —           | 10  | ns               | —     |
| Data Setup Time for Inputs                                                                    | t <sub>NIIVKH</sub> | Master    | 8           | —   | ns               | —     |
|                                                                                               | t <sub>NEIVKH</sub> | Slave     | 4           | —   |                  | —     |
| Data Hold Time for Inputs                                                                     | t <sub>NIIXKH</sub> | Master    | 0           | —   | ns               | —     |
|                                                                                               | t <sub>NEIXKH</sub> | Slave     | 2           | —   |                  | —     |
| Data Valid (after SCK edge) for Outputs                                                       | t <sub>NIKHOV</sub> | Master    | —           | 5   | ns               | —     |
|                                                                                               | t <sub>NEKHOV</sub> | Slave     | —           | 10  |                  | —     |
| Data Hold Time for Outputs                                                                    | t <sub>NIKHOX</sub> | Master    | 0           | —   | ns               | —     |
|                                                                                               | t <sub>NEKHOX</sub> | Slave     | 0           | —   |                  | —     |
| Notes:                                                                                        |                     |           |             |     |                  |       |
| 1. tp = 2 * platform Clk period. For details, see register SPI_CTARn in the Reference Manual. |                     |           |             |     |                  |       |

This figure shows the SPI timing master when CPHA = 0.



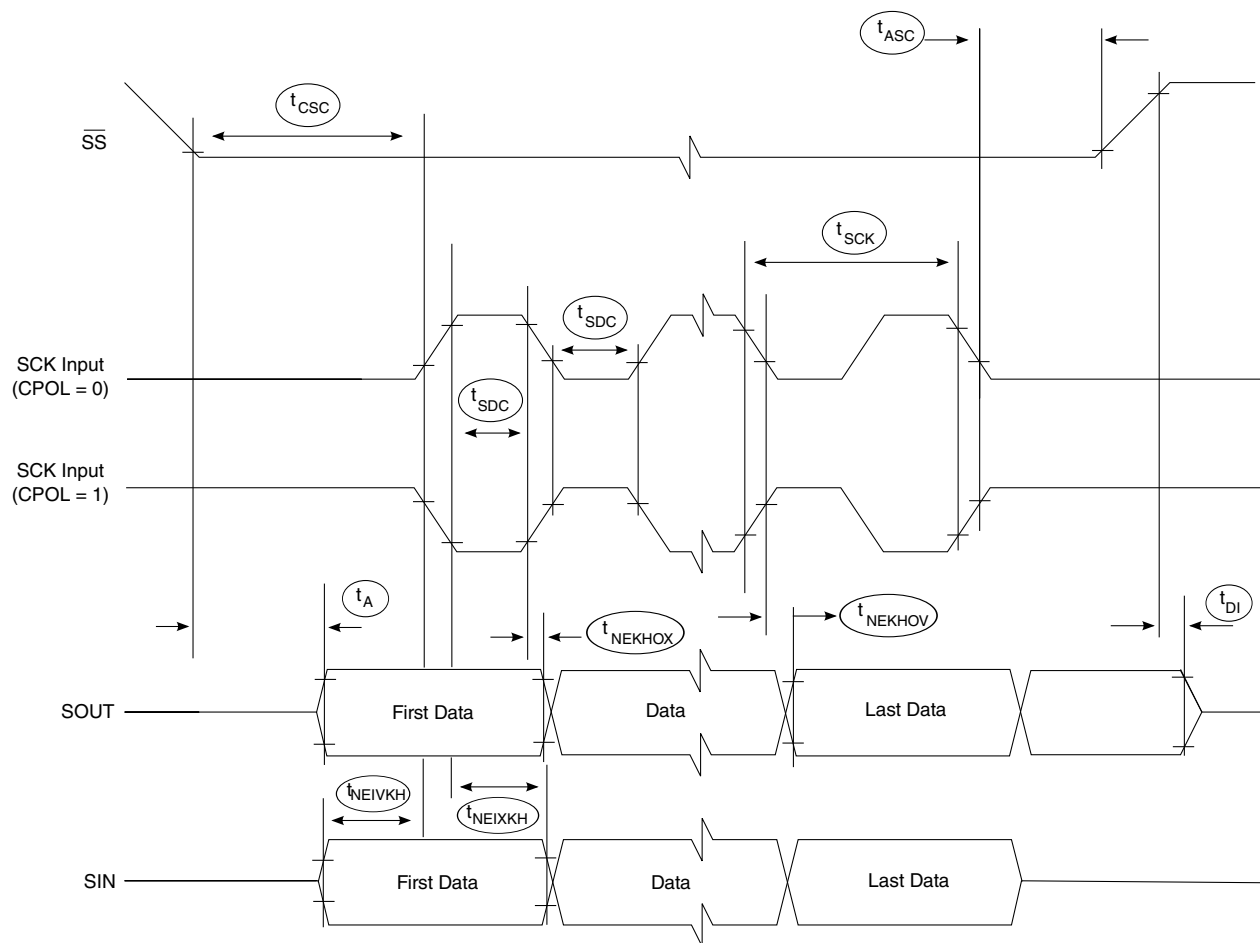
**Figure 51. SPI timing master, CPHA = 0**

This figure shows the SPI timing master when CPHA = 1.



**Figure 52. SPI timing master,  $\text{CPHA} = 1$**

This figure shows the SPI timing slave when  $\text{CPHA} = 0$ .



**Figure 53. SPI timing slave, CPHA = 0**

This figure shows the SPI timing slave when CPHA = 1.

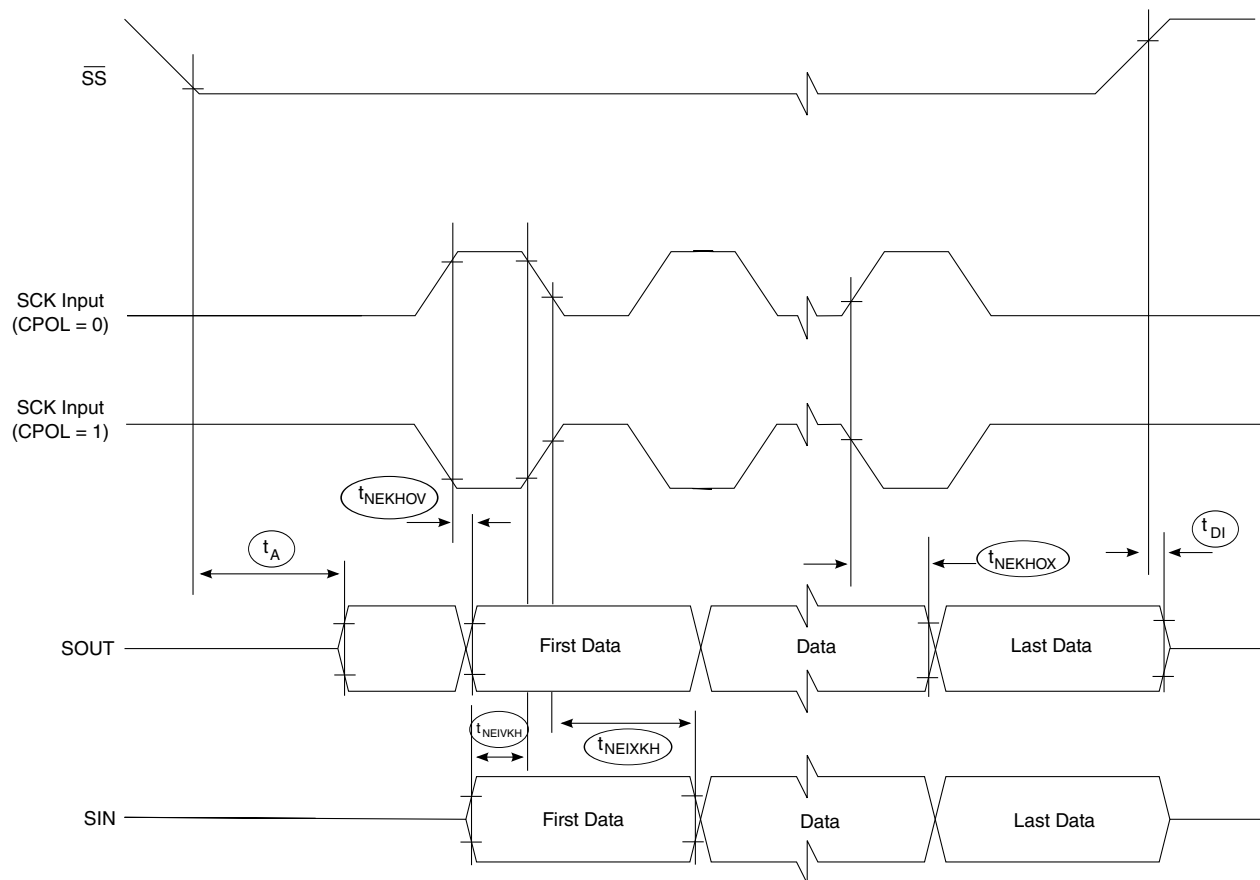


Figure 54. SPI timing slave, CPHA = 1

## 3.21 QuadSPI interface

This section describes the DC and AC electrical characteristics for the QuadSPI interface.

### 3.21.1 QuadSPI DC electrical characteristics

This table provides the DC electrical characteristics for the QuadSPI interface operating at  $BV_{DD} = 3.3\text{ V}$ .

Table 100. QuadSPI DC electrical characteristics (3.3 V)<sup>3</sup>

| Parameter                                                     | Symbol   | Min                  | Max                  | Unit          | Notes |
|---------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                            | $V_{IH}$ | $0.7 \times BV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                             | $V_{IL}$ | —                    | $0.2 \times BV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = BV_{DD}$ ) | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage                                           | $V_{OH}$ | 2.4                  | —                    | V             | —     |

Table continues on the next page...

**Table 100. QuadSPI DC electrical characteristics (3.3 V)<sup>3</sup> (continued)**

| Parameter                                                                                                                                                                                                                                                                                                                                                                               | Symbol          | Min | Max | Unit | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|------|-------|
| (BV <sub>DD</sub> = min, I <sub>OH</sub> = -2 mA)                                                                                                                                                                                                                                                                                                                                       |                 |     |     |      |       |
| Output low voltage<br>(BV <sub>DD</sub> = min, I <sub>OL</sub> = 2 mA)                                                                                                                                                                                                                                                                                                                  | V <sub>OL</sub> | —   | 0.4 | V    | —     |
| <b>Notes:</b><br>1. The min V <sub>IL</sub> and max V <sub>IH</sub> values are based on the respective min and max BV <sub>IN</sub> values found in <a href="#">Table 3</a> .<br>2. The symbol V <sub>IN</sub> , in this case, represents the BV <sub>IN</sub> symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |                 |     |     |      |       |

This table provides the DC electrical characteristics for the QuadSPI interface operating at BV<sub>DD</sub> = 1.8 V.

**Table 101. QuadSPI DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                                               | Symbol          | Min                    | Max                    | Unit | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------------------------|------------------------|------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                                      | V <sub>IH</sub> | 0.7 x BV <sub>DD</sub> | —                      | V    | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                                       | V <sub>IL</sub> | —                      | 0.2 x BV <sub>DD</sub> | V    | 1     |
| Input current (V <sub>IN</sub> = 0 V or V <sub>IN</sub> = BV <sub>DD</sub> )                                                                                                                                                                                                                                                                                                            | I <sub>IN</sub> | —                      | ±50                    | μA   | 2     |
| Output high voltage<br>(BV <sub>DD</sub> = min, I <sub>OH</sub> = -0.5 mA)                                                                                                                                                                                                                                                                                                              | V <sub>OH</sub> | 1.35                   | —                      | V    | —     |
| Output low voltage<br>(BV <sub>DD</sub> = min, I <sub>OL</sub> = 0.5 mA)                                                                                                                                                                                                                                                                                                                | V <sub>OL</sub> | —                      | 0.4                    | V    | —     |
| <b>Notes:</b><br>1. The min V <sub>IL</sub> and max V <sub>IH</sub> values are based on the respective min and max BV <sub>IN</sub> values found in <a href="#">Table 3</a> .<br>2. The symbol V <sub>IN</sub> , in this case, represents the BV <sub>IN</sub> symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |                 |                        |                        |      |       |

### 3.21.2 QuadSPI AC timing specifications

This section describes the QuadSPI timing specifications in SDR mode. All data is based on a negative edge data launch from the device and a positive edge data capture, as shown in the timing figures in this section.

#### 3.21.2.1 QuadSPI timing SDR mode

This table provides the QuadSPI input and output timing in SDR mode.

**Table 102. SDR mode QuadSPI input and output timing**

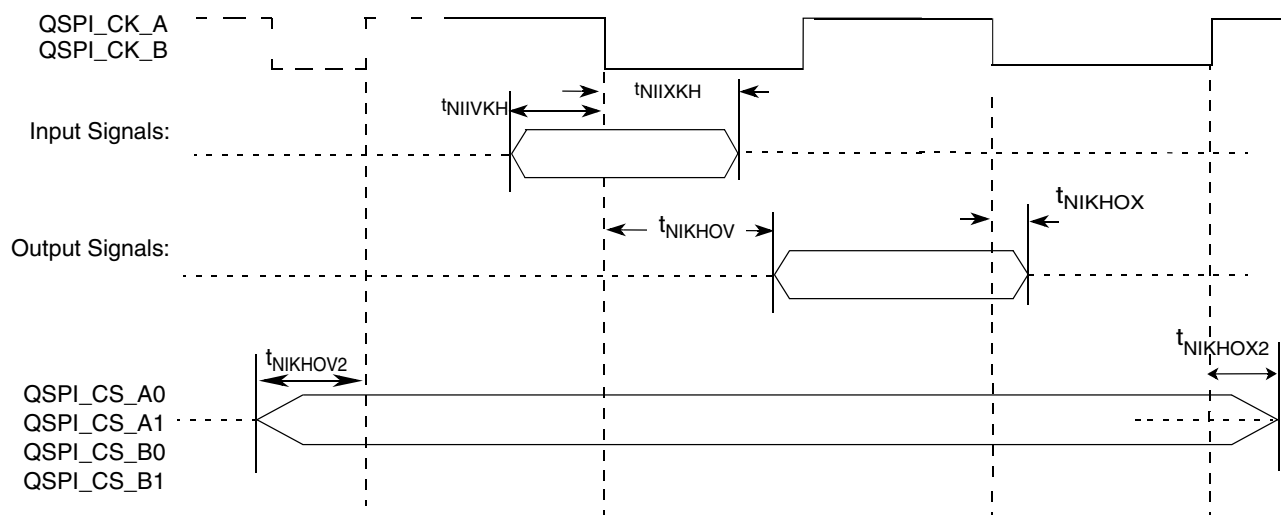
| Parameter                               | Symbol                       | Min            | Max | Unit | Notes |
|-----------------------------------------|------------------------------|----------------|-----|------|-------|
| Clock rise/fall time                    | $T_{RISE}/T_{FALL}$          | 1              | —   | ns   | 1     |
| CS output hold time                     | $t_{NIKHOX2}$                | $-3.4 + j * T$ | —   | ns   | 1, 2  |
| CS output delay                         | $t_{NIKHOV2}$                | $-3.5 + k * T$ | —   | ns   | 1, 2  |
| Setup time for incoming data            | $t_{NIIVKH}$                 | 8.6            | —   | ns   | 1     |
| Hold time requirement for incoming data | $t_{NIIXKH}$                 | 0.4            | —   | ns   | 1     |
| Output data valid                       | $t_{NIKHOV}$<br>$t_{NIKLOV}$ | —              | 4.5 | ns   | 1     |
| Output data hold                        | $t_{NIKHOX}$<br>$t_{NIKLOX}$ | -4.4           | —   | ns   | 1     |

**Notes:**

1. The input timing is relative to the sampling clock edge which is configurable. For more information, refer to register QuadSPI\_SMPR from *LS102xA Reference Manual*.

2. (T) represents the clock period, (j) represents QuadSPI\_FLSHCR[TCSH], and (k) depends on QuadSPI\_FLSHCR[TCSS].

This figure shows the QuadSPI AC timing in SDR mode.

**Figure 55. QuadSPI AC timing — SDR mode**

### 3.22 Enhanced secure digital host controller (eSDHC)

This section describes the DC and AC electrical specifications for the eSDHC interface.

**Note:** This section is preliminary and is subject to further change.

### 3.22.1 eSDHC DC electrical characteristics

This table provides the DC electrical characteristics for the eSDHC interface operating at  $D/EV_{DD} = 3.3\text{ V}$ .

**Table 103. eSDHC interface DC electrical characteristics<sup>3</sup>**

| Characteristic                                                                                                                                                                                                                                                          | Symbol          | Condition                                              | Min                   | Max                    | Unit          | Notes |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|--------------------------------------------------------|-----------------------|------------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                      | $V_{IH}$        | —                                                      | $0.7 \times EV_{DD}$  | —                      | V             | 1     |
| Input low voltage                                                                                                                                                                                                                                                       | $V_{IL}$        | —                                                      | —                     | $0.2 \times EV_{DD}$   | V             | 1     |
| Output high voltage                                                                                                                                                                                                                                                     | $V_{OH}$        | $I_{OH} = -100\text{ }\mu\text{A}$ at $EV_{DD}$<br>min | $0.75 \times EV_{DD}$ | —                      | V             | —     |
| Output low voltage                                                                                                                                                                                                                                                      | $V_{OL}$        | $I_{OL} = 100\text{ }\mu\text{A}$ at $EV_{DD}$<br>min  | —                     | $0.125 \times EV_{DD}$ | V             | —     |
| Output high voltage                                                                                                                                                                                                                                                     | $V_{OH}$        | $I_{OH} = -100\text{ }\mu\text{A}$                     | $EV_{DD} - 0.2$       | —                      | V             | 2     |
| Output low voltage                                                                                                                                                                                                                                                      | $V_{OL}$        | $I_{OL} = 2\text{ mA}$                                 | —                     | 0.3                    | V             | 2     |
| Input/output leakage current                                                                                                                                                                                                                                            | $I_{IN}/I_{OZ}$ | —                                                      | -10                   | 10                     | $\mu\text{A}$ | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $EV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. Open-drain mode is for MMC cards only.<br>3. The eSDHC interface is powered by $DV_{DD}$ and $EV_{DD}$ . |                 |                                                        |                       |                        |               |       |

This table provides the DC electrical characteristics for the eSDHC interface operating at  $D/EV_{DD} = 1.8\text{ V}$  or  $3.3\text{ V}$ .

**Table 104. eSDHC interface DC electrical characteristics (dual-voltage cards)<sup>1, 4</sup>**

| Characteristic                                                                                                                                                                                                                                                                                                                                  | Symbol          | Condition                                              | Min                      | Max                   | Unit          | Notes |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|--------------------------------------------------------|--------------------------|-----------------------|---------------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                              | $V_{IH}$        | —                                                      | $0.7 \times EV_{DD}$     | —                     | V             | 2     |
| Input low voltage                                                                                                                                                                                                                                                                                                                               | $V_{IL}$        | —                                                      | —                        | $0.25 \times EV_{DD}$ | V             | 2     |
| Output high voltage                                                                                                                                                                                                                                                                                                                             | $V_{OH}$        | $I_{OH} = -100\text{ }\mu\text{A}$ at $EV_{DD}$<br>min | $EV_{DD} - 0.2\text{ V}$ | —                     | V             | —     |
| Output low voltage                                                                                                                                                                                                                                                                                                                              | $V_{OL}$        | $I_{OL} = 100\text{ }\mu\text{A}$ at $EV_{DD}$<br>min  | —                        | 0.2                   | V             | —     |
| Output high voltage                                                                                                                                                                                                                                                                                                                             | $V_{OH}$        | $I_{OH} = -100\text{ }\mu\text{A}$                     | $EV_{DD} - 0.2$          | —                     | V             | 3     |
| Output low voltage                                                                                                                                                                                                                                                                                                                              | $V_{OL}$        | $I_{OL} = 2\text{ mA}$                                 | —                        | 0.3                   | V             | 3     |
| Input/Output leakage current                                                                                                                                                                                                                                                                                                                    | $I_{IN}/I_{OZ}$ | —                                                      | -10                      | 10                    | $\mu\text{A}$ | —     |
| <b>Notes:</b><br>1. The eSDHC interface is powered by $DV_{DD}$ and $EV_{DD}$ .<br>2. The min $V_{IL}$ and $V_{IH}$ values are based on the respective min and max $D/EV_{IN}$ values found in <a href="#">Table 3</a> .<br>3. Open-drain mode is for MMC cards only.<br>4. For recommended operating conditions, see <a href="#">Table 3</a> . |                 |                                                        |                          |                       |               |       |

### 3.22.2 eSDHC AC timing specifications

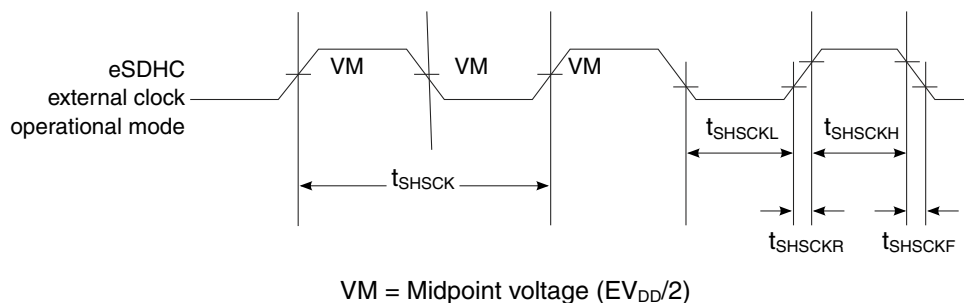
This section provides the AC timing specifications.

This table provides the eSDHC AC timing specifications as defined in [Figure 56](#) and [Figure 57](#) ( $EV_{DD}/DV_{DD} = 1.8\text{ V}$  or  $3.3\text{ V}$ ).

**Table 105. eSDHC AC timing specifications (high speed/ full speed)<sup>6</sup>**

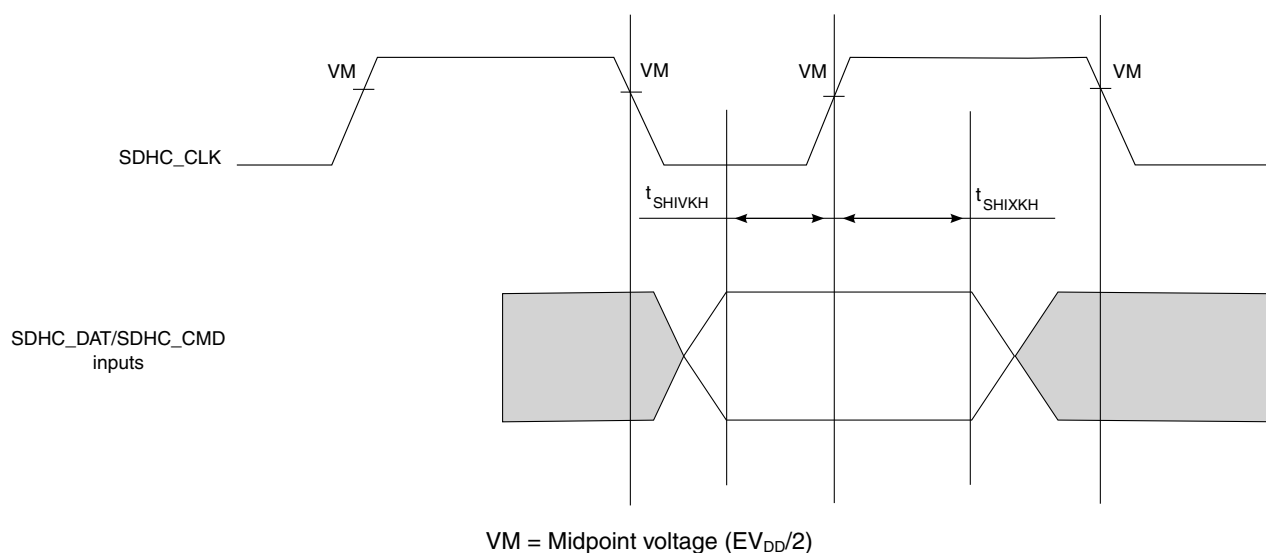
| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |                                      | Symbol <sup>1</sup>           | Min  | Max     | Unit | Notes   |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------|-------------------------------|------|---------|------|---------|
| SDHC_CLK clock frequency                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | SD/SDIO (full-speed/high-speed mode) | $f_{SHSCK}$                   | 0    | 25/46.5 | MHz  | 2, 4    |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | MMC full-speed/high-speed mode       |                               |      | 20/46.5 |      |         |
| SDHC_CLK clock low time (full-speed/high-speed mode)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                                      | $t_{SHSCLK}$                  | 10/7 | —       | ns   | 4       |
| SDHC_CLK clock high time (full-speed/high-speed mode)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |                                      | $t_{SHSSCKH}$                 | 10/7 | —       | ns   | 4       |
| SDHC_CLK clock rise and fall times                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |                                      | $t_{SHSCKR}/$<br>$t_{SHSCKF}$ | —    | 3       | ns   | 4       |
| Input setup times: SDHC_CMD, SDHC_DATx, to SDHC_CLK                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                                      | $t_{SHIVKH}$                  | 4.1  | —       | ns   | 3, 4, 5 |
| Input hold times: SDHC_CMD, SDHC_DATx, to SDHC_CLK                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |                                      | $t_{SHIXKH}$                  | 2.5  | —       | ns   | 3, 4, 5 |
| Output hold time: SDHC_CLK to SDHC_CMD, SDHC_DATx valid                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                      | $t_{SHKHox}$                  | -3   | —       | ns   | 3, 4, 5 |
| Output delay time: SDHC_CLK to SDHC_CMD, SDHC_DATx valid                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                      | $t_{SHKHov}$                  | —    | 3.3     | ns   | 3, 4, 5 |
| <b>Notes:</b><br>1. The symbols used for timing specifications follow these patterns: $t_{(\text{first three letters of functional block})(\text{signal})(\text{state}) (\text{reference})(\text{state})}$ for inputs and $t_{(\text{first three letters of functional block})(\text{reference})(\text{state})(\text{signal})(\text{state})}$ for outputs. For example, $t_{SHDKHOX}$ symbolizes eSDHC device timing (SH) Data (D) Command (C) clock reference (K) going to the high (H) state, with respect to the output (O) reaching the invalid state (X) or output hold time. Note that, in general, the clock reference symbol is based on five letters representing the clock of a particular function. For rise and fall times, the latter convention is used with the appropriate letter: R (rise) or F (fall).<br>2. In full-speed mode, the clock frequency value can be 0-25 MHz for an SD/SDIO card and 0-20 MHz for an MMC card. In high-speed mode, the clock frequency value can be 0-50 MHz for an SD/SDIO card and 0-52 MHz for an MMC card.<br>3. Without voltage translator and SDHC_CLK_SYNC_IN and SDHC_CLK_SYNC_OUT, to satisfy setup timing, one-way board-routing delay between host and card, on SDHC_CLK, SDHC_CMD, and SDHC_DATx should not exceed 1 ns for any high-speed MMC card. For any high-speed or default-speed mode SD card, the one-way board routing delay between host and card, on SDHC_CLK, SDHC_CMD, and SDHC_DATx should not exceed 1.5 ns. With a voltage translator, a 1.7 ns skew for input setup time and 0.5 ns skew for output delay time are considered in the table.<br>4. $C_{CARD} \leq 10\text{ pF}$ , (1 card), and $C_L = C_{BUS} + C_{HOST} + C_{CARD} \leq 40\text{ pF}$ .<br>5. The parameter values apply to both full-speed and high-speed modes.<br>6. For recommended operating conditions, see <a href="#">Table 3</a> . |                                      |                               |      |         |      |         |

This figure shows the eSDHC clock input timing diagram.



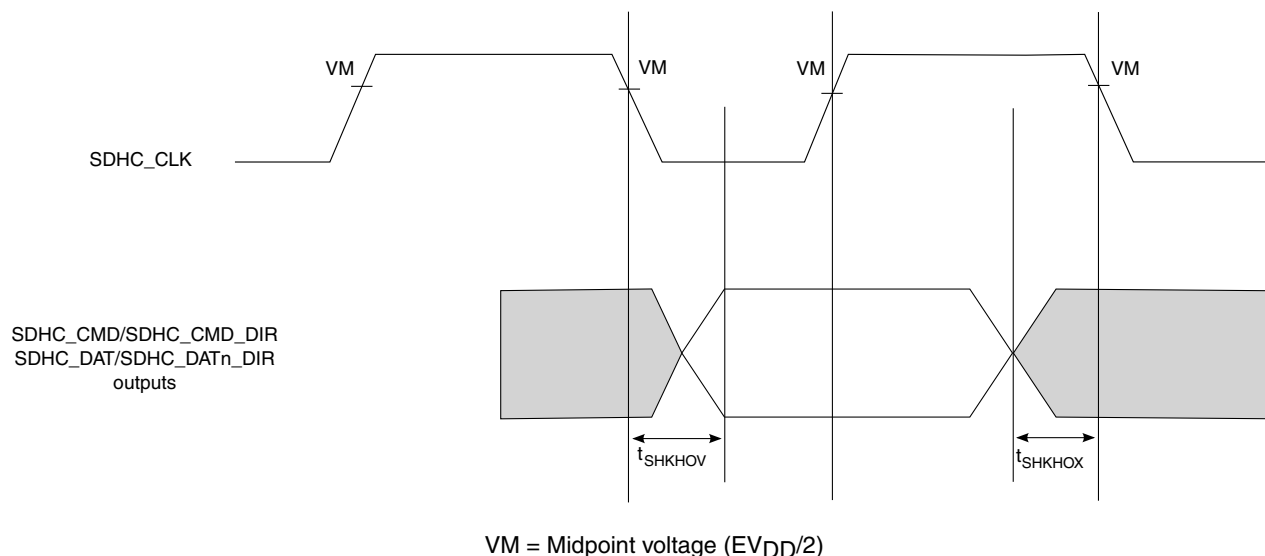
**Figure 56. eSDHC clock input timing diagram**

This figure shows the eSDHC input AC timing diagram for high-speed mode.



**Figure 57. eSDHC high-speed mode input AC timing diagram**

This figure shows the eSDHC output AC timing diagram for high-speed mode.



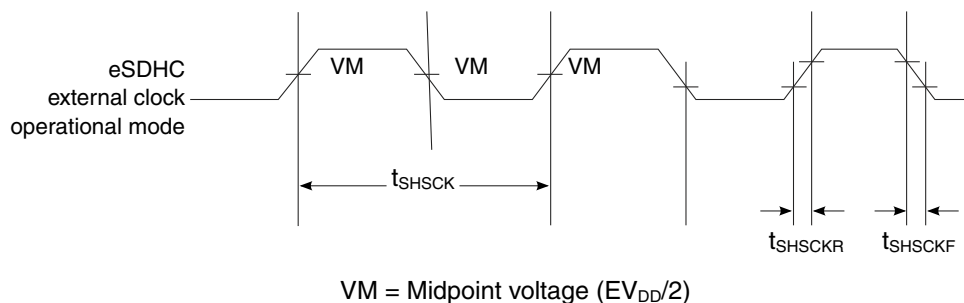
**Figure 58. eSDHC high-speed mode output AC timing diagram**

This table provides the eSDHC AC timing specifications for SDR50 mode ( $EV_{DD}/DV_{DD} = 1.8$  V).

**Table 106. eSDHC AC timing specifications (SDR50)<sup>2</sup>**

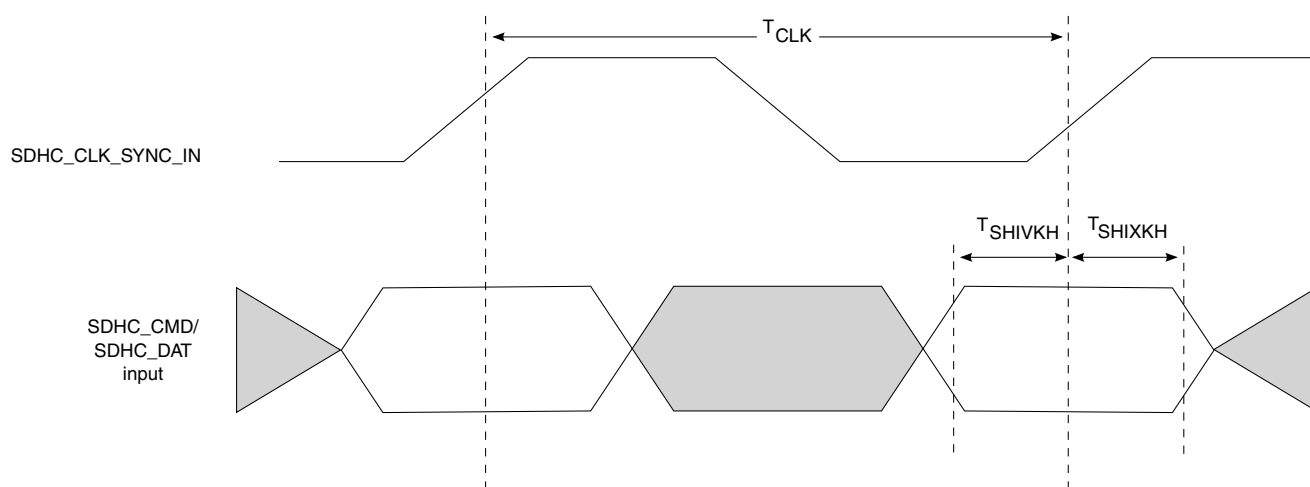
| Parameter                                                                                                                                                                            | Symbol                        | Min | Max | Units | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|-----|-----|-------|-------|
| SDHC_CLK clock frequency                                                                                                                                                             | $f_{SHSCK}$                   | —   | 82  | MHz   | —     |
| SDHC_CLK duty cycle                                                                                                                                                                  | —                             | 45  | 55  | %     | —     |
| SDHC_CLK clock rise and fall times                                                                                                                                                   | $t_{SHSCKR}/$<br>$t_{SHSCKF}$ | —   | 1   | ns    | 1     |
| Input setup times: SDHC_CMD, SDHC_DATx, to SDHC_CLK_SYNC_IN                                                                                                                          | $t_{SHIVKH}$                  | 2.8 | —   | ns    | —     |
| Input hold times: SDHC_CMD, SDHC_DATx, to SDHC_CLK_SYNC_IN                                                                                                                           | $t_{SHIXKH}$                  | 0.9 | —   | ns    | —     |
| Output hold time: SDHC_CLK to SDHC_CMD, SDHC_DATx valid, SDHC_DATx_DIR, SDHC_CMD_DIR                                                                                                 | $t_{SHKHOX}$                  | 1.9 | —   | ns    | —     |
| Output delay time: SDHC_CLK to SDHC_CMD, SDHC_DATx valid, SDHC_DATx_DIR, SDHC_CMD_DIR                                                                                                | $t_{SHKHOV}$                  | —   | 7.7 | ns    | —     |
| <b>Notes:</b><br>1. $C_{CARD} \leq 10$ pF, (1 card), and $C_L = C_{BUS} + C_{HOST} + C_{CARD} \leq 30$ pF.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |                               |     |     |       |       |

This figure shows the eSDHC clock input timing diagram for SDR50 mode.



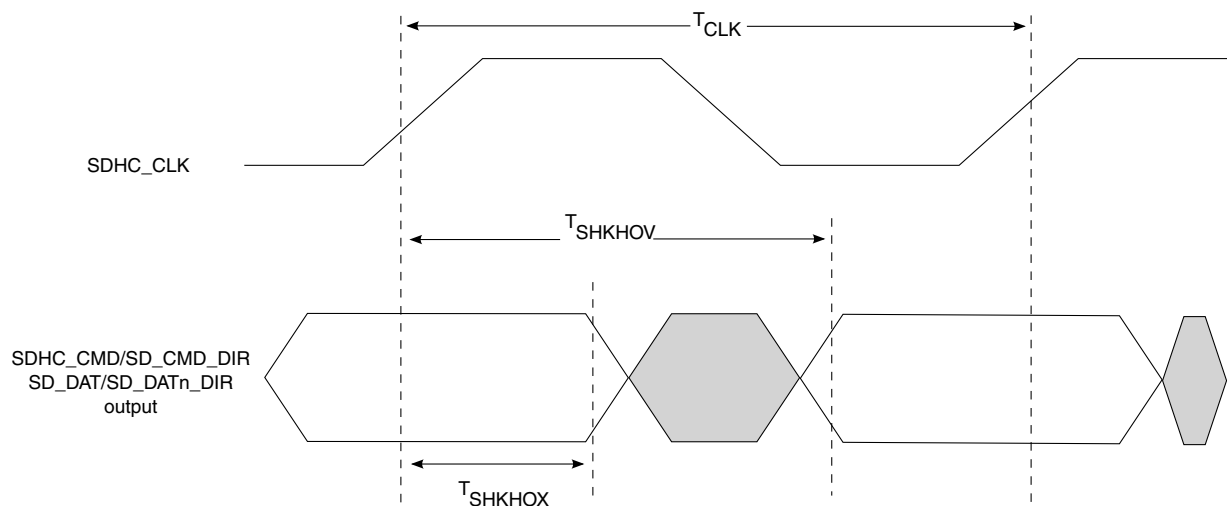
**Figure 59. eSDHC SDR50 mode clock input timing diagram**

This figure shows the eSDHC input AC timing diagram for SDR50 mode.



**Figure 60. eSDHC SDR50 mode input AC timing diagram**

This figure shows the eSDHC output AC timing diagram for SDR50 mode.



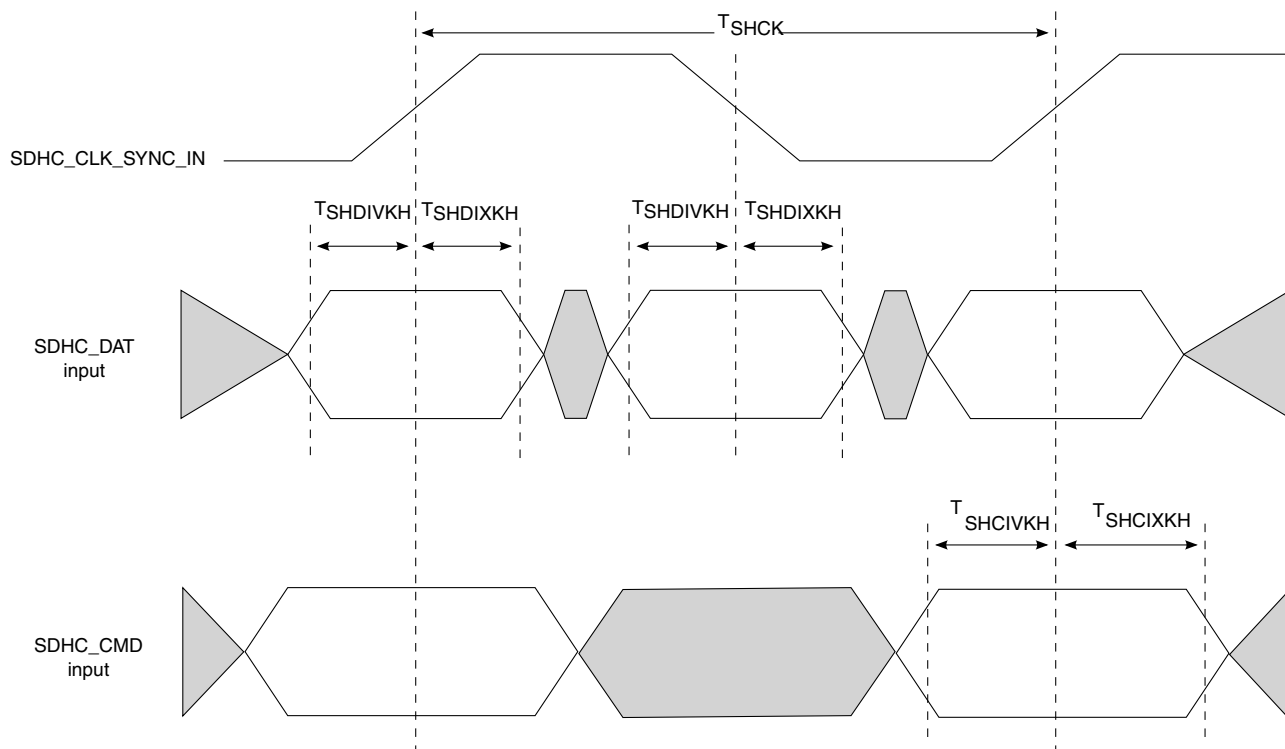
**Figure 61. eSDHC SDR50 mode output AC timing diagram**

This table provides the eSDHC AC timing specifications for DDR50/eMMC DDR mode ( $EV_{DD}/DV_{DD} = 1.8\text{ V}$  for DDR50,  $EV_{DD}/DV_{DD} = 1.8\text{ V}$  or  $3.3\text{ V}$  for eMMC DDR mode).

**Table 107. eSDHC AC timing specifications (DDR50/eMMC DDR)<sup>3</sup>**

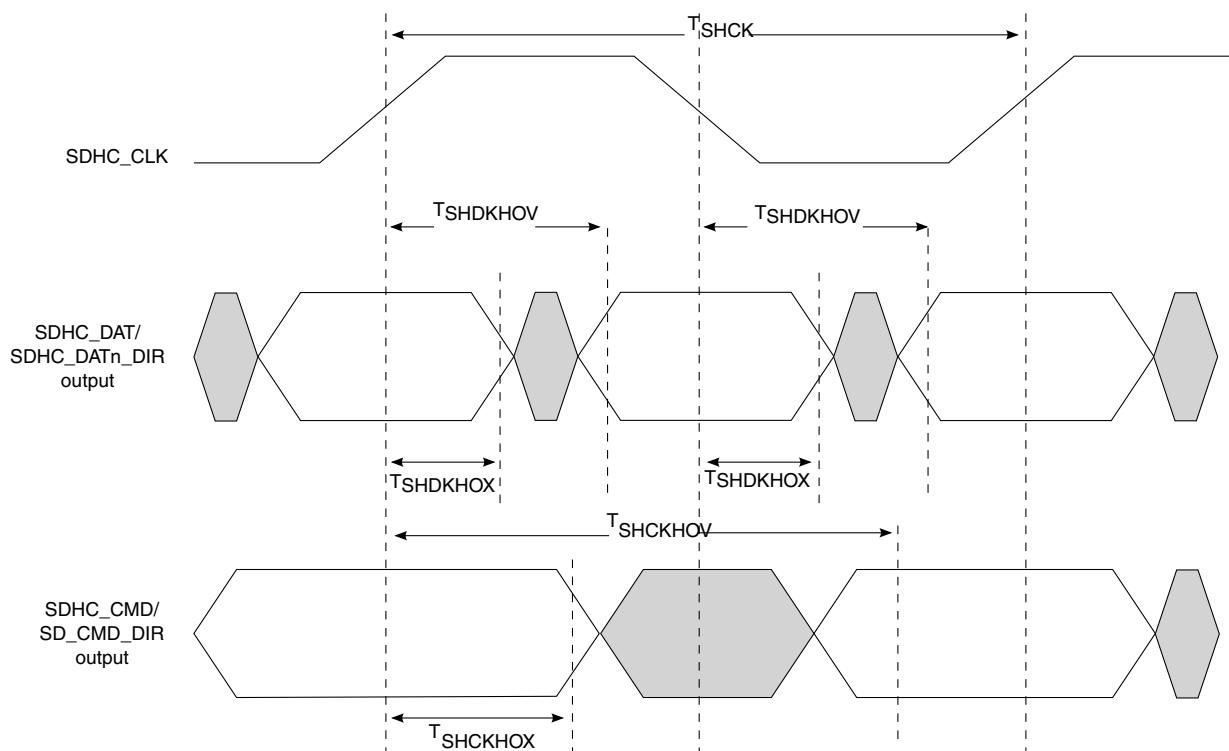
| Parameter                                                                         |                    | Symbol        | Min                           | Max   | Units | Notes |
|-----------------------------------------------------------------------------------|--------------------|---------------|-------------------------------|-------|-------|-------|
| SDHC_CLK clock frequency                                                          | SD/SDIO DDR50 mode | $f_{SHSCK}$   | —                             | 44    | MHz   | —     |
|                                                                                   | eMMC DDR mode      |               |                               | 44    |       |       |
| SDHC_CLK duty cycle                                                               |                    | —             | 47                            | 53    | %     | —     |
| SDHC_CLK clock rise and fall times                                                | SD/SDIO DDR50 mode | $t_{SHSCKR}/$ | —                             | 4     | ns    | 1     |
|                                                                                   | eMMC DDR mode      | $t_{SHSCKF}$  |                               | 2     |       | 2     |
| Input setup times: SDHC_DATx to SDHC_CLK_SYNC_IN                                  | SD/SDIO DDR50 mode | $t_{SHDIVKH}$ | 1.8V = 1.98ns                 | —     | ns    | —     |
|                                                                                   | eMMC DDR mode      |               | 3.3V = 3.2ns<br>1.8V = 1.98ns |       |       |       |
| Input hold times: SDHC_DATx to SDHC_CLK_SYNC_IN                                   | SD/SDIO DDR50 mode | $t_{SHDIXKH}$ | 1.0                           | —     | ns    | —     |
|                                                                                   | eMMC DDR mode      |               | 1.8V = 1.0ns<br>3.3V = 1.2ns  |       |       |       |
| Output hold time: SDHC_CLK to SDHC_DATx valid, SDHC_DATx_DIR                      | SD/SDIO DDR50 mode | $t_{SHDKHOX}$ | 2.2                           | —     | ns    | —     |
|                                                                                   | eMMC DDR mode      |               | 3.92                          |       |       |       |
| Output delay time: SDHC_CLK to SDHC_DATx valid, SDHC_DATx_DIR                     | SD/SDIO DDR50 mode | $t_{SHDKHOV}$ | —                             | 6.1   | ns    | —     |
|                                                                                   | eMMC DDR mode      |               |                               | 6.3   |       |       |
| Input setup times: SDHC_CMD to SDHC_CLK                                           | SD/SDIO DDR50 mode | $t_{SHCIVKH}$ | 3.3                           | —     | ns    | —     |
|                                                                                   | eMMC DDR mode      |               | 3.45                          |       |       |       |
| Input hold times: SDHC_CMD to SDHC_CLK                                            | SD/SDIO DDR50 mode | $t_{SHCIXKH}$ | 0.4                           | —     | ns    | —     |
|                                                                                   | eMMC DDR mode      |               | 0.38                          |       |       |       |
| Output hold time: SDHC_CLK to SDHC_CMD valid, SDHC_CMD_DIR                        | SD/SDIO DDR50 mode | $t_{SHCKHOX}$ | 2.2                           | —     | ns    | —     |
|                                                                                   | eMMC DDR mode      |               | 4.42                          |       |       |       |
| Output delay time: SDHC_CLK to SDHC_CMD valid, SDHC_CMD_DIR                       | SD/SDIO DDR50 mode | $t_{SHCKHOV}$ | —                             | 12.2  | ns    | —     |
|                                                                                   | eMMC DDR mode      |               |                               | 15.35 |       |       |
| Notes:                                                                            |                    |               |                               |       |       |       |
| 1. $C_{CARD} \leq 10\text{ pF}$ , (1 card).                                       |                    |               |                               |       |       |       |
| 2. $C_L = C_{BUS} + C_{HOST} + C_{CARD} \leq 20\text{ pF}$ for MMC, 40 pF for SD. |                    |               |                               |       |       |       |
| 3. For recommended operating conditions, see <a href="#">Table 3</a> .            |                    |               |                               |       |       |       |

This figure shows the eSDHC DDR50/eMMC DDR mode input AC timing diagram.



**Figure 62. eSDHC DDR50/eMMC DDR mode input AC timing diagram**

This figure shows the DDR50/eMMC DDR mode output AC timing diagram.



**Figure 63. eSDHC DDR50/eMMC DDR mode output AC timing diagram**

This table provides the eSDHC AC timing specifications for SDR104/eMMC HS200 mode ( $EV_{DD}/DV_{DD} = 1.8$  V).

**Table 108. eSDHC AC timing specifications (SDR104/eMMC HS200)<sup>2</sup>**

| Parameter                                                                             |                     | Symbol                  | Min | Max  | Units         | Notes |
|---------------------------------------------------------------------------------------|---------------------|-------------------------|-----|------|---------------|-------|
| SDHC_CLK clock frequency                                                              | SD/SDIO SDR104 mode | $f_{SHSCK}$             | —   | 166  | MHz           | —     |
|                                                                                       | eMMC HS200 mode     |                         |     |      |               |       |
| SDHC_CLK duty cycle                                                                   |                     | —                       | 40  | 60   | %             | —     |
| SDHC_CLK clock rise and fall times                                                    |                     | $t_{SHSCKR}/t_{SHSCKF}$ | —   | 1    | ns            | 1     |
| Output hold time: SDHC_CLK to SDHC_CMD, SDHC DATx valid, SDHC_CMD_DIR, SDHC_DATx_DIR  | SD/SDIO SDR104 mode | $T_{SHKHOX}$            | 1.7 | —    | ns            | —     |
|                                                                                       | eMMC HS200 mode     |                         |     |      |               |       |
| Output delay time: SDHC_CLK to SDHC_CMD, SDHC DATx valid, SDHC_CMD_DIR, SDHC_DATx_DIR | SD/SDIO SDR104      | $T_{SHKHOV}$            | —   | 3.82 | ns            | —     |
|                                                                                       | eMMC HS200 mode     |                         |     |      |               |       |
| Input data window (UI)                                                                | SD/SDIO SDR104 mode | $t_{SHIDV}$             | 0.5 | —    | Unit interval | —     |
|                                                                                       | eMMC HS200 mode     |                         |     |      |               |       |

**Notes:**

- $C_L = C_{BUS} + C_{HOST} + C_{CARD} \leq 10$  pF.
- For recommended operating conditions, see [Table 3](#).

This figure shows the SDR104/HS200 mode AC timing diagram.

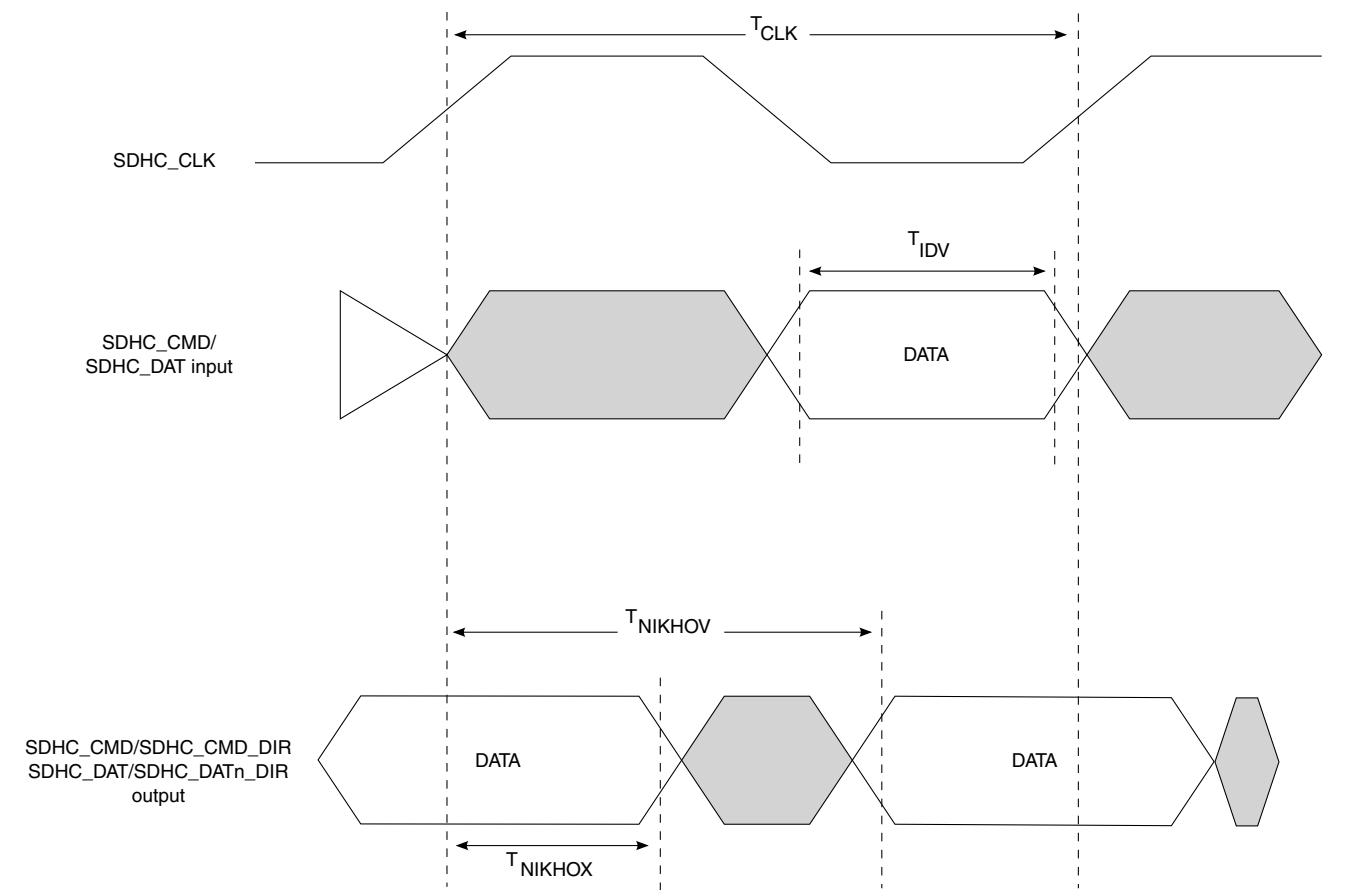


Figure 64. SDR104/eMMC HS200 mode AC timing diagram

3.23 JTAG controller

This section describes the DC and AC electrical specifications for the IEEE 1149.1 (JTAG) interface.

3.23.1 JTAG DC electrical characteristics

This table provides the JTAG DC electrical characteristics.

Table 109. JTAG DC electrical characteristics (OV<sub>DD</sub> = 1.8V)<sup>3</sup>

| Parameter          | Symbol          | Min                    | Max | Unit | Notes |
|--------------------|-----------------|------------------------|-----|------|-------|
| Input high voltage | V <sub>IH</sub> | 0.7 x OV <sub>DD</sub> | —   | V    | 1     |

Table continues on the next page...

**Table 109. JTAG DC electrical characteristics ( $OV_{DD} = 1.8V$ )<sup>3</sup> (continued)**

| Parameter                                                                  | Symbol   | Min  | Max                  | Unit          | Notes |
|----------------------------------------------------------------------------|----------|------|----------------------|---------------|-------|
| Input low voltage                                                          | $V_{IL}$ | —    | $0.2 \times OV_{DD}$ | V             | 1     |
| Input current ( $OV_{IN} = 0\text{ V}$ or $OV_{IN} = OV_{DD}$ )            | $I_{IN}$ | —    | -100/+50             | $\mu\text{A}$ | 2, 4  |
| Output high voltage ( $OV_{DD} = \text{min}$ , $I_{OH} = -0.5\text{ mA}$ ) | $V_{OH}$ | 1.35 | —                    | V             | —     |
| Output low voltage ( $OV_{DD} = \text{min}$ , $I_{OL} = 0.5\text{ mA}$ )   | $V_{OL}$ | —    | 0.4                  | V             | —     |

**Notes:**

1. The min  $V_{IL}$  and max  $V_{IH}$  values are based on the respective min and max  $OV_{IN}$  values found in [Table 3](#).
2. The symbol  $V_{IN}$ , in this case, represents the  $OV_{IN}$  symbol found in [Table 3](#).
3. For recommended operating conditions, see [Table 3](#).
4. TDI, TMS, and TRST\_B have internal pull-ups per the IEEE Std 1149.1 specification.

**3.23.2 JTAG AC timing specifications**

This table provides the JTAG AC timing specifications as defined in [Figure 65](#), [Figure 66](#), [Figure 67](#), and [Figure 68](#).

**Table 110. JTAG AC timing specifications<sup>4</sup>**

| Parameter                                         |                    | Symbol <sup>1</sup>                  | Min | Max  | Unit | Notes |
|---------------------------------------------------|--------------------|--------------------------------------|-----|------|------|-------|
| JTAG external clock frequency of operation        |                    | f <sub>JTG</sub>                     | 0   | 33.3 | MHz  | —     |
| JTAG external clock cycle time                    |                    | t <sub>JTG</sub>                     | 30  | —    | ns   | —     |
| JTAG external clock pulse width measured at 1.4 V |                    | t <sub>JTKHKL</sub>                  | 15  | —    | ns   | —     |
| JTAG external clock rise and fall times           |                    | t <sub>JTGR</sub> /t <sub>JTGF</sub> | 0   | 2    | ns   | —     |
| TRST_B assert time                                |                    | t <sub>TRST</sub>                    | 25  | —    | ns   | 2     |
| Input setup times                                 |                    | t <sub>JTDVKH</sub>                  | 4   | —    | ns   | —     |
| Input hold times                                  |                    | t <sub>JTDXXH</sub>                  | 10  | —    | ns   | —     |
| Output valid times                                | Boundary-scan data | t <sub>JTKLDV</sub>                  | —   | 15   | ns   | 3     |
|                                                   | TDO                |                                      | —   | 10   |      |       |
| Output hold times                                 |                    | t <sub>JTKLDX</sub>                  | 0   | —    | ns   | 3     |

**Notes:**

1. The symbols used for timing specifications follow these patterns:  $t_{(\text{first two letters of functional block})(\text{signal})(\text{state})(\text{reference})(\text{state})}$  for inputs and  $t_{(\text{first two letters of functional block})(\text{reference})(\text{state})(\text{signal})(\text{state})}$  for outputs. For example,  $t_{JTDVKH}$  symbolizes JTAG device timing (JT) with respect to the time data input signals (D) reaching the valid state (V) relative to the  $t_{JTG}$  clock reference (K) going to the high (H) state or setup time. Also,  $t_{JTDXKH}$  symbolizes JTAG timing (JT) with respect to the time data input signals (D) reaching the invalid state (X) relative to the  $t_{JTG}$  clock reference (K) going to the high (H) state. Note that, in general, the clock reference symbol representation is based on three letters representing the clock of a particular function. For rise and fall times, the latter convention is used with the appropriate letter: R (rise) or F (fall).
2. TRST\_B is an asynchronous level sensitive signal. The setup time is for test purposes only.
3. All outputs are measured from the midpoint voltage of the falling edge of  $t_{CLK}$  to the midpoint of the signal in question. The output timings are measured at the pins. All output timings assume a purely resistive 50- $\Omega$  load. Time-of-flight delays must be added for trace lengths, vias, and connectors in the system.
4. For recommended operating conditions, see [Table 3](#).

This figure shows the AC test load for TDO and the boundary-scan outputs of the device.

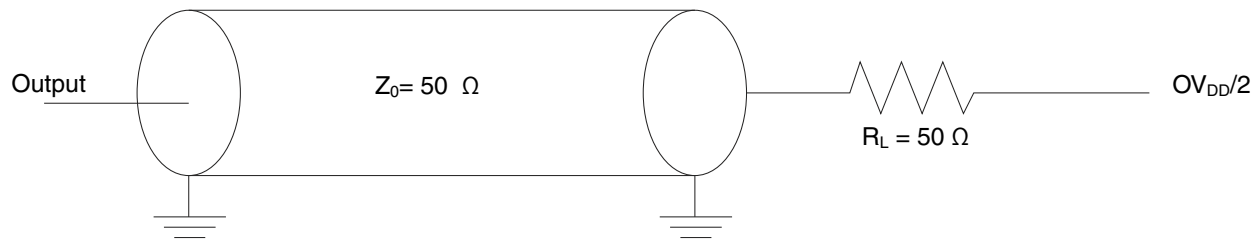


Figure 65. AC test load for the JTAG interface

This figure shows the JTAG clock input timing diagram.

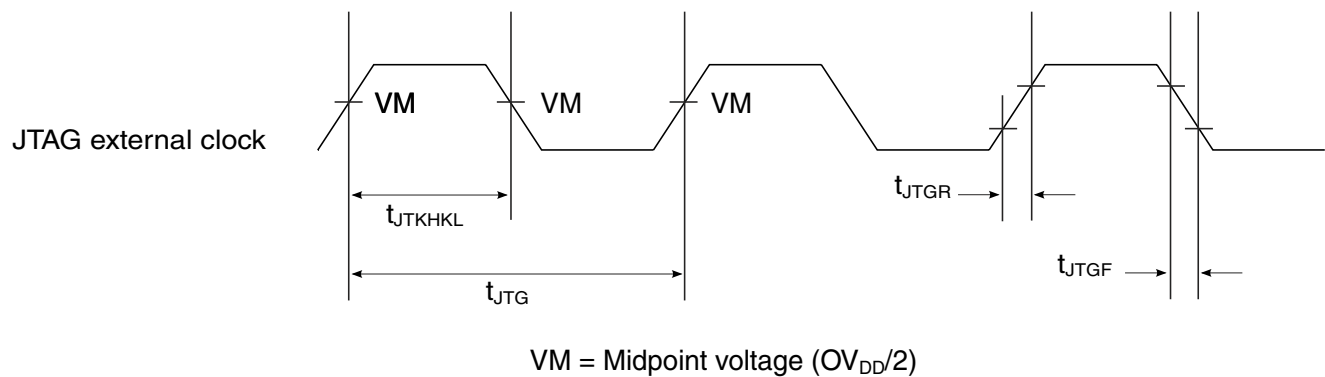


Figure 66. JTAG clock input timing diagram

This figure shows the TRST\_B timing diagram.

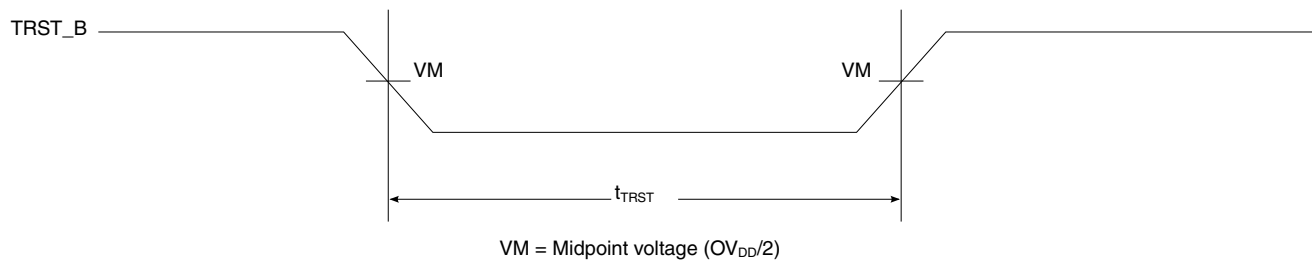


Figure 67. TRST\_B timing diagram

This figure shows the boundary-scan timing diagram.

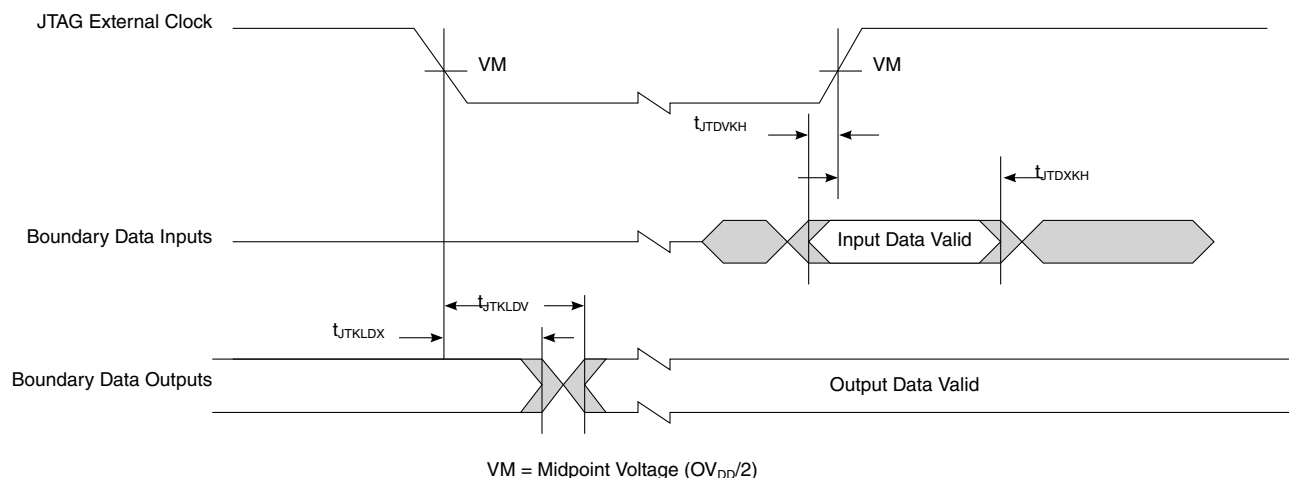


Figure 68. Boundary-scan timing diagram

## 3.24 I<sup>2</sup>C interface

This section describes the DC and AC electrical characteristics for the I<sup>2</sup>C interfaces.

### 3.24.1 I<sup>2</sup>C DC electrical characteristics

This table provides the DC electrical characteristics for the I<sup>2</sup>C1 interfaces operating at  $D1V_{DD} = 3.3$  V, the I<sup>2</sup>C2 interfaces operating at  $DV_{DD} = 3.3$  V, and the I<sup>2</sup>C3 interfaces operating at  $BV_{DD} = 3.3$  V.

Table 111. I<sup>2</sup>C DC electrical characteristics ( $DV_{DD}$ ,  $D1V_{DD} = 3.3$  V)<sup>4</sup>

| Parameter                                                                                                                               | Symbol       | Min                  | Max                  | Unit    | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------|--------------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                      | $V_{IH}$     | $0.7 \times nV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                       | $V_{IL}$     | —                    | $0.2 \times nV_{DD}$ | V       | 1     |
| Output low voltage<br>( $DV_{DD} = \min$ , $I_{OL} = 3$ mA)                                                                             | $V_{OL}$     | —                    | 0.4                  | V       | —     |
| Pulse width of spikes which must be suppressed by the input filter                                                                      | $t_{I2KHKL}$ | 0                    | 50                   | ns      | 2     |
| Input current each I/O pin (input voltage is between $0.1 \times DV_{DD}$ and $0.9 \times DV_{DD}(\max)$ )                              | $I_I$        | -50                  | 50                   | $\mu$ A | 3     |
| Capacitance for each I/O pin                                                                                                            | $C_I$        | —                    | 10                   | pF      | —     |
| <b>Notes:</b>                                                                                                                           |              |                      |                      |         |       |
| 1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $DV_{IN}$ values found in <a href="#">Table 3</a> . |              |                      |                      |         |       |

**Table 111. I<sup>2</sup>C DC electrical characteristics (DV<sub>DD</sub>, D1V<sub>DD</sub> = 3.3 V)<sup>4</sup>**

| Parameter                                                                       | Symbol | Min | Max | Unit | Notes |
|---------------------------------------------------------------------------------|--------|-----|-----|------|-------|
| 2. See the chip reference manual for information about the digital filter used. |        |     |     |      |       |
| 3. I/O pins obstruct the SDA and SCL lines if DV <sub>DD</sub> is switched off. |        |     |     |      |       |
| 4. For recommended operating conditions, see <a href="#">Table 3</a> .          |        |     |     |      |       |

This table provides the DC electrical characteristics for the I<sup>2</sup>C1 interfaces operating at D1V<sub>DD</sub> = 1.8 V, the I<sup>2</sup>C2 interfaces operating at DV<sub>DD</sub> = 1.8 V, and the I<sup>2</sup>C3 interfaces operating at BV<sub>DD</sub> = 1.8 V.

**Table 112. I<sup>2</sup>C DC electrical characteristics (DV<sub>DD</sub>, D1V<sub>DD</sub> = 1.8 V)<sup>4</sup>**

| Parameter                                                                                                     | Symbol              | Min                       | Max                       | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------|---------------------|---------------------------|---------------------------|------|-------|
| Input high voltage                                                                                            | V <sub>IH</sub>     | 0.7 x<br>nV <sub>DD</sub> | —                         | V    | 1     |
| Input low voltage                                                                                             | V <sub>IL</sub>     | —                         | 0.2 x<br>nV <sub>DD</sub> | V    | 1     |
| Output low voltage (DV <sub>DD</sub> = min, I <sub>OL</sub> = 2 mA)                                           | V <sub>OL</sub>     | 0                         | 0.4                       | V    | —     |
| Pulse width of spikes which must be suppressed by the input filter                                            | t <sub>I2KHKL</sub> | 0                         | 50                        | ns   | 2     |
| Input current each I/O pin (input voltage is between 0.1 x DV <sub>DD</sub> and 0.9 x DV <sub>DD</sub> (max)) | I <sub>I</sub>      | -50                       | 50                        | μA   | 3     |
| Capacitance for each I/O pin                                                                                  | C <sub>I</sub>      | —                         | 10                        | pF   | —     |

**Notes:**

1. The min V<sub>IL</sub> and max V<sub>IH</sub> values are based on the respective min and max DV<sub>IN</sub> values found in [Table 3](#).
2. See the chip reference manual for information about the digital filter used.
3. I/O pins obstruct the SDA and SCL lines if DV<sub>DD</sub> is switched off.
4. For recommended operating conditions, see [Table 3](#).

### 3.24.2 I<sup>2</sup>C AC timing specifications

This table provides the AC timing specifications for the I<sup>2</sup>C interfaces.

**Table 113. I<sup>2</sup>C AC timing specifications<sup>5</sup>**

| Parameter                                                                                    | Symbol <sup>1</sup> | Min | Max | Unit | Notes |
|----------------------------------------------------------------------------------------------|---------------------|-----|-----|------|-------|
| SCL clock frequency                                                                          | f <sub>I2C</sub>    | 0   | 400 | kHz  | 2     |
| Low period of the SCL clock                                                                  | t <sub>I2CL</sub>   | 1.3 | —   | μs   | —     |
| High period of the SCL clock                                                                 | t <sub>I2CH</sub>   | 0.6 | —   | μs   | —     |
| Setup time for a repeated START condition                                                    | t <sub>I2SVKH</sub> | 0.6 | —   | μs   | —     |
| Hold time (repeated) START condition (after this period, the first clock pulse is generated) | t <sub>I2SXKL</sub> | 0.6 | —   | μs   | —     |

*Table continues on the next page...*

**Table 113. I<sup>2</sup>C AC timing specifications<sup>5</sup> (continued)**

| Parameter                                                |                              | Symbol <sup>1</sup> | Min                 | Max | Unit          | Notes |
|----------------------------------------------------------|------------------------------|---------------------|---------------------|-----|---------------|-------|
| Data setup time                                          |                              | $t_{I2DVKH}$        | 100                 | —   | ns            | —     |
| Data input hold time                                     | CBUS compatible masters      | $t_{I2DXKL}$        | —                   | —   | $\mu\text{s}$ | 3     |
|                                                          | I <sup>2</sup> C bus devices |                     | 0                   | —   |               |       |
| Data output delay time                                   |                              | $t_{I2OVKL}$        | —                   | 0.9 | $\mu\text{s}$ | 4     |
| Setup time for STOP condition                            |                              | $t_{I2PVKH}$        | 0.6                 | —   | $\mu\text{s}$ | —     |
| Bus free time between a STOP and START condition         |                              | $t_{I2KHDX}$        | 1.3                 | —   | $\mu\text{s}$ | —     |
| Noise margin at the LOW level for each connected device  |                              | $V_{NL}$            | $0.1 \times V_{DD}$ | —   | V             | —     |
| Noise margin at the HIGH level for each connected device |                              | $V_{NH}$            | $0.2 \times V_{DD}$ | —   | V             | —     |
| Capacitive load for each bus line                        |                              | $C_b$               | —                   | 400 | pF            | —     |

**Notes:**

1. The symbols used for timing specifications herein follow these patterns:  $t_{(\text{first two letters of functional block})(\text{signal})(\text{state})(\text{reference})(\text{state})}$  for inputs and  $t_{(\text{first two letters of functional block})(\text{reference})(\text{state})(\text{signal})(\text{state})}$  for outputs. For example,  $t_{I2DVKH}$  symbolizes I<sup>2</sup>C timing (I2) with respect to the time data input signals (D) reaching the valid state (V) relative to the  $t_{I2C}$  clock reference (K) going to the high (H) state or setup time. Also,  $t_{I2SXKL}$  symbolizes I<sup>2</sup>C timing (I2) for the time that the data with respect to the START condition (S) went invalid (X) relative to the  $t_{I2C}$  clock reference (K) going to the low (L) state or hold time. Also,  $t_{I2PVKH}$  symbolizes I<sup>2</sup>C timing (I2) for the time that the data with respect to the STOP condition (P) reaches the valid state (V) relative to the  $t_{I2C}$  clock reference (K) going to the high (H) state or setup time.

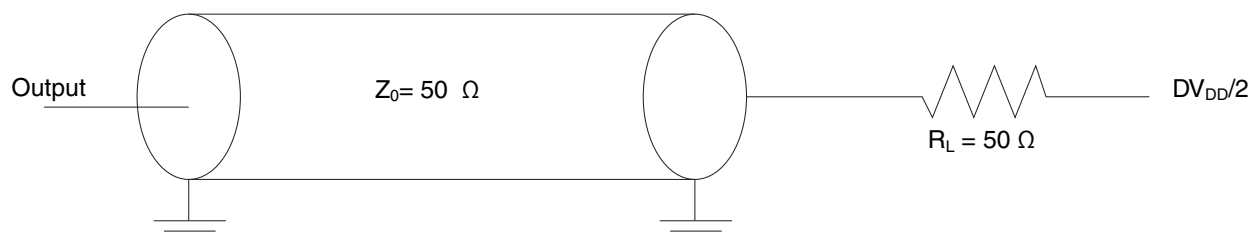
2. The requirements for I<sup>2</sup>C frequency calculation must be followed. See *Determining the I<sup>2</sup>C Frequency Divider Ratio for SCL* (AN2919).

3. As a transmitter, the chip provides a delay time of at least 300 ns for the SDA signal (referred to the  $V_{IHmin}$  of the SCL signal) to bridge the undefined region of the falling edge of SCL to avoid unintended generation of a START or STOP condition. When the chip acts as the I<sup>2</sup>C bus master while transmitting, it drives both SCL and SDA. As long as the load on SCL and SDA are balanced, the chip does not generate an unintended START or STOP condition. Therefore, the 300 ns SDA output delay time is not a concern. If, under some rare condition, the 300 ns SDA output delay time is required for the chip as transmitter, see *Determining the I<sup>2</sup>C Frequency Divider Ratio for SCL* (AN2919).

4. The maximum  $t_{I2OVKL}$  has to be met only if the device does not stretch the LOW period ( $t_{I2CL}$ ) of the SCL signal.

5. For recommended operating conditions, see [Table 3](#).

This figure shows the AC test load for the I<sup>2</sup>C.

**Figure 69. I<sup>2</sup>C AC test load**

This figure shows the AC timing diagram for the I<sup>2</sup>C bus.

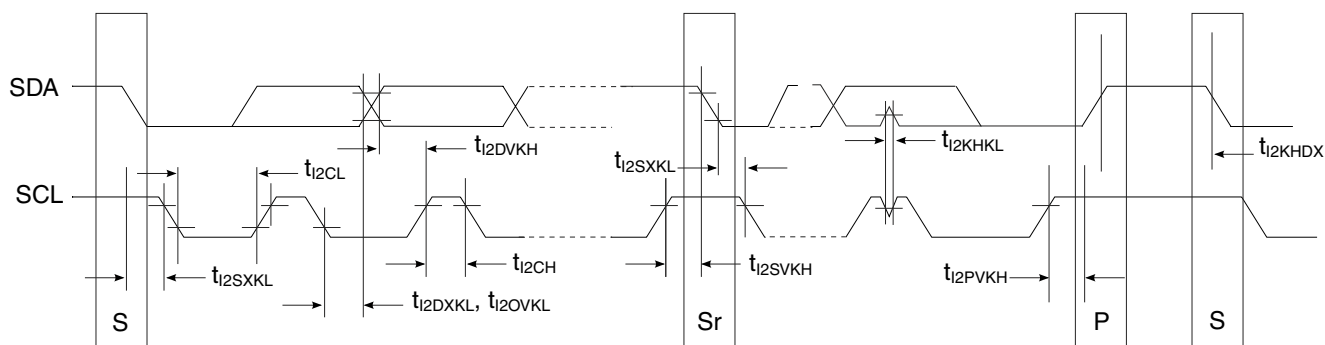


Figure 70. I²C bus AC timing diagram

## 3.25 GPIO interface

This section describes the DC and AC electrical characteristics for the GPIO interface. There are GPIO pins on various power supplies in this device. In this section,  $LV_{IN}$  and  $LV_{DD}$  stands for any power supply that the GPIO is running off.

### 3.25.1 GPIO DC electrical characteristics

This table provides the DC electrical characteristics for GPIO pins operating at  $L/L1/D/D1/O/O1/E/BV_{DD} = 3.3\text{ V}$ .

Table 114. GPIO DC electrical characteristics (3.3 V)<sup>3</sup>

| Parameter                                                                                                              | Symbol   | Min                  | Max                  | Unit          | Notes |
|------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                                                                     | $V_{IH}$ | $0.7 \times nV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                                                                      | $V_{IL}$ | —                    | $0.2 \times nV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = LV_{DD}$ )                                                          | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage<br>( $LV_{DD} = \text{min}$ , $I_{OH} = -2\text{ mA}$ )                                            | $V_{OH}$ | 2.4                  | —                    | V             | —     |
| Output low voltage<br>( $LV_{DD} = \text{min}$ , $I_{OL} = 2\text{ mA}$ )                                              | $V_{OL}$ | —                    | 0.4                  | V             | —     |
| <b>Notes:</b>                                                                                                          |          |                      |                      |               |       |
| 1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $LV_{IN}$ values found in Table 3. |          |                      |                      |               |       |
| 2. The symbol $V_{IN}$ , in this case, represents the $LV_{IN}$ symbol referenced in Table 3.                          |          |                      |                      |               |       |
| 3. For recommended operating conditions, see Table 3.                                                                  |          |                      |                      |               |       |

This table provides the DC electrical characteristics for GPIO pins operating at  $L/L1/D/D1/O/O1/E/BV_{DD} = 2.5\text{ V}$ ,  $V_{DD} = 2.5\text{ V}$ .

**Table 115. GPIO DC electrical characteristics (2.5 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                                              | Symbol   | Min                  | Max                  | Unit    | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                                     | $V_{IH}$ | $0.7 \times nV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                                      | $V_{IL}$ | —                    | $0.2 \times nV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = LV_{DD}/L1V_{DD}$ )                                                                                                                                                                                                                                                                                                        | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage<br>( $LV_{DD}/L1V_{DD} = \text{min}$ , $I_{OH} = -1$ mA)                                                                                                                                                                                                                                                                                           | $V_{OH}$ | 2.0                  | —                    | V       | —     |
| Output low voltage<br>( $LV_{DD}/L1V_{DD} = \text{min}$ , $I_{OL} = 1$ mA)                                                                                                                                                                                                                                                                                             | $V_{OL}$ | —                    | 0.4                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $LV_{IN}/L1V_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $LV_{IN}/L1V_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |         |       |

This table provides the DC electrical characteristics for GPIO pins operating at  $L/L1/D/D1/O/O1/E/BV_{DD} = 1.8$  V.

**Table 116. GPIO DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                                                                                                                                                                            | Symbol   | Min                  | Max                  | Unit    | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------------------|----------------------|---------|-------|
| Input high voltage                                                                                                                                                                                                                                                                                                                                   | $V_{IH}$ | $0.7 \times nV_{DD}$ | —                    | V       | 1     |
| Input low voltage                                                                                                                                                                                                                                                                                                                                    | $V_{IL}$ | —                    | $0.2 \times nV_{DD}$ | V       | 1     |
| Input current ( $V_{IN} = 0$ V or $V_{IN} = LV_{DD}$ )                                                                                                                                                                                                                                                                                               | $I_{IN}$ | —                    | $\pm 50$             | $\mu A$ | 2     |
| Output high voltage<br>( $LV_{DD} = \text{min}$ , $I_{OH} = -0.5$ mA)                                                                                                                                                                                                                                                                                | $V_{OH}$ | 1.35                 | —                    | V       | —     |
| Output low voltage<br>( $LV_{DD} = \text{min}$ , $I_{OL} = 0.5$ mA)                                                                                                                                                                                                                                                                                  | $V_{OL}$ | —                    | 0.4                  | V       | —     |
| <b>Notes:</b><br>1. The min $V_{IL}$ and max $V_{IH}$ values are based on the respective min and max $LV_{IN}$ values found in <a href="#">Table 3</a> .<br>2. The symbol $V_{IN}$ , in this case, represents the $LV_{IN}$ symbol referenced in <a href="#">Table 3</a> .<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |          |                      |                      |         |       |

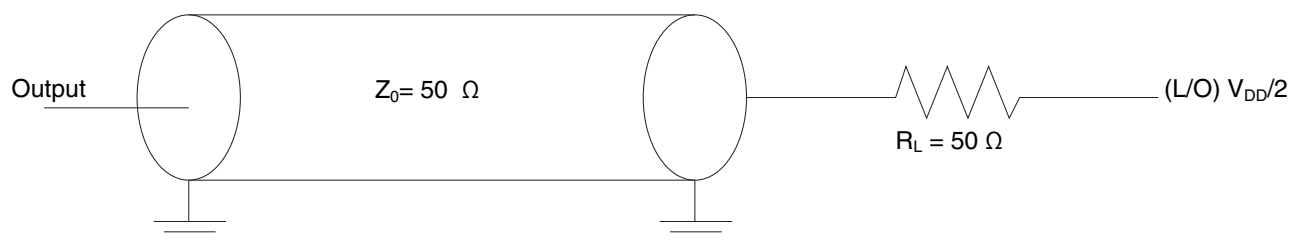
### 3.25.2 GPIO AC timing specifications

This table provides the GPIO input and output AC timing specifications.

**Table 117. GPIO input AC timing specifications**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | Symbol      | Min | Unit | Notes   |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|-----|------|---------|
| GPIO inputs—minimum pulse width                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | $t_{PIWID}$ | 20  | ns   | 1, 2, 3 |
| <b>Note:</b><br>1. GPIO inputs and outputs are asynchronous to any visible clock. GPIO outputs should be synchronized before use by any external synchronous logic. GPIO inputs are required to be valid for at least $t_{PIWID}$ to ensure proper operation.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> .<br>3. Entry and exit from deep sleep respectively require a minimum pulse width $t_{PIWID}$ of 35 SYSCLK. See the Reference Manual for details on Entry and Exit from deep sleep. |             |     |      |         |

This figure shows the AC test load for the GPIO.

**Figure 71. GPIO AC test load**

## 3.26 GIC interface

This section describes the DC and AC electrical characteristics for the GIC interface.

### 3.26.1 GIC DC electrical characteristics

This table provides the DC electrical characteristics for GIC pins operating at  $L/L1/D/D1/O/O1/E/BV_{DD} = 3.3\text{ V}$ .

**Table 118. GIC DC electrical characteristics (3.3 V)<sup>3</sup>**

| Parameter                                                                   | Symbol   | Min                  | Max                  | Unit          | Notes |
|-----------------------------------------------------------------------------|----------|----------------------|----------------------|---------------|-------|
| Input high voltage                                                          | $V_{IH}$ | $0.7 \times nV_{DD}$ | —                    | V             | 1     |
| Input low voltage                                                           | $V_{IL}$ | —                    | $0.2 \times nV_{DD}$ | V             | 1     |
| Input current ( $V_{IN} = 0\text{ V}$ or $V_{IN} = LV_{DD}$ )               | $I_{IN}$ | —                    | $\pm 50$             | $\mu\text{A}$ | 2     |
| Output high voltage<br>( $LV_{DD} = \text{min}$ , $I_{OH} = -2\text{ mA}$ ) | $V_{OH}$ | 2.4                  | —                    | V             | —     |
| Output low voltage                                                          | $V_{OL}$ | —                    | 0.4                  | V             | —     |

Table continues on the next page...

**Table 118. GIC DC electrical characteristics (3.3 V)<sup>3</sup> (continued)**

| Parameter                                                                                                                                                    | Symbol | Min | Max | Unit | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|-----|------|-------|
| (LV <sub>DD</sub> = min, I <sub>OL</sub> = 2 mA)                                                                                                             |        |     |     |      |       |
| <b>Notes:</b>                                                                                                                                                |        |     |     |      |       |
| 1. The min V <sub>IL</sub> and max V <sub>IH</sub> values are based on the respective min and max LV <sub>IN</sub> values found in <a href="#">Table 3</a> . |        |     |     |      |       |
| 2. The symbol V <sub>IN</sub> , in this case, represents the LV <sub>IN</sub> symbol referenced in <a href="#">Table 3</a> .                                 |        |     |     |      |       |
| 3. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                                       |        |     |     |      |       |

This table provides the DC electrical characteristics for GIC pins operating at L/L1/D/D1/O/O1/E/BV<sub>DD</sub> = 2.5 V.

**Table 119. GIC DC electrical characteristics (2.5 V)<sup>3</sup>**

| Parameter                                                                                                                                                                       | Symbol          | Min                    | Max                    | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------------------------|------------------------|------|-------|
| Input high voltage                                                                                                                                                              | V <sub>IH</sub> | 0.7 x nV <sub>DD</sub> | —                      | V    | 1     |
| Input low voltage                                                                                                                                                               | V <sub>IL</sub> | —                      | 0.2 x nV <sub>DD</sub> | V    | 1     |
| Input current (V <sub>IN</sub> = 0 V or V <sub>IN</sub> = LV <sub>DD</sub> /L1V <sub>DD</sub> )                                                                                 | I <sub>IN</sub> | —                      | ±50                    | μA   | 2     |
| Output high voltage<br>(LV <sub>DD</sub> /L1V <sub>DD</sub> = min, I <sub>OH</sub> = -1 mA)                                                                                     | V <sub>OH</sub> | 2.0                    | —                      | V    | —     |
| Output low voltage<br>(LV <sub>DD</sub> /L1V <sub>DD</sub> = min, I <sub>OL</sub> = 1 mA)                                                                                       | V <sub>OL</sub> | —                      | 0.4                    | V    | —     |
| <b>Notes:</b>                                                                                                                                                                   |                 |                        |                        |      |       |
| 1. The min V <sub>IL</sub> and max V <sub>IH</sub> values are based on the respective min and max LV <sub>IN</sub> /L1V <sub>IN</sub> values found in <a href="#">Table 3</a> . |                 |                        |                        |      |       |
| 2. The symbol V <sub>IN</sub> , in this case, represents the LV <sub>IN</sub> /L1V <sub>IN</sub> symbol referenced in <a href="#">Table 3</a> .                                 |                 |                        |                        |      |       |
| 3. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                                                          |                 |                        |                        |      |       |

This table provides the DC electrical characteristics for GIC pins operating at L/L1/D/D1/O/O1/E/BV<sub>DD</sub> = 1.8 V.

**Table 120. GIC DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                                                                                                                                    | Symbol          | Min                    | Max                    | Unit | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------------------------|------------------------|------|-------|
| Input high voltage                                                                                                                                           | V <sub>IH</sub> | 0.7 x nV <sub>DD</sub> | —                      | V    | 1     |
| Input low voltage                                                                                                                                            | V <sub>IL</sub> | —                      | 0.2 x nV <sub>DD</sub> | V    | 1     |
| Input current (V <sub>IN</sub> = 0 V or V <sub>IN</sub> = LV <sub>DD</sub> )                                                                                 | I <sub>IN</sub> | —                      | ±50                    | μA   | 2     |
| Output high voltage<br>(LV <sub>DD</sub> = min, I <sub>OH</sub> = -0.5 mA)                                                                                   | V <sub>OH</sub> | 1.35                   | —                      | V    | —     |
| Output low voltage<br>(LV <sub>DD</sub> = min, I <sub>OL</sub> = 0.5 mA)                                                                                     | V <sub>OL</sub> | —                      | 0.4                    | V    | —     |
| <b>Notes:</b>                                                                                                                                                |                 |                        |                        |      |       |
| 1. The min V <sub>IL</sub> and max V <sub>IH</sub> values are based on the respective min and max LV <sub>IN</sub> values found in <a href="#">Table 3</a> . |                 |                        |                        |      |       |

**Table 120. GIC DC electrical characteristics (1.8 V)<sup>3</sup>**

| Parameter                                                                                                      | Symbol | Min | Max | Unit | Notes |
|----------------------------------------------------------------------------------------------------------------|--------|-----|-----|------|-------|
| 2. The symbol $V_{IN}$ , in this case, represents the $LV_{IN}$ symbol referenced in <a href="#">Table 3</a> . |        |     |     |      |       |
| 3. For recommended operating conditions, see <a href="#">Table 3</a> .                                         |        |     |     |      |       |

### 3.26.2 GIC AC timing specifications

This table provides the GIC input and output AC timing specifications.

**Table 121. GIC Input AC timing specifications<sup>2</sup>**

| Characteristic                                                                                                                                                                                                                                                                  | Symbol      | Min | Max | Unit   | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|-----|-----|--------|-------|
| GIC inputs-minimum pulse width                                                                                                                                                                                                                                                  | $t_{PIWID}$ | 3   | -   | SYCLKs | 1, 3  |
| 1. GIC inputs and outputs are asynchronous to any visible clock. GIC outputs must be synchronized before use by any external synchronous logic. GIC inputs are required to be valid for at least $t_{PIWID}$ ns to ensure proper operation when working in edge triggered mode. |             |     |     |        |       |
| 2. For recommended operating conditions, see <a href="#">Table 3</a> .                                                                                                                                                                                                          |             |     |     |        |       |
| 3. Entry and exit from deep sleep respectively require a minimum pulse width $t_{PIWID}$ of 25 SYCLK. See the applicable device reference manual for details on Entry and Exit from deep sleep.                                                                                 |             |     |     |        |       |

## 3.27 High-speed serial interfaces (HSSI)

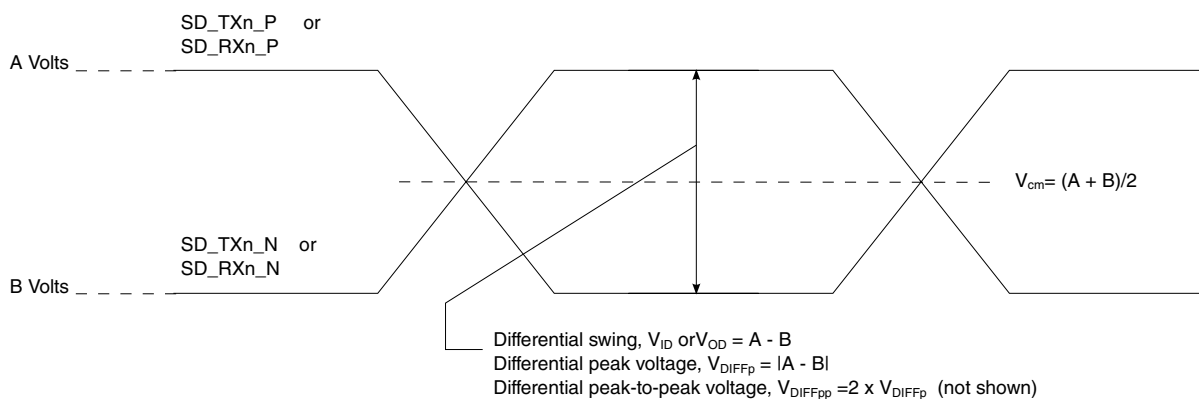
The chip features a Serializer/Deserializer (SerDes) interface to be used for high-speed serial interconnect applications. The SerDes interface can be used for PCI Express, SGMII, and serial ATA (SATA) data transfers.

This section describes the most common portion of the SerDes DC electrical specifications: the DC requirement for SerDes reference clocks. The SerDes data lane's transmitter (Tx) and receiver (Rx) reference circuits are also described.

### 3.27.1 Signal terms definitions

The SerDes utilizes differential signaling to transfer data across the serial link. This section defines the terms that are used in the description and specification of differential signals.

This figure shows how the signals are defined. For illustration purposes only, one SerDes lane is used in the description. This figure shows the waveform for either a transmitter output (SD\_TX $n$ \_P and SD\_TX $n$ \_N) or a receiver input (SD\_RX $n$ \_P and SD\_RX $n$ \_N). Each signal swings between A volts and B volts where  $A > B$ .



**Figure 72. Differential voltage definitions for transmitter or receiver**

Using this waveform, the definitions are as described in the following list. To simplify the illustration, the definitions assume that the SerDes transmitter and receiver operate in a fully symmetrical differential signaling environment:

#### Single-Ended Swing

The transmitter output signals and the receiver input signals SD\_TXn\_P, SD\_TXn\_N, SD\_RXn\_P and SD\_RXn\_N each have a peak-to-peak swing of A - B volts. This is also referred to as each signal wire's single-ended swing.

#### Differential Output Voltage, $V_{OD}$ (or Differential Output Swing)

The differential output voltage (or swing) of the transmitter,  $V_{OD}$ , is defined as the difference of the two complementary output voltages:  $V_{SD\_TXn\_P} - V_{SD\_TXn\_N}$ . The  $V_{OD}$  value can be either positive or negative.

#### Differential Input Voltage, $V_{ID}$ (or Differential Input Swing)

The differential input voltage (or swing) of the receiver,  $V_{ID}$ , is defined as the difference of the two complementary input voltages:  $V_{SD\_RXn\_P} - V_{SD\_RXn\_N}$ . The  $V_{ID}$  value can be either positive or negative.

#### Differential Peak Voltage, $V_{DIFFp}$

The peak value of the differential transmitter output signal or the differential receiver input signal is defined as the differential peak voltage,  $V_{DIFFp} = |A - B|$  volts.

#### Differential Peak-to-Peak, $V_{DIFFp-p}$

Because the differential output signal of the transmitter and the differential input signal of the receiver each range from A - B to -(A - B) volts, the peak-to-peak value of the differential transmitter output signal or the differential receiver input signal is defined as differential peak-to-peak voltage,  $V_{DIFFp-p} = 2 \times V_{DIFFp} = 2 \times |A - B|$  volts, which is twice the differential swing in amplitude, or twice the differential peak. For example, the output differential peak-to-peak voltage can also be calculated as  $V_{TX-DIFFp-p} = 2 \times |V_{OD}|$ .

#### Differential Waveform

The differential waveform is constructed by subtracting the inverting signal (SD\_TXn\_N, for example) from the non-inverting signal (SD\_TXn\_P, for example)

within a differential pair. There is only one signal trace curve in a differential waveform. The voltage represented in the differential waveform is not referenced to ground. See [Figure 77](#) as an example for differential waveform.

#### Common Mode Voltage, $V_{cm}$

The common mode voltage is equal to half of the sum of the voltages between each conductor of a balanced interchange circuit and ground. In this example, for SerDes output,  $V_{cm\_out} = (V_{SD\_TXn\_P} + V_{SD\_TXn\_N}) \div 2 = (A + B) \div 2$ , which is the arithmetic mean of the two complementary output voltages within a differential pair. In a system, the common mode voltage may often differ from one component's output to the other's input. It may be different between the receiver input and driver output circuits within the same component. It is also referred to as the DC offset on some occasions.

To illustrate these definitions using real values, consider the example of a current mode logic (CML) transmitter that has a common mode voltage of 2.25 V and outputs, TD and TD\_B. If these outputs have a swing from 2.0 V to 2.5 V, the peak-to-peak voltage swing of each signal (TD or TD\_B) is 500 mV p-p, which is referred to as the single-ended swing for each signal. Because the differential signaling environment is fully symmetrical in this example, the transmitter output's differential swing ( $V_{OD}$ ) has the same amplitude as each signal's single-ended swing. The differential output signal ranges between 500 mV and -500 mV. In other words,  $V_{OD}$  is 500 mV in one phase and -500 mV in the other phase. The peak differential voltage ( $V_{DIFFp}$ ) is 500 mV. The peak-to-peak differential voltage ( $V_{DIFFp-p}$ ) is 1000 mV p-p.

### 3.27.2 SerDes reference clocks

The SerDes reference clock inputs are applied to an internal phase-locked loop (PLL) whose output creates the clock used by the corresponding SerDes lanes. The SerDes reference clocks inputs are SD1\_REF\_CLK[1:2]\_P and SD1\_REF\_CLK[1:2]\_N.

SerDes may be used for various combinations of the following IP blocks based on the RCW Configuration field SRDS\_PRTCLn:

- SGMII (1.25 Gbps)
- PCIe (2.5 and 5 Gbps)
- SATA (1.5, 3.0, and 6.0 Gbps)

The following sections describe the SerDes reference clock requirements and provide application information.

### 3.27.2.1 SerDes spread-spectrum clock source recommendations

SD1\_REF\_CLK $n$ \_P and SD1\_REF\_CLK $n$ \_N are designed to work with spread-spectrum clocking for the PCI Express protocol only with the spreading specification defined in [Table 122](#). When using spread-spectrum clocking for PCI Express, both ends of the link partners should use the same reference clock. For best results, a source without significant unintended modulation must be used.

The SerDes transmitter does not support spread-spectrum clocking for the SATA protocol. The SerDes receiver does support spread-spectrum clocking on receive, which means the SerDes receiver can receive data correctly from a SATA serial link partner using spread-spectrum clocking.

Spread-spectrum clocking cannot be used if the same SerDes reference clock is shared with other non-spread-spectrum-supported protocols. For example, if spread-spectrum clocking is desired on a SerDes reference clock for the PCI Express protocol and the same reference clock is used for any other protocol, such as SATA or SGMII because of the SerDes lane usage mapping option, spread-spectrum clocking cannot be used at all.

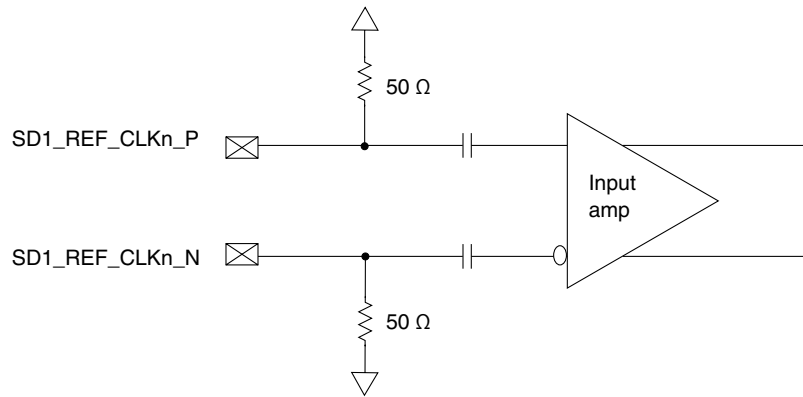
This table provides the source recommendations for SerDes spread-spectrum clocking.

**Table 122. SerDes spread-spectrum clock source recommendations <sup>1</sup>**

| Parameter                                                                                                                    | Min | Max  | Unit | Notes |
|------------------------------------------------------------------------------------------------------------------------------|-----|------|------|-------|
| Frequency modulation                                                                                                         | 30  | 33   | kHz  | —     |
| Frequency spread                                                                                                             | +0  | -0.5 | %    | 2     |
| <b>Notes:</b><br>1. At recommended operating conditions. See <a href="#">Table 3</a> .<br>2. Only down-spreading is allowed. |     |      |      |       |

### 3.27.2.2 SerDes reference clock receiver characteristics

This figure shows a receiver reference diagram of the SerDes reference clocks.



**Figure 73. Receiver of SerDes reference clocks**

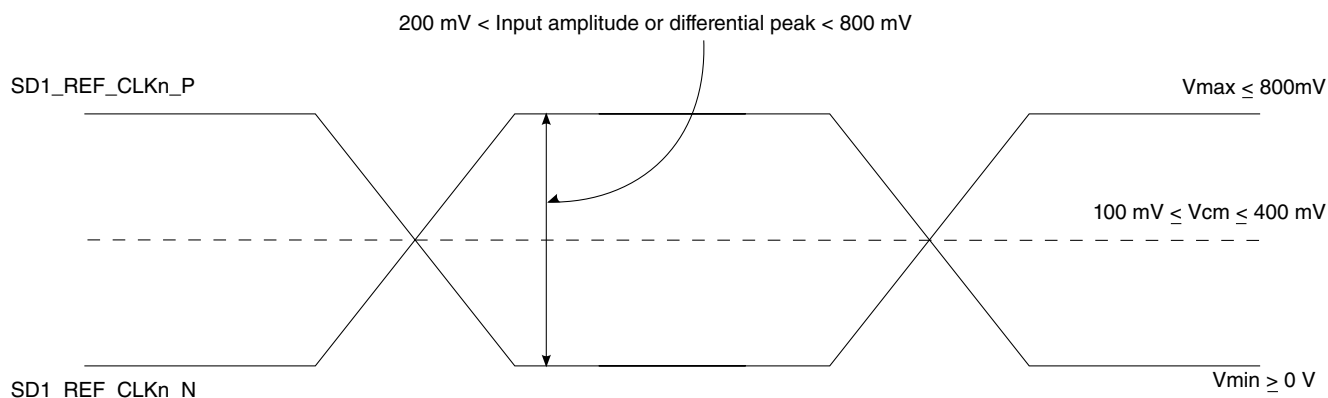
The characteristics of the clock signals are as follows:

- The SerDes transceiver's core power supply voltage requirements ( $SV_{DDn}$ ) are as specified in [Table 3](#).
- The SerDes reference clock receiver reference circuit structure is as follows:
  - The SD1\_REF\_CLKn\_P and SD1\_REF\_CLKn\_N are internally AC-coupled differential inputs as shown in [Figure 73](#). Each differential clock input (SD1\_REF\_CLKn\_P or SD1\_REF\_CLKn\_N) has on-chip 50-Ω termination to SGNDn followed by on-chip AC-coupling.
  - The external reference clock driver must be able to drive this termination.
  - The SerDes reference clock input can be either differential or single-ended. See the differential mode and single-ended mode descriptions in [Signal terms definitions](#) for detailed requirements.
- The maximum average current requirement also determines the common mode voltage range.
  - When the SerDes reference clock differential inputs are DC coupled externally with the clock driver chip, the maximum average current allowed for each input pin is 8 mA. In this case, the exact common mode input voltage is not critical as long as it is within the range allowed by the maximum average current of 8 mA because the input is AC-coupled on-chip.
  - This current limitation sets the maximum common mode input voltage to be less than 0.4 V ( $0.4\text{ V} \div 50 = 8\text{ mA}$ ) while the minimum common mode input level is 0.1 V above SGNDn. For example, a clock with a 50/50 duty cycle can be produced by a clock driver with output driven by its current source from 0 mA to 16 mA (0-0.8 V), such that each phase of the differential input has a single-ended swing from 0 V to 800 mV with the common mode voltage at 400 mV.
  - If the device driving the SD1\_REF\_CLKn\_P and SD1\_REF\_CLKn\_N inputs cannot drive 50 Ω to SGNDn DC or the drive strength of the clock driver chip exceeds the maximum input current limitations, it must be AC-coupled off-chip.
- The input amplitude requirement is described in detail in the following sections.

### 3.27.2.3 DC-level requirements for SerDes reference clocks

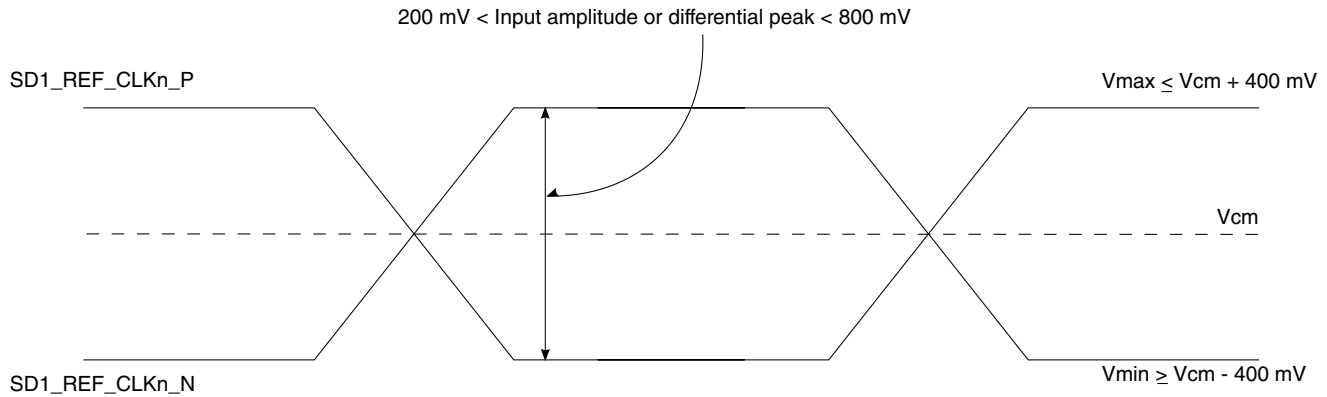
The DC-level requirements for the SerDes reference clock inputs are different depending on the signaling mode used to connect the clock driver chip and SerDes reference clock inputs, as described below:

- **Differential Mode**
  - The input amplitude of the differential clock must be between 400 mV and 1600 mV differential peak-to-peak (or between 200 mV and 800 mV differential peak). In other words, each signal wire of the differential pair must have a single-ended swing of less than 800 mV and greater than 200 mV. This requirement is the same for both external DC-coupled or AC-coupled connection.
  - For an external DC-coupled connection, as described in [Figure 73](#), the maximum average current requirements set the requirement for average voltage (common mode voltage) as between 100 mV and 400 mV.
  - This figure shows the SerDes reference clock input requirement for a DC-coupled connection scheme.



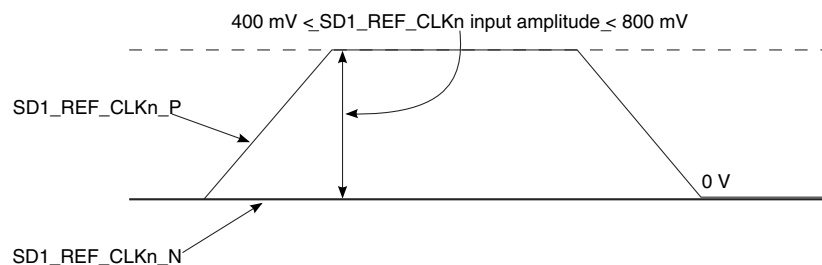
**Figure 74. Differential reference clock input DC requirements (external DC-coupled)**

- For an external AC-coupled connection, there is no common mode voltage requirement for the clock driver. Because the external AC-coupling capacitor blocks the DC level, the clock driver and the SerDes reference clock receiver operate in different common mode voltages. The SerDes reference clock receiver in this connection scheme has its common mode voltage set to SGNDn. Each signal wire of the differential inputs is allowed to swing below and above the common mode voltage (SGNDn).
- This figure shows the SerDes reference clock input requirement for an AC-coupled connection scheme.



**Figure 75. Differential reference clock input DC requirements (external AC-coupled)**

- Single-ended mode
  - The reference clock can also be single-ended. The SD1\_REF\_CLKn\_P input amplitude (single-ended swing) must be between 400 mV and 800 mV peak-to-peak (from  $V_{MIN}$  to  $V_{MAX}$ ) with SD1\_REF\_CLKn\_N either left unconnected or tied to ground.
  - To meet the input amplitude requirement, the reference clock inputs may need to be externally DC- or AC-coupled. For the best noise performance, the reference of the clock could be DC- or AC-coupled into the unused phase (SD1\_REF\_CLKn\_N) through the same source impedance as the clock input (SD1\_REF\_CLKn\_P) in use.
  - The SD1\_REF\_CLKn\_P input average voltage must be between 200 and 400 mV.
  - This figure shows the SerDes reference clock input requirement for single-ended signaling mode.



**Figure 76. Single-ended reference clock input DC requirements**

### 3.27.2.4 AC requirements for SerDes reference clocks

This table provides the AC requirements for SerDes reference clocks for protocols running at data rates up to 5 Gb/s.

This includes PCI Express (2.5 and 5 GT/s), SGMII (1.25 Gbps), and SATA (1.5, 3.0, and 6.0 Gbps). SerDes reference clocks need to be verified by the customer's application design.

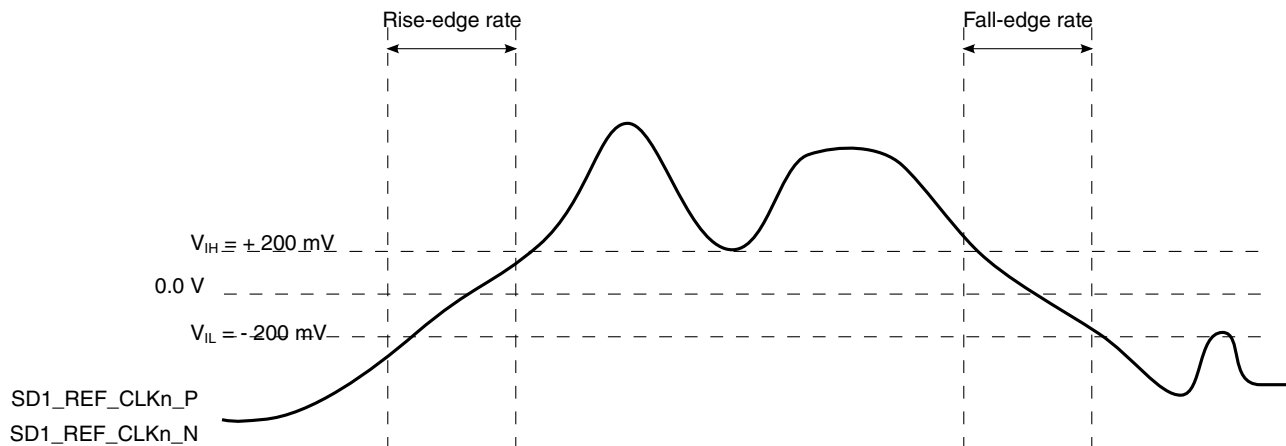
**Table 123. SD1\_REF\_CLKn\_P and SD1\_REF\_CLKn\_N input clock requirements**  
(S1V<sub>DDn</sub> = 1.0 V) <sup>1</sup>

| Parameter                                                                                                                 | Symbol                                  | Min  | Typ     | Max  | Unit   | Notes  |
|---------------------------------------------------------------------------------------------------------------------------|-----------------------------------------|------|---------|------|--------|--------|
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N frequency range                                                                            | t <sub>CLK_REF</sub>                    | —    | 100/125 | —    | MHz    | 2      |
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N clock frequency tolerance                                                                  | t <sub>CLK_TOL</sub>                    | -300 | —       | 300  | ppm    | 3      |
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N clock frequency tolerance                                                                  | t <sub>CLK_TOL</sub>                    | -100 | —       | 100  | ppm    | 4      |
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N reference clock duty cycle                                                                 | t <sub>CLK_DUTY</sub>                   | 40   | 50      | 60   | %      | 5      |
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N max deterministic peak-to-peak jitter at 10 <sup>-6</sup> BER                              | t <sub>CLK_DJ</sub>                     | —    | —       | 42   | ps     | —      |
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N total reference clock jitter at 10 <sup>-6</sup> BER (peak-to-peak jitter at refClk input) | t <sub>CLK_TJ</sub>                     | —    | —       | 86   | ps     | 6      |
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N 10 kHz to 1.5 MHz RMS jitter                                                               | t <sub>REFCLK-LF-RMS</sub>              | —    | —       | 3    | ps RMS | 7      |
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N > 1.5 MHz to Nyquist RMS jitter                                                            | t <sub>REFCLK-HF-RMS</sub>              | —    | —       | 3.1  | ps RMS | 7      |
| SD1_REF_CLKn_P/ SD1_REF_CLKn_N rising/falling edge rate                                                                   | t <sub>CLKRRR</sub> /t <sub>CLKFR</sub> | 1    | —       | 4    | V/ns   | 9      |
| Differential input high voltage                                                                                           | V <sub>IH</sub>                         | 200  | —       | —    | mV     | 5      |
| Differential input low voltage                                                                                            | V <sub>IL</sub>                         | —    | —       | -200 | mV     | 5      |
| Rising edge rate (SD1_REF_CLKn_P) to falling edge rate (SD1_REF_CLKn_N) matching                                          | Rise-Fall Matching                      | —    | —       | 20   | %      | 10, 11 |

**Notes:**

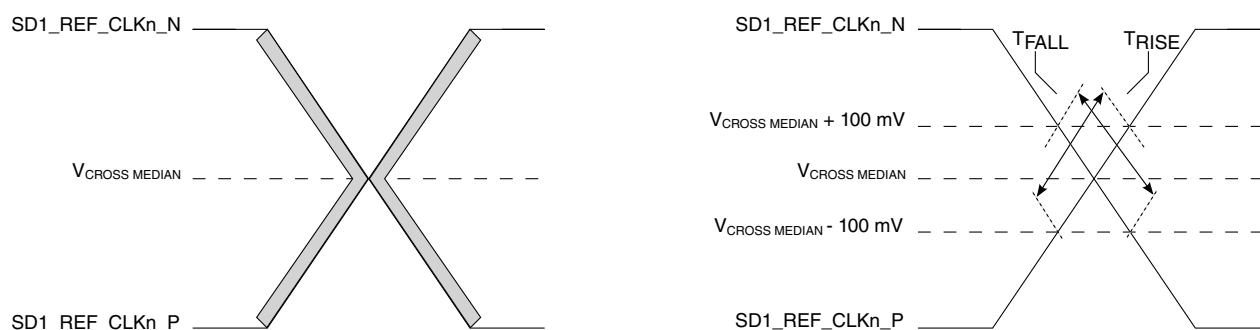
- For recommended operating conditions, see [Table 3](#).
- Caution:** Only 100 and 125 have been tested. In-between values do not work correctly with the rest of the system.
- For PCI Express (2.5 and 5 GT/s).
- For SGMII.
- Measurement taken from differential waveform.
- Limits from PCI Express CEM Rev 2.0.
- For PCI Express 5 GT/s, per PCI Express base specification Rev 3.0.
- Measured from -200 mV to +200 mV on the differential waveform (derived from SD1\_REF\_CLKn\_P minus SD1\_REF\_CLKn\_N). The signal must be monotonic through the measurement region for rise and fall time. The 400 mV measurement window is centered on the differential zero crossing. See [Figure 77](#).
- Measurement taken from single-ended waveform.
- Matching applies to rising edge for SD1\_REF\_CLKn\_P and falling edge rate for SD1\_REF\_CLKn\_N. It is measured using a 200 mV window centered on the median cross point where SD1\_REF\_CLKn\_P rising meets SD1\_REF\_CLKn\_N falling. The median cross point is used to calculate the voltage thresholds that the oscilloscope uses for the edge rate calculations. The rise edge rate of SD1\_REF\_CLKn\_P must be compared to the fall edge rate of SD1\_REF\_CLKn\_N, the maximum allowed difference should not exceed 20% of the slowest edge rate. See [Figure 78](#).

This figure shows the differential measurement points for rise and fall time.



**Figure 77. Differential measurement points for rise and fall time**

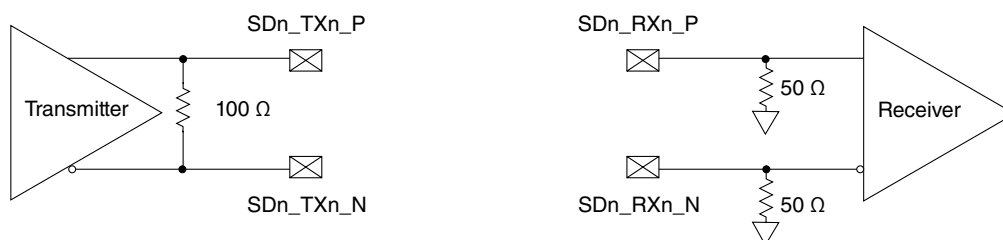
This figure shows the single-ended measurement points for rise and fall time matching.



**Figure 78. Single-ended measurement points for rise and fall time matching**

### 3.27.3 SerDes transmitter and receiver reference circuits

This figure shows the reference circuits for SerDes data lane's transmitter and receiver.



**Figure 79. SerDes transmitter and receiver reference circuits**

The DC and AC specifications of the SerDes data lanes are defined in each interface protocol section below based on the application usage:

- [PCI Express](#)
- [Serial ATA \(SATA\) interface](#)
- [SGMII interface](#)

Note that an external AC-coupling capacitor is required for the above serial transmission protocols with the capacitor value defined in the specification of each protocol section.

### 3.27.4 PCI Express

This section describes the clocking dependencies, as well as the DC and AC electrical specifications for the PCI Express bus.

#### 3.27.4.1 Clocking dependencies

The ports on the two ends of a link must transmit data at a rate that is within 600 ppm of each other at all times. This is specified to allow bit rate clock sources with a  $\pm 300$  ppm tolerance.

#### 3.27.4.2 PCI Express DC physical layer specifications

This section contains the DC specifications for the physical layer of PCI Express on this chip.

##### 3.27.4.2.1 PCI Express DC physical layer transmitter specifications

This section describes the PCI Express DC physical layer transmitter specifications for 2.5 GT/s and 5 GT/s.

This table provides the PCI Express 2.0 (2.5 GT/s) DC specifications for the differential output at all transmitters. The parameters are specified at the component pins.

**Table 124. PCI Express 2.0 (2.5 GT/s) differential transmitter output DC specifications**  
( $X1V_{DD} = 1.35\text{ V}$ )<sup>1</sup>

| Parameter                                         | Symbol            | Min | Typical | Max  | Units    | Notes |
|---------------------------------------------------|-------------------|-----|---------|------|----------|-------|
| Differential peak-to-peak output voltage          | $V_{TX-DIFFp-p}$  | 800 | 1000    | 1200 | mV       | 2     |
| De-emphasized differential output voltage (ratio) | $V_{TX-DE-RATIO}$ | 3.0 | 3.5     | 4.0  | dB       | 3     |
| DC differential transmitter impedance             | $Z_{TX-DIFF-DC}$  | 80  | 100     | 120  | $\Omega$ | 4     |
| Transmitter DC impedance                          | $Z_{TX-DC}$       | 40  | 50      | 60   | $\Omega$ | 5     |

Notes:

**Table 124. PCI Express 2.0 (2.5 GT/s) differential transmitter output DC specifications**  
( $X1V_{DD} = 1.35\text{ V}$ )<sup>1</sup>

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                        | Symbol | Min | Typical | Max | Units | Notes |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|---------|-----|-------|-------|
| 1. For recommended operating conditions, see <a href="#">Table 3</a> .<br>2. $V_{TX-DIFFp-p} = 2 \times  V_{TX-D+} - V_{TX-D-} $<br>3. Ratio of the $V_{TX-DIFFp-p}$ of the second and following bits after a transition divided by the $V_{TX-DIFFp-p}$ of the first bit after a transition.<br>4. Transmitter DC differential mode low impedance.<br>5. Required transmitter D+, as well as D- DC impedance during all states. |        |     |         |     |       |       |

This table provides the PCI Express 2.0 (5 GT/s) DC specifications for the differential output at all transmitters. The parameters are specified at the component pins.

**Table 125. PCI Express 2.0 (5 GT/s) differential transmitter output DC specifications**  
( $X1V_{DD} = 1.35\text{ V}$ )<sup>1</sup>

| Parameter                                          | Symbol                      | Min | Typical | Max  | Units    | Notes |
|----------------------------------------------------|-----------------------------|-----|---------|------|----------|-------|
| Differential peak-to-peak output voltage           | $V_{TX-DIFFp-p}$            | 800 | 1000    | 1200 | mV       | 2     |
| Low power differential peak-to-peak output voltage | $V_{TX-DIFFp-p\_low}$       | 400 | 500     | 1200 | mV       | 2     |
| De-emphasized differential output voltage (ratio)  | $V_{TX-DE-}$<br>RATIO-3.5dB | 3.0 | 3.5     | 4.0  | dB       | 3     |
| De-emphasized differential output voltage (ratio)  | $V_{TX-DE-}$<br>RATIO-6.0dB | 5.5 | 6.0     | 6.5  | dB       | 3     |
| DC differential transmitter impedance              | $Z_{TX-DIFF-DC}$            | 80  | 100     | 120  | $\Omega$ | 4     |
| Transmitter DC Impedance                           | $Z_{TX-DC}$                 | 40  | 50      | 60   | $\Omega$ | 5     |

**Notes:**

- For recommended operating conditions, see [Table 3](#).
- $V_{TX-DIFFp-p} = 2 \times |V_{TX-D+} - V_{TX-D-}|$
- Ration of the  $V_{TX-DIFFp-p}$  of the second and following bits after a transition divided by the  $V_{TX-DIFFp-p}$  of the first bit after a transition.
- Transmitter DC differential mode low impedance.
- Required transmitter D+, as well as D- DC impedance during all states.

### 3.27.4.3 PCI Express DC physical layer receiver specifications

This section discusses the PCI Express DC physical layer receiver specifications for 2.5 GT/s and 5 GT/s.

This table defines the DC specifications for the PCI Express 2.0 (2.5 GT/s) differential input at all receivers. The parameters are specified at the component pins.

**Table 126. PCI Express 2.0 (2.5 GT/s) differential receiver input DC specifications (S1V<sub>DD</sub> = 1.0 V)**

| Parameter                               | Symbol                           | Min | Typ  | Max  | Units | Notes   |
|-----------------------------------------|----------------------------------|-----|------|------|-------|---------|
| Differential input peak-to-peak voltage | V <sub>RX-DIFFp-p</sub>          | 120 | 1000 | 1200 | mV    | 1, 2    |
| DC differential input impedance         | Z <sub>RX-DIFF-DC</sub>          | 80  | 100  | 120  | Ω     | 3       |
| DC input impedance                      | Z <sub>RX-DC</sub>               | 40  | 50   | 60   | Ω     | 1, 3, 4 |
| Powered down DC input impedance         | Z <sub>RX-HIGH-IMP-DC</sub>      | 50  | —    | —    | kΩ    | 5, 6    |
| Electrical idle detect threshold        | V <sub>RX-IDLE-DET-DIFFp-p</sub> | 65  | —    | 175  | mV    | 7, 8    |

**Notes:**

1. Measured at the package pins with a test load of 50Ω to GND on each pin.
2.  $V_{RX-DIFFp-p} = 2 \times |V_{RX-D+} - V_{RX-D-}|$
3. Impedance during all LTSSM states. When transitioning from a fundamental reset to detect (the initial state of the LTSSM) there is a 5 ms transition time before receiver termination values must be met on all unconfigured lanes of a port.
4. Required receiver D+ as well as D- DC impedance (50 ± 20% tolerance).
5. The receiver DC common mode impedance that exists when no power is present or fundamental reset is asserted. This helps ensure that the receiver detect circuit does not falsely assume a receiver is powered on when it is not. This term must be measured at 300 mV above the receiver ground.
6. Required receiver D+ as well as D- DC impedance when the receiver terminations do not have power.
7.  $V_{RX-IDLE-DET-DIFFp-p} = 2 \times |V_{RX-D+} - V_{RX-D-}|$
8. Measured at the package pins of the receiver.

This table defines the DC specifications for the PCI Express 2.0 (5 GT/s) differential input at all receivers. The parameters are specified at the component pins.

**Table 127. PCI Express 2.0 (5 GT/s) differential receiver input DC specifications (S1V<sub>DD</sub> = 1.0 V)**

| Parameter                               | Symbol                           | Min | Typ  | Max  | Units | Notes   |
|-----------------------------------------|----------------------------------|-----|------|------|-------|---------|
| Differential input peak-to-peak voltage | V <sub>RX-DIFFp-p</sub>          | 120 | 1000 | 1200 | mV    | 1, 2    |
| DC differential input impedance         | Z <sub>RX-DIFF-DC</sub>          | 80  | 100  | 120  | Ω     | 3       |
| DC input impedance                      | Z <sub>RX-DC</sub>               | 40  | 50   | 60   | Ω     | 1, 3, 4 |
| Powered down DC input impedance         | Z <sub>RX-HIGH-IMP-DC</sub>      | 50  | —    | —    | kΩ    | 5, 6    |
| Electrical idle detect threshold        | V <sub>RX-IDLE-DET-DIFFp-p</sub> | 65  | —    | 175  | mV    | 7, 8    |

**Notes:**

1. Measured at the package pins with a test load of 50Ω to GND on each pin.
2.  $V_{RX-DIFFp-p} = 2 \times |V_{RX-D+} - V_{RX-D-}|$
3. Impedance during all LTSSM states. When transitioning from a fundamental reset to detect (the initial state of the LTSSM) there is a 5 ms transition time before receiver termination values must be met on all unconfigured lanes of a port.
4. Required receiver D+ as well as D- DC impedance (50 ± 20% tolerance).

**Table 127. PCI Express 2.0 (5 GT/s) differential receiver input DC specifications (S1V<sub>DD</sub> = 1.0 V)**

| Parameter                                                                                                                                                                                                                                                                                           | Symbol | Min | Typ | Max | Units | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|-----|-----|-------|-------|
| 5. The receiver DC common mode impedance that exists when no power is present or fundamental reset is asserted. This helps ensure that the receiver detect circuit does not falsely assume a receiver is powered on when it is not. This term must be measured at 300 mV above the receiver ground. |        |     |     |     |       |       |
| 6. Required receiver D+ as well as D- DC impedance when the receiver terminations do not have power.                                                                                                                                                                                                |        |     |     |     |       |       |
| 7. $V_{RX-IDLE-DET-DIFFp-p} = 2 \times  V_{RX-D+} - V_{RX-D-} $                                                                                                                                                                                                                                     |        |     |     |     |       |       |
| 8. Measured at the package pins of the receiver.                                                                                                                                                                                                                                                    |        |     |     |     |       |       |

### 3.27.4.4 PCI Express AC physical layer specifications

This section describes the AC specifications for the physical layer of PCI Express on this device.

#### 3.27.4.4.1 PCI Express AC physical layer transmitter specifications

This section discusses the PCI Express AC physical layer transmitter specifications for 2.5 GT/s and 5 GT/s.

This table provides the PCI Express 2.0 (2.5 GT/s) AC specifications for the differential output at all transmitters. The parameters are specified at the component pins. The AC timing specifications do not include RefClk jitter.

**Table 128. PCI Express 2.0 (2.5 GT/s) differential transmitter output AC specifications**

| Parameter                                                                    | Symbol                                   | Min    | Typ | Max    | Units | Notes   |
|------------------------------------------------------------------------------|------------------------------------------|--------|-----|--------|-------|---------|
| Unit interval                                                                | UI                                       | 399.88 | 400 | 400.12 | ps    | 1       |
| Minimum transmitter eye width                                                | T <sub>TX-EYE</sub>                      | 0.75   | —   | —      | UI    | 2, 3, 4 |
| Maximum time between the jitter median and maximum deviation from the median | T <sub>TX-EYE-MEDIAN-to-MAX-JITTER</sub> | —      | —   | 0.125  | UI    | 2, 4, 5 |
| AC coupling capacitor                                                        | C <sub>TX</sub>                          | 75     | —   | 200    | nF    | 6, 7    |

**Notes:**

- Each UI is 400 ps ± 300 ppm. UI does not account for spread-spectrum clock dictated variations.
- Specified at the measurement point into a timing and voltage test load as shown in [Figure 80](#) and measured over any 250 consecutive transmitter UIs.
- The maximum transmitter jitter can be derived as  $T_{TX-MAX-JITTER} = 1 - T_{TX-EYE} = 0.25 \text{ UI}$ . Does not include spread-spectrum or RefCLK jitter. Includes device random jitter at 10<sup>-12</sup>.
- A  $T_{TX-EYE} = 0.75 \text{ UI}$  provides for a total sum of deterministic and random jitter budget of  $T_{TX-JITTER-MAX} = 0.25 \text{ UI}$  for the transmitter collected over any 250 consecutive transmitter UIs. The  $T_{TX-EYE-MEDIAN-to-MAX-JITTER}$  median is less than half of the total transmitter jitter budget collected over any 250 consecutive transmitter UIs. It must be noted that the median is not the same as the mean. The jitter median describes the point in time where the number of jitter points on either side is approximately equal as opposed to the averaged time value.

**Table 128. PCI Express 2.0 (2.5 GT/s) differential transmitter output AC specifications**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Symbol | Min | Typ | Max | Units | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|-----|-----|-----|-------|-------|
| 5. Jitter is defined as the measurement variation of the crossing points ( $V_{TX-DIFFp-p} = 0$ V) in relation to a recovered transmitter UI. A recovered transmitter UI is calculated over 3,500 consecutive unit intervals of sample data. Jitter is measured using all edges of the 250 consecutive UI in the center of the 3,500 UI used for calculating the transmitter UI.<br>6. The chip's SerDes transmitter does not have $C_{TX}$ built-in. An external AC coupling capacitor of 100 nF is required.<br>7. All transmitters must be AC coupled. The AC coupling is required either within the media or within the transmitting component itself. |        |     |     |     |       |       |

This table provides the PCI Express 2.0 (5 GT/s) AC specifications for the differential output at all transmitters. The parameters are specified at the component pins. The AC timing specifications do not include RefClk jitter.

**Table 129. PCI Express 2.0 (5 GT/s) differential transmitter output AC specifications**

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | Symbol            | Min    | Typ    | Max    | Units | Notes |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------|--------|--------|--------|-------|-------|
| Unit Interval                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | UI                | 199.94 | 200.00 | 200.06 | ps    | 1     |
| Minimum transmitter eye width                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | $T_{TX-EYE}$      | 0.75   | —      | —      | UI    | 2, 3  |
| Transmitter RMS deterministic jitter > 1.5 MHz                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | $T_{TX-HF-DJ-DD}$ | —      | —      | 0.15   | ps    | —     |
| Transmitter RMS deterministic jitter < 1.5 MHz                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | $T_{TX-LF-RMS}$   | —      | 3.0    | —      | ps    | 4     |
| AC coupling capacitor                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | $C_{TX}$          | 75     | —      | 200    | nF    | 5, 6  |
| <b>Notes:</b><br>1. Each UI is 200 ps $\pm$ 300 ppm. UI does not account for spread-spectrum clock dictated variations.<br>2. Specified at the measurement point into a timing and voltage test load as shown in <a href="#">Figure 80</a> and measured over any 250 consecutive transmitter UIs.<br>3. The maximum transmitter jitter can be derived as: $T_{TX-MAX-JITTER} = 1 - T_{TX-EYE} = 0.25$ UI.<br>4. Reference input clock RMS jitter (< 1.5 MHz) at pin < 1ps.<br>5. The chip's SerDes transmitter does not have $C_{TX}$ built-in. An external AC coupling capacitor of 100 nF is required.<br>6. All transmitters must be AC coupled. The AC coupling is required either within the media or within the transmitting component itself. |                   |        |        |        |       |       |

### 3.27.4.4.2 PCI Express AC physical layer receiver specifications

This section discusses the PCI Express AC physical layer receiver specifications for 2.5 GT/s and 5 GT/s.

This table provides the AC specifications for the PCI Express 2.0 (2.5 GT/s) differential input at all receivers. The parameters are specified at the component pins. The AC timing specifications do not include RefClk jitter.

**Table 130. PCI Express 2.0 (2.5 GT/s) differential receiver input AC specifications**

| Parameter                                                                    | Symbol                            | Min    | Typ    | Max    | Units | Notes      |
|------------------------------------------------------------------------------|-----------------------------------|--------|--------|--------|-------|------------|
| Unit Interval                                                                | UI                                | 399.88 | 400.00 | 400.12 | ps    | 1          |
| Minimum receiver eye width                                                   | $T_{RX-EYE}$                      | 0.4    | —      | —      | UI    | 2, 3, 4    |
| Maximum time between the jitter median and maximum deviation from the median | $T_{RX-EYE-MEDIAN-to-MAX-JITTER}$ | —      | —      | 0.3    | UI    | 3, 4, 5, 6 |

**Notes:**

- Each UI is 400 ps  $\pm$  300 ppm. UI does not account for spread-spectrum clock dictated variations.
- The maximum interconnect media and transmitter jitter that can be tolerated by the receiver can be derived as  $T_{RX-MAX-JITTER} = 1 - T_{RX-EYE} = 0.6$  UI.
- Specified at the measurement point and measured over any 250 consecutive UIs. The test load in [Figure 80](#) must be used as the receiver device when taking measurements. If the clocks to the receiver and transmitter are not derived from the same reference clock, the transmitter UI recovered from 3500 consecutive UI must be used as a reference for the eye diagram.
- A  $T_{RX-EYE} = 0.40$  UI provides for a total sum of 0.60 UI deterministic and random jitter budget for the transmitter and interconnect collected any 250 consecutive UIs. The  $T_{RX-EYE-MEDIAN-to-MAX-JITTER}$  specification ensures a jitter distribution in which the median and the maximum deviation from the median is less than half of the total. UI jitter budget collected over any 250 consecutive transmitter UIs. It must be noted that the median is not the same as the mean. The jitter median describes the point in time where the number of jitter points on either side is approximately equal as opposed to the averaged time value. If the clocks to the receiver and transmitter are not derived from the same reference clock, the transmitter UI recovered from 3500 consecutive UI must be used as the reference for the eye diagram.
- It is recommended that the recovered transmitter UI is calculated using all edges in the 3500 consecutive UI interval with a fit algorithm using a minimization merit function. Least squares and median deviation fits have worked well with experimental and simulated data.
- Jitter is defined as the measurement variation of the crossing points ( $V_{RX-DIFFp-p} = 0$  V) in relation to a recovered transmitter UI. A recovered transmitter UI is calculated over 3,500 consecutive unit intervals of sample data. Jitter is measured using all edges of the 250 consecutive UI in the center of the 3,500 UI used for calculating the transmitter UI.

This table defines the AC specifications for the PCI Express 2.0 (5 GT/s) differential input at all receivers. The parameters are specified at the component pins. The AC timing specifications do not include RefClk jitter.

**Table 131. PCI Express 2.0 (5 GT/s) differential receiver input AC specifications<sup>4</sup>**

| Parameter                                        | Symbol            | Min    | Typ    | Max    | Units | Notes |
|--------------------------------------------------|-------------------|--------|--------|--------|-------|-------|
| Unit Interval                                    | UI                | 199.40 | 200.00 | 200.06 | ps    | 1     |
| Max receiver inherent timing error               | $T_{RX-TJ-CC}$    | —      | —      | 0.4    | UI    | 2     |
| Max receiver inherent deterministic timing error | $T_{RX-DJ-DD-CC}$ | —      | —      | 0.30   | UI    | 3     |

**Notes:**

- Each UI is 200 ps  $\pm$  300 ppm. UI does not account for spread-spectrum clock dictated variations.
- The maximum inherent total timing error for common and separated RefClk receiver architecture.
- The maximum inherent deterministic timing error for common and separated RefClk receiver architecture.
- If spread spectrum clocking is desired, common clock must be used.

### 3.27.4.5 Test and measurement load

The AC timing and voltage parameters must be verified at the measurement point. The package pins of the device must be connected to the test/measurement load within 0.2 inches of that load, as shown in the following figure.

#### NOTE

The allowance of the measurement point to be within 0.2 inches of the package pins is meant to acknowledge that package/board routing may benefit from D+ and D- not being exactly matched in length at the package pin boundary. If the vendor does not explicitly state where the measurement point is located, the measurement point is assumed to be the D+ and D- package pins.

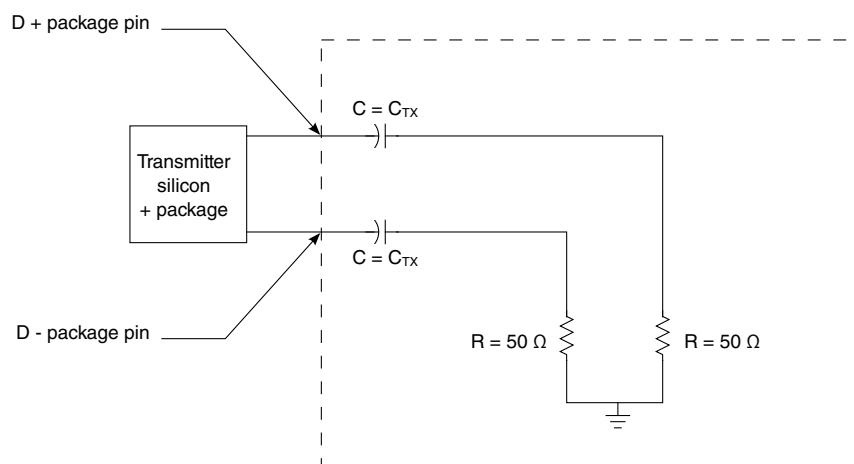


Figure 80. Test and measurement load

## 3.27.5 Serial ATA (SATA) interface

This section describes the DC and AC electrical specifications for the SATA interface.

### 3.27.5.1 SATA DC electrical characteristics

This section describes the DC electrical characteristics for SATA.

#### 3.27.5.1.1 SATA DC transmitter output characteristics

This table provides the differential transmitter output DC characteristics for the SATA interface at Gen1i/1m or 1.5 Gbits/s transmission.

**Table 132. Gen1i/1m 1.5 G transmitter DC specifications ( $X1V_{DD} = 1.35\text{ V}$ )<sup>3</sup>**

| Parameter                                                                                                                                         | Symbol                      | Min | Typ | Max | Units    | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|-----|-----|-----|----------|-------|
| Tx differential output voltage                                                                                                                    | $V_{\text{SATA\_TXDIFF}}$   | 400 | 500 | 600 | mV p-p   | 1     |
| Tx differential pair impedance                                                                                                                    | $Z_{\text{SATA\_TXDIFFIM}}$ | 85  | 100 | 115 | $\Omega$ | 2     |
| <b>Notes:</b><br>1. Terminated by 50 $\Omega$ load.<br>2. DC impedance.<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |                             |     |     |     |          |       |

This table provides the differential transmitter output DC characteristics for the SATA interface at Gen2i/2m or 3.0 Gbits/s transmission.

**Table 133. Gen 2i/2m 3 G transmitter DC specifications ( $X1V_{DD} = 1.35\text{ V}$ )<sup>2</sup>**

| Parameter                                                                                                                     | Symbol                      | Min | Typ | Max | Units    | Notes |
|-------------------------------------------------------------------------------------------------------------------------------|-----------------------------|-----|-----|-----|----------|-------|
| Transmitter differential output voltage                                                                                       | $V_{\text{SATA\_TXDIFF}}$   | 400 | —   | 700 | mV p-p   | 1     |
| Transmitter differential pair impedance                                                                                       | $Z_{\text{SATA\_TXDIFFIM}}$ | 85  | 100 | 115 | $\Omega$ | —     |
| <b>Notes:</b><br>1. Terminated by 50 $\Omega$ load.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |                             |     |     |     |          |       |

This table provides the differential transmitter output DC characteristics for the SATA interface at Gen 3i transmission.

**Table 134. Gen 3i transmitter DC specifications ( $X1V_{DD} = 1.35\text{ V}$ )<sup>2</sup>**

| Parameter                                                                                                                     | Symbol                      | Min | Typ | Max | Units    | Notes |
|-------------------------------------------------------------------------------------------------------------------------------|-----------------------------|-----|-----|-----|----------|-------|
| Transmitter differential output voltage                                                                                       | $V_{\text{SATA\_TXDIFF}}$   | 240 | —   | 900 | mV p-p   | 1     |
| Transmitter differential pair impedance                                                                                       | $Z_{\text{SATA\_TXDIFFIM}}$ | 85  | 100 | 115 | $\Omega$ | —     |
| <b>Notes:</b><br>1. Terminated by 50 $\Omega$ load.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |                             |     |     |     |          |       |

### 3.27.5.1.2 SATA DC receiver input characteristics

This table provides the Gen1i/1m or 1.5 Gbits/s differential receiver input DC characteristics for the SATA interface.

**Table 135. Gen1i/1m 1.5 G receiver input DC specifications (S1V<sub>DD</sub> = 1.0 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                     | Symbol                   | Min | Typical | Max | Units  | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|-----|---------|-----|--------|-------|
| Differential input voltage                                                                                                                                                                    | V <sub>SATA_RXDIFF</sub> | 240 | 500     | 600 | mV p-p | 1     |
| Differential receiver input impedance                                                                                                                                                         | Z <sub>SATA_RXSEIM</sub> | 85  | 100     | 115 | Ω      | 2     |
| OOB signal detection threshold                                                                                                                                                                | V <sub>SATA_OOB</sub>    | 50  | 120     | 240 | mV p-p | —     |
| <b>Notes:</b><br>1. Voltage relative to common of either signal comprising a differential pair.<br>2. DC impedance.<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |                          |     |         |     |        |       |

This table provides the Gen2i/2m or 3 Gbits/s differential receiver input DC characteristics for the SATA interface.

**Table 136. Gen2i/2m 3 G receiver input DC specifications (S1V<sub>DD</sub> = 1.0 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                     | Symbol                   | Min | Typical | Max | Units  | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|-----|---------|-----|--------|-------|
| Differential input voltage                                                                                                                                                                    | V <sub>SATA_RXDIFF</sub> | 240 | —       | 750 | mV p-p | 1     |
| Differential receiver input impedance                                                                                                                                                         | Z <sub>SATA_RXSEIM</sub> | 85  | 100     | 115 | Ω      | 2     |
| OOB signal detection threshold                                                                                                                                                                | V <sub>SATA_OOB</sub>    | 75  | 120     | 240 | mV p-p | 2     |
| <b>Notes:</b><br>1. Voltage relative to common of either signal comprising a differential pair.<br>2. DC impedance.<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |                          |     |         |     |        |       |

This table provides the Gen 3i differential receiver input DC characteristics for the SATA interface.

**Table 137. Gen 3i receiver input DC specifications (S1V<sub>DD</sub> = 1.0 V)<sup>3</sup>**

| Parameter                                                                                                                                                                                     | Symbol                   | Min | Typical | Max  | Units  | Notes |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|-----|---------|------|--------|-------|
| Differential input voltage                                                                                                                                                                    | V <sub>SATA_RXDIFF</sub> | 240 | —       | 1000 | mV p-p | 1     |
| Differential receiver input impedance                                                                                                                                                         | Z <sub>SATA_RXSEIM</sub> | 85  | 100     | 115  | Ω      | 2     |
| OOB signal detection threshold                                                                                                                                                                | —                        | 75  | 120     | 200  | mV p-p | —     |
| <b>Notes:</b><br>1. Voltage relative to common of either signal comprising a differential pair.<br>2. DC impedance.<br>3. For recommended operating conditions, see <a href="#">Table 3</a> . |                          |     |         |      |        |       |

### 3.27.5.2 SATA AC timing specifications

This section describes the SATA AC timing specifications.

### 3.27.5.2.1 AC requirements for SATA REF\_CLK

This table provides the AC requirements for the SATA reference clock. These requirements must be guaranteed by the customer's application design.

**Table 138. SATA reference clock input requirements<sup>6</sup>**

| Parameter                                                                               | Symbol          | Min  | Typ     | Max  | Unit | Notes   |
|-----------------------------------------------------------------------------------------|-----------------|------|---------|------|------|---------|
| SD1_REF_CLK1_P/SD1_REF_CLK1_N frequency range                                           | $t_{CLK\_REF}$  | —    | 100/125 | —    | MHz  | 1       |
| SD1_REF_CLK1_P/SD1_REF_CLK1_N clock frequency tolerance                                 | $t_{CLK\_TOL}$  | -350 | —       | +350 | ppm  | —       |
| SD1_REF_CLK1_P/SD1_REF_CLK1_N reference clock duty cycle                                | $t_{CLK\_DUTY}$ | 40   | 50      | 60   | %    | 5       |
| SD1_REF_CLK1_P/SD1_REF_CLK1_N cycle-to-cycle clock jitter (period jitter)               | $t_{CLK\_CJ}$   | —    | —       | 100  | ps   | 2       |
| SD1_REF_CLK1_P/SD1_REF_CLK1_N total reference clock jitter, phase jitter (peak-to-peak) | $t_{CLK\_PJ}$   | -50  | —       | +50  | ps   | 2, 3, 4 |

**Notes:**

1. **Caution:** Only 100 and 125 MHz have been tested. In-between values do not work correctly with the rest of the system.
2. At RefClk input.
3. In a frequency band from 150 kHz to 15 MHz at BER of  $10^{-12}$ .
4. Total peak-to-peak deterministic jitter must be less than or equal to 50 ps.
5. Measurement taken from differential waveform.
6. For recommended operating conditions, see [Table 3](#).

### 3.27.5.3 AC transmitter output characteristics

This table provides the differential transmitter output AC characteristics for the SATA interface at Gen 1i/1m or 1.5 Gbits/s transmission. The AC timing specifications do not include RefClk jitter.

**Table 139. Gen 1i/1m 1.5 G transmitter AC specifications<sup>2</sup>**

| Parameter                              | Symbol                | Min      | Typ      | Max      | Units  | Notes |
|----------------------------------------|-----------------------|----------|----------|----------|--------|-------|
| Channel speed                          | $t_{CH\_SPEED}$       | —        | 1.5      | —        | Gbps   | —     |
| Unit interval                          | $T_{UI}$              | 666.4333 | 666.6667 | 670.2333 | ps     | —     |
| Total jitter data-data 5 UI            | $U_{SATA\_TXTJ5UI}$   | —        | —        | 0.355    | UI p-p | 1     |
| Total jitter, data-data 250 UI         | $U_{SATA\_TXTJ250UI}$ | —        | —        | 0.47     | UI p-p | 1     |
| Deterministic jitter, data-data 5 UI   | $U_{SATA\_TXDJ5UI}$   | —        | —        | 0.175    | UI p-p | 1     |
| Deterministic jitter, data-data 250 UI | $U_{SATA\_TXDJ250UI}$ | —        | —        | 0.22     | UI p-p | 1     |

**Notes:**

1. Measured at transmitter output pins peak-to-peak phase variation; random data pattern.
2. For recommended operating conditions, see [Table 3](#).

This table provides the differential transmitter output AC characteristics for the SATA interface at Gen 2i/2m or 3.0 Gbits/s transmission. The AC timing specifications do not include RefClk jitter.

**Table 140. Gen 2i/2m 3 G transmitter AC specifications<sup>2</sup>**

| Parameter                                                                                                                                                                            | Symbol                  | Min      | Typ      | Max      | Units  | Notes |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------|----------|----------|----------|--------|-------|
| Channel speed                                                                                                                                                                        | $t_{CH\_SPEED}$         | —        | 3.0      | —        | Gbps   | —     |
| Unit Interval                                                                                                                                                                        | $T_{UI}$                | 333.2167 | 333.3333 | 335.1167 | ps     | —     |
| Total jitter $f_{C3dB} = f_{BAUD} \div 500$                                                                                                                                          | $U_{SATA\_TXTJfB/500}$  | —        | —        | 0.37     | UI p-p | 1     |
| Total jitter $f_{C3dB} = f_{BAUD} \div 1667$                                                                                                                                         | $U_{SATA\_TXTJfB/1667}$ | —        | —        | 0.55     | UI p-p | 1     |
| Deterministic jitter, $f_{C3dB} = f_{BAUD} \div 500$                                                                                                                                 | $U_{SATA\_TXDJfB/500}$  | —        | —        | 0.19     | UI p-p | 1     |
| Deterministic jitter, $f_{C3dB} = f_{BAUD} \div 1667$                                                                                                                                | $U_{SATA\_TXDJfB/1667}$ | —        | —        | 0.35     | UI p-p | 1     |
| <b>Notes:</b><br>1. Measured at transmitter output pins peak-to-peak phase variation; random data pattern.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |                         |          |          |          |        |       |

This table provides the differential transmitter output AC characteristics for the SATA interface at Gen 3i transmission. The AC timing specifications do not include RefClk jitter.

**Table 141. Gen 3i transmitter AC specifications ( $S1V_{DD} = 1.0$  V)**

| Parameter                                                     | Symbol | Min      | Typ      | Max      | Units  |
|---------------------------------------------------------------|--------|----------|----------|----------|--------|
| Speed                                                         | —      | —        | 6.0      | —        | Gb/s   |
| Total jitter before and after compliance interconnect channel | $J_T$  | —        | —        | 0.52     | UI p-p |
| Random jitter before compliance interconnect channel          | $J_R$  | —        | —        | 0.18     | UI p-p |
| Unit interval                                                 | UI     | 166.6083 | 166.6667 | 167.5583 | ps     |

### 3.27.5.4 AC differential receiver input characteristics

This table provides the Gen1i/1m or 1.5 Gbits/s differential receiver input AC characteristics for the SATA interface. The AC timing specifications do not include RefClk jitter.

**Table 142. Gen 1i/1m 1.5 G receiver AC specifications<sup>2</sup>**

| Parameter                      | Symbol                | Min      | Typical  | Max      | Units  | Notes |
|--------------------------------|-----------------------|----------|----------|----------|--------|-------|
| Unit Interval                  | $T_{UI}$              | 666.4333 | 666.6667 | 670.2333 | ps     | —     |
| Total jitter data-data 5 UI    | $U_{SATA\_RXTJ5UI}$   | —        | —        | 0.43     | UI p-p | 1     |
| Total jitter, data-data 250 UI | $U_{SATA\_RXTJ250UI}$ | —        | —        | 0.60     | UI p-p | 1     |

*Table continues on the next page...*

**Table 142. Gen 1i/1m 1.5 G receiver AC specifications<sup>2</sup> (continued)**

| Parameter                                                                                                               | Symbol                       | Min | Typical | Max  | Units  | Notes |
|-------------------------------------------------------------------------------------------------------------------------|------------------------------|-----|---------|------|--------|-------|
| Deterministic jitter, data-data 5 UI                                                                                    | $U_{\text{SATA\_RXDJ5UI}}$   | —   | —       | 0.25 | UI p-p | 1     |
| Deterministic jitter, data-data 250 UI                                                                                  | $U_{\text{SATA\_RXDJ250UI}}$ | —   | —       | 0.35 | UI p-p | 1     |
| <b>Notes:</b><br>1. Measured at the receiver.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |                              |     |         |      |        |       |

This table provides the differential receiver input AC characteristics for the SATA interface at Gen2i/2m or 3.0 Gbits/s transmission. The AC timing specifications do not include RefClk jitter.

**Table 143. Gen 2i/2m 3 G receiver AC specifications<sup>2</sup>**

| Parameter                                                                                                               | Symbol                         | Min      | Typical  | Max      | Units  | Notes |
|-------------------------------------------------------------------------------------------------------------------------|--------------------------------|----------|----------|----------|--------|-------|
| Unit Interval                                                                                                           | $T_{\text{UI}}$                | 333.2167 | 333.3333 | 335.1167 | ps     | —     |
| Total jitter $f_{\text{C3dB}} = f_{\text{BAUD}} \div 500$                                                               | $U_{\text{SATA\_RXTJfB/500}}$  | —        | —        | 0.60     | UI p-p | 1     |
| Total jitter $f_{\text{C3dB}} = f_{\text{BAUD}} \div 1667$                                                              | $U_{\text{SATA\_RXTJfB/1667}}$ | —        | —        | 0.65     | UI p-p | 1     |
| Deterministic jitter, $f_{\text{C3dB}} = f_{\text{BAUD}} \div 500$                                                      | $U_{\text{SATA\_RXDJfB/500}}$  | —        | —        | 0.42     | UI p-p | 1     |
| Deterministic jitter, $f_{\text{C3dB}} = f_{\text{BAUD}} \div 1667$                                                     | $U_{\text{SATA\_RXDJfB/1667}}$ | —        | —        | 0.35     | UI p-p | 1     |
| <b>Notes:</b><br>1. Measured at the receiver.<br>2. For recommended operating conditions, see <a href="#">Table 3</a> . |                                |          |          |          |        |       |

This table provides the differential receiver input AC characteristics for the SATA interface at Gen 3i transmission. The AC timing specifications do not include RefClk jitter.

**Table 144. Gen 3i receiver AC specifications<sup>2</sup>**

| Parameter                                                                                               | Symbol         | Min      | Typical  | Max      | Units  | Notes |
|---------------------------------------------------------------------------------------------------------|----------------|----------|----------|----------|--------|-------|
| Total jitter after compliance interconnect channel                                                      | $J_{\text{T}}$ | —        | —        | 0.60     | UI p-p | 1     |
| Random jitter before compliance interconnect channel                                                    | $J_{\text{R}}$ | —        | —        | 0.18     | UI p-p | 1     |
| Unit interval: 6.0 Gb/s                                                                                 | UI             | 166.6083 | 166.6667 | 167.5583 | ps     | —     |
| <b>Notes:</b><br>1. Measured at the receiver.<br>2. The AC specifications do not include RefClk jitter. |                |          |          |          |        |       |

## 4 Hardware design considerations

### 4.1 Power supply design

#### 4.1.1 Core and platform supply voltage filtering

The  $V_{DD}$ ,  $V_{DDC}$  supply is normally derived from a linear regulator or switching power supply that can regulate its output voltage very accurately despite changes in current demand from the chip within the regulator's relatively low bandwidth. Several bulk decoupling capacitors must be distributed around the PCB to supply transient current demand above the bandwidth of the voltage regulator.

These bulk capacitors should have a low equivalent series resistance (ESR) rating to ensure a quick response time. They should also be connected to the power and ground planes through two vias to minimize inductance. Customers should work directly with their power regulator vendor for best values and types of bulk capacitors.

As a guideline for customers and their power regulator vendors, NXP recommends that these bulk capacitors be chosen to maintain the positive transient power surges to less than + 50 mV (negative transient undershoot should comply with specification of -30 mV) for current steps of up to 2A with a slew rate of 1.5A/ $\mu$ s.

These bulk decoupling capacitors will ideally supply a stable voltage for current transients into the megahertz range. Above that, see [Decoupling recommendations](#) for further decoupling recommendations.

#### 4.1.2 PLL power supply filtering

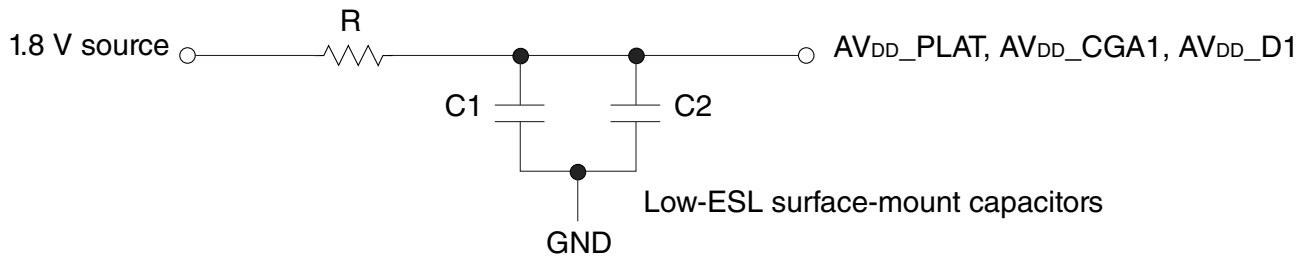
Each of the PLLs is provided with power through independent power supply pins ( $AV_{DD\_PLAT}$ ,  $AV_{DD\_CGA1}$ ,  $AV_{DD\_D1}$  and  $AV_{DD\_SD1\_PLLn}$ ).  $AV_{DD\_PLAT}$ ,  $AV_{DD\_CGA1}$ , and  $AV_{DD\_D1}$  voltages must be derived directly from a 1.8 V voltage source through a low frequency filter scheme.  $AV_{DD\_SD1\_PLLn}$  voltages must be derived directly from the  $X1V_{DD}$  source through a low frequency filter scheme. The recommended solution for PLL filtering is to provide independent filter circuits per PLL power supply, as illustrated in [Figure 81](#), one for each of the  $AV_{DD}$  pins. By providing independent filters to each PLL, the opportunity to cause noise injection from one PLL to the other is reduced. This circuit is intended to filter noise in the PLL's resonant frequency range from a 500 kHz to 10 MHz range.

Each circuit should be placed as close as possible to the specific  $AV_{DD}$  pin being supplied to minimize noise coupled from nearby circuits. It should be possible to route directly from the capacitors to the  $AV_{DD}$  pin, which is on the periphery of the footprint, without the inductance of vias.

This figure shows the PLL power supply filter circuit.

Where:

- $R = 5\ \Omega \pm 5\%$
- $C1 = 10\ \mu\text{F} \pm 10\%$ , 0603, X5R, with  $ESL \leq 0.5\ \text{nH}$
- $C2 = 1.0\ \mu\text{F} \pm 10\%$ , 0402, X5R, with  $ESL \leq 0.5\ \text{nH}$



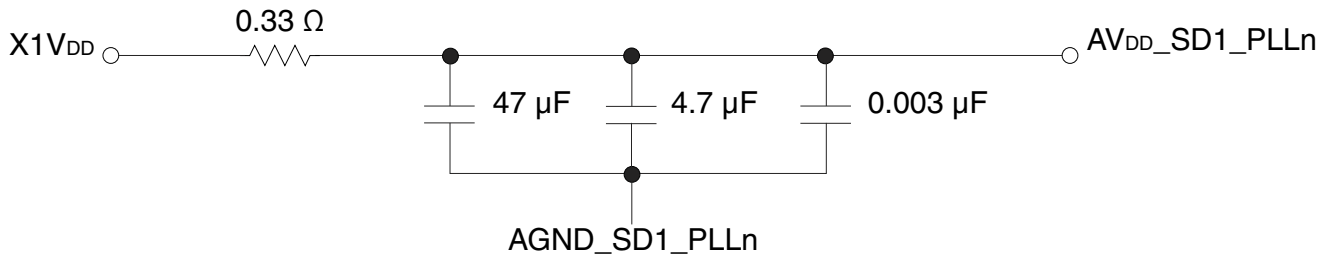
**Figure 81. PLL power supply filter circuit**

Note the following:

- A higher capacitance value for  $C2$  may be used to improve the filter as long as the other  $C2$  parameters do not change (0402 body, X5R,  $ESL \leq 0.5\ \text{nH}$ ).
- Voltage for  $AV_{DD}$  is defined at the input of the PLL supply filter and not the pin of  $AV_{DD}$ .

The  $AV_{DD\_SD1\_PLLn}$  signals provide power for the analog portions of the SerDes PLL. To ensure stability of the internal clock, the power supplied to the PLL is filtered using a circuit similar to the one shown in following [Figure 82](#). For maximum effectiveness, the filter circuit is placed as closely as possible to the  $AV_{DD\_SD1\_PLLn}$  balls to ensure it filters out as much noise as possible. The ground connection should be near the  $AV_{DD\_SD1\_PLLn}$  balls. The  $0.003\text{-}\mu\text{F}$  capacitors should be closest to the balls, followed by a  $4.7\text{-}\mu\text{F}$  and  $47\text{-}\mu\text{F}$  capacitor, and finally the  $0.33\ \Omega$  resistor to the board supply plane. The capacitors are connected from  $AV_{DD\_SD1\_PLLn}$  to the ground plane. Use ceramic chip capacitors with the highest possible self-resonant frequency. All traces should be kept short, wide, and direct.

This figure shows the PLL power supply filter circuit for the SerDes.



**Figure 82. SerDes PLL power supply filter circuit**

Note the following:

- $AV_{DD\_SD1\_PLLn}$  should be a filtered version of  $X1V_{DD}$ .
- Signals on the SerDes interface are fed from the  $X1V_{DD}$  power plane.
- Voltage for  $AV_{DD\_SD1\_PLLn}$  is defined at the PLL supply filter and not the pin of  $AV_{DD\_SD1\_PLLn}$ .
- The  $47\text{-}\mu F$  0805 XR5 or XR7,  $4.7\text{-}\mu F$  0603, and  $0.003\text{-}\mu F$  0402 capacitors are recommended. The size and material type are important. A  $0.33\text{-}\Omega \pm 1\%$  resistor is recommended.
- There needs to be dedicated analog ground,  $AGND\_SD1\_PLLn$  for each  $AV_{DD\_SD1\_PLLn}$  pin up to the physical locale of the filters themselves.

### 4.1.3 S1V<sub>DD</sub> power supply filtering

$S1V_{DD}$  may be supplied by a linear regulator or sourced by a filtered  $V_{DD}$ . Systems may design in both options to allow flexibility to address system noise dependencies.

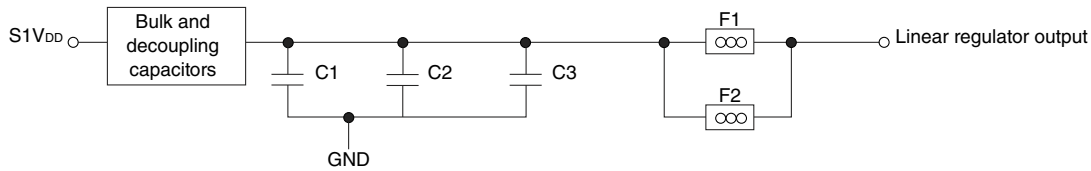
#### NOTE

For initial system bring-up, the linear regulator option is highly recommended.

The following figure illustrates an example solution for  $S1V_{DD}$  filtering, where  $S1V_{DD}$  is sourced from a linear regulator. The component values in this example filter are system dependent and are still under characterization. Component values may need adjustment based on the system or environment noise.

Where:

- $C1 = 0.003\ \mu F \pm 10\%$ , X5R, with  $ESL \leq 0.5\ nH$
- $C2$  and  $C3 = 2.2\ \mu F \pm 10\%$ , X5R, with  $ESL \leq 0.5\ nH$
- $F1$  and  $F2 = 120\ \Omega$  at 100 MHz 2A 25% 0603 Ferrite (for example, Murata BLM18PG121SH1)
- Bulk and decoupling capacitors are added, as needed, per power supply design.



**Figure 83. S1V<sub>DD</sub> power supply filter circuit**

Note the following:

- For maximum S1V<sub>DD</sub> power-up ramp rate, see [Table 12](#).
- There needs to be enough output capacitance or a soft start feature to ensure the ramp rate requirement is met.
- The ferrite beads should be placed in parallel to reduce voltage droop.
- Besides a linear regulator, a low-noise, dedicated switching regulator can also be used. The goal is 10 mVp-p, 50 kHz - 500 MHz.

#### 4.1.4 X1V<sub>DD</sub> power supply filtering

X1V<sub>DD</sub> must be supplied by a linear regulator or sourced by a filtered G1V<sub>DD</sub>. Systems may design in both options to allow flexibility to address system noise dependencies.

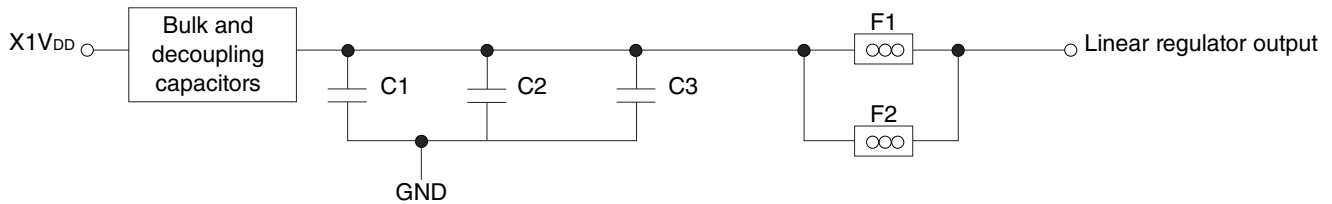
#### NOTE

For initial system bring-up, the linear regulator option is highly recommended.

The following figure is an example solution for X1V<sub>DD</sub> filtering, where X1V<sub>DD</sub> is sourced from a linear regulator. The component values in this example filter are system dependent and are still under characterization. Component values may need adjustment based on the system or environment noise.

Where:

- C1 = 0.003  $\mu$ F  $\pm$  10%, X5R, with ESL  $\leq$  0.5 nH
- C2 and C3 = 2.2  $\mu$ F  $\pm$  10%, X5R, with ESL  $\leq$  0.5 nH
- F1 and F2 = 120  $\Omega$  at 100 MHz 2A 25% 0603 Ferrite (for example, Murata BLM18PG121SH1)
- Bulk and decoupling capacitors are added, as needed, per power supply design.



**Figure 84. X1V<sub>DD</sub> power supply filter circuit**

Note the following:

- For maximum X1V<sub>DD</sub> power-up ramp rate, see [Table 12](#).
- There needs to be enough output capacitance or a soft-start feature to ensure the ramp rate requirement is met.
- The ferrite beads should be placed in parallel to reduce voltage droop.
- Besides a linear regulator, a low-noise, dedicated switching regulator can be used. 10 mVp-p, 50 kHz - 500 MHz is the noise goal.

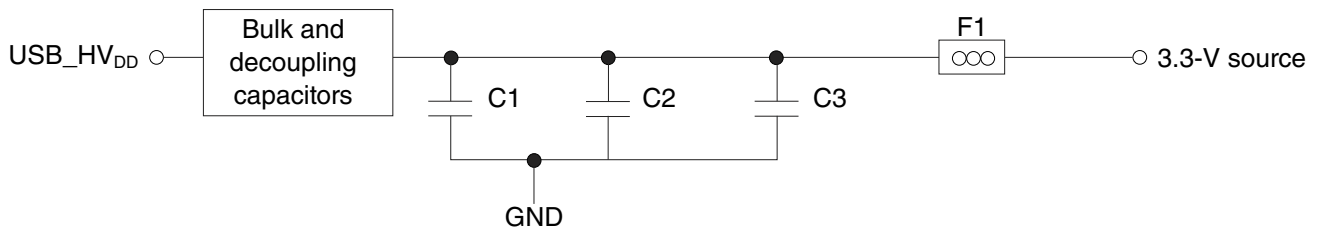
#### 4.1.5 USB\_HV<sub>DD</sub> power supply filtering

USB\_HV<sub>DD</sub> must be sourced by a filtered 3.3 V voltage source using a star connection.

The following figure illustrates an example solution for USB\_HV<sub>DD</sub> filtering, where USB\_HV<sub>DD</sub> is sourced from a 3.3 V voltage source. The component values in this example filter are system dependent and are still under characterization. Component values may need adjustment based on the system or environment noise.

Where:

- C1 = 0.003  $\mu$ F  $\pm$  10%, X5R, with ESL  $\leq$  0.5 nH
- C2 and C3 = 2.2  $\mu$ F  $\pm$  10%, X5R, with ESL  $\leq$  0.5 nH
- F1 = 120  $\Omega$  at 100 MHz 2A 25% 0603 Ferrite (for example, Murata BLM18PG121SH1)
- Bulk and decoupling capacitors are added, as needed, per power supply design.



**Figure 85. USB\_HV<sub>DD</sub> power supply filter circuit**

### 4.1.6 USB\_SnV<sub>DD</sub> power supply filtering (SDV<sub>DD</sub>, SPV<sub>DD</sub>, SXV<sub>DD</sub>)

USB\_SnV<sub>DD</sub> must be sourced by a filtered V<sub>DD</sub> using a star connection.

The following figure illustrates an example solution for USB\_SnV<sub>DD</sub> filtering, where USB\_SnV<sub>DD</sub> is sourced from V<sub>DD</sub>. The component values in this example filter are system dependent and are still under characterization. Component values may need adjustment based on the system or environment noise.

Where:

- C1 = 2.2  $\mu$ F  $\pm$  20%, X5R, with Low ESL (for example, Panasonic ECJ0EB0J225M)
- F1 = 120  $\Omega$  at 100-MHz 2A 25% Ferrite (for example, Murata BLM18PG121SH1)
- Bulk and decoupling capacitors are added, as needed, per power supply design.

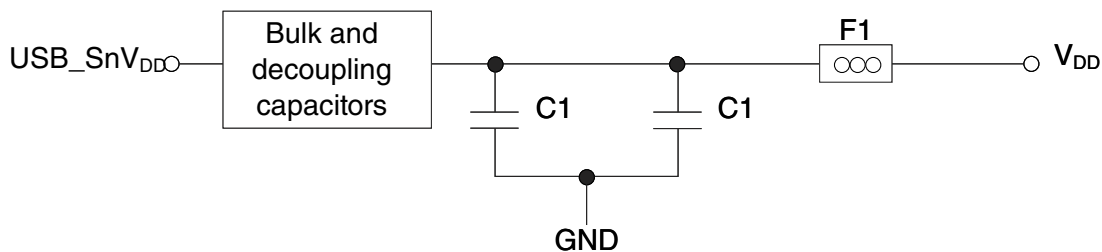


Figure 86. USB\_SnV<sub>DD</sub> power supply filter circuit

## 4.2 Decoupling recommendations

Because of large address and data buses and high operating frequencies, the device can generate transient power surges and high frequency noise in its power supply, especially while driving large capacitive loads. This noise must be prevented from reaching other components in the chip system, and the chip itself requires a clean, tightly regulated source of power. Therefore, it is recommended that the system designer place at least one decoupling capacitor at each V<sub>DD</sub>, V<sub>DDC</sub>, TA\_BB\_V<sub>DD</sub>, O1V<sub>DD</sub>, OV<sub>DD</sub>, BV<sub>DD</sub>, D1V<sub>DD</sub>, DV<sub>DD</sub>, EV<sub>DD</sub>, L1V<sub>DD</sub>, LV<sub>DD</sub>, and G1V<sub>DD</sub> pin of the device. These decoupling capacitors should receive their power from separate V<sub>DD</sub>, V<sub>DDC</sub>, TA\_BB\_V<sub>DD</sub>, O1V<sub>DD</sub>, OV<sub>DD</sub>, BV<sub>DD</sub>, D1V<sub>DD</sub>, DV<sub>DD</sub>, EV<sub>DD</sub>, L1V<sub>DD</sub>, LV<sub>DD</sub>, G1V<sub>DD</sub>, and GND power planes in the PCB, utilizing short traces to minimize inductance. Capacitors may be placed directly under the device using a standard escape pattern. Others may surround the part.

These capacitors should have a value of 0.1  $\mu$ F. Only ceramic surface mount technology (SMT) capacitors should be used to minimize lead inductance, preferably 0402 or 0603 sizes.

As presented in [Core and platform supply voltage filtering](#), it is recommended that there be several bulk storage capacitors distributed around the PCB, feeding the  $V_{DD}$ ,  $V_{DDC}$  and other planes (for example,  $V_{DD}$ ,  $DV_{DD}$ ,  $EV_{DD}$ ,  $LV_{DD}$ , and  $G1V_{DD}$ ), to enable quick recharging of the smaller chip capacitors.

### 4.3 SerDes block power supply decoupling recommendations

The SerDes block requires a clean, tightly regulated source of power ( $S1V_{DD}$  and  $X1V_{DD}$ ) to ensure low jitter on transmit and reliable recovery of data in the receiver. An appropriate decoupling scheme is outlined below:

1. The board should have at least 1 x 0.1-uF SMT ceramic chip capacitor placed as close as possible to each supply ball of the device. Where the board has blind vias, these capacitors should be placed directly below the chip supply and ground connections. Where the board does not have blind vias, these capacitors should be placed in a ring around the device as close to the supply and ground connections as possible.
2. Between the device and any SerDes voltage regulator, there should be a lower bulk capacitor. For example, a 10-uF, low ESR SMT tantalum or ceramic capacitor. There should also be a higher bulk capacitor. For example, a 100uF - 300-uF low ESR SMT tantalum or ceramic capacitor.

#### NOTE

Only SMT capacitors should be used to minimize inductance. Connections from all capacitors to power and ground should be done with multiple vias to further reduce inductance.

### 4.4 Connection recommendations

The following is a list of connection recommendations:

- To ensure reliable operation, it is highly recommended to connect unused inputs to an appropriate signal level. Unless otherwise noted in this document, all unused active low inputs should be tied to  $V_{DD}$ ,  $V_{DDC}$ ,  $TA\_BB\_V_{DD}$ ,  $O1V_{DD}$ , and  $OV_{DD}$ ,  $BV_{DD}$ ,  $D1V_{DD}$ ,  $DV_{DD}$ ,  $EV_{DD}$ ,  $L1V_{DD}$ ,  $LV_{DD}$ , and  $G1V_{DD}$ , as required. All unused active high inputs should be connected to GND. All NC (no-connect) signals must remain unconnected. Power and ground connections must be made to all external  $V_{DD}$ ,  $V_{DDC}$ ,  $TA\_BB\_V_{DD}$ ,  $O1V_{DD}$ ,  $OV_{DD}$ ,  $BV_{DD}$ ,  $D1V_{DD}$ ,  $DV_{DD}$ ,  $EV_{DD}$ ,  $L1V_{DD}$ ,  $LV_{DD}$ ,  $G1V_{DD}$ , and GND pins of the device.
- The TEST\_SEL\_B pin must be pulled to  $OV_{DD}$  through a 100-ohm to 1k-ohm resistor.

### 4.4.1 JTAG configuration signals

Correct operation of the JTAG interface requires configuration of a group of system control pins, as demonstrated in [Figure 88](#). Take care to ensure that these pins are maintained at a valid deasserted state under normal operating conditions as most have asynchronous behavior and spurious assertion will give unpredictable results.

The JTAG port of these processors allows a remote computer system (typically, a PC with dedicated hardware and debugging software) to access and control the internal operations of the processor. The Arm Cortex 10-pin header connects primarily through the JTAG port of the processor, with some additional status monitoring signals.

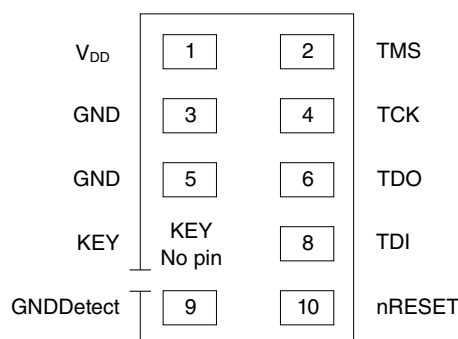
The Cortex Debug Connector has a standard header, as shown in [Figure 87](#). The connector typically has pin 7 removed as a connector key.

The Arm Cortex 10-pin header adds many benefits, such as breakpoints, watchpoints, register and memory examination/modification, and other standard debugger features. An inexpensive option can be to leave the Arm Cortex 10-pin header unpopulated until needed.

#### 4.4.1.1 Termination of unused signals

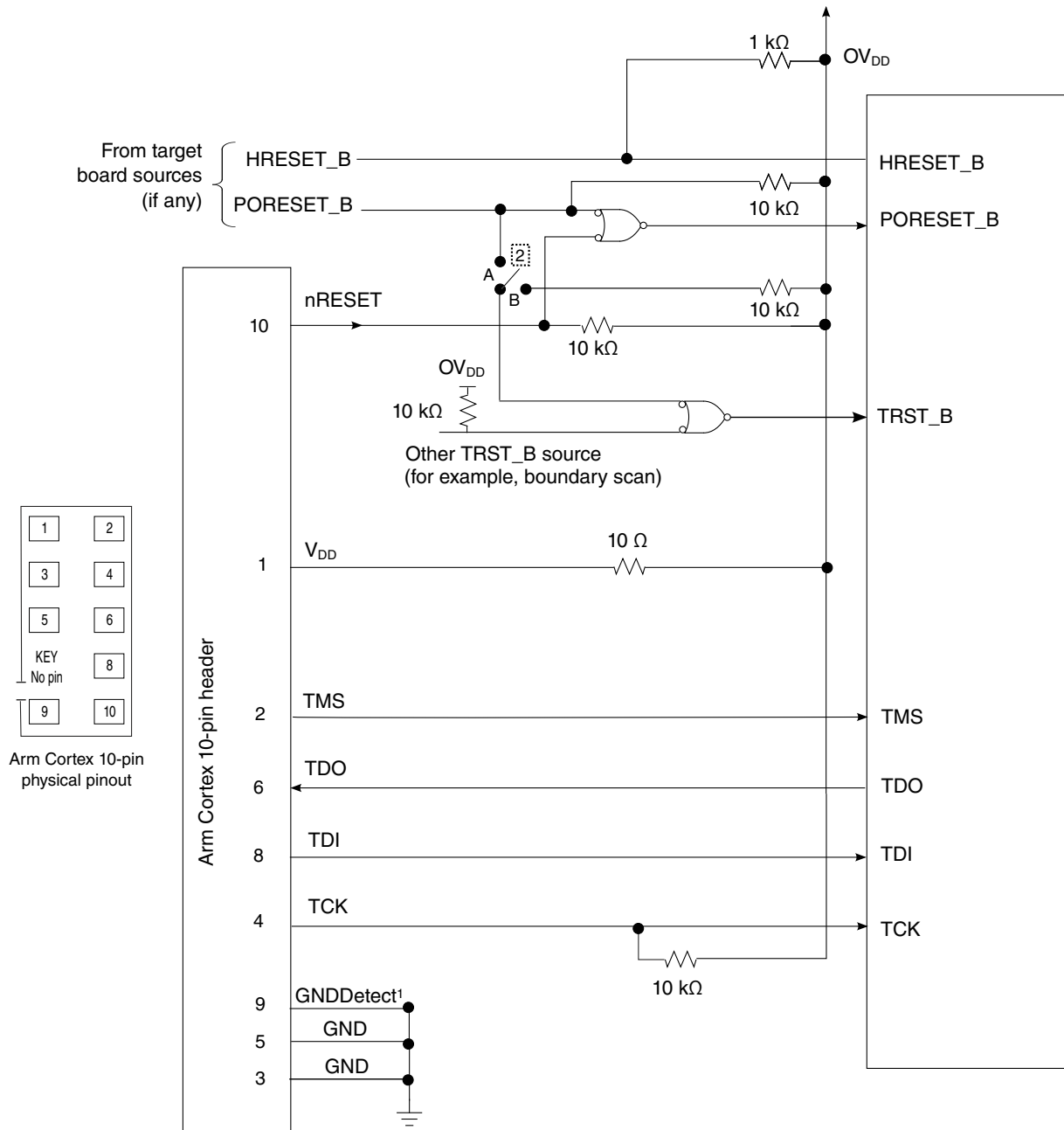
If the JTAG interface and Arm Cortex 10-pin header are not used, no pull-up/pull-down is required for TDI, TMS, or TDO.

This figure shows the Arm Cortex 10-pin header physical pinout.



**Figure 87. Arm Cortex 10-pin header physical pinout**

This figure shows the JTAG interface connection.

**Note:**

1. GNDDetect<sup>1</sup> is an optional board feature. Check with 3<sup>rd</sup>-party tool vendor.
2. This switch is included as a precaution for IEEE 1149.1 testing. The switch should be open (in position B) during BSDL testing to avoid accidentally asserting the TRST\_B line. For normal device operation or debug testing, ensure this switch is closed (in position A).

**Figure 88. JTAG interface connection**

## 4.4.2 Guidelines for high-speed interface termination

#### 4.4.2.1 SerDes interface entirely unused

If the high-speed SerDes interface is not used at all, the unused pin should be terminated as described in this section.

Note that  $S1V_{DD}$ ,  $X1V_{DD}$ ,  $AVDD\_SD1\_PLL1$ , and  $AVDD\_SD1\_PLL2$  must remain powered.

$AVDD\_SD1\_PLL1$  must be connected to  $X1V_{DD}$  through a  $0\text{-}\Omega$  resistor (instead of through a filter circuit, as shown in [Figure 82](#)).

The following pins must be left unconnected:

- $SD1\_TX[3:0]\_P$
- $SD1\_TX[3:0]\_N$
- $SD1\_IMP\_CAL\_RX$
- $SD1\_IMP\_CAL\_TX$

The following pins must be connected to  $S1GND$ :

- $SD1\_REF\_CLK1\_P$ ,  $SD1\_REF\_CLK2\_P$
- $SD1\_REF\_CLK1\_N$ ,  $SD1\_REF\_CLK2\_N$

It is recommended for the following pins to be connected to  $S1GND$ :

- $SD1\_RX[3:0]\_P$
- $SD1\_RX[3:0]\_N$

It is possible to disable the SerDes module by disabling all PLLs associated with it. Use the following method to disable the SerDes module:

- $SRDS\_PLL\_PD\_S1 = 2'b11$  (Both PLLs are configured as powered down; all data lanes selected by the protocols defined in  $SRDS\_PRTCL\_S1$  associated to the PLLs are powered down, as well.)
- $SRDS\_PLL\_REF\_CLK\_SEL\_S1 = 2'b00$
- $SRDS\_PRTCL\_S1 = 2$  (No other values are permitted when both PLLs are powered down.)

#### 4.4.2.2 SerDes interface partly unused

If only part of the high-speed SerDes interface pins are used, the remaining high-speed serial I/O pins should be terminated as described in this section.

Note that both  $S1V_{DD}$  and  $X1V_{DD}$  must remain powered.

If any of the PLLs are unused, the corresponding AVDD\_SD1\_PLL1 and AVDD\_SD1\_PLL2 must be connected to X1V<sub>DD</sub> through a 0-Ω resistor (instead of through a filter circuit, as shown in [Figure 82](#)).

The following unused pins must be left unconnected:

- SD1\_TX0\_P
- SD1\_TX0\_N

The following unused pins must be connected to S1GND:

- SD1\_REF\_CLK<sub>n</sub>\_P, SD1\_REF\_CLK<sub>n</sub>\_N (If the entire SerDes is unused.)

It is recommended for the following unused pins to be connected to S1GND:

- SD1\_RX0\_P
- SD1\_RX0\_N

In the RCW configuration field SRDS\_PLL\_PD\_S1, the respective bits for each unused PLL must be set to power it down. A module is disabled when both its PLLs are turned off.

Unused lanes must be powered down through the SRDSx Lane m General Control 0 (SRDSxLNmGCR0) register as follows:

- SRDSxLNmGCR0[RRST] = 0
- SRDSxLNmGCR0[TRST] = 0
- SRDSxLNmGCR0[RX\_PD] = 1
- SRDSxLNmGCR0[TX\_PD] = 1

Note that in the case where the SerDes pins are connected to slots, it is acceptable to have these pins unterminated when unused.

#### 4.4.3 USB1 PHY connections

This section describes the hardware connections required for the USB PHY.

This figure shows the VBUS interface for the chip.

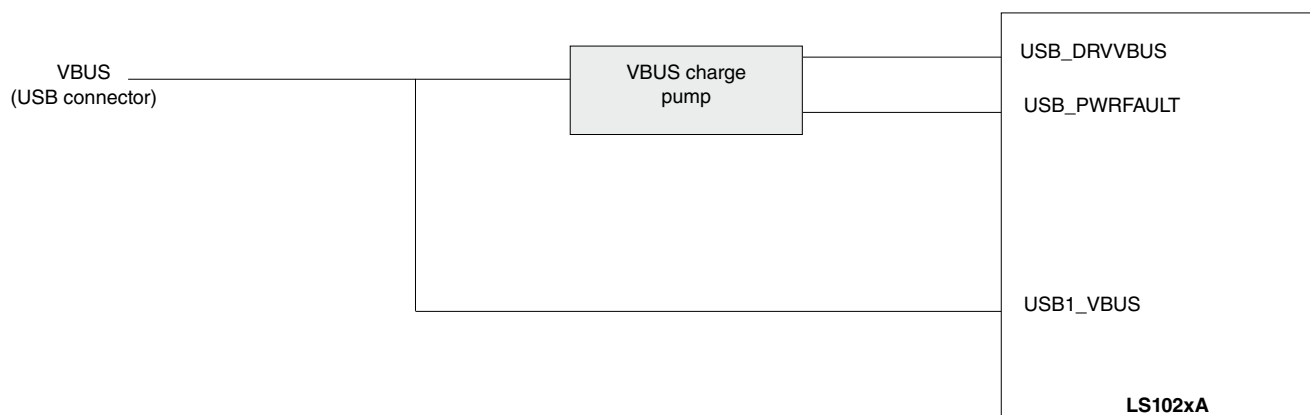


Figure 89. USB1 PHY VBUS interface

## 4.5 Thermal

This table provides the thermal characteristics for the chip. Note that these numbers are based on design estimates.

Table 145. Package thermal characteristics (no lid)<sup>5</sup>

| Rating                                  | Board                   | Symbol             | Value | Unit | Notes |
|-----------------------------------------|-------------------------|--------------------|-------|------|-------|
| Junction to ambient, natural convection | Single-layer board (1s) | $R_{\theta JA}$    | 47    | °C/W | 1, 2  |
| Junction to ambient, natural convection | Four-layer board (2s2p) | $R_{\theta JA}$    | 43    | °C/W | 1, 3  |
| Junction to ambient (at 200 ft./min.)   | Single-layer board (1s) | $R_{\theta JMA}$   | 45    | °C/W | 1, 2  |
| Junction to ambient (at 200 ft./min.)   | Four-layer board (2s2p) | $R_{\theta JMA}$   | 38    | °C/W | 1, 2  |
| Junction to board                       | —                       | $R_{\theta JB}$    | 33    | °C/W | 3     |
| Junction to case top                    | —                       | $R_{\theta JCtop}$ | <0.1  | °C/W | 4     |

### Notes:

1. Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.
2. Junction-to-ambient thermal resistance determined per JEDEC JESD51-3 and JESD51-6 with the board (JESD51-9) horizontal.
3. Junction-to-board thermal resistance determined per JEDEC JESD51-8. Thermal test board meets JEDEC specification for the specified package.
4. Junction-to-case top at the top of the package determined using MIL-STD 883 Method 1012.1. The cold plate temperature is used for the case temperature. Reported value includes the thermal resistance of the interface layer.
5. For additional details, see [Thermal management information](#).

**Table 146. Package thermal characteristics (with lid)**

| Rating                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Board                   | Symbol              | Value | Unit | Notes |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------|---------------------|-------|------|-------|
| Junction to Ambient Natural Convection                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Single-layer board (1s) | $R_{\theta JA}$     | 35    | °C/W | 1     |
| Junction to Ambient Natural Convection                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Four-layer board (2s2p) | $R_{\theta JA}$     | 24    | °C/W | 1     |
| Junction to Ambient, Moving Air (1 m/s)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Single-layer board (1s) | $R_{\theta JMA}$    | 24.5  | °C/W | 1     |
| Junction to Ambient, Moving Air (1 m/s)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Four-layer board (2s2p) | $R_{\theta JMA}$    | 18    | °C/W | 1     |
| Junction to Board                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |                         | $R_{\theta JB}$     | 12.6  | °C/W | 2     |
| Junction to Case (Top)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | -                       | $R_{\theta JACtop}$ | 1.8   | °C/W | 3     |
| Notes:<br>1. Junction-to-Ambient Thermal Resistance determined per JEDEC JESD51-2A and JESD51-6. Thermal test board meets JEDEC specification for this package (JESD51-9).<br>2. Junction-to-Board thermal resistance determined per JEDEC JESD51-8. Thermal test board meets JEDEC specification for the specified package.<br>3. Junction-to-Case at the top of the package determined using MIL-STD 883 Method 1012.1. The cold plate temperature is used for the case temperature. Reported value includes the thermal resistance of the interface layer. |                         |                     |       |      |       |

## 4.6 Recommended thermal model

Information about Flotherm models of the package or thermal data not available in this document can be obtained from your local NXP sales office.

## 4.7 Temperature diode

The chip has a temperature diode on the microprocessor that can be used in conjunction with other system temperature monitoring devices (such as Analog Devices, ADT7461A). These devices feature series resistance cancellation using three current measurements, where up to 1.5 K $\Omega$  of resistance can be automatically cancelled from the temperature result, allowing noise filtering and a more accurate reading.

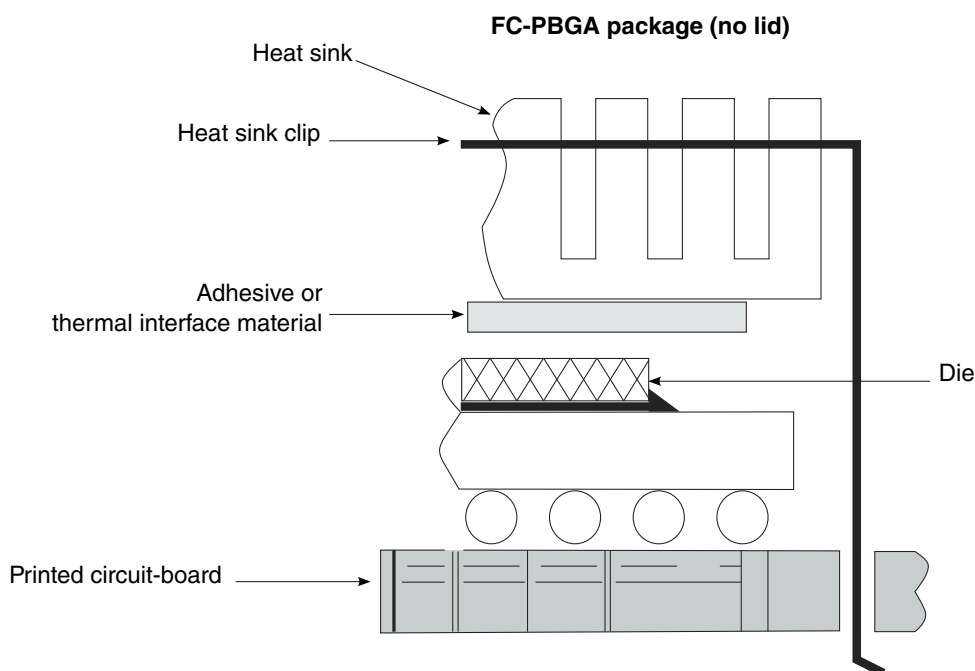
The following are the specifications of the chip's on-board temperature diode:

- Operating range: 10 - 230  $\mu$ A
- Ideality factor over temperature range 80 °C - 105 °C:  $n = 1.006 \pm 0.003$ , with approximate error  $\pm 1$  °C and error under  $\pm 3$  °C for temperature range 0 °C to 85 °C.

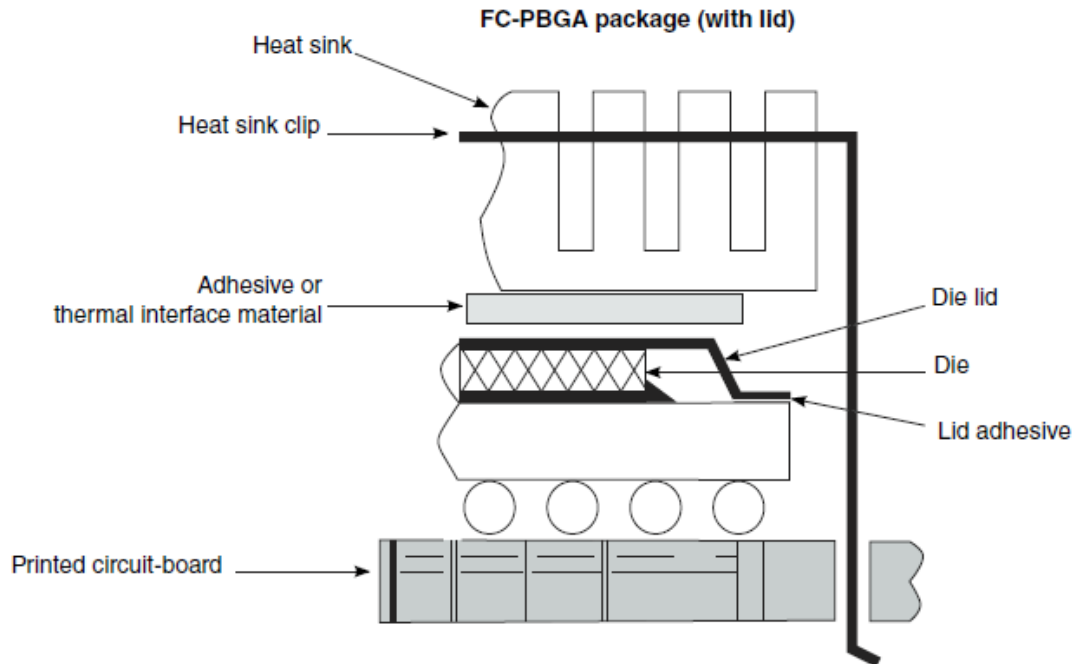
## 4.8 Thermal management information

This section describes the thermal management information for the flip-chip, plastic-ball, grid array (FC-PBGA) package for air-cooled applications. Proper thermal control design is primarily dependent on the system-level design — the heat sink, airflow, and thermal interface material.

The recommended attachment method to the heat sink is illustrated in the following figure. The heat sink should be attached to the printed-circuit board with the spring force centered over the die. This spring force should not exceed 10 pounds force for *no-lid* package and *with-lid* package.



**Figure 90. Package exploded, cross-sectional view-FC-PBGA (no lid)**



**Figure 91. Package exploded, cross-sectional view-FC-PBGA (with lid)**

The system board designer can choose between several types of heat sinks to place on the device. There are several commercially available thermal interfaces to choose from in the industry. Ultimately, the final selection of an appropriate heat sink depends on many factors, such as thermal performance at a given air velocity, spatial volume, mass, attachment method, assembly, and cost.

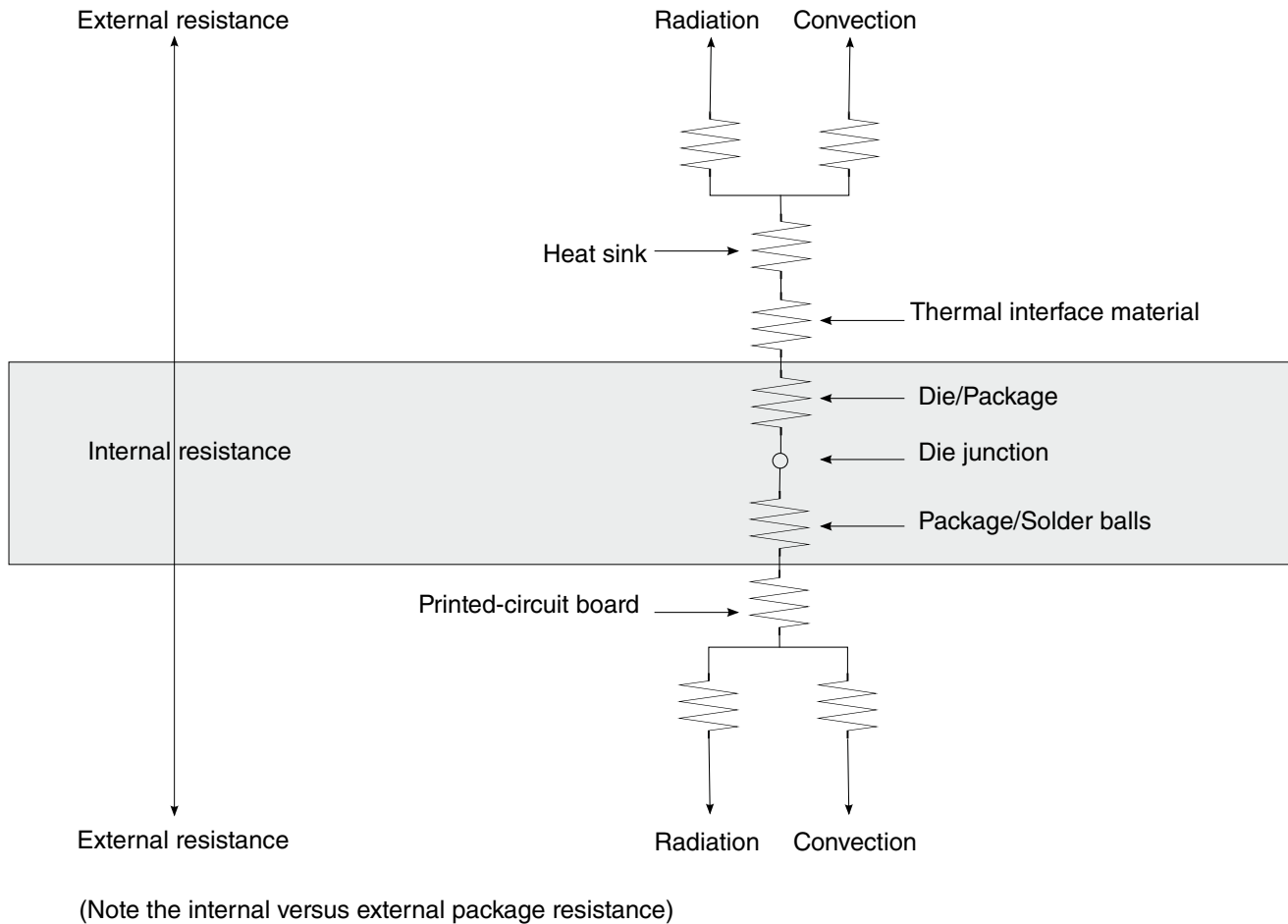
For additional information regarding thermal management of lid-less flip-chip packages, see application note AN4871, "Assembly Handling and Thermal Solutions for Lidless Flip Chip Ball Grid Array Packages".

#### 4.8.1 Internal package conduction resistance

For the package, the intrinsic internal conduction thermal resistance paths are as follows:

- The die junction-to-case thermal resistance
- The die junction-to-board thermal resistance

This figure shows the primary heat transfer path for a package with an attached heat sink mounted to a printed-circuit board.



**Figure 92. Package with heat sink mounted to a printed-circuit board**

The heat sink removes most of the heat from the device. Heat generated on the active side of the chip is conducted through the silicon and through the heat sink attach material (or thermal interface material), and finally to the heat sink. The junction-to-case thermal resistance is low enough that the heat sink attach material and heat sink thermal resistance are the dominant terms.

## 4.8.2 Thermal interface materials

A thermal interface material is required at the package-to-heat sink interface to minimize the thermal contact resistance. The performance of thermal interface materials improves with increasing contact pressure; this performance characteristic chart is generally provided by the thermal interface vendor. The recommended method of mounting heat sinks on the package is by means of a spring clip attachment to the printed-circuit board (see [Figure 90](#)).

The system board designer can choose among several types of commercially available thermal interface materials.

## 5 Package information

### 5.1 Mechanical dimensions of the FC-PBGA (no lid)

This figure shows the mechanical dimensions and bottom surface nomenclature of the chip.



**Notes:**

1. All dimensions in millimeters.
2. Dimensioning and tolerancing per ASME Y14.5M - 1994.
3. Maximum solder ball diameter measured parallel to datum C.
4. Datum C, the seating plane, is determined by the spherical crowns of the solder balls.
5. Parallelism measurement shall exclude any effect of mark on top surface of package.

## **5.2 Mechanical dimensions of the FC-PBGA (with lid)**

This figure shows the mechanical dimensions and bottom surface nomenclature of the chip.

### Notes:

- QorIQ LS1020A Data Sheet, Rev. 8, 06/2019**

3. Maximum solder ball diameter measured parallel to datum C.
4. Datum C, the seating plane, is determined by the spherical crowns of the solder balls.
5. Parallelism measurement shall exclude any effect of mark on top surface of package.
6. All dimensions are symmetric across the package center lines, unless dimensioned otherwise.
7. Pin 1 thru hole shall be centered within the foot area.
8. 19.15 mm maximum package assembly (lid + laminate) X and Y.
9. Lid overhang on substrate not to exceed 0.1 mm.

## 6 Security fuse processor

This chip implements the QorIQ platform's Trust Architecture, supporting capabilities such as secure boot. Use of the Trust Architecture features is dependent on programming fuses in the Security Fuse Processor (SFP). The details of the Trust Architecture and SFP can be found in the chip reference manual.

To program SFP fuses, the user is required to supply 1.8 V to the TA\_PROG\_SFP pin per [Power sequencing](#). TA\_PROG\_SFP should only be powered for the duration of the fuse programming cycle, with a per device limit of two fuse programming cycles. All other times, TA\_PROG\_SFP should be connected to GND. The sequencing requirements for raising and lowering TA\_PROG\_SFP are shown in [Power sequencing](#). To ensure device reliability, fuse programming must be performed within the recommended fuse programming temperature range per [Table 3](#).

### NOTE

Users not implementing the QorIQ platform's Trust Architecture features should connect TA\_PROG\_SFP to GND.

## 7 Ordering information

### 7.1 Part numbering nomenclature

This table provides the NXP QorIQ platform part numbering nomenclature.

**Table 147. Part numbering nomenclature**

| <i>p</i>                                     | <i>ls</i>  | <i>n</i>          | <i>nn</i>               | <i>n</i>  | <i>x</i>  | <i>t</i>                               | <i>e</i>                               | <i>n</i>                                 | <i>c</i>                                    | <i>d</i>                                                             | <i>r</i>     |
|----------------------------------------------|------------|-------------------|-------------------------|-----------|-----------|----------------------------------------|----------------------------------------|------------------------------------------|---------------------------------------------|----------------------------------------------------------------------|--------------|
| Qual Status                                  | Generation | Performance level | Number of virtual cores | Unique ID | Core type | Temperature range                      | Encryption                             | Package type                             | CPU speed                                   | DDR data rate                                                        | Die revision |
| P="Prototype"<br>S="Special"<br>Blank="Qual" | LS         | 1                 | 02                      | 0         | A = Arm   | S = Standard temp<br>X = Extended temp | E = SEC present<br>N = SEC not present | 7 = LCFC (no lid)<br>8 = LCFC (with lid) | K = 1000 MHz<br>H = 800 MHz<br>M = 1200 MHz | N = 1300 MT/s<br>K = 1000 MT/s<br>Q = 1600 MT/s<br>Z = Not specified | B = Rev 2.0  |

## 7.2 Orderable part numbers addressed by this document

This table provides the NXP orderable part numbers addressed by this document for the chip.

**Table 148. Orderable part numbers addressed by this document**

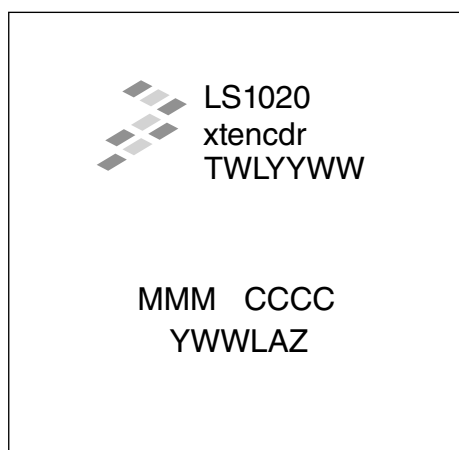
| Part number/<br>marking on<br>the chip                                                                                     | <i>p</i> | <i>ls</i> | <i>n</i> | <i>nn</i>              | <i>n</i> | <i>x</i> | <i>t</i>                     | <i>e</i>                       | <i>n</i>                                 | <i>c</i>                                    | <i>d</i>                       | <i>r</i> |
|----------------------------------------------------------------------------------------------------------------------------|----------|-----------|----------|------------------------|----------|----------|------------------------------|--------------------------------|------------------------------------------|---------------------------------------------|--------------------------------|----------|
| LS1020ASE7M QB<br>LS1020AXE7M QB<br>LS1020ASN7M QB<br>LS1020AXN7M QB<br>LS1020ASE7K QB<br>LS1020AXE7K QB<br>LS1020ASN7K QB | blank    | LS        | 1        | 02 = 2 cores (virtual) | 0        | A = Arm  | S = Std temp<br>X = Ext temp | E = Encrypt<br>N = Not Encrypt | 7 = LCFC (no lid)<br>8 = LCFC (with lid) | M = 1200 MHz<br>K = 1000 MHz<br>H = 800 MHz | N = 1300 MT/s<br>Q = 1600 MT/s | B        |

**Table 148. Orderable part numbers addressed by this document**

| Part number/<br>marking on<br>the chip | <i>p</i> | <i>ls</i> | <i>n</i> | <i>nn</i> | <i>n</i> | <i>x</i> | <i>t</i> | <i>e</i> | <i>n</i> | <i>c</i> | <i>d</i> | <i>r</i> |
|----------------------------------------|----------|-----------|----------|-----------|----------|----------|----------|----------|----------|----------|----------|----------|
| LS1020AXN7K<br>QB                      |          |           |          |           |          |          |          |          |          |          |          |          |
| LS1020ASE7H<br>NB                      |          |           |          |           |          |          |          |          |          |          |          |          |
| LS1020AXE7H<br>NB                      |          |           |          |           |          |          |          |          |          |          |          |          |
| LS1020ASN7H<br>NB                      |          |           |          |           |          |          |          |          |          |          |          |          |
| LS1020AXN7H<br>NB                      |          |           |          |           |          |          |          |          |          |          |          |          |
| LS1020ASE8K<br>QB                      |          |           |          |           |          |          |          |          |          |          |          |          |

## 7.2.1 Part marking

Parts are marked as in the example shown in this figure.



FC-BGA

**Legend:**

LS1020xtencdr is the part marking on the die. See the corresponding orderable part number in the table above.

TWLYYWW is the test traceability code.

MMM is the mask number.

CCCC is the country code.

YWWLAZ is the assembly traceability code.

**Figure 95. Part marking for FC-BGA chip without lid (LS1020A)**



FC-BGA

Legend:  
LS1020xtencdr is the part marking on the die. See the corresponding orderable part number in the table above.  
AWLYYWW is the test traceability code.  
MMMMM is the mask number.  
CCCCC is the country code.  
YWWLAZ is the assembly traceability code.

Figure 96. Part marking for FC-BGA chip with lid (LS1020A)

8 Revision history

This table summarizes revisions to this document.

Table 149. Revision history

| Revision | Date    | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|----------|---------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 8        | 06/2019 | <ul style="list-style-type: none"><li>In <a href="#">Table 1</a>,<ul style="list-style-type: none"><li>added note 25.</li><li>changed the note reference of D1_MAPAR_ERR_B signal from 6 to 25.</li></ul></li><li>Added note 6 in <a href="#">Table 5</a>.</li><li>Removed row ECn_GTX_CLK125 jitter from <a href="#">Table 19</a>.</li><li>Updated Min and Max values for MDQS preamble and MDQS postamble parameters in <a href="#">Table 31</a>.</li><li>Updated the specifications of the chip's on-board temperature diode in <a href="#">Temperature diode</a> section.</li></ul> |
| 7        | 07/2018 | <ul style="list-style-type: none"><li>In <a href="#">Table 1</a>, merged two eSDHC buses.</li><li>Updated <a href="#">Table 2</a>.</li><li>Removed table "PLL lock times" from <a href="#">RESET initialization</a>.</li><li>In <a href="#">Table 99</a>, updated Min value of parameters CS to SCK Delay and After SCK Delay and added footnote 1 to these parameters.</li><li>Updated <a href="#">Table 102</a>.</li><li>In <a href="#">Table 109</a>, updated footnote 4.</li><li>Updated <a href="#">Figure 55</a>.</li></ul>                                                       |
| 6        | 09/2017 | <ul style="list-style-type: none"><li>In <a href="#">Table 1</a>,<ul style="list-style-type: none"><li>updated signal description for signals TD1_ANODE and TD1_CATHODE.</li></ul></li></ul>                                                                                                                                                                                                                                                                                                                                                                                            |

Table continues on the next page...

**Table 149. Revision history (continued)**

| Revision | Date    | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|----------|---------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|          |         | <ul style="list-style-type: none"> <li>• updated note reference for signals SPARE1 and SPARE2.</li> <li>• updated note 19.</li> <li>• Replaced ARM with Arm throughout the document as per updated Arm brand guidelines</li> <li>• Added <a href="#">Table 11</a>.</li> <li>• In <a href="#">Table 35</a>, added note 5 and updated notes for parameter Output differential voltage (XVDD-Typ at 1.35 V).</li> <li>• In <a href="#">Table 53</a>, added note 6 and updated note reference for parameter TSEC_1588_CLK_IN clock period.</li> <li>• In <a href="#">Table 109</a>, added note 4 and updated max value and note reference for parameter Input current (OVIN = 0 V or OVIN = OVDD).</li> <li>• Added new section, <a href="#">Temperature diode</a>.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 5        | 03/2017 | <ul style="list-style-type: none"> <li>• In <a href="#">Table 1</a>, updated the note 22.</li> <li>• In <a href="#">Table 2</a>, removed note for PLL core supply measurement.</li> <li>• In <a href="#">Table 3</a>, added note 8.</li> <li>• In <a href="#">Table 23</a>, removed slew rate.</li> <li>• Updated <a href="#">Table 24</a> and added note 7.</li> <li>• In the <a href="#">Thermal</a> section, added <a href="#">Table 146</a> for the thermal characteristics of the package with lid.</li> <li>• In the <a href="#">Thermal management information</a> section, added spring force value for package with lid and added <a href="#">Figure 91</a>.</li> <li>• Added new section, <a href="#">Mechanical dimensions of the FC-PBGA (with lid)</a>.</li> <li>• Updated <a href="#">Table 147</a> for CPU speed and "with lid" package type.</li> <li>• Updated <a href="#">Table 148</a>.</li> <li>• In the <a href="#">Part marking</a> section, added <a href="#">Figure 96</a>.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 4        | 11/2016 | <ul style="list-style-type: none"> <li>• In <a href="#">Table 8</a>, added a new row for supporting 1200 MHz frequency.</li> <li>• In <a href="#">Table 9</a>, added a new column for 1.2 GHz frequency.</li> <li>• In <a href="#">Table 26</a>, updated maximum value for input low voltage.</li> <li>• In <a href="#">Table 112</a>, updated maximum value for output low voltage.</li> <li>• In the <a href="#">GIC DC electrical characteristics</a> section, updated "LVDD/ L1VDD = 2.5 V" to "L/L1/D/D1/O/O1/E/BV<sub>DD</sub> = 2.5 V".</li> <li>• In the <a href="#">GPIO DC electrical characteristics</a> section, updated "LVDD/ L1VDD = 2.5 V" to "L/L1/D/D1/O/O1/E/BV<sub>DD</sub> = 2.5 V".</li> <li>• In <a href="#">Table 148</a>, added part numbers for 1200 MHz.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 3        | 05/2016 | <ul style="list-style-type: none"> <li>• Throughout document: <ul style="list-style-type: none"> <li>• Changed company references from Freescale to NXP within the body of the document content.</li> <li>• Renamed description for power supply TA_BB_VDD from "Low Powered Security Monitor supply" to Battery Backed Security Monitor supply."</li> <li>• Removed reference to signal TA_BB_RTC.</li> </ul> </li> <li>• In <a href="#">Pinout list</a>, <ul style="list-style-type: none"> <li>• Changed name of "Trust" section to "Battery Backed Trust."</li> <li>• For signal TA_BB_RTC: <ul style="list-style-type: none"> <li>• Changed signal description to "Reserved"</li> <li>• Applied note #15, "These pins must be pulled to ground (GND)."</li> </ul> </li> <li>• For TA_BB_TMP_DETECT_B, changed signal description from "Low Power Tamper Detect" to "Battery Backed Tamper Detect"</li> <li>• For CKSTP_OUT_B, changed signal description to "Reserved"</li> <li>• For power supply TA_BB_VDD, changed description from "Low Power Security Monitor Supply" to "Battery Backed Security Monitor Supply"</li> <li>• Moved D1_MDM8 (B21), D1_MDQS8 (A21), D1_MDQS8_B(A20) from the reserved listing back to their active locations.</li> </ul> </li> <li>• In <a href="#">Power sequencing</a>, updated stable value from 75ms to 400ms and added step three to secure boot fuse programming sequence.</li> </ul> |

*Table continues on the next page...*

**Table 149. Revision history (continued)**

| Revision | Date    | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|----------|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|          |         | <ul style="list-style-type: none"> <li>In <a href="#">Differential system clock DC electrical characteristics table</a>, added note 3, "Input differential voltage swing (Vid) specified is equal to <math>IVDIFF\_SYSCLK\_P - VDIFF\_SYSCLK\_NI</math>."</li> <li>In <a href="#">Differential system clock AC timing specifications table</a>, added note 3, "The 100 MHz reference frequency is needed if USB is used. The reference clock to USB PHY is selectable between SYSCLK or DIFF_SYSCLK/DIF_SYSCLK_B. The selected clock must meet the clock specifications for USB."</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 2        | 02/2016 | <ul style="list-style-type: none"> <li>In Features listing, removed "supports 1000Base KX" from SerDes feature list.</li> <li>In <a href="#">Pinout list</a>, added new note, "Permissible voltage range" to the USB1_VBUS pin.</li> <li>In <a href="#">Recommended operating conditions</a>, updated table and added the following sentence to table note #7, "This also applies to DVDD and D1VDD."</li> <li>In <a href="#">Output driver capability table</a>, added D1VDD to DVDD.</li> <li>In <a href="#">Real-time clock recommendations table</a>, added a "Typical value" column and updated min and max values.</li> <li>In the table for <a href="#">Differential system clock DC electrical characteristics</a>, updated min, max, and typical values for input capacitance and added note #2, "The die capacitance may cause reflection of the clock signal through the package back to the pin. This should not affect the signal quality seen by internal PLL. Recommend verifying signal quality using IBIS simulations."</li> <li><a href="#">RESET initialization timing specifications table</a>, added new notes #5 &amp; #6.</li> <li>In <a href="#">EMI1 DC electrical characteristics</a>, updated all tables: <ul style="list-style-type: none"> <li>Removed table note #2, "The symbol L1VIN, in this case, represents the L1VIN symbol referenced in Table 3."</li> <li>Removed table note #3, "The symbol L1VDD, in this case, represents the L1VDD symbols referenced in Table 3."</li> <li>Updated LVDD to L1VDD.</li> </ul> </li> <li>In <a href="#">USB 3.0 reference clock requirements</a> : <ul style="list-style-type: none"> <li>Added a paragraph concerning the two options for USB PHY reference clock.</li> <li>Removed rows pertaining to Common mode input level, Differential input swing, Single-ended input logic low, Single-ended input logic high, Input edge rate, and Reference clock skew from the Reference clock requirements table</li> </ul> </li> <li>In <a href="#">QuadSPI timing SDR mode</a>, updated figure QuadSPI AC timing — SDR mode.</li> <li>In <a href="#">eSDHC AC timing specifications</a>, updated the following figures: <ul style="list-style-type: none"> <li>eSDHC DDR50/eMMC DDR mode input AC timing diagram</li> <li>eSDHC DDR50/eMMC DDR mode output AC timing diagram</li> </ul> </li> <li>In <a href="#">SATA DC transmitter output characteristics</a>, updated title of table from Gen 3i transmitter DC specifications (<math>S1VDD = 1.0\text{ V}</math>)<sup>2</sup> to Gen 3i transmitter DC specifications (<math>X1VDD = 1.35\text{ V}</math>)<sup>2</sup></li> <li>In <a href="#">Termination of unused signals</a>, updated note #2 of figure, "JTAG interface connection," to read: "This switch is included as a precaution for IEEE 1149.1 testing."</li> </ul> |
| 1        | 11/2015 | <ul style="list-style-type: none"> <li>In <a href="#">Introduction</a> updated block diagram.</li> <li>In <a href="#">DDR3L and DDR4 SDRAM interface AC timing specifications</a>, added entries for 1000 MT/s data rate.</li> <li>In <a href="#">DDR3L and DDR4 SDRAM interface output AC timing specifications</a>, added entries for 1000 MT/s data rate.</li> <li>Removed topic, DDR3L and DDR4 SDRAM differential timing specifications.</li> <li>In <a href="#">Part numbering nomenclature</a>, changed the unit of measure for DDR data rate (column d) from MHz to MT/s.</li> <li>In <a href="#">Orderable part numbers addressed by this document</a>, changed the unit of measure for DDR data rate (column d) from MHz to MT/s.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 0        | 10/2015 | Initial public release                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |

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